

# MSP430F51x2、MSP430F51x1 混合信号微控制器

## 1 器件概述

### 1.1 特性

- 低电源电压范围：  
3.6V 到 1.8V
  - 超低功耗
    - 激活模式(AM): 180 $\mu$ A/MHz
    - 待机模式 (LPM3 WDT 模式, 3V) : 1.1 $\mu$ A
    - 关闭模式 (LPM4 RAM 保持, 3V) : 0.9 $\mu$ A
    - 关断模式 (LPM4.5, 3V): 0.25 $\mu$ A
  - 在不到 5 $\mu$ s 的时间内超快速地从待机模式中唤醒
  - 16 位精简指令集计算机 (RISC) 架构, 扩展内存, 40ns 指令周期时间
  - 灵活的电源管理系统
    - 内置可编程的低压降稳压器 (LDO)
    - 电源电压监控、监视、和临时限电
  - 统一时钟系统
    - 针对频率稳定的锁频环路 (FLL) 控制环路
    - 低功率低频内部时钟源 (VLO)
    - 低频修整内部基准源 (REFO)
    - 32kHz 晶振 (XT1)
    - 频率高达 25MHz 的高频晶振 (XT1)
  - 硬件乘法器支持 32 位运算
  - 3 通道直接存储器访问 (DMA)
  - 多达 12 个 5V 耐压数字推挽式 I/O, 驱动强度高达 20mA<sup>(1)</sup>
  - 具有 3 个捕捉/比较寄存器且支持高分辨率模式的 16 位定时器 TD0
  - 具有 3 个捕捉/比较寄存器且支持高分辨率模式的 16 位定时器 TD1
  - 具有 3 个捕捉/比较寄存器的 16 位定时器 TA0
  - 通用串行通信接口 (USCI) <sup>(1)</sup>
    - USCI\_A0 支持:
      - 增强型通用异步收发器 (UART) 支持自动波特率检测
      - IrDA 编码和解码
      - 同步 SPI
    - USCI\_B0 支持:
      - I<sup>2</sup>C
      - 同步串行外设接口 (SPI)
  - 10 位 200ksps 模数转换器 (ADC)
    - 内部基准电压
    - 采样和保持
    - 自动扫描功能
    - 多达 8 个外部通道和 2 个内部通道, 包括温度传感器<sup>(1)</sup>
  - 多达 16 通道的片上比较器, 包含超低功耗模式<sup>(1)</sup>
  - 串行板上编程, 无需外部编程电压
  - [Device Comparison](#) 总结了可用的系列产品成员
  - 采用 40 引脚四方扁平无引线 (QFN) (RSB), 38 引脚薄型小外形尺寸 (TSSOP) (DA), 和 40 引脚芯片尺寸球状引脚栅格阵列 (BGA) (YFF) 封装
  - 有关完整模块说明, 请参见 [《MSP430x5xx 和 MSP430x6xx 系列器件用户指南》](#)
- (1) 40 引脚 QFN 封装选项提供全部功能。有关其他封装的可用功能, 请参见 [Signal Descriptions](#)。

### 1.2 应用范围

- 模拟和数字传感器系统
- LED 照明
- 数字电源
- 电机控制
- 遥控
- 恒温器



### 1.3 说明

TI MSP 系列超低功耗微控制器种类繁多，各成员器件配备不同的外设集以满足各类应用的需求。该架构与五种低功耗模式配合使用，是延长便携式测量应用电池寿命的最优选择。该器件具有一个强大的 16 位 RISC CPU，使用 16 位寄存器以及常数发生器，以便获得最高编码效率。数控振荡器 (DCO) 可使器件在不到 5 $\mu$ s 的时间内从低功耗模式唤醒并进入工作模式。

MSP430F51x2 微控制器包含 2 个 16 位高分辨率定时器、2 个 USCI (USCI\_A0 和 USCI\_B0)、1 个 32 位硬件乘法器、1 个高性能 10 位 ADC、1 个片上比较器、1 个三通道 DMA、5V 耐压 I/O 以及多达 29 个 I/O 引脚。

MSP430F51x1 微控制器包含 2 个 16 位高分辨率定时器、2 个 USCI (USCI\_A0 和 USCI\_B0)、1 个 32 位硬件乘法器、1 个片上比较器、1 个三通道 DMA、5V 耐压 I/O 以及多达 29 个 I/O 引脚。

这些器件的典型应用包括：模拟和数字传感器系统、LED 照明、数字电源、电机控制、远程控制、温度调节装置、数字定时器和手持式仪表。

器件信息<sup>(1)</sup>

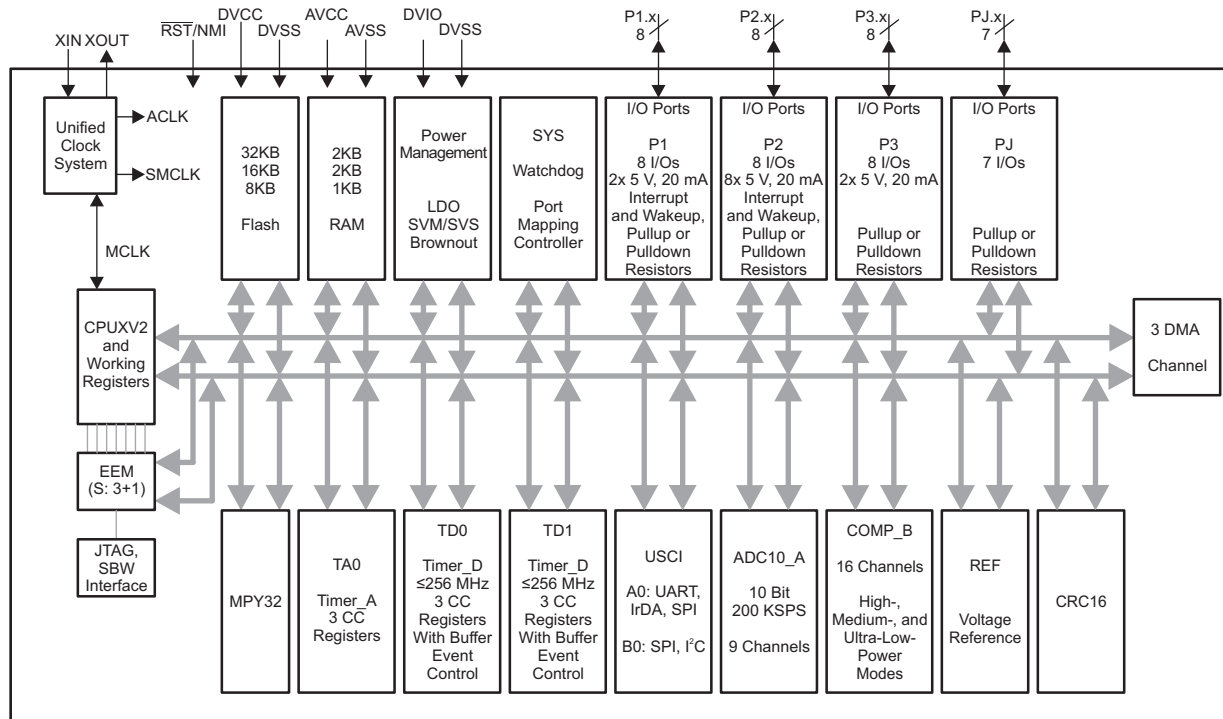
| 器件型号            | 封装         | 封装尺寸 <sup>(2)</sup> |
|-----------------|------------|---------------------|
| MSP430F5172IYFF | DSBGA (40) | 3.1mm x 2.8mm       |
| MSP430F5172IRSB | WQFN (40)  | 5mm x 5mm           |
| MSP430F5172IDA  | TSSOP (38) | 12.5mm x 6.2mm      |

(1) 要获得最新的产品、封装和订购信息，请参见封装选项附录（节 8），或者访问德州仪器 (TI) 网站 [www.ti.com](http://www.ti.com)。

(2) 此处显示的尺寸为近似值。要获得包含误差值的封装尺寸，请参见节 8 中的机械数据。

## 1.4 功能方框图

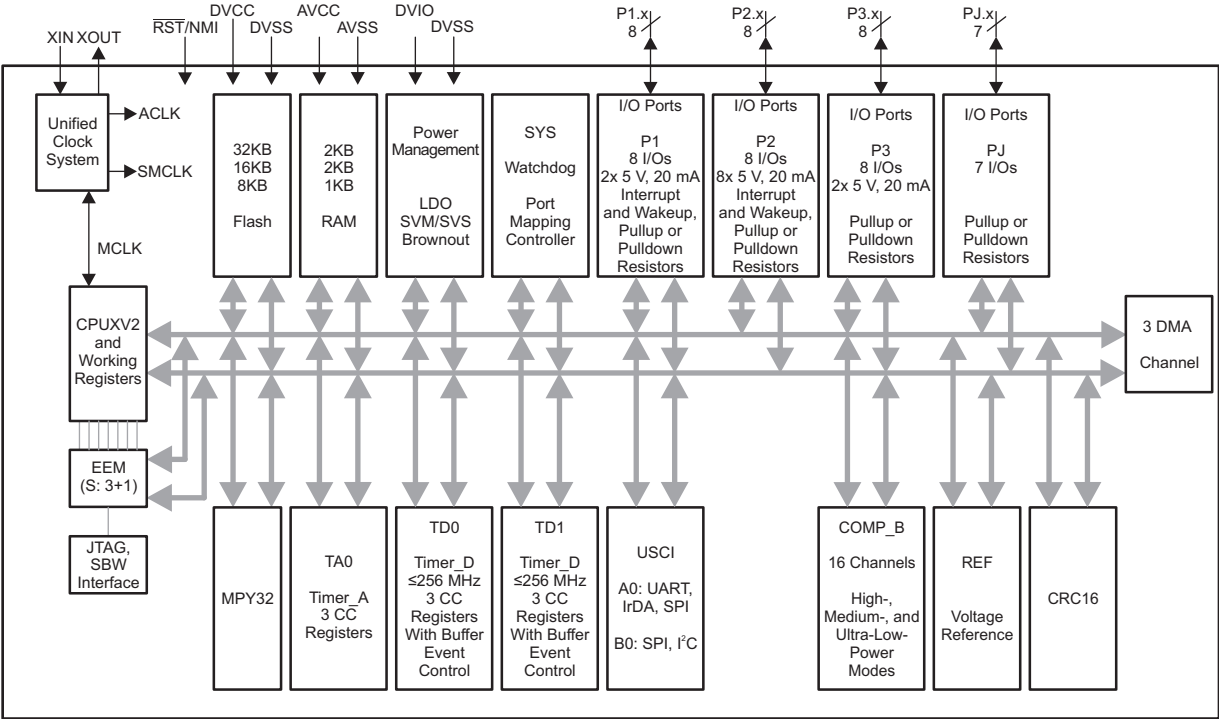
图 1-1 显示 MSP430F51x2 器件的功能方框图。



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图 1-1. 功能方框图，MSP430F51x2

图 1-2 显示 MSP430F51x1 器件的功能方框图。



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图 1-2. 功能方框图, MSP430F51x1

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## 2 修订历史记录

| Changes from May 13, 2015 to May 9, 2016                                                                                                                                    | Page                |
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| • Added <a href="#">Section 3.1, Related Products</a> .....                                                                                                                 | <a href="#">8</a>   |
| • Added "with reconfigurable port mapping secondary function" to applicable GPIO descriptions (ports P1, P2, and P3) in <a href="#">Table 4-1, Terminal Functions</a> ..... | <a href="#">11</a>  |
| • Changed all MIN, TYP, and MAX values for the $V_{REF}$ parameter in <a href="#">Section 5.43, Comparator_B</a> .....                                                      | <a href="#">43</a>  |
| • Changed all instances of "bootstrap loader" to "bootloader" .....                                                                                                         | <a href="#">54</a>  |
| • Corrected spelling of NMIIFG in <a href="#">Table 6-8, System Module Interrupt Vector Registers</a> .....                                                                 | <a href="#">59</a>  |
| • 已将先前的“开发工具支持”部分替换为“ <a href="#">节 7.3、工具和软件</a> ” .....                                                                                                                   | <a href="#">99</a>  |
| • 已更改格式并添加内容至 <a href="#">节 7.4、文档支持部分</a> .....                                                                                                                            | <a href="#">101</a> |

### 3 Device Comparison

Table 3-1 summarizes the available family members.

**Table 3-1. Device Comparison<sup>(1)(2)</sup>**

| DEVICE      | FLASH<br>(KB) | SRAM<br>(KB) | Timer_A <sup>(3)</sup> | Timer_D <sup>(4)</sup> | USCI                             |                                     | ADC10_A<br>(Ch) | Comp_B<br>(Ch) | I/O | PACKAGE  |
|-------------|---------------|--------------|------------------------|------------------------|----------------------------------|-------------------------------------|-----------------|----------------|-----|----------|
|             |               |              |                        |                        | CHANNEL A:<br>UART, IrDA,<br>SPI | CHANNEL B:<br>SPI, I <sup>2</sup> C |                 |                |     |          |
| MSP430F5172 | 32            | 2            | 3                      | 3, 3                   | 1                                | 1                                   | 9 ext, 2 int    | 16             | 31  | 40 QFN   |
|             |               |              |                        |                        |                                  |                                     | 8 ext, 2 int    | 15             | 29  | 40 DSBGA |
|             |               |              |                        |                        |                                  |                                     | 8 ext, 2 int    | 15             | 29  | 38 TSSOP |
| MSP430F5152 | 16            | 2            | 3                      | 3, 3                   | 1                                | 1                                   | 9 ext, 2 int    | 16             | 31  | 40 QFN   |
|             |               |              |                        |                        |                                  |                                     | 8 ext, 2 int    | 15             | 29  | 40 DSBGA |
|             |               |              |                        |                        |                                  |                                     | 8 ext, 2 int    | 15             | 29  | 38 TSSOP |
| MSP430F5132 | 8             | 1            | 3                      | 3, 3                   | 1                                | 1                                   | 9 ext, 2 int    | 16             | 31  | 40 QFN   |
|             |               |              |                        |                        |                                  |                                     | 8 ext, 2 int    | 15             | 29  | 40 DSBGA |
|             |               |              |                        |                        |                                  |                                     | 8 ext, 2 int    | 15             | 29  | 38 TSSOP |
| MSP430F5171 | 32            | 2            | 3                      | 3, 3                   | 1                                | 1                                   | –               | 16             | 31  | 40 QFN   |
|             |               |              |                        |                        |                                  |                                     |                 | 15             | 29  | 40 DSBGA |
|             |               |              |                        |                        |                                  |                                     |                 | 15             | 29  | 38 TSSOP |
| MSP430F5151 | 16            | 2            | 3                      | 3, 3                   | 1                                | 1                                   | –               | 16             | 31  | 40 QFN   |
|             |               |              |                        |                        |                                  |                                     |                 | 15             | 29  | 40 DSBGA |
|             |               |              |                        |                        |                                  |                                     |                 | 15             | 29  | 38 TSSOP |
| MSP430F5131 | 8             | 1            | 3                      | 3, 3                   | 1                                | 1                                   | –               | 16             | 31  | 40 QFN   |
|             |               |              |                        |                        |                                  |                                     |                 | 15             | 29  | 40 DSBGA |
|             |               |              |                        |                        |                                  |                                     |                 | 15             | 29  | 38 TSSOP |

- (1) For the most current package and ordering information, see the *Package Option Addendum* in [§ 8](#), or see the TI website at [www.ti.com](http://www.ti.com).
- (2) Package drawings, thermal data, and symbolization are available at [www.ti.com/packaging](http://www.ti.com/packaging).
- (3) Each number in the sequence represents an instantiation of Timer\_A with its associated number of capture compare registers and PWM output generators available. For example, a number sequence of 3, 5 would represent two instantiations of Timer\_A, the first instantiation having 3 and the second instantiation having 5 capture compare registers and PWM output generators, respectively.
- (4) Each number in the sequence represents an instantiation of Timer\_D with its associated number of capture compare registers and PWM output generators available. For example, a number sequence of 3, 5 would represent two instantiations of Timer\_D, the first instantiation having 3 and the second instantiation having 5 capture compare registers and PWM output generators, respectively.

### 3.1 Related Products

For information about other devices in this family of products or related products, see the following links.

**Products for MSP 16-Bit and 32-Bit MCUs** Low-power mixed-signal processors with smart analog and digital peripherals for a wide range of industrial and consumer applications.

**Products for Low Power + Performance MCUs** MSP low power + performance microcontrollers from TI provide designers with increased processing capability, smart analog, advanced security, and display and communication peripherals while using less watts than ever before for the development of “always on” embedded applications.

**Products for MSP430F5x/6x MCUs** MSP430F5x/6x microcontrollers from the MSP Low-Power + Performance MCU series offer low power with added performance and increased design options. These 16-bit devices feature new and innovative integrated peripherals such as USB and LCD on chip, in addition to higher CPU speeds and more memory.

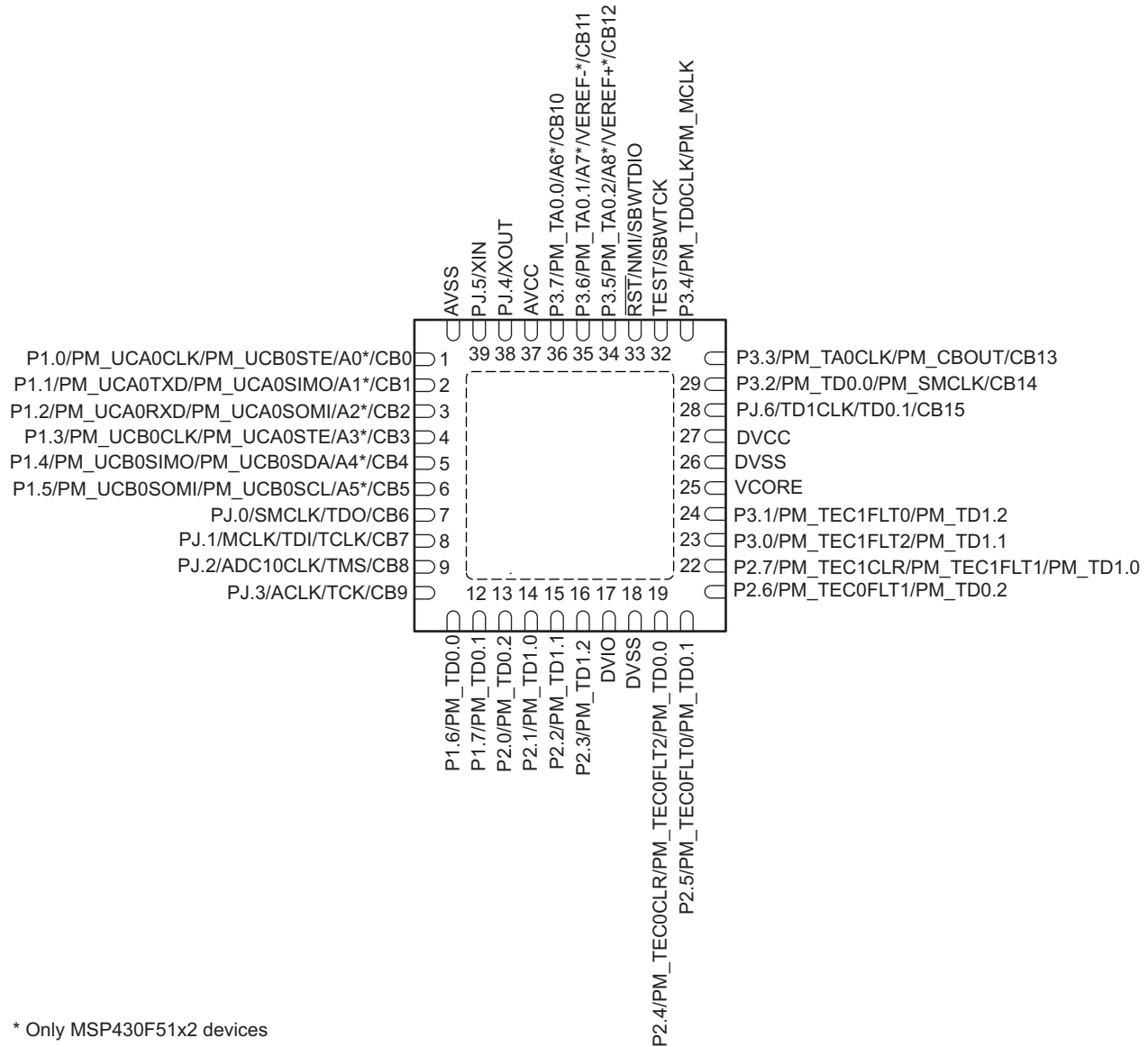
**Companion Products for MSP430F5172** Review products that are frequently purchased or used in conjunction with this product.

**Reference Designs for MSP430F5172** TI Designs Reference Design Library is a robust reference design library that spans analog, embedded processor, and connectivity. Created by TI experts to help you jump start your system design, all TI Designs include schematic or block diagrams, BOMs, and design files to speed your time to market. Search and download designs at [ti.com/tidesigns](http://ti.com/tidesigns).

## 4 Terminal Configuration and Functions

### 4.1 Pin Diagrams

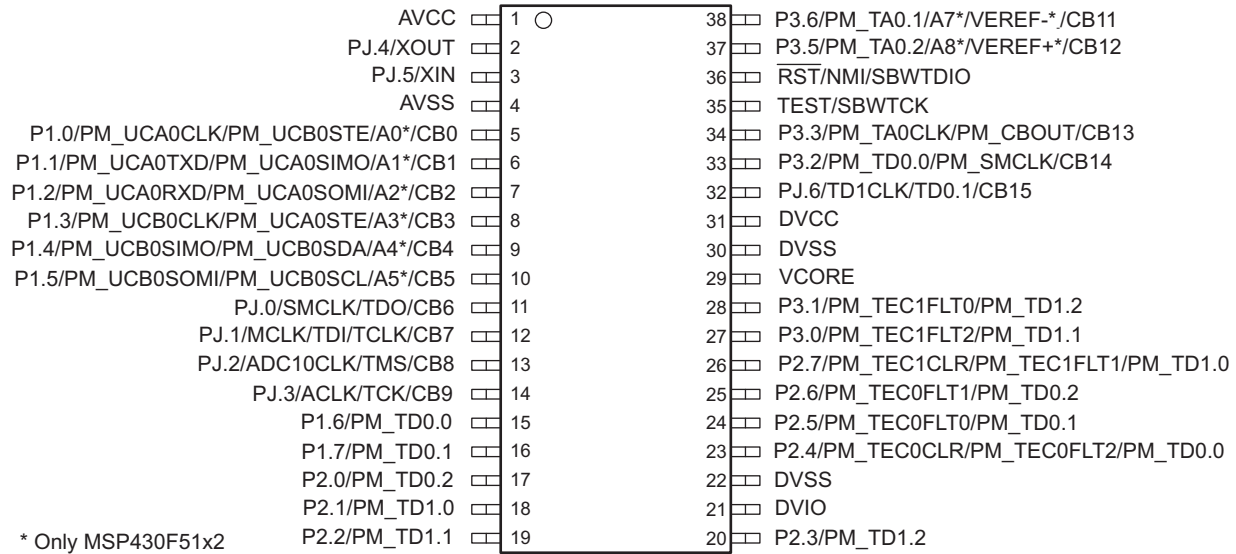
Figure 4-1 shows the pinout for the 40-pin RSB package.



\* Only MSP430F51x2 devices

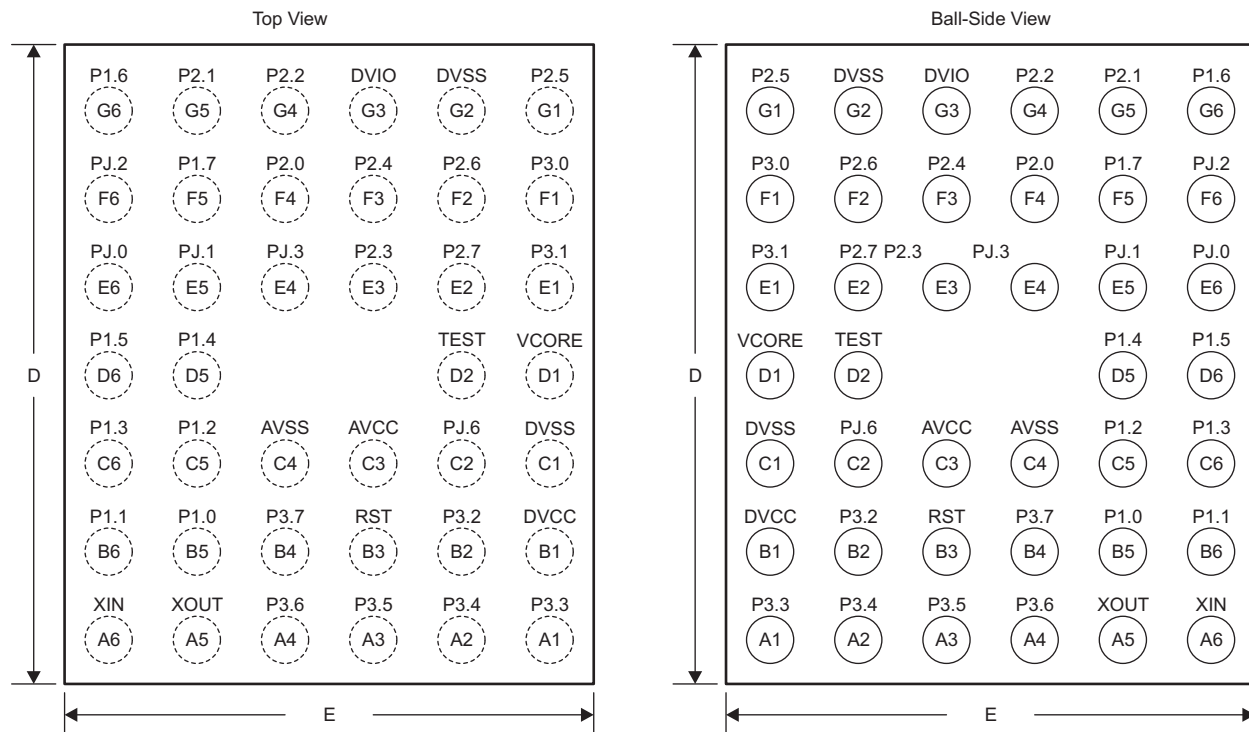
**Figure 4-1. 40-Pin RSB Package (Top View)**

Figure 4-2 shows the pinout for the 38-pin DA package.



**Figure 4-2. 38-Pin DA Package (Top View)**

Figure 4-3 shows the pinout for the 40-pin YFF package.



**Figure 4-3. 40-Pin YFF Package (Top and Bottom Views)**

## 4.2 Signal Descriptions

Table 4-1 describes the signals for all device and package variants.

**Table 4-1. Terminal Functions**

| TERMINAL                                                              |                    |    |     | I/O <sup>(1)</sup>       | DESCRIPTION                                                                                                                                                                                                                                                                                                                                       |
|-----------------------------------------------------------------------|--------------------|----|-----|--------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                                                  | NO. <sup>(2)</sup> |    |     |                          |                                                                                                                                                                                                                                                                                                                                                   |
|                                                                       | RSB                | DA | YFF |                          |                                                                                                                                                                                                                                                                                                                                                   |
| P1.0/<br>PM_UCA0CLK/<br><br>PM_UCB0STE/<br>A0 <sup>(3)</sup> /<br>CB0 | 1                  | 5  | B5  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function <sup>(4)</sup><br>Default mapping: Clock signal input – USCI_A0 SPI slave mode; Clock signal output – USCI_A0 SPI master mode<br>Default mapping: Slave transmit enable – USCI_B0 SPI mode<br>Analog input A0 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 0 |
| P1.1/<br>PM_UCA0TXD/<br>PM_UCA0SIMO/<br>A1 <sup>(3)</sup> /<br>CB1    | 2                  | 6  | B6  | I/O                      | General-purpose digital I/O<br>Default mapping: Transmit data – USCI_A0 UART mode<br>Default mapping: Slave in, master out – USCI_A0 SPI mode<br>Analog input A1 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 1                                                                                                                              |
| P1.2/<br>PM_UCA0RXD/<br>PM_UCA0SOMI/<br>A2 <sup>(3)</sup> /<br>CB2    | 3                  | 7  | C5  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: Receive data – USCI_A0 UART mode<br>Default mapping: Slave out, master in – USCI_A0 SPI mode<br>Analog input A2 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 2                                                                           |
| P1.3/<br>PM_UCB0CLK/<br><br>PM_UCA0STE/<br>A3 <sup>(3)</sup> /<br>CB3 | 4                  | 8  | C6  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: Clock signal input – USCI_B0 SPI slave mode; Clock signal output – USCI_B0 SPI master mode<br>Default mapping: Slave transmit enable – USCI_A0 SPI mode<br>Analog input A3 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 3                |
| P1.4/<br>PM_UCB0SIMO/<br>PM_UCB0SDA/<br>A4 <sup>(3)</sup> /<br>CB4    | 5                  | 9  | D5  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: Slave in, master out – USCI_B0 SPI mode<br>Default mapping: I <sup>2</sup> C data – USCI_B0 I <sup>2</sup> C mode<br>Analog input A4 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 4                                                      |
| P1.5/<br>PM_UCB0SOMI/<br>PM_UCB0SCL/<br>A5 <sup>(3)</sup> /<br>CB5    | 6                  | 10 | D6  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: Slave out, master in – USCI_B0 SPI mode<br>Default mapping: I <sup>2</sup> C clock – USCI_B0 I <sup>2</sup> C mode<br>Analog input A5 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 5                                                     |
| PJ.0/<br>SMCLK/<br>TDO/<br>CB6                                        | 7                  | 11 | E6  | I/O                      | General-purpose digital I/O<br>SMCLK clock output<br>Test data output port<br>Comparator_B Input 6                                                                                                                                                                                                                                                |
| PJ.1/<br>MCLK/<br>TDI/TCLK/<br>CB7                                    | 8                  | 12 | E5  | I/O                      | General-purpose digital I/O<br>MCLK clock output<br>Test data input or test clock input<br>Comparator_B Input 7                                                                                                                                                                                                                                   |
| PJ.2/<br>ADC10CLK/<br>TMS/<br>CB8                                     | 9                  | 13 | F6  | I/O                      | General-purpose digital I/O<br>ADC10_A clock output<br>Test mode select<br>Comparator_B Input 8                                                                                                                                                                                                                                                   |
| PJ.3/<br>ACLK/<br>TCK/<br>CB9                                         | 10                 | 14 | E4  | I/O                      | General-purpose digital I/O<br>ACLK output port<br>Test clock<br>Comparator_B Input 9                                                                                                                                                                                                                                                             |
| P1.6/<br>PM_TD0.0                                                     | 11                 | 15 | G6  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 CCR0 compare output/capture input                                                                                                                                                                                                         |

(1) I = input, O = output

(2) N/A = not available on this package offering

(3) The ADC10\_A module is available on MSP430F51x2 devices. The secondary pin functions Ax (ADC10\_A channel x) available only in MSP430F51x2 devices.

(4) For details on the Port Mapping Controller, see Section 6.9.2.

**Table 4-1. Terminal Functions (continued)**

| TERMINAL<br>NAME                                 | NO. <sup>(2)</sup> |    |     | I/O <sup>(1)</sup>       | DESCRIPTION                                                                                                                                                                                                                                                |
|--------------------------------------------------|--------------------|----|-----|--------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                                  | RSB                | DA | YFF |                          |                                                                                                                                                                                                                                                            |
| P1.7/<br>PM_TD0.1                                | 12                 | 16 | F5  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 CCR1 compare output/capture input                                                                                                                  |
| P2.0/<br>PM_TD0.2                                | 13                 | 17 | F4  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 CCR2 compare output/capture input                                                                                                                  |
| P2.1/<br>PM_TD1.0                                | 14                 | 18 | G5  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD1 CCR0 compare output/capture input                                                                                                                  |
| P2.2/<br>PM_TD1.1                                | 15                 | 19 | G4  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD1 CCR1 compare output/capture input                                                                                                                  |
| P2.3/<br>PM_TD1.2                                | 16                 | 20 | E3  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD1 CCR2 compare output/capture input                                                                                                                  |
| DVIO                                             | 17                 | 21 | G3  |                          | 5-V tolerant digital I/O power supply                                                                                                                                                                                                                      |
| DVSS                                             | 18                 | 22 | G2  |                          | Digital ground supply                                                                                                                                                                                                                                      |
| P2.4/<br>PM_TEC0CLR/<br>PM_TEC0FLT2/<br>PM_TD0.0 | 19                 | 23 | F3  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 external clear input<br>Default mapping: TD0 fault input channel 2 (controlled by module input enable)<br>Default mapping: TD0 CCR0 compare output |
| P2.5/<br>PM_TEC0FLT0/<br>PM_TD0.1                | 20                 | 24 | G1  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 fault input channel 0<br>Default mapping: TD0 CCR1 compare output                                                                                  |
| P2.6/<br>PM_TEC0FLT1/<br>PM_TD0.2                | 21                 | 25 | F2  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 fault input channel 1<br>Default mapping: TD0 CCR2 compare output                                                                                  |
| P2.7/<br>PM_TEC1CLR/<br>PM_TEC1FLT1/<br>PM_TD1.0 | 22                 | 26 | E2  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD1 external clear<br>Default mapping: TD1 fault input channel 1 (controlled by module input enable)<br>Default mapping: TD1 CCR0 compare output       |
| P3.0/<br>PM_TEC1FLT2/<br>PM_TD1.1                | 23                 | 27 | F1  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD1 fault input channel 2<br>Default mapping: TD1 CCR1 compare output                                                                                  |
| P3.1/<br>PM_TEC1FLT0/<br>PM_TD1.2                | 24                 | 28 | E1  | I/O,<br>DV <sub>IO</sub> | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD1 fault input channel 0<br>Default mapping: TD1 CCR2 compare output                                                                                  |
| VCORE                                            | 25                 | 29 | D1  |                          | Regulated core power supply                                                                                                                                                                                                                                |
| DVSS                                             | 26                 | 30 | C1  |                          | Digital ground supply                                                                                                                                                                                                                                      |
| DVCC                                             | 27                 | 31 | B1  |                          | Digital power supply                                                                                                                                                                                                                                       |
| PJ.6/<br>TD1CLK/<br>TD0.1/<br>CB15               | 28                 | 32 | C2  | I/O                      | General-purpose digital I/O<br>TD1 clock input<br>TD0 CCR1 compare output<br>Comparator_B Input 15                                                                                                                                                         |
| P3.2/<br>PM_TD0.0/<br>PM_SMCLK/<br>CB14          | 29                 | 33 | B2  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 CCR0 capture input<br>Default mapping: SMCLK output<br>Comparator_B Input 14                                                                       |
| P3.3/<br>PM_TA0CLK/<br>PM_CBOUT/<br>CB13         | 30                 | 34 | A1  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TA0 clock input<br>Default mapping: Comparator_B output<br>Comparator_B Input 13                                                                       |
| P3.4/<br>PM_TD0CLK/<br>PM_MCLK                   | 31                 | –  | A2  | I/O                      | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TD0 clock input<br>Default mapping: MCLK output                                                                                                        |
| TEST/<br>SBWTCK                                  | 32                 | 35 | D2  |                          | Test mode pin – select digital I/O on JTAG pins<br>Spy-Bi-Wire input clock                                                                                                                                                                                 |
| RST/<br>NMI/<br>SBWTDIO                          | 33                 | 36 | B3  |                          | Reset input active low <sup>(5)</sup><br>Nonmaskable interrupt input<br>Spy-Bi-Wire data input/output                                                                                                                                                      |

(5) When this pin is configured as reset, the internal pullup resistor is enabled by default.

**Table 4-1. Terminal Functions (continued)**

| TERMINAL                                                     |                    |    |     | I/O <sup>(1)</sup> | DESCRIPTION                                                                                                                                                                                                                                                                                                    |
|--------------------------------------------------------------|--------------------|----|-----|--------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                                         | NO. <sup>(2)</sup> |    |     |                    |                                                                                                                                                                                                                                                                                                                |
|                                                              | RSB                | DA | YFF |                    |                                                                                                                                                                                                                                                                                                                |
| P3.5/<br>PM TA0.2/<br>A8 <sup>(3)</sup> /<br>VEREF+/<br>CB12 | 34                 | 37 | A3  | I/O                | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TA0 CCR2 compare output/capture input<br>Analog input A8 – 10-bit ADC <sup>(3)</sup><br>Positive terminal for the ADC reference voltage for an external applied reference voltage<br>Comparator_B Input 12 |
| P3.6/<br>PM TA0.1/<br>A7 <sup>(3)</sup> /<br>VEREF-/<br>CB11 | 35                 | 38 | A4  | I/O                | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TA0 CCR1 compare output/capture input<br>Analog input A7 – 10-bit ADC <sup>(3)</sup><br>Negative terminal for the ADC reference voltage for an external applied reference voltage<br>Comparator_B Input 11 |
| P3.7/<br>PM TA0.0/<br>A6 <sup>(3)</sup> /<br>CB10            | 36                 | –  | B4  | I/O                | General-purpose digital I/O with reconfigurable port mapping secondary function<br>Default mapping: TA0 CCR0 compare output/capture input<br>Analog input A6 – 10-bit ADC <sup>(3)</sup><br>Comparator_B Input 10                                                                                              |
| AVCC                                                         | 37                 | 1  | C3  |                    | Analog power supply                                                                                                                                                                                                                                                                                            |
| PJ.4/<br>XOUT                                                | 38                 | 2  | A5  | I/O                | General-purpose digital I/O<br>Output terminal of crystal oscillator                                                                                                                                                                                                                                           |
| PJ.5/<br>XIN                                                 | 39                 | 3  | A6  | I/O                | General-purpose digital I/O<br>Input terminal for crystal oscillator                                                                                                                                                                                                                                           |
| AVSS                                                         | 40                 | 4  | C4  |                    | Analog ground supply                                                                                                                                                                                                                                                                                           |
| QFN pad                                                      | –                  | NA | NA  |                    | Recommended to connect to DVSS externally                                                                                                                                                                                                                                                                      |

## 5 Specifications

### 5.1 Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                                                                          | MIN  | MAX            | UNIT |
|--------------------------------------------------------------------------|------|----------------|------|
| Voltage $V_{CC}$ applied at DVCC to DVSS                                 | −0.3 | 4.1 V          | V    |
| Voltage $V_{IO}$ applied at VIO to DVSS                                  | −0.3 | 6.1 V          | V    |
| Voltage applied to any pin (excluding V <sub>CORE</sub> ) <sup>(2)</sup> | −0.3 | $V_{CC} + 0.3$ | V    |
| Diode current at any device pin                                          |      | ±2             | mA   |
| Maximum operating junction temperature, $T_J$                            |      | 95             | °C   |
| Storage temperature, $T_{stg}$                                           | −55  | 150            | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages referenced to  $V_{SS}$ .  $V_{CORE}$  is for internal device usage only. No external DC loading or voltage should be applied.

### 5.2 ESD Ratings

|                                     |                                                                                | VALUE | UNIT |
|-------------------------------------|--------------------------------------------------------------------------------|-------|------|
| $V_{(ESD)}$ Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±1000 | V    |
|                                     | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±250  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Pins listed as ±1000 V may actually have higher performance.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process. Pins listed as ±250 V may actually have higher performance.

### 5.3 Recommended Operating Conditions

Typical values are specified at  $V_{CC} = 3.3$  V and  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

|                          |                                                                                                                 | MIN                    | NOM | MAX | UNIT |
|--------------------------|-----------------------------------------------------------------------------------------------------------------|------------------------|-----|-----|------|
| $V_{CC}$                 | Supply voltage during program execution and flash programming<br>$V(AVCC) = V(DVCC) = V_{CC}$ <sup>(1)(2)</sup> | PMMCOREVx = 0          | 1.8 | 3.6 | V    |
|                          |                                                                                                                 | PMMCOREVx = 0, 1       | 2.0 | 3.6 |      |
|                          |                                                                                                                 | PMMCOREVx = 0, 1, 2    | 2.2 | 3.6 |      |
|                          |                                                                                                                 | PMMCOREVx = 0, 1, 2, 3 | 2.4 | 3.6 |      |
| $V_{IO}$                 | Supply voltage of pins P1.6, P1.7, P2.0 to P2.7, P3.0, and P3.1 supplied by VIO <sup>(3)</sup>                  | 1.8                    |     | 5.5 | V    |
| $V_{SS}$                 | Supply voltage $V(AVSS) = V(DVSS) = V_{SS}$                                                                     |                        | 0   |     | V    |
| $T_A$                    | Operating free-air temperature                                                                                  | −40                    |     | 85  | °C   |
| $T_J$                    | Operating junction temperature                                                                                  | −40                    |     | 85  | °C   |
| $C_{(VCORE)}$            | Recommended capacitor at V <sub>CORE</sub> <sup>(4)</sup>                                                       |                        | 470 |     | nF   |
| $C_{(DVCC)}/C_{(VCORE)}$ | Capacitor ratio of DVCC to V <sub>CORE</sub>                                                                    | 10                     |     |     |      |

- (1) TI recommends powering AVCC and DVCC from the same source. A maximum difference of 0.3 V between V(AVCC) and V(DVCC) can be tolerated during power up and operation.
- (2) The minimum supply voltage is defined by the supervisor SVS levels when it is enabled. See the [Section 5.28](#) threshold parameters for the exact values and further details.
- (3) TI recommends powering DVCC and AVCC before powering DVIO. At DVCC and AVCC voltages higher than 1.8 V, the maximum difference of 0.3 V between DVIO and DVCC and AVCC can be exceeded.
- (4) A capacitor tolerance of ±20% or better is required.

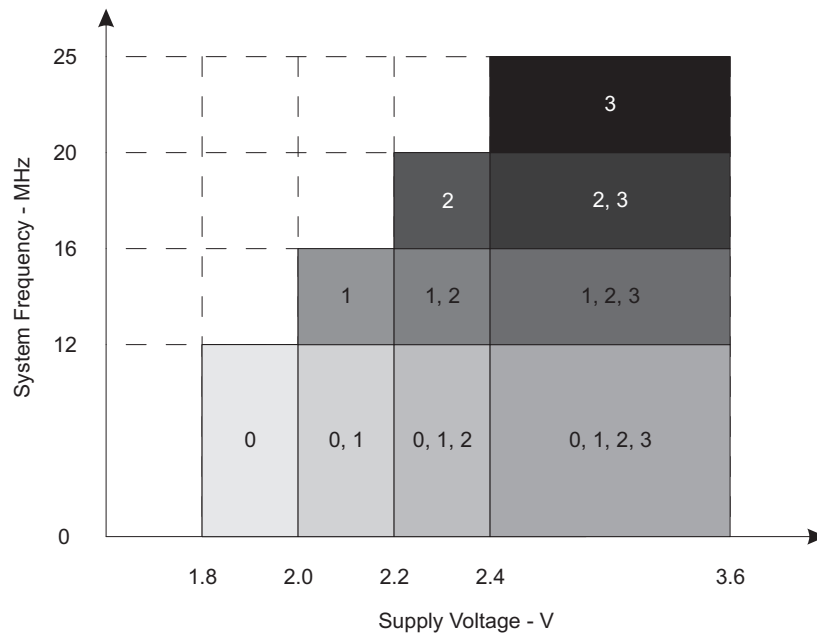
## Recommended Operating Conditions (continued)

Typical values are specified at  $V_{CC} = 3.3\text{ V}$  and  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

|                     |                                                                                                                 | MIN                                                                                                 | NOM | MAX | UNIT |
|---------------------|-----------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------|-----|-----|------|
| $f_{\text{SYSTEM}}$ | Processor frequency (maximum MCLK frequency) <sup>(5)</sup> <sup>(6)</sup><br>(see <a href="#">Figure 5-1</a> ) | PMMCOREVx = 0,<br>$1.8\text{ V} \leq V_{CC} \leq 3.6\text{ V}$<br>(default condition)               |     | 0   | 12   |
|                     |                                                                                                                 | PMMCOREVx = 1,<br>$2.0\text{ V} \leq V_{CC} \leq 3.6\text{ V}$                                      |     | 0   | 16   |
|                     |                                                                                                                 | PMMCOREVx = 2,<br>$2.2\text{ V} \leq V_{CC} \leq 3.6\text{ V}$                                      |     | 0   | 20   |
|                     |                                                                                                                 | PMMCOREVx = 3,<br>$2.4\text{ V} \leq V_{CC} \leq 3.6\text{ V}$                                      |     | 0   | 25   |
| $P_{\text{INT}}$    | Internal power dissipation                                                                                      | $V_{CC} \times I_{\text{DVCC}}$                                                                     |     |     | W    |
| $P_{\text{IO}}$     | I/O power dissipation of the I/O pins powered by DVCC                                                           | $(V_{CC} - V_{\text{IOH}}) \times I_{\text{IOH}} + V_{\text{IOL}} \times I_{\text{IOL}}$            |     |     | W    |
| $P_{\text{IO5}}$    | I/O power dissipation of the I/O pins powered by VIO                                                            | $(V_{\text{IO}} - V_{\text{IOH5}}) \times I_{\text{IOH5}} + V_{\text{IOL5}} \times I_{\text{IOL5}}$ |     |     | W    |
| $P_{\text{MAX}}$    | Maximum allowed power dissipation, $P_{\text{MAX}} > P_{\text{IO}} + P_{\text{IO5}} + P_{\text{INT}}$           | $(T_J - T_A) / R_{\theta\text{JA}}$                                                                 |     |     | W    |

(5) The MSP430™ CPU is clocked directly with MCLK. Both the high and low phase of MCLK must not exceed the pulse duration of the specified maximum frequency.

(6) Modules may have a different maximum input clock specification. See the specification of the respective module in this data sheet.



NOTE: The numbers within the fields denote the supported PMMCOREVx settings.

**Figure 5-1. Frequency vs Supply Voltage**

## 5.4 Active Mode Supply Current Into $V_{CC}$ Excluding External Current

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER              | EXECUTION MEMORY | V <sub>CC</sub> | PMMCOREVx | FREQUENCY (f <sub>DCO</sub> = f <sub>MCLK</sub> = f <sub>SMCLK</sub> ) |      |       |      |        |      |        |     |        |      | UNIT |
|------------------------|------------------|-----------------|-----------|------------------------------------------------------------------------|------|-------|------|--------|------|--------|-----|--------|------|------|
|                        |                  |                 |           | 1 MHz                                                                  |      | 8 MHz |      | 12 MHz |      | 20 MHz |     | 25 MHz |      |      |
|                        |                  |                 |           | TYP                                                                    | MAX  | TYP   | MAX  | TYP    | MAX  | TYP    | MAX | TYP    | MAX  |      |
| I <sub>AM, Flash</sub> | Flash            | 3 V             | 0         | 0.24                                                                   | 0.27 | 1.48  | 1.60 | —      | —    | —      | —   | —      | —    | mA   |
|                        |                  |                 | 1         | 0.26                                                                   | —    | 1.66  | —    | 2.48   | 2.7  | —      | —   | —      | —    |      |
|                        |                  |                 | 2         | 0.28                                                                   | —    | 1.83  | —    | 2.72   | —    | 4.50   | 4.8 | —      | —    |      |
|                        |                  |                 | 3         | 0.28                                                                   | —    | 1.83  | —    | 2.66   | —    | 4.40   | —   | 5.60   | 6.15 |      |
| I <sub>AM, RAM</sub>   | RAM              | 3 V             | 0         | 0.17                                                                   | 0.2  | 0.89  | 0.97 | —      | —    | —      | —   | —      | —    | mA   |
|                        |                  |                 | 1         | 0.18                                                                   | —    | 1.00  | —    | 1.49   | 1.62 | —      | —   | —      | —    |      |
|                        |                  |                 | 2         | 0.20                                                                   | —    | 1.14  | —    | 1.68   | —    | 2.75   | 3.0 | —      | —    |      |
|                        |                  |                 | 3         | 0.20                                                                   | —    | 1.20  | —    | 1.78   | —    | 2.92   | —   | 3.64   | 4.0  |      |

## 5.5 Low-Power Mode Supply Currents (Into $V_{CC}$ ) Excluding External Current

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1) (2)</sup>

| PARAMETER                                        | $V_{CC}$ | PMMCOREVx | –40°C |      | 25°C |      | 60°C |      | 85°C |     | UNIT    |
|--------------------------------------------------|----------|-----------|-------|------|------|------|------|------|------|-----|---------|
|                                                  |          |           | TYP   | MAX  | TYP  | MAX  | TYP  | MAX  | TYP  | MAX |         |
| $I_{LPM0, 1MHz}$ Low-power mode 0                | 2.2 V    | 0         | 82    | 90   | 85   | 90   | 87   | 95   | 85   | 100 | $\mu A$ |
|                                                  | 3 V      | 3         | 88    | 100  | 85   | 100  | 90   | 104  | 88   | 104 |         |
| $I_{LPM2}$ Low-power mode 2                      | 2.2 V    | 0         | 10    | 12.5 | 10   | 12   | 10   | 12.5 | 12.5 | 13  | $\mu A$ |
|                                                  | 3 V      | 3         | 9     | 11.5 | 11   | 13   | 11   | 15   | 12   | 14  |         |
| $I_{LPM3, XT1LF}$ Low-power mode 3, crystal mode | 2.2 V    | 0         | 1.7   | –    | 1.8  | 2.0  | 2.5  | –    | 3.5  | 6.0 | $\mu A$ |
|                                                  | 3 V      |           | 2.0   | –    | 2.0  | 2.2  | 3.0  | –    | 3.7  | 6.0 |         |
|                                                  | 2.2 V    | 1         | 1.8   | –    | 1.9  | –    | 2.5  | –    | 4.0  | –   |         |
|                                                  | 3 V      |           | 2.1   | –    | 2.2  | –    | 2.5  | –    | 4.0  | –   |         |
|                                                  | 2.2 V    | 2         | 1.8   | –    | 2.0  | –    | 2.5  | –    | 4.2  | –   |         |
|                                                  | 3 V      |           | 2.0   | –    | 2.2  | –    | 2.8  | –    | 4.2  | –   |         |
|                                                  | 2.2 V    | 3         | 1.9   | –    | 2.0  | 2.5  | 2.9  | –    | 4.8  | 6.5 |         |
|                                                  | 3 V      |           | 2.1   | –    | 2.2  | 2.5  | 3.0  | –    | 5.2  | 7.0 |         |
| $I_{LPM3, VLO}$ Low-power mode 3, VLO mode       | 2.2 V    | 0         | 1.0   | –    | 1.0  | 1.25 | 1.6  | –    | 3.5  | 4.5 | $\mu A$ |
|                                                  | 3 V      |           | 1.1   | –    | 1.2  | 1.4  | 1.5  | –    | 3.6  | 5.0 |         |
|                                                  | 2.2 V    | 1         | 1.0   | –    | 1.1  | –    | 1.8  | –    | 3.0  | –   |         |
|                                                  | 3 V      |           | 1.3   | –    | 1.1  | –    | 2.0  | –    | 3.2  | –   |         |
|                                                  | 2.2 V    | 2         | 1.1   | –    | 1.1  | –    | 1.8  | –    | 3.1  | –   |         |
|                                                  | 3 V      |           | 1.1   | –    | 1.2  | –    | 2.0  | –    | 3.2  | –   |         |
|                                                  | 2.2 V    | 3         | 1.1   | –    | 1.1  | 1.4  | 1.9  | –    | 3.5  | 5.0 |         |
|                                                  | 3 V      |           | 1.1   | –    | 1.2  | 1.5  | 2.1  | –    | 4.0  | 5.2 |         |
| $I_{LPM4}$ Low-power mode 4                      | 3 V      | 0         | 0.8   | –    | 0.9  | 1.3  | 1.4  | –    | 3.5  | 4.7 | $\mu A$ |
|                                                  |          | 1         | 0.8   | –    | 1.0  | –    | 1.4  | –    | 3.5  | –   |         |
|                                                  |          | 2         | 0.8   | –    | 1.0  | –    | 1.5  | –    | 3.6  | –   |         |
|                                                  |          | 3         | 0.9   | –    | 1.0  | 1.3  | 1.6  | –    | 3.6  | 5.0 |         |
| $I_{LPM4.5}$ Low-power mode 4.5                  | 2.2 V    | x         | 0.06  | –    | 0.20 | 0.26 | 0.33 | –    | 0.60 | 0.9 | $\mu A$ |
|                                                  | 3 V      | x         | 0.07  | –    | 0.25 | 0.29 | 0.37 | –    | 0.77 | 0.9 |         |

(1) All inputs are tied to 0 V or to  $V_{CC}$ . Outputs do not source or sink any current. DVIO = DVCC = AVCC.

(2) The currents are characterized with a Micro Crystal MS1V-T1K SMD crystal with a load capacitance of 12.5 pF. The internal and external load capacitance are chosen to closely match the required 9 pF.

## 5.6 Thermal Resistance Characteristics

|                                                                 |                         |            | VALUE      | UNIT |      |
|-----------------------------------------------------------------|-------------------------|------------|------------|------|------|
| $\theta_{JA}$ Junction-to-ambient thermal resistance, still air | Low-K board (JESD51-3)  | QFN (RSB)  | 87         | °C/W |      |
|                                                                 |                         | TSSOP (DA) | 109        |      |      |
|                                                                 | High-K board (JESD51-7) | QFN (RSB)  | 35         |      |      |
|                                                                 |                         | TSSOP (DA) | 69         |      |      |
| $\theta_{JC}$ Junction-to-case thermal resistance               |                         |            | QFN (RSB)  | 36   | °C/W |
|                                                                 |                         |            | TSSOP (DA) | 19   |      |

## 5.7 Schmitt-Trigger Inputs – General-Purpose I/O (P1.0 to P1.5, P3.2 to P3.7, and PJ.0 to PJ.6)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                  | TEST CONDITIONS                                                  | $V_{CC}$ | MIN  | TYP | MAX  | UNIT       |
|------------------------------------------------------------|------------------------------------------------------------------|----------|------|-----|------|------------|
| $V_{IT+}$ Positive-going input threshold voltage           |                                                                  | 1.8 V    | 0.80 |     | 1.40 | V          |
|                                                            |                                                                  | 3 V      | 1.50 |     | 2.10 |            |
| $V_{IT-}$ Negative-going input threshold voltage           |                                                                  | 1.8 V    | 0.45 |     | 1.00 | V          |
|                                                            |                                                                  | 3 V      | 0.75 |     | 1.65 |            |
| $V_{hys}$ Input voltage hysteresis ( $V_{IT+} - V_{IT-}$ ) |                                                                  | 1.8 V    | 0.3  |     | 0.8  | V          |
|                                                            |                                                                  | 3 V      | 0.4  |     | 1.0  |            |
| $R_{Pull}$ Pullup or pulldown resistor <sup>(1)</sup>      | For pullup: $V_{IN} = V_{SS}$<br>For pulldown: $V_{IN} = V_{CC}$ |          | 20   | 35  | 50   | k $\Omega$ |
| $C_I$ Input capacitance                                    | $V_{IN} = V_{SS}$ or $V_{CC}$                                    |          |      | 5   |      | pF         |

(1) Also applies to  $\overline{RST}$  pin when pullup or pulldown resistor is enabled.

## 5.8 Schmitt-Trigger Inputs – General-Purpose I/O (P1.6 and P1.7, P2.0 to P2.7, and P3.0 and P3.1)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                  | TEST CONDITIONS                                                  | $V_{IO}$ | MIN  | TYP | MAX  | UNIT       |
|------------------------------------------------------------|------------------------------------------------------------------|----------|------|-----|------|------------|
| $V_{IT+}$ Positive-going input threshold voltage           |                                                                  | 1.8 V    | 0.80 |     | 1.40 | V          |
|                                                            |                                                                  | 3 V      | 1.20 |     | 2.00 |            |
|                                                            |                                                                  | 5 V      | 2.10 |     | 2.50 |            |
| $V_{IT-}$ Negative-going input threshold voltage           |                                                                  | 1.8 V    | 0.45 |     | 0.90 | V          |
|                                                            |                                                                  | 3 V      | 0.75 |     | 1.30 |            |
|                                                            |                                                                  | 5 V      | 1.10 |     | 1.60 |            |
| $V_{hys}$ Input voltage hysteresis ( $V_{IT+} - V_{IT-}$ ) |                                                                  | 1.8 V    | 0.27 |     | 0.45 | V          |
|                                                            |                                                                  | 3 V      | 0.45 |     | 0.65 |            |
|                                                            |                                                                  | 5 V      | 0.9  |     | 1.2  |            |
| $R_{Pull}$ Pullup or pulldown resistor                     | For pullup: $V_{IN} = V_{SS}$<br>For pulldown: $V_{IN} = V_{CC}$ |          | 20   | 35  | 50   | k $\Omega$ |
| $C_I$ Input capacitance                                    | $V_{IN} = V_{SS}$ or $V_{CC}$                                    |          |      | 5   |      | pF         |

## 5.9 Inputs – Ports P1 and P2<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                            | TEST CONDITIONS                                                                             | $V_{CC}$ or $V_{IO}$ | MIN | MAX | UNIT |
|------------------------------------------------------|---------------------------------------------------------------------------------------------|----------------------|-----|-----|------|
| $t_{(int)}$ External interrupt timing <sup>(2)</sup> | Port P1.0 to P1.5, External trigger pulse duration to set interrupt flag                    | 1.8 V to 3.6 V       | 20  |     | ns   |
|                                                      | Port P1.6 and P1.7, and P2.0 to P2.7, External trigger pulse duration to set interrupt flag | 1.8 V to 5 V         | 25  |     |      |

(1) Some devices may contain additional ports with interrupts. See the block diagram and terminal function descriptions.

(2) An external signal sets the interrupt flag every time the minimum interrupt pulse duration  $t_{(int)}$  is met. It may be set by trigger signals shorter than  $t_{(int)}$ .

## 5.10 Leakage Current – General-Purpose I/O

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                            |                                |                                               | TEST CONDITIONS | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|--------------------------------------|--------------------------------|-----------------------------------------------|-----------------|-----------------|-----|-----|-----|------|
| I <sub>lkg</sub> (P <sub>x.y</sub> ) | High-impedance leakage current | Port P1.0 to P1.5, P3.0 to P3.7, PJ.0 to PJ.6 | (1) (2)         | 1.8 V to 3.6 V  |     | ±1  | ±50 | nA   |
|                                      |                                | Port P1.6 and P1.7, P2.0 to P2.7              |                 | 1.8 V to 5 V    |     | ±1  | ±50 |      |

(1) The leakage current is measured with V<sub>SS</sub> or V<sub>CC</sub> applied to the corresponding pins, unless otherwise noted.

(2) The leakage of the digital port pins is measured individually. The port pin is selected for input and the pullup or pulldown resistor is disabled.

## 5.11 Outputs – Ports P1, P3, PJ (Full Drive Strength, P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER       |                           | TEST CONDITIONS                              | V <sub>CC</sub> | MIN                    | MAX                    | UNIT |
|-----------------|---------------------------|----------------------------------------------|-----------------|------------------------|------------------------|------|
| V <sub>OH</sub> | High-level output voltage | I <sub>(OHmax)</sub> = –3 mA <sup>(1)</sup>  | 1.8 V           | V <sub>CC</sub> – 0.25 | V <sub>CC</sub>        | V    |
|                 |                           | I <sub>(OHmax)</sub> = –10 mA <sup>(2)</sup> |                 | V <sub>CC</sub> – 0.60 | V <sub>CC</sub>        |      |
|                 |                           | I <sub>(OHmax)</sub> = –5 mA <sup>(1)</sup>  | 3 V             | V <sub>CC</sub> – 0.25 | V <sub>CC</sub>        |      |
|                 |                           | I <sub>(OHmax)</sub> = –15 mA <sup>(2)</sup> |                 | V <sub>CC</sub> – 0.60 | V <sub>CC</sub>        |      |
| V <sub>OL</sub> | Low-level output voltage  | I <sub>(OLmax)</sub> = 3 mA <sup>(1)</sup>   | 1.8 V           | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 | V    |
|                 |                           | I <sub>(OLmax)</sub> = 10 mA <sup>(2)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|                 |                           | I <sub>(OLmax)</sub> = 5 mA <sup>(1)</sup>   | 3 V             | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|                 |                           | I <sub>(OLmax)</sub> = 15 mA <sup>(2)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |

(1) The maximum total current, I<sub>(OHmax)</sub> and I<sub>(OLmax)</sub>, for all outputs combined should not exceed ±48 mA to hold the maximum voltage drop specified.

(2) The maximum total current, I<sub>(OHmax)</sub> and I<sub>(OLmax)</sub>, for all outputs combined should not exceed ±100 mA to hold the maximum voltage drop specified.

## 5.12 Outputs – Ports P1 to P3 (Full Drive Strength, P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER        |                           | TEST CONDITIONS                               | V <sub>IO</sub> | MIN                    | MAX                    | UNIT |
|------------------|---------------------------|-----------------------------------------------|-----------------|------------------------|------------------------|------|
| V <sub>OH5</sub> | High-level output voltage | I <sub>(OH5max)</sub> = –3 mA <sup>(1)</sup>  | 1.8 V           | V <sub>IO</sub> – 0.25 | V <sub>IO</sub>        | V    |
|                  |                           | I <sub>(OH5max)</sub> = –10 mA <sup>(2)</sup> |                 | V <sub>IO</sub> – 0.60 | V <sub>IO</sub>        |      |
|                  |                           | I <sub>(OH5max)</sub> = –5 mA <sup>(1)</sup>  | 3 V             | V <sub>IO</sub> – 0.25 | V <sub>IO</sub>        |      |
|                  |                           | I <sub>(OH5max)</sub> = –15 mA <sup>(2)</sup> |                 | V <sub>IO</sub> – 0.60 | V <sub>IO</sub>        |      |
|                  |                           | I <sub>(OH5max)</sub> = –7 mA <sup>(1)</sup>  | 5 V             | V <sub>IO</sub> – 0.25 | V <sub>IO</sub>        |      |
|                  |                           | I <sub>(OH5max)</sub> = –20 mA <sup>(2)</sup> |                 | V <sub>IO</sub> – 0.60 | V <sub>IO</sub>        |      |
| V <sub>OL5</sub> | Low-level output voltage  | I <sub>(OL5max)</sub> = 3 mA <sup>(1)</sup>   | 1.8 V           | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 | V    |
|                  |                           | I <sub>(OL5max)</sub> = 10 mA <sup>(2)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|                  |                           | I <sub>(OL5max)</sub> = 5 mA <sup>(1)</sup>   | 3 V             | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|                  |                           | I <sub>(OL5max)</sub> = 15 mA <sup>(2)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|                  |                           | I <sub>(OL5max)</sub> = 7 mA <sup>(1)</sup>   | 5 V             | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|                  |                           | I <sub>(OL5max)</sub> = 20 mA <sup>(2)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |

(1) The maximum total current, I<sub>(OH5max)</sub> and I<sub>(OL5max)</sub>, for all outputs combined should not exceed ±48 mA to hold the maximum voltage drop specified.

(2) The maximum total current, I<sub>(OH5max)</sub> and I<sub>(OL5max)</sub>, for all outputs combined should not exceed ±200 mA to hold the maximum voltage drop specified.

### 5.13 Outputs – Ports P1, P3, PJ (Reduced Drive Strength, P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                                 | TEST CONDITIONS                             | V <sub>CC</sub> | MIN                    | MAX                    | UNIT |
|-------------------------------------------|---------------------------------------------|-----------------|------------------------|------------------------|------|
| V <sub>OH</sub> High-level output voltage | I <sub>(OHmax)</sub> = –1 mA <sup>(2)</sup> | 1.8 V           | V <sub>CC</sub> – 0.25 | V <sub>CC</sub>        | V    |
|                                           | I <sub>(OHmax)</sub> = –3 mA <sup>(3)</sup> |                 | V <sub>CC</sub> – 0.60 | V <sub>CC</sub>        |      |
|                                           | I <sub>(OHmax)</sub> = –2 mA <sup>(2)</sup> | 3 V             | V <sub>CC</sub> – 0.25 | V <sub>CC</sub>        |      |
|                                           | I <sub>(OHmax)</sub> = –6 mA <sup>(3)</sup> |                 | V <sub>CC</sub> – 0.60 | V <sub>CC</sub>        |      |
| V <sub>OL</sub> Low-level output voltage  | I <sub>(OLmax)</sub> = 1 mA <sup>(2)</sup>  | 1.8 V           | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 | V    |
|                                           | I <sub>(OLmax)</sub> = 3 mA <sup>(3)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|                                           | I <sub>(OLmax)</sub> = 2 mA <sup>(2)</sup>  | 3 V             | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|                                           | I <sub>(OLmax)</sub> = 6 mA <sup>(3)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |

(1) Selecting reduced drive strength may reduce EMI.

(2) The maximum total current, I<sub>(OHmax)</sub> and I<sub>(OLmax)</sub>, for all outputs combined, should not exceed ±48 mA to hold the maximum voltage drop specified.

(3) The maximum total current, I<sub>(OHmax)</sub> and I<sub>(OLmax)</sub>, for all outputs combined, should not exceed ±100 mA to hold the maximum voltage drop specified.

### 5.14 Outputs – Ports P1 to P3 (Reduced Drive Strength, P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                                  | TEST CONDITIONS                               | V <sub>IO</sub> | MIN                    | MAX                    | UNIT |
|--------------------------------------------|-----------------------------------------------|-----------------|------------------------|------------------------|------|
| V <sub>OH5</sub> High-level output voltage | I <sub>(OH5max)</sub> = –1 mA <sup>(2)</sup>  | 1.8 V           | V <sub>IO</sub> – 0.25 | V <sub>IO</sub>        | V    |
|                                            | I <sub>(OH5max)</sub> = –3 mA <sup>(3)</sup>  |                 | V <sub>IO</sub> – 0.60 | V <sub>IO</sub>        |      |
|                                            | I <sub>(OH5max)</sub> = –2 mA <sup>(2)</sup>  | 3 V             | V <sub>IO</sub> – 0.25 | V <sub>IO</sub>        |      |
|                                            | I <sub>(OH5max)</sub> = –6 mA <sup>(3)</sup>  |                 | V <sub>IO</sub> – 0.60 | V <sub>IO</sub>        |      |
|                                            | I <sub>(OH5max)</sub> = –4 mA <sup>(2)</sup>  | 5.0 V           | V <sub>IO</sub> – 0.25 | V <sub>IO</sub>        |      |
|                                            | I <sub>(OH5max)</sub> = –12 mA <sup>(3)</sup> |                 | V <sub>IO</sub> – 0.60 | V <sub>IO</sub>        |      |
| V <sub>OL5</sub> Low-level output voltage  | I <sub>(OL5max)</sub> = 1 mA <sup>(2)</sup>   | 1.8 V           | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 | V    |
|                                            | I <sub>(OL5max)</sub> = 3 mA <sup>(3)</sup>   |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|                                            | I <sub>(OL5max)</sub> = 2 mA <sup>(2)</sup>   | 3 V             | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|                                            | I <sub>(OL5max)</sub> = 6 mA <sup>(3)</sup>   |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |
|                                            | I <sub>(OH5max)</sub> = 4 mA <sup>(2)</sup>   | 5.0 V           | V <sub>SS</sub>        | V <sub>SS</sub> + 0.25 |      |
|                                            | I <sub>(OL5max)</sub> = 12 mA <sup>(3)</sup>  |                 | V <sub>SS</sub>        | V <sub>SS</sub> + 0.60 |      |

(1) Selecting reduced drive strength may reduce EMI.

(2) The maximum total current, I<sub>(OH5max)</sub> and I<sub>(OL5max)</sub>, for all outputs combined, should not exceed ±48 mA to hold the maximum voltage drop specified.

(3) The maximum total current, I<sub>(OH5max)</sub> and I<sub>(OL5max)</sub>, for all outputs combined, should not exceed ±200 mA to hold the maximum voltage drop specified.

## 5.15 Output Frequency – Ports P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                       | TEST CONDITIONS                                                                             | MIN                                        | MAX | UNIT |
|-------------------------------------------------|---------------------------------------------------------------------------------------------|--------------------------------------------|-----|------|
| $f_{P_{x,y}}$ Port output frequency (with load) | PJ.0/SMCLK<br>$C_L = 20\text{ pF}$ , $R_L = 1\text{ k}\Omega$ <sup>(1)</sup> <sup>(2)</sup> | $V_{CC} = 1.8\text{ V}$ ,<br>PMMCOREVx = 0 | 16  | MHz  |
|                                                 |                                                                                             | $V_{CC} = 3\text{ V}$ ,<br>PMMCOREVx = 3   | 25  |      |
| $f_{Port\_CLK}$ Clock output frequency          | PJ.3/ACLK<br>PJ.0/SMCLK<br>PJ.1/MCLK<br>$C_L = 20\text{ pF}$ <sup>(2)</sup>                 | $V_{CC} = 1.8\text{ V}$ ,<br>PMMCOREVx = 0 | 16  | MHz  |
|                                                 |                                                                                             | $V_{CC} = 3\text{ V}$ ,<br>PMMCOREVx = 3   | 25  |      |

(1) A resistive divider with  $2 \times 0.5\text{ k}\Omega$  between  $V_{CC}$  and  $V_{SS}$  is used as load. The output is connected to the center tap of the divider.

(2) The output voltage reaches at least 10% and 90%  $V_{CC}$  at the specified toggle frequency.

## 5.16 Output Frequency – Ports P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

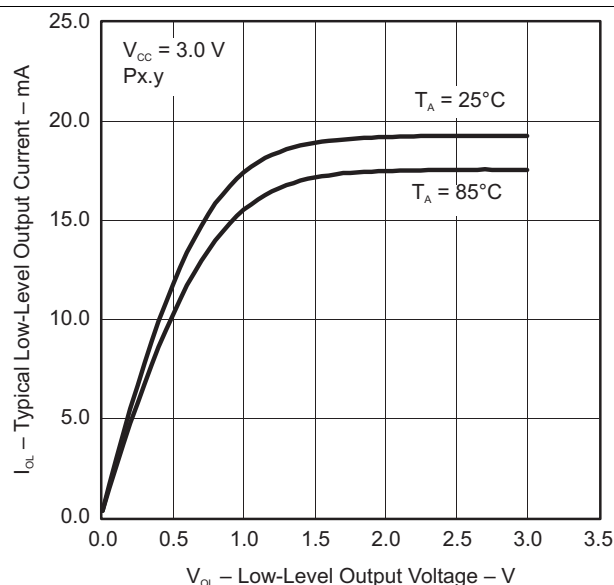
| PARAMETER                                       | TEST CONDITIONS                                                                                                    | MIN                                                                  | MAX | UNIT |
|-------------------------------------------------|--------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------|-----|------|
| $f_{P_{x,y}}$ Port output frequency (with load) | P1.6 port mapper SMCLK from P3.4,<br>$C_L = 20\text{ pF}$ , $R_L = 1\text{ k}\Omega$ <sup>(1)</sup> <sup>(2)</sup> | $V_{CC} = 1.8\text{ V}$ , $V_{IO} = 1.8\text{ V}$ ,<br>PMMCOREVx = 0 | 16  | MHz  |
|                                                 |                                                                                                                    | $V_{CC} = 3\text{ V}$ , $V_{IO} = 3\text{ V}$ ,<br>PMMCOREVx = 3     | 25  |      |
|                                                 |                                                                                                                    | $V_{CC} = 3\text{ V}$ , $V_{IO} = 5\text{ V}$ ,<br>PMMCOREVx = 3     | 25  |      |
| $f_{Port\_CLK}$ Clock output frequency          | P1.6 port mapper SMCLK from P3.4,<br>$C_L = 20\text{ pF}$ <sup>(2)</sup>                                           | $V_{CC} = 1.8\text{ V}$ , $V_{IO} = 1.8\text{ V}$ ,<br>PMMCOREVx = 0 | 16  | MHz  |
|                                                 |                                                                                                                    | $V_{CC} = 3\text{ V}$ , $V_{IO} = 3\text{ V}$ ,<br>PMMCOREVx = 3     | 25  |      |
|                                                 |                                                                                                                    | $V_{CC} = 3\text{ V}$ , $V_{IO} = 5\text{ V}$ ,<br>PMMCOREVx = 3     | 25  |      |

(1) A resistive divider with  $2 \times 0.5\text{ k}\Omega$  between  $V_{CC}$  and  $V_{SS}$  is used as load. The output is connected to the center tap of the divider.

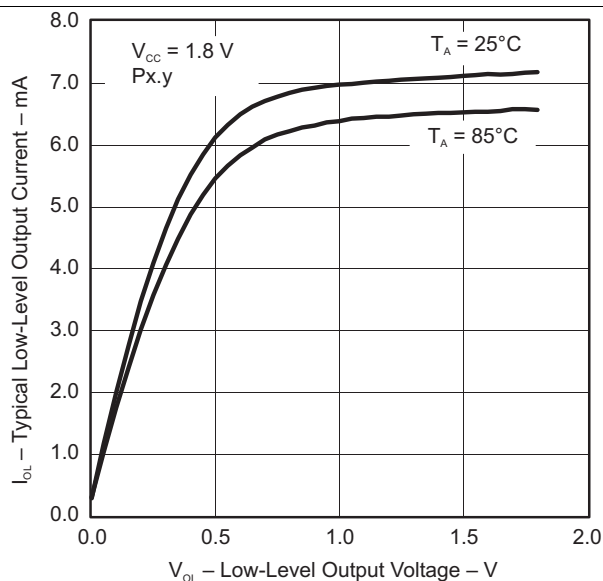
(2) The output voltage reaches at least 10% and 90%  $V_{CC}$  at the specified toggle frequency.

## 5.17 Typical Characteristics – Outputs, Reduced Drive Strength (PxDS.y = 0), Ports P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6

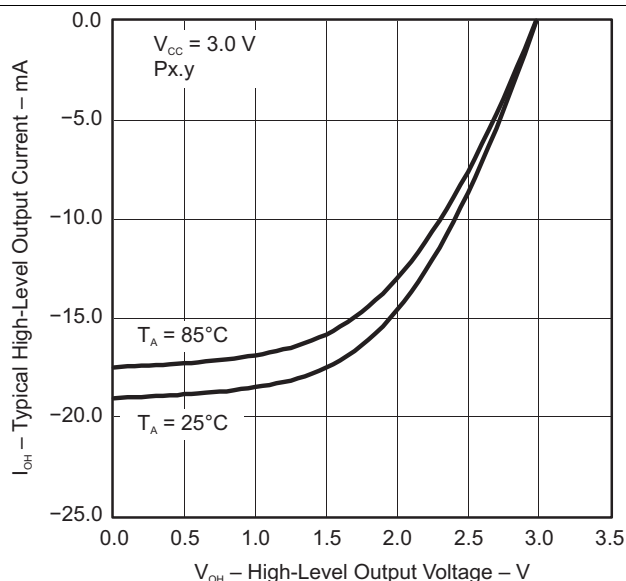
over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)



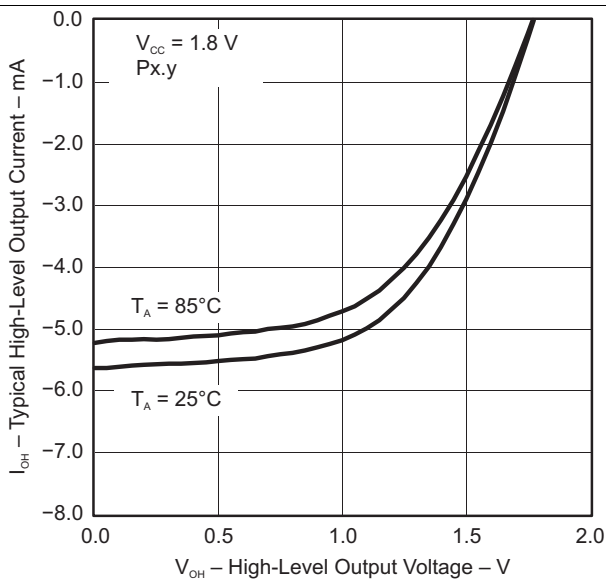
**Figure 5-2. Typical Low-Level Output Current vs Low-Level Output Voltage**



**Figure 5-3. Typical Low-Level Output Current vs Low-Level Output Voltage**



**Figure 5-4. Typical High-Level Output Current vs High-Level Output Voltage**



**Figure 5-5. Typical High-Level Output Current vs High-Level Output Voltage**

## 5.18 Typical Characteristics – Outputs, Full Drive Strength (PxDS.y = 1), Ports P1.0 to P1.5, P3.2 to P3.7, PJ.0 to PJ.6

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

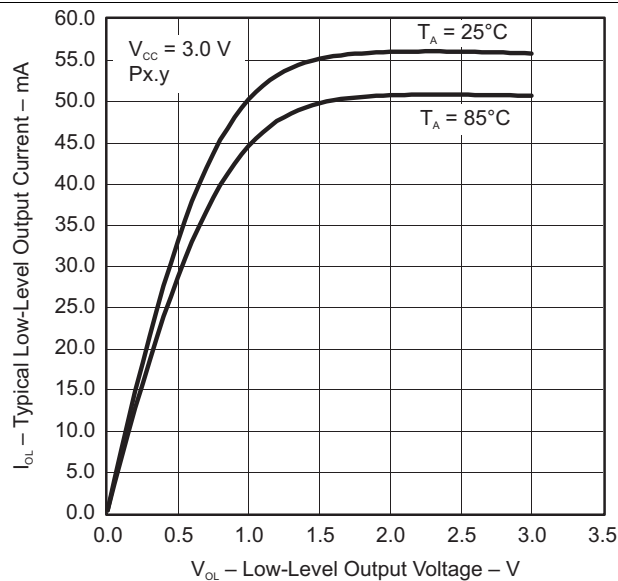


Figure 5-6. Typical Low-Level Output Current vs Low-Level Output Voltage

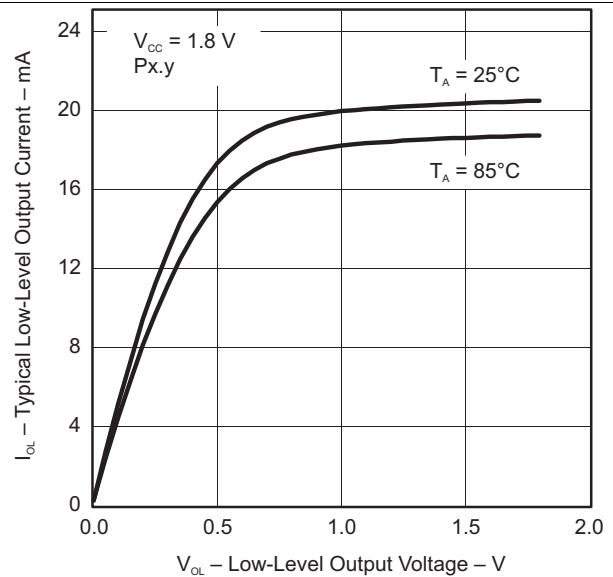


Figure 5-7. Typical Low-Level Output Current vs Low-Level Output Voltage

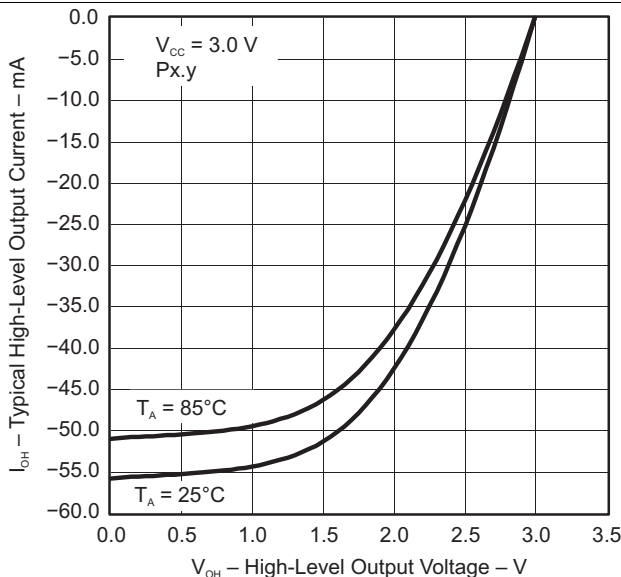


Figure 5-8. Typical High-Level Output Current vs High-Level Output Voltage

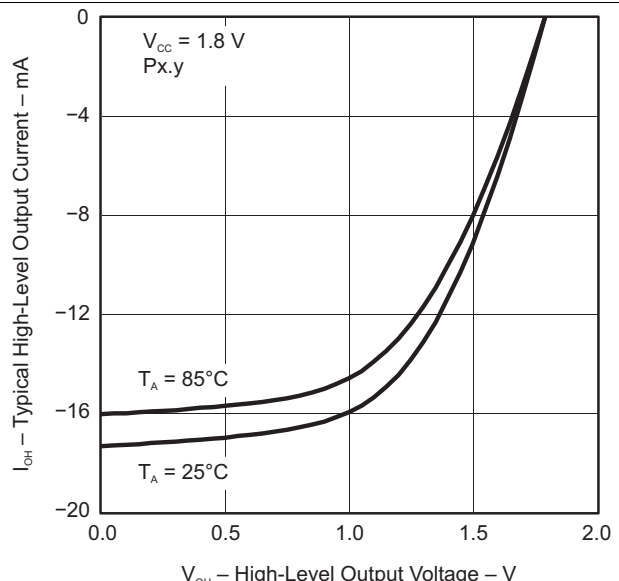
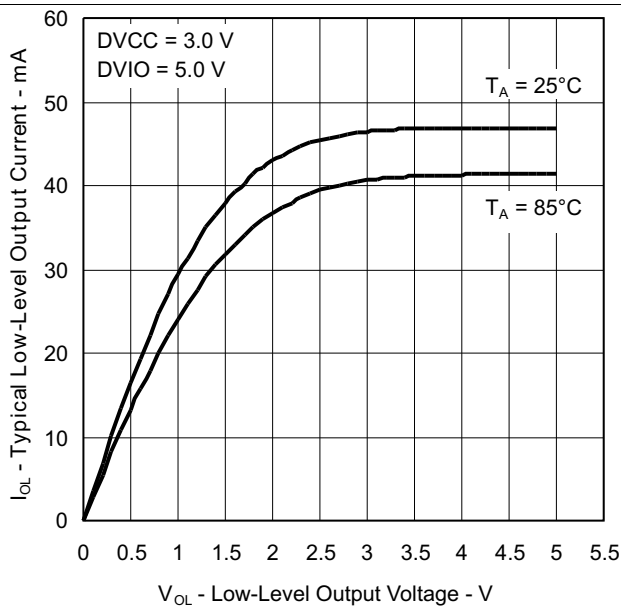


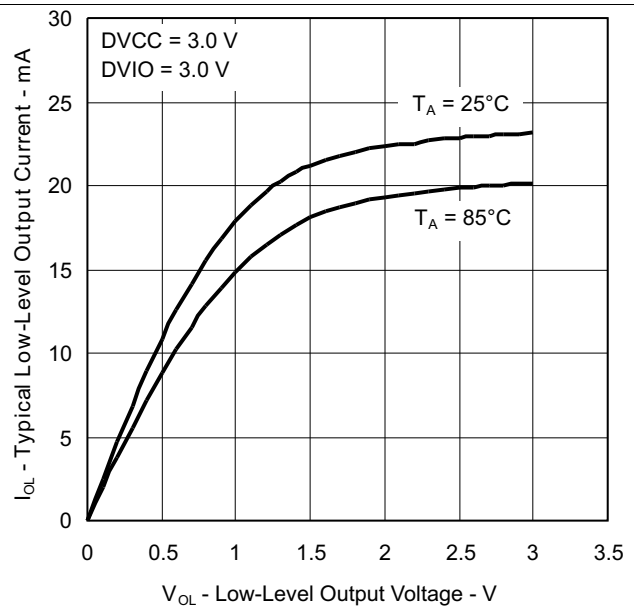
Figure 5-9. Typical High-Level Output Current vs High-Level Output Voltage

## 5.19 Typical Characteristics – Outputs, Reduced Drive Strength (PxDS.y = 0), Ports P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1

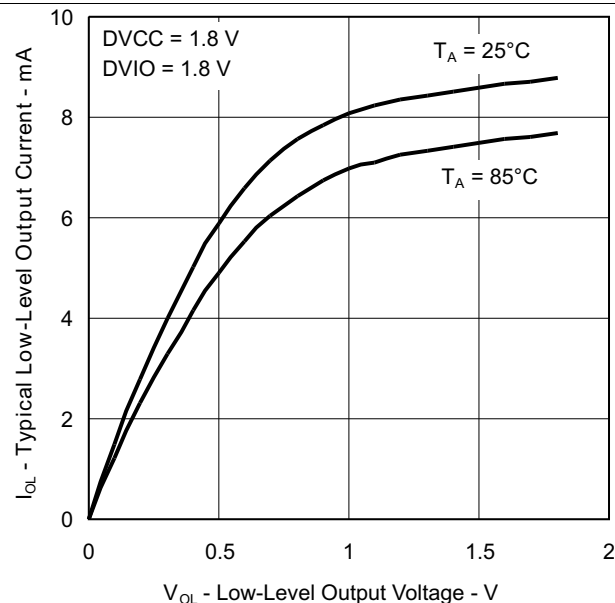
over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)



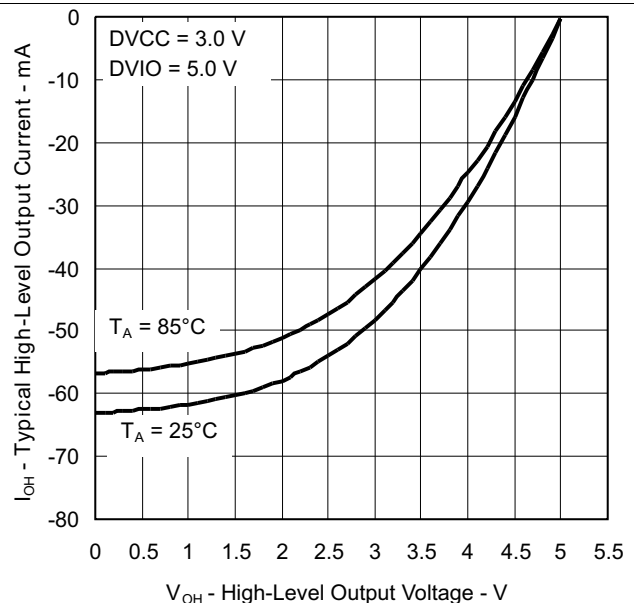
**Figure 5-10. Typical Low-Level Output Current vs Low-Level Output Voltage**



**Figure 5-11. Typical Low-Level Output Current vs Low-Level Output Voltage**



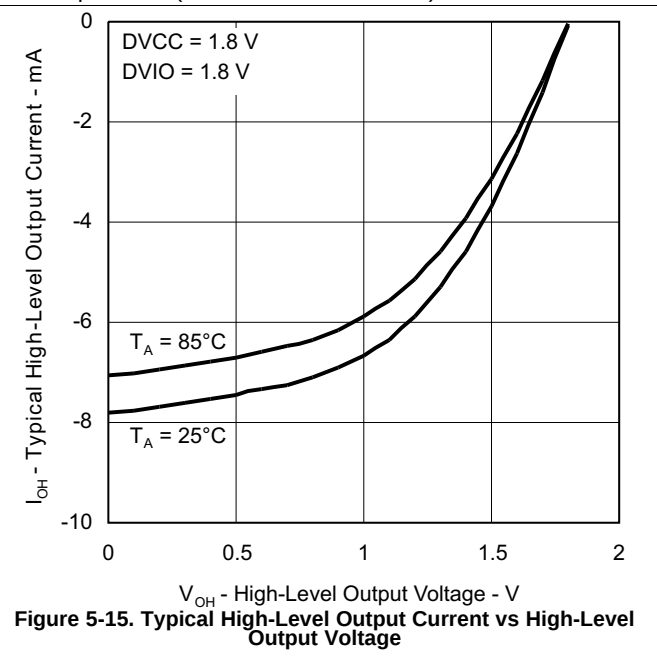
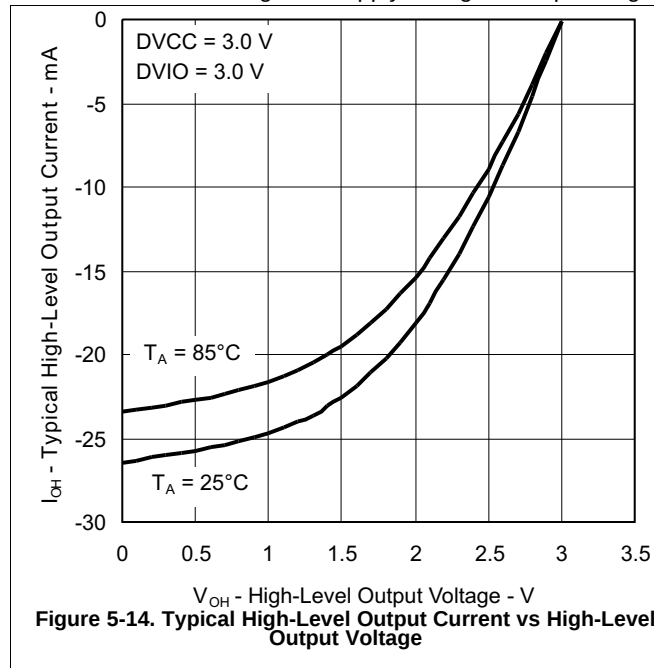
**Figure 5-12. Typical Low-Level Output Current vs Low-Level Output Voltage**



**Figure 5-13. Typical High-Level Output Current vs High-Level Output Voltage**

## Typical Characteristics – Outputs, Reduced Drive Strength (PxDS.y = 0), Ports P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1 (continued)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)



## 5.20 Typical Characteristics – Outputs, Full Drive Strength (PxDS.y = 1), Ports P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

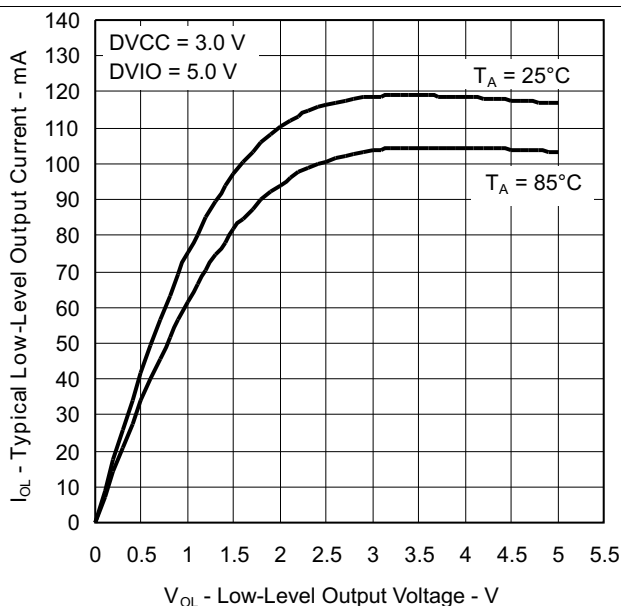


Figure 5-16. Typical Low-Level Output Current vs Low-Level Output Voltage

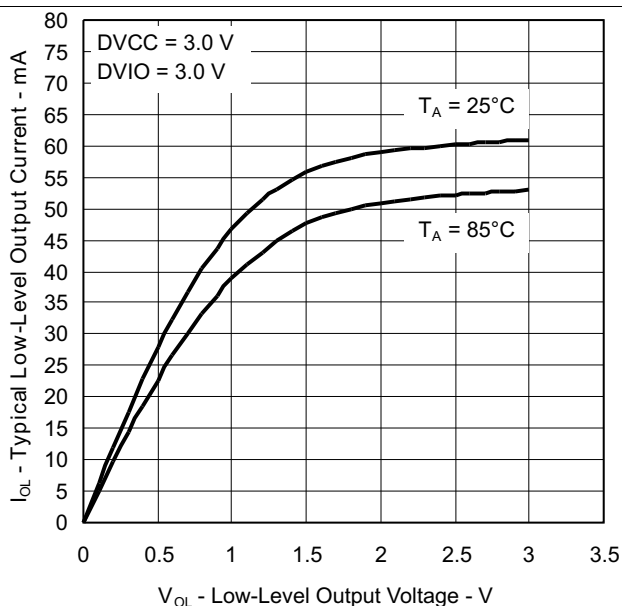


Figure 5-17. Typical Low-Level Output Current vs Low-Level Output Voltage

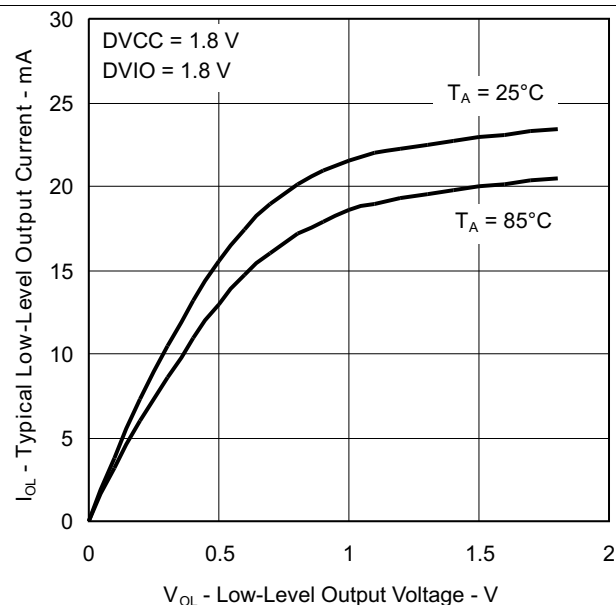


Figure 5-18. Typical Low-Level Output Current vs Low-Level Output Voltage

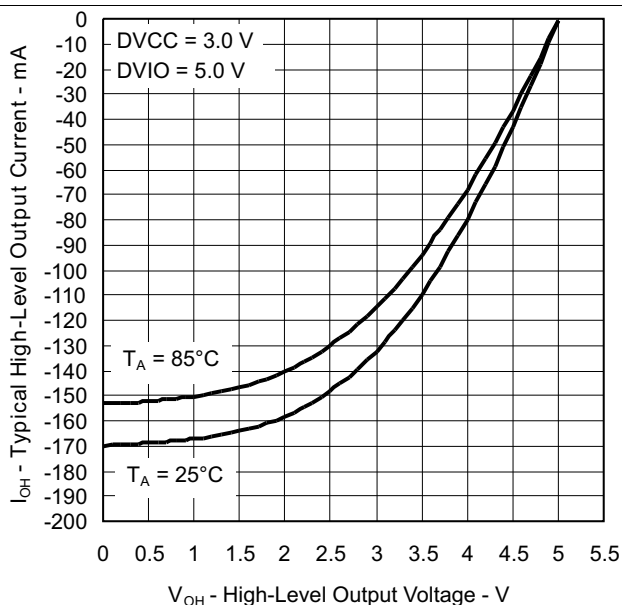
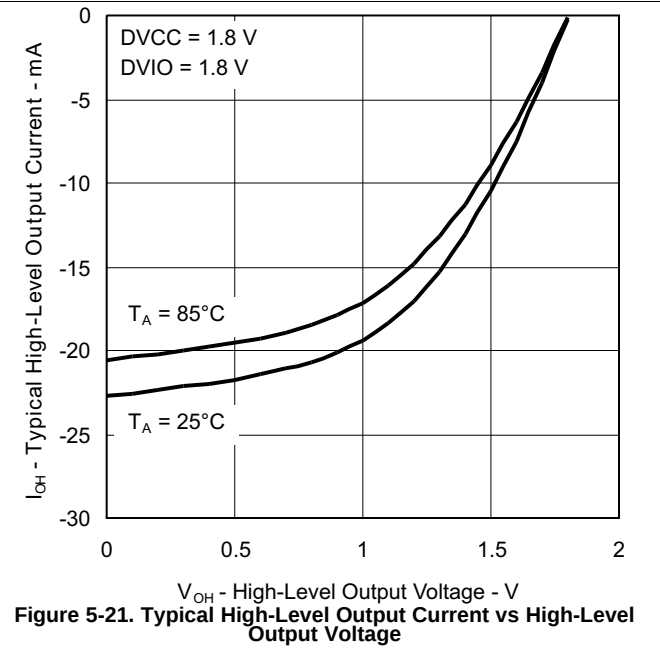
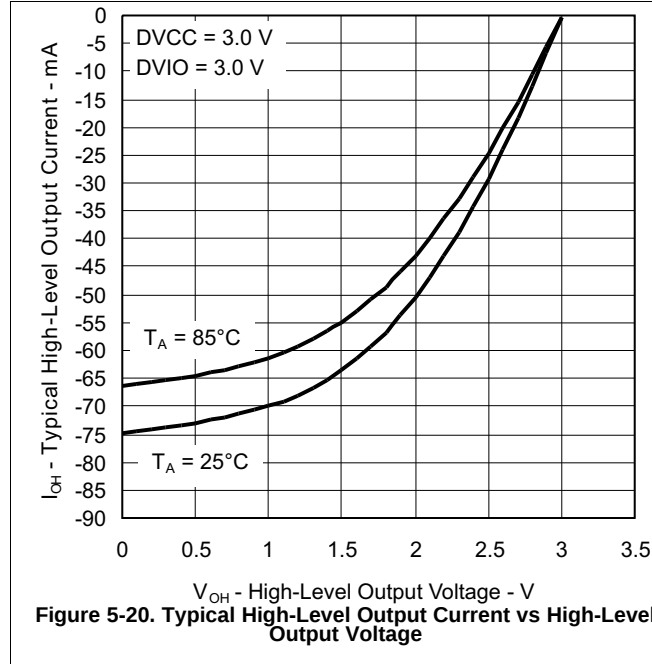


Figure 5-19. Typical High-Level Output Current vs High-Level Output Voltage

## Typical Characteristics – Outputs, Full Drive Strength (PxDS.y = 1), Ports P1.6 and P1.7, P2.0 to P2.7, P3.0 and P3.1 (continued)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)



## 5.21 Crystal Oscillator, XT1, Low-Frequency Mode

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER              |                                                                                            | TEST CONDITIONS                                                                                                                   | V <sub>CC</sub> | MIN   | TYP    | MAX   | UNIT |
|------------------------|--------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|-----------------|-------|--------|-------|------|
| I <sub>DVCC,LF</sub>   | Differential XT1 oscillator crystal current consumption from lowest drive setting, LF mode | f <sub>OSC</sub> = 32768 Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 1, T <sub>A</sub> = 25°C                             | 3 V             | 0.075 |        |       | μA   |
|                        |                                                                                            | f <sub>OSC</sub> = 32768 Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 2, T <sub>A</sub> = 25°C                             |                 | 0.170 |        |       |      |
|                        |                                                                                            | f <sub>OSC</sub> = 32768 Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 3, T <sub>A</sub> = 25°C                             |                 | 0.290 |        |       |      |
| f <sub>XT1,LF0</sub>   | XT1 oscillator crystal frequency, LF mode                                                  | XTS = 0, XT1BYPASS = 0                                                                                                            |                 | 32768 |        |       | Hz   |
| f <sub>XT1,LF,SW</sub> | XT1 oscillator logic-level square-wave input frequency, LF mode                            | XTS = 0, XT1BYPASS = 1                                                                                                            |                 | 10    | 32.768 | 50    | kHz  |
| O <sub>A,LF</sub>      | Oscillation allowance for LF crystals                                                      | XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 0, f <sub>XT1,LF</sub> = 32768 Hz, C <sub>L,eff</sub> = 6 pF                      |                 | 210   |        |       | kΩ   |
|                        |                                                                                            | XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 1, f <sub>XT1,LF</sub> = 32768 Hz, C <sub>L,eff</sub> = 12 pF                     |                 | 300   |        |       |      |
| C <sub>L,eff</sub>     | Integrated effective load capacitance, LF mode                                             | XTS = 0, XCAP <sub>x</sub> = 0                                                                                                    |                 | 1     |        |       | pF   |
|                        |                                                                                            | XTS = 0, XCAP <sub>x</sub> = 1                                                                                                    |                 | 5.5   |        |       |      |
|                        |                                                                                            | XTS = 0, XCAP <sub>x</sub> = 2                                                                                                    |                 | 8.5   |        |       |      |
|                        |                                                                                            | XTS = 0, XCAP <sub>x</sub> = 3                                                                                                    |                 | 12.0  |        |       |      |
| Duty cycle, LF mode    |                                                                                            | XTS = 0, Measured at ACLK, f <sub>XT1,LF</sub> = 32768 Hz                                                                         |                 | 30%   |        | 70%   |      |
| f <sub>Fault,LF</sub>  | Oscillator fault frequency, LF mode                                                        | XTS = 0                                                                                                                           |                 | 10    |        | 10000 | Hz   |
| t <sub>START,LF</sub>  | Start-up time, LF mode                                                                     | f <sub>OSC</sub> = 32768 Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 0, T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 12 pF | 3 V             | 1000  |        |       | ms   |
|                        |                                                                                            | f <sub>OSC</sub> = 32768 Hz, XTS = 0, XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 3, T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 12 pF |                 | 500   |        |       |      |

## 5.22 Crystal Oscillator, XT1, High-Frequency Mode<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                                                          | TEST CONDITIONS                                                                                                                       | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|--------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|-----|-----|------|
| I <sub>DVCC,HF</sub><br>Differential XT1 oscillator crystal current consumption from lowest drive setting, HF mode | f <sub>OSC</sub> = 4 MHz,<br>XTS = 1, XOSCOFF = 0,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 0,<br>T <sub>A</sub> = 25°C              | 3 V             |     | 200 |     | μA   |
|                                                                                                                    | f <sub>OSC</sub> = 12 MHz,<br>XTS = 1, XOSCOFF = 0,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 1,<br>T <sub>A</sub> = 25°C             |                 |     | 260 |     |      |
|                                                                                                                    | f <sub>OSC</sub> = 20 MHz,<br>XTS = 1, XOSCOFF = 0,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 2,<br>T <sub>A</sub> = 25°C             |                 |     | 325 |     |      |
|                                                                                                                    | f <sub>OSC</sub> = 32 MHz,<br>XTS = 1, XOSCOFF = 0,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 3,<br>T <sub>A</sub> = 25°C             |                 |     | 450 |     |      |
| f <sub>XT1,HF0</sub><br>XT1 oscillator crystal frequency, HF mode 0                                                | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 0 <sup>(2)</sup>                                                                   |                 | 4   |     | 8   | MHz  |
| f <sub>XT1,HF1</sub><br>XT1 oscillator crystal frequency, HF mode 1                                                | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 1 <sup>(2)</sup>                                                                   |                 | 8   |     | 16  | MHz  |
| f <sub>XT1,HF2</sub><br>XT1 oscillator crystal frequency, HF mode 2                                                | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 2 <sup>(2)</sup>                                                                   |                 | 16  |     | 24  | MHz  |
| f <sub>XT1,HF3</sub><br>XT1 oscillator crystal frequency, HF mode 3                                                | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 3 <sup>(2)</sup>                                                                   |                 | 24  |     | 32  | MHz  |
| f <sub>XT1,HF,SW</sub><br>XT1 oscillator logic-level square-wave input frequency, HF mode                          | XTS = 1,<br>XT1BYPASS = 1 <sup>(3) (2)</sup>                                                                                          |                 | 0.7 |     | 32  | MHz  |
| O <sub>AHF</sub><br>Oscillation allowance for HF crystals <sup>(4)</sup>                                           | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 0,<br>f <sub>XT1,HF</sub> = 6 MHz, C <sub>L,eff</sub> = 15 pF                      |                 |     | 450 |     | Ω    |
|                                                                                                                    | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 1,<br>f <sub>XT1,HF</sub> = 12 MHz, C <sub>L,eff</sub> = 15 pF                     |                 |     | 320 |     |      |
|                                                                                                                    | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 2,<br>f <sub>XT1,HF</sub> = 20 MHz, C <sub>L,eff</sub> = 15 pF                     |                 |     | 200 |     |      |
|                                                                                                                    | XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 3,<br>f <sub>XT1,HF</sub> = 32 MHz, C <sub>L,eff</sub> = 15 pF                     |                 |     | 200 |     |      |
| t <sub>START,HF</sub><br>Start-up time, HF mode                                                                    | f <sub>OSC</sub> = 6 MHz, XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 0,<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 15 pF  | 3 V             |     | 0.5 |     | ms   |
|                                                                                                                    | f <sub>OSC</sub> = 20 MHz, XTS = 1,<br>XT1BYPASS = 0, XT1DRIVE <sub>x</sub> = 2,<br>T <sub>A</sub> = 25°C, C <sub>L,eff</sub> = 15 pF |                 |     | 0.3 |     |      |
| C <sub>L,eff</sub><br>Integrated effective load capacitance, HF mode <sup>(5) (6)</sup>                            | XTS = 1                                                                                                                               |                 |     | 1   |     | pF   |

- (1) To improve EMI on the XT1 oscillator the following guidelines should be observed.
- Keep the traces between the device and the crystal as short as possible.
  - Design a good ground plane around the oscillator pins.
  - Prevent crosstalk from other clock or data lines into oscillator pins XIN and XOUT.
  - Avoid running PCB traces underneath or adjacent to the XIN and XOUT pins.
  - Use assembly materials and processes that avoid any parasitic load on the oscillator XIN and XOUT pins.
  - If conformal coating is used, make sure that it does not induce capacitive or resistive leakage between the oscillator pins.

(2) Maximum frequency of operation of the entire device cannot be exceeded.

(3) When XT1BYPASS is set, the VLO, REFO, XT1 circuits are automatically powered down.

(4) Oscillation allowance is based on a safety factor of 5 for recommended crystals.

(5) Includes parasitic bond and package capacitance (approximately 2 pF per pin).

Because the PCB adds additional capacitance, TI recommends verifying the correct load by measuring the ACLK frequency. For a correct setup, the effective load capacitance should always match the specification of the used crystal.

(6) Requires external capacitors at both terminals. Values are specified by crystal manufacturers.

## Crystal Oscillator, XT1, High-Frequency Mode<sup>(1)</sup> (continued)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                   | TEST CONDITIONS                                             | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|-----------------------------------------------------------------------------|-------------------------------------------------------------|-----------------|-----|-----|-----|------|
| Duty cycle, HF mode                                                         | XTS = 1, Measured at ACLK,<br>f <sub>XT1,HF2</sub> = 20 MHz |                 | 40% | 50% | 60% |      |
| f <sub>Fault,HF</sub> Oscillator fault frequency,<br>HF mode <sup>(7)</sup> | XTS = 1 <sup>(8)</sup>                                      |                 | 30  |     | 300 | kHz  |

(7) Frequencies below the MIN specification set the fault flag. Frequencies above the MAX specification do not set the fault flag. Frequencies between the MIN and MAX specifications might set the flag.

(8) Measured with logic-level input frequency but also applies to operation with crystals.

## 5.23 Internal Very-Low-Power Low-Frequency Oscillator (VLO)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                              | TEST CONDITIONS                 | V <sub>CC</sub> | MIN | TYP | MAX | UNIT |
|------------------------------------------------------------------------|---------------------------------|-----------------|-----|-----|-----|------|
| f <sub>VLO</sub> VLO frequency                                         | Measured at ACLK                | 1.8 V to 3.6 V  | 6   | 9.4 | 14  | kHz  |
| df <sub>VLO</sub> /dT VLO frequency temperature drift                  | Measured at ACLK <sup>(1)</sup> | 1.8 V to 3.6 V  |     | 0.5 |     | %/°C |
| df <sub>VLO</sub> /dV <sub>CC</sub> VLO frequency supply voltage drift | Measured at ACLK <sup>(2)</sup> | 1.8 V to 3.6 V  |     | 4   |     | %/V  |
| Duty cycle                                                             | Measured at ACLK                | 1.8 V to 3.6 V  | 40% | 50% | 60% |      |

(1) Calculated using the box method: (MAX(–40°C to 85°C) – MIN(–40°C to 85°C)) / MIN(85°C – (–40°C)). The coefficient is negative.

(2) Calculated using the box method: (MAX(1.8 V to 3.6 V) – MIN(1.8 V to 3.6 V)) / MIN(1.8 V to 3.6 V) / (3.6 V – 1.8 V). The coefficient is positive.

## 5.24 Internal Reference, Low-Frequency Oscillator (REFO)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                                                | TEST CONDITIONS                    | V <sub>CC</sub>        | MIN            | TYP   | MAX   | UNIT |
|--------------------------------------------------------------------------|------------------------------------|------------------------|----------------|-------|-------|------|
| I <sub>REFO</sub> REFO oscillator current consumption                    | T <sub>A</sub> = 25°C              | 1.8 V to 3.6 V         |                | 3     |       | μA   |
| f <sub>REFO</sub>                                                        | REFO frequency calibrated          | Measured at ACLK       | 1.8 V to 3.6 V | 32768 |       | Hz   |
|                                                                          | REFO absolute tolerance calibrated | Full temperature range | 1.8 V to 3.6 V |       | ±3.5% |      |
|                                                                          |                                    | T <sub>A</sub> = 25°C  | 3 V            |       | ±1.5% |      |
| df <sub>REFO</sub> /dT REFO frequency temperature drift                  | Measured at ACLK <sup>(1)</sup>    | 1.8 V to 3.6 V         |                | 0.01  |       | %/°C |
| df <sub>REFO</sub> /dV <sub>CC</sub> REFO frequency supply voltage drift | Measured at ACLK <sup>(2)</sup>    | 1.8 V to 3.6 V         |                | 1.0   |       | %/V  |
| Duty cycle                                                               | Measured at ACLK                   | 1.8 V to 3.6 V         | 40%            | 50%   | 60%   |      |
| t <sub>START</sub> REFO start-up time                                    | 40%/60% duty cycle                 | 1.8 V to 3.6 V         |                | 25    |       | μs   |

(1) Calculated using the box method: (MAX(–40°C to 85°C) – MIN(–40°C to 85°C)) / MIN(85°C – (–40°C))

(2) Calculated using the box method: (MAX(1.8 V to 3.6 V) – MIN(1.8 V to 3.6 V)) / MIN(1.8 V to 3.6 V) / (3.6 V – 1.8 V)

## 5.25 DCO Frequency

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 5-22](#))

| PARAMETER                                                          | TEST CONDITIONS                                            | MIN  | TYP | MAX  | UNIT  |
|--------------------------------------------------------------------|------------------------------------------------------------|------|-----|------|-------|
| $f_{DCO(0,0)}$ DCO frequency (0, 0) <sup>(1)</sup>                 | DCORSELx = 0, DCOx = 0, MODx = 0                           | 0.07 |     | 0.20 | MHz   |
| $f_{DCO(0,31)}$ DCO frequency (0, 31) <sup>(1)</sup>               | DCORSELx = 0, DCOx = 31, MODx = 0                          | 0.70 |     | 1.70 | MHz   |
| $f_{DCO(1,0)}$ DCO frequency (1, 0) <sup>(1)</sup>                 | DCORSELx = 1, DCOx = 0, MODx = 0                           | 0.15 |     | 0.38 | MHz   |
| $f_{DCO(1,31)}$ DCO frequency (1, 31) <sup>(1)</sup>               | DCORSELx = 1, DCOx = 31, MODx = 0                          | 1.47 |     | 3.45 | MHz   |
| $f_{DCO(2,0)}$ DCO frequency (2, 0) <sup>(1)</sup>                 | DCORSELx = 2, DCOx = 0, MODx = 0                           | 0.32 |     | 0.75 | MHz   |
| $f_{DCO(2,31)}$ DCO frequency (2, 31) <sup>(1)</sup>               | DCORSELx = 2, DCOx = 31, MODx = 0                          | 3.17 |     | 7.38 | MHz   |
| $f_{DCO(3,0)}$ DCO frequency (3, 0) <sup>(1)</sup>                 | DCORSELx = 3, DCOx = 0, MODx = 0                           | 0.64 |     | 1.51 | MHz   |
| $f_{DCO(3,31)}$ DCO frequency (3, 31) <sup>(1)</sup>               | DCORSELx = 3, DCOx = 31, MODx = 0                          | 6.07 |     | 14.0 | MHz   |
| $f_{DCO(4,0)}$ DCO frequency (4, 0) <sup>(1)</sup>                 | DCORSELx = 4, DCOx = 0, MODx = 0                           | 1.3  |     | 3.2  | MHz   |
| $f_{DCO(4,31)}$ DCO frequency (4, 31) <sup>(1)</sup>               | DCORSELx = 4, DCOx = 31, MODx = 0                          | 12.3 |     | 28.2 | MHz   |
| $f_{DCO(5,0)}$ DCO frequency (5, 0) <sup>(1)</sup>                 | DCORSELx = 5, DCOx = 0, MODx = 0                           | 2.5  |     | 6.0  | MHz   |
| $f_{DCO(5,31)}$ DCO frequency (5, 31) <sup>(1)</sup>               | DCORSELx = 5, DCOx = 31, MODx = 0                          | 23.7 |     | 54.1 | MHz   |
| $f_{DCO(6,0)}$ DCO frequency (6, 0) <sup>(1)</sup>                 | DCORSELx = 6, DCOx = 0, MODx = 0                           | 4.6  |     | 10.7 | MHz   |
| $f_{DCO(6,31)}$ DCO frequency (6, 31) <sup>(1)</sup>               | DCORSELx = 6, DCOx = 31, MODx = 0                          | 39.0 |     | 88.0 | MHz   |
| $f_{DCO(7,0)}$ DCO frequency (7, 0) <sup>(1)</sup>                 | DCORSELx = 7, DCOx = 0, MODx = 0                           | 8.5  |     | 19.6 | MHz   |
| $f_{DCO(7,31)}$ DCO frequency (7, 31) <sup>(1)</sup>               | DCORSELx = 7, DCOx = 31, MODx = 0                          | 60   |     | 135  | MHz   |
| $S_{DCORSEL}$ Frequency step between range DCORSEL and DCORSEL + 1 | $S_{RSEL} = f_{DCO(DCORSEL+1,DCO)} / f_{DCO(DCORSEL,DCO)}$ | 1.2  |     | 2.4  | ratio |
| $S_{DCO}$ Frequency step between tap DCO and DCO + 1               | $S_{DCO} = f_{DCO(DCORSEL,DCO+1)} / f_{DCO(DCORSEL,DCO)}$  | 1.02 |     | 1.12 | ratio |
| Duty cycle                                                         | Measured at SMCLK                                          | 40%  | 50% | 60%  |       |
| $df_{DCO}/dT$ DCO frequency temperature drift                      | $f_{DCO} = 1$ MHz, $V_{CORE} = 1.2$ V, 2.0 V               |      | 0.1 |      | %/°C  |
| $df_{DCO}/dV_{CORE}$ DCO frequency voltage drift                   | $f_{DCO} = 1$ MHz                                          |      | 1.9 |      | %/V   |

- (1) When selecting the proper DCO frequency range (DCORSELx), the target DCO frequency,  $f_{DCO}$ , should be set to reside within the range of  $f_{DCO(n,0),MAX} \leq f_{DCO} \leq f_{DCO(n,31),MIN}$ , where  $f_{DCO(n,0),MAX}$  represents the maximum frequency specified for the DCO frequency, range n, tap 0 (DCOx = 0) and  $f_{DCO(n,31),MIN}$  represents the minimum frequency specified for the DCO frequency, range n, tap 31 (DCOx = 31). This ensures that the target DCO frequency resides within the range selected. It should also be noted that if the actual  $f_{DCO}$  frequency for the selected range causes the FLL or the application to select tap 0 or 31, the DCO fault flag is set to report that the selected range is at its minimum or maximum tap setting.

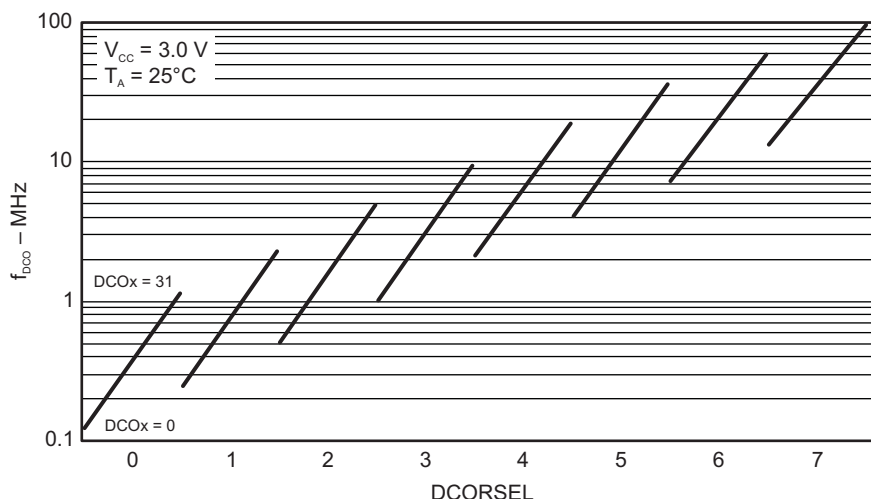


Figure 5-22. Typical DCO Frequency

## 5.26 PMM, Brownout Reset (BOR)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER               |                                                                                  | TEST CONDITIONS                   | MIN  | TYP  | MAX  | UNIT |
|-------------------------|----------------------------------------------------------------------------------|-----------------------------------|------|------|------|------|
| $V_{(DVCC\_BOR\_IT-)}$  | BOR <sub>H</sub> on voltage, DV <sub>CC</sub> falling level                      | $dDV_{CC}/dt < 3 \text{ V/s}$     |      |      | 1.45 | V    |
| $V_{(DVCC\_BOR\_IT+)}$  | BOR <sub>H</sub> off voltage, DV <sub>CC</sub> rising level                      | $dDV_{CC}/dt < 3 \text{ V/s}$     | 0.80 | 1.30 | 1.50 | V    |
| $V_{(DVCC\_BOR\_hys)}$  | BOR <sub>H</sub> hysteresis                                                      |                                   | 40   |      | 275  | mV   |
| $V_{(VCORE\_BOR\_IT-)}$ | BOR <sub>L</sub> on voltage, V <sub>CORE</sub> falling level                     | DV <sub>CC</sub> = 1.8 V to 3.6 V | 0.69 |      | 0.87 | V    |
| $V_{(VCORE\_BOR\_IT+)}$ | BOR <sub>L</sub> off voltage, V <sub>CORE</sub> rising level                     | DV <sub>CC</sub> = 1.8 V to 3.6 V | 0.83 |      | 1.05 | V    |
| $V_{(VCORE\_BOR\_hys)}$ | BOR <sub>L</sub> hysteresis                                                      |                                   | 60   |      | 200  | mV   |
| $t_{dBOR}$              | BOR <sub>L</sub> reset release time                                              |                                   |      |      | 2000 | μs   |
| $t_{RESET}$             | Pulse duration required at $\overline{RST}/\overline{NMI}$ pin to accept a reset |                                   | 2    |      |      | μs   |

## 5.27 PMM, Core Voltage

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER        |                                              | TEST CONDITIONS                                                                                      | MIN | TYP  | MAX | UNIT |
|------------------|----------------------------------------------|------------------------------------------------------------------------------------------------------|-----|------|-----|------|
| $V_{CORE3(AM)}$  | Core voltage, active mode, PMMCOREV = 3      | $2.4 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ mA} \leq I(V_{CORE}) \leq 25 \text{ mA}$ |     | 1.90 |     | V    |
| $V_{CORE2(AM)}$  | Core voltage, active mode, PMMCOREV = 2      | $2.2 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ mA} \leq I(V_{CORE}) \leq 21 \text{ mA}$ |     | 1.80 |     | V    |
| $V_{CORE1(AM)}$  | Core voltage, active mode, PMMCOREV = 1      | $2.0 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ mA} \leq I(V_{CORE}) \leq 17 \text{ mA}$ |     | 1.60 |     | V    |
| $V_{CORE0(AM)}$  | Core voltage, active mode, PMMCOREV = 0      | $1.8 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ mA} \leq I(V_{CORE}) \leq 13 \text{ mA}$ |     | 1.40 |     | V    |
| $V_{CORE3(LPM)}$ | Core voltage, active mode, PMMCOREV = 3      | $2.4 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ mA} \leq I(V_{CORE}) \leq 30 \text{ μA}$ |     | 1.94 |     | V    |
| $V_{CORE2(LPM)}$ | Core voltage, low-current mode, PMMCOREV = 2 | $2.2 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ μA} \leq I(V_{CORE}) \leq 30 \text{ μA}$ |     | 1.84 |     | V    |
| $V_{CORE1(LPM)}$ | Core voltage, low-current mode, PMMCOREV = 1 | $2.0 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ μA} \leq I(V_{CORE}) \leq 30 \text{ μA}$ |     | 1.64 |     | V    |
| $V_{CORE0(LPM)}$ | Core voltage, low-current mode, PMMCOREV = 0 | $1.8 \text{ V} \leq DV_{CC} \leq 3.6 \text{ V}$ , $0 \text{ μA} \leq I(V_{CORE}) \leq 30 \text{ μA}$ |     | 1.44 |     | V    |

## 5.28 PMM, SVS High Side

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER         |                                       | TEST CONDITIONS                                                      | MIN  | TYP  | MAX  | UNIT          |
|-------------------|---------------------------------------|----------------------------------------------------------------------|------|------|------|---------------|
| $I_{(SVSH)}$      | SVS current consumption               | SVSHE = 0, $DV_{CC} = 3.6\text{ V}$                                  |      | 0    |      | nA            |
|                   |                                       | SVSHE = 1, $DV_{CC} = 3.6\text{ V}$ , SVSHFP = 0                     |      | 200  |      |               |
|                   |                                       | SVSHE = 1, $DV_{CC} = 3.6\text{ V}$ , SVSHFP = 1                     |      | 2    |      | $\mu\text{A}$ |
| $V_{(SVSH\_IT-)}$ | SVS <sub>H</sub> on voltage level     | SVSHE = 1, SVSHRVL = 0                                               | 1.59 | 1.64 | 1.69 | V             |
|                   |                                       | SVSHE = 1, SVSHRVL = 1                                               | 1.79 | 1.84 | 1.91 |               |
|                   |                                       | SVSHE = 1, SVSHRVL = 2                                               | 1.98 | 2.04 | 2.11 |               |
|                   |                                       | SVSHE = 1, SVSHRVL = 3                                               | 2.10 | 2.16 | 2.23 |               |
| $V_{(SVSH\_IT+)}$ | SVS <sub>H</sub> off voltage level    | SVSHE = 1, SVSMHRRRL = 0                                             | 1.62 | 1.74 | 1.81 | V             |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 1                                             | 1.88 | 1.94 | 2.01 |               |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 2                                             | 2.07 | 2.14 | 2.21 |               |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 3                                             | 2.20 | 2.26 | 2.33 |               |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 4                                             | 2.32 | 2.40 | 2.48 |               |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 5                                             | 2.56 | 2.70 | 2.84 |               |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 6                                             | 2.85 | 3.00 | 3.15 |               |
|                   |                                       | SVSHE = 1, SVSMHRRRL = 7                                             | 2.85 | 3.00 | 3.15 |               |
| $t_{pd(SVSH)}$    | SVS <sub>H</sub> propagation delay    | SVSHE = 1, $dV_{DVCC}/dt = 10\text{ mV}/\mu\text{s}$ , SVSHFP = 1    |      | 2.5  |      | $\mu\text{s}$ |
|                   |                                       | SVSHE = 1, $dV_{DVCC}/dt = \pm 1\text{ mV}/\mu\text{s}$ , SVSHFP = 0 |      | 25   |      |               |
| $t_{(SVSH)}$      | SVS <sub>H</sub> on or off delay time | SVSHE = 0 $\rightarrow$ 1, SVSHFP = 1                                |      | 12.5 |      | $\mu\text{s}$ |
|                   |                                       | SVSHE = 0 $\rightarrow$ 1, SVSHFP = 0                                |      | 100  |      |               |
| $dV_{DVCC}/dt$    | $DV_{CC}$ rise time                   |                                                                      | 0    |      | 1000 | V/s           |

## 5.29 PMM, SVM High Side

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                             | TEST CONDITIONS                                          | MIN  | TYP  | MAX  | UNIT |
|-------------------------------------------------------|----------------------------------------------------------|------|------|------|------|
| $I_{(SVMH)}$ SVM <sub>H</sub> current consumption     | SVMHE = 0, DV <sub>CC</sub> = 3.6 V                      |      | 0    |      | nA   |
|                                                       | SVMHE = 1, DV <sub>CC</sub> = 3.6 V, SVMHFP = 0          |      | 200  |      |      |
|                                                       | SVMHE = 1, DV <sub>CC</sub> = 3.6 V, SVMHFP = 1          |      | 2.0  |      | μA   |
| $V_{(SVMH)}$ SVM <sub>H</sub> on or off voltage level | SVMHE = 1, SVSMHRRRL = 0                                 | 1.65 | 1.74 | 1.86 | V    |
|                                                       | SVMHE = 1, SVSMHRRRL = 1                                 | 1.85 | 1.94 | 2.02 |      |
|                                                       | SVMHE = 1, SVSMHRRRL = 2                                 | 2.02 | 2.14 | 2.22 |      |
|                                                       | SVMHE = 1, SVSMHRRRL = 3                                 | 2.18 | 2.26 | 2.35 |      |
|                                                       | SVMHE = 1, SVSMHRRRL = 4                                 | 2.32 | 2.40 | 2.48 |      |
|                                                       | SVMHE = 1, SVSMHRRRL = 5                                 | 2.56 | 2.70 | 2.84 |      |
|                                                       | SVMHE = 1, SVSMHRRRL = 6                                 | 2.85 | 3.00 | 3.15 |      |
|                                                       | SVMHE = 1, SVSMHRRRL = 7                                 | 2.85 | 3.00 | 3.15 |      |
| $t_{pd(SVMH)}$ SVM <sub>H</sub> propagation delay     | SVMHE = 1, dV <sub>DVCC</sub> /dt = 10 mV/μs, SVMHFP = 1 |      | 2.5  |      | μs   |
|                                                       | SVMHE = 1, dV <sub>DVCC</sub> /dt = 1 mV/μs, SVMHFP = 0  |      | 20   |      | μs   |
| $t_{(SVMH)}$ SVM <sub>H</sub> on or off delay time    | SVMHE = 0 -> 1, SVSHFP = 1                               |      | 12.5 |      | μs   |
|                                                       | SVMHE = 0 -> 1, SVSHFP = 0                               |      | 100  |      |      |

## 5.30 PMM, SVS Low Side

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                          | TEST CONDITIONS                                          | MIN | TYP  | MAX | UNIT |
|----------------------------------------------------|----------------------------------------------------------|-----|------|-----|------|
| $I_{(SVSL)}$ SVS <sub>L</sub> current consumption  | SVSLE = 0, PMMCOREV = 2                                  |     | 0    |     | nA   |
|                                                    | SVSLE = 1, PMMCOREV = 2, SVSLFP = 0                      |     | 200  |     |      |
|                                                    | SVSLE = 1, PMMCOREV = 2, SVSLFP = 1                      |     | 2.0  |     | μA   |
| $t_{(SVSL)}$ SVS <sub>L</sub> on or off delay time | SVSLE = 1, dV <sub>CORE</sub> /dt = 10 mV/μs, SVSLFP = 1 |     | 6    |     | μs   |
|                                                    | SVSLE = 1, dV <sub>CORE</sub> /dt = 1 mV/μs, SVSLFP = 0  |     | 50   |     |      |
| $t_{pd(SVSL)}$ SVS <sub>L</sub> propagation delay  | SVMHE = 0 -> 1, SVSLFP = 1                               |     | 12.5 |     | μs   |
|                                                    | SVMHE = 0 -> 1, SVSLFP = 0                               |     | 100  |     |      |

## 5.31 PMM, SVM Low Side

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                          | TEST CONDITIONS                                          | MIN | TYP  | MAX | UNIT |
|----------------------------------------------------|----------------------------------------------------------|-----|------|-----|------|
| $I_{(SVML)}$ SVM <sub>L</sub> current consumption  | SVMLE = 0, PMMCOREV = 2                                  |     | 0    |     | nA   |
|                                                    | SVMLE = 1, PMMCOREV = 2, SVMLFP = 0                      |     | 200  |     |      |
|                                                    | SVMLE = 1, PMMCOREV = 2, SVMLFP = 1                      |     | 2.0  |     | μA   |
| $t_{pd(SVML)}$ SVM <sub>L</sub> propagation delay  | SVMLE = 1, dV <sub>CORE</sub> /dt = 10 mV/μs, SVMLFP = 1 |     | 2.5  |     | μs   |
|                                                    | SVMLE = 1, dV <sub>CORE</sub> /dt = 1 mV/μs, SVMLFP = 0  |     | 30   |     |      |
| $t_{(SVML)}$ SVM <sub>L</sub> on or off delay time | SVMLE = 0 -> 1, SVSLFP = 1                               |     | 12.5 |     | μs   |
|                                                    | SVMLE = 0 -> 1, SVSLFP = 0                               |     | 100  |     |      |

### 5.32 Wake-up Times From Low-Power Modes

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER      |                                                      | TEST CONDITIONS                                                 |                       | MIN | TYP | MAX | UNIT |
|----------------|------------------------------------------------------|-----------------------------------------------------------------|-----------------------|-----|-----|-----|------|
| tFAST-WAKE-UP  | Wake-up time from LPM2, LPM3, or LPM4 to active mode | PMMCOREVx = SVSMLRRLx = n (where n = 0, 1, 2, or 3), SVSLFP = 1 | fMCLK ≥ 4 MHz         |     | 3   | 6.5 | μs   |
|                |                                                      |                                                                 | 1 MHz < fMCLK < 4 MHz |     | 4   | 8.0 |      |
| tSLOW-WAKE-UP  | Wake-up time from LPM2, LPM3, or LPM4 to active mode | PMMCOREVx = SVSMLRRLx = n (where n = 0, 1, 2, or 3), SVSLFP = 0 |                       |     | 150 | 165 | μs   |
| tWAKE-UP LPM5  | Wake-up time from LPM4.5 to active mode              |                                                                 |                       |     | 2   | 3   | ms   |
| tWAKE-UP-RESET | Wake-up time from RST or BOR event to active mode    |                                                                 |                       |     | 2   | 3   | ms   |

### 5.33 Timer\_A

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER           | TEST CONDITIONS                                                                                         | V <sub>CC</sub> | MIN | MAX | UNIT |
|---------------------|---------------------------------------------------------------------------------------------------------|-----------------|-----|-----|------|
| $f_{\text{TA}}$     | Timer_A input clock frequency<br>Internal: SMCLK, ACLK<br>External: TACLK<br>Duty cycle = 50% $\pm$ 10% | 1.8 V, 3 V      |     | 25  | MHz  |
| $t_{\text{TA,cap}}$ | Timer_A capture timing<br>All capture inputs.<br>Minimum pulse duration required for capture.           | 1.8 V, 3 V      | 20  |     | ns   |

### 5.34 USCI (UART Mode)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER               | TEST CONDITIONS                                                                                     | V <sub>CC</sub> | MIN | TYP                 | MAX | UNIT |
|-------------------------|-----------------------------------------------------------------------------------------------------|-----------------|-----|---------------------|-----|------|
| $f_{\text{USCI}}$       | USCI input clock frequency<br>Internal: SMCLK, ACLK<br>External: UCLK<br>Duty cycle = 50% $\pm$ 10% |                 |     | $f_{\text{SYSTEM}}$ |     | MHz  |
| $f_{\text{max,BITCLK}}$ | Maximum BITCLK clock frequency (equals baud rate in MBaud) <sup>(1)</sup>                           |                 | 1   |                     |     | MHz  |
| $t_{\text{r}}$          | UART receive deglitch time                                                                          | 2.2 V           | 50  | 150                 | 200 | ns   |
|                         |                                                                                                     | 3 V             | 50  | 150                 | 200 |      |

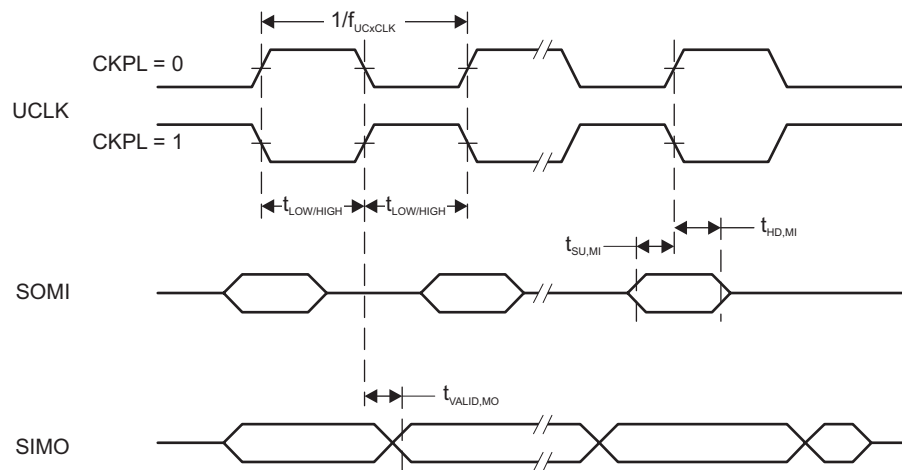
(1) The DCO wake-up time must be considered in LPM3 and LPM4. The wake-up time must be considered in LPMx.5.

### 5.35 USCI (SPI Master Mode)

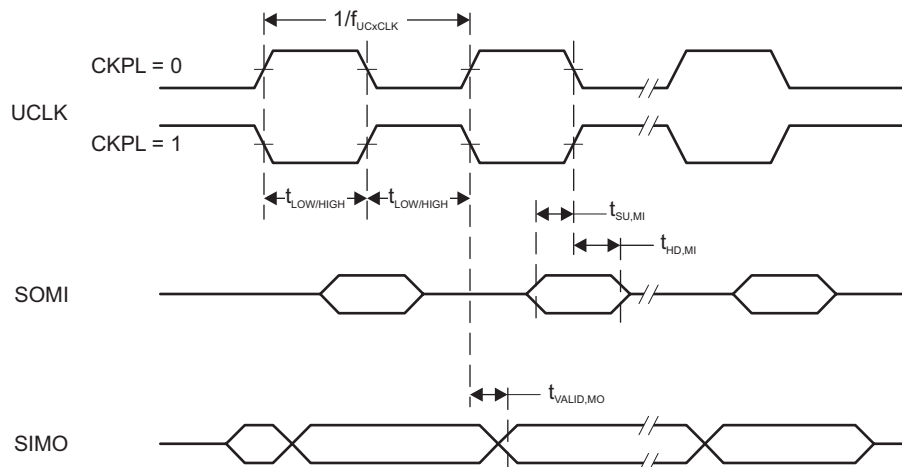
over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup> (see [Figure 5-23](#) and [Figure 5-24](#))

| PARAMETER             |                                            | TEST CONDITIONS                                                  | V <sub>CC</sub> | MIN                 | MAX | UNIT |
|-----------------------|--------------------------------------------|------------------------------------------------------------------|-----------------|---------------------|-----|------|
| f <sub>USCI</sub>     | USCI input clock frequency                 | SMCLK, ACLK<br>Duty cycle = 50% ±10%                             |                 | f <sub>SYSTEM</sub> |     | MHz  |
| t <sub>SU,MI</sub>    | SOMI input data setup time                 | PMMCOREV = 0                                                     | 1.8 V           | 55                  | ns  |      |
|                       |                                            |                                                                  | 3 V             | 38                  |     |      |
|                       |                                            | PMMCOREV = 3                                                     | 2.4 V           | 30                  |     |      |
|                       |                                            |                                                                  | 3 V             | 25                  |     |      |
| t <sub>HD,MI</sub>    | SOMI input data hold time                  | PMMCOREV = 0                                                     | 1.8 V           | 0                   | ns  |      |
|                       |                                            |                                                                  | 3 V             | 0                   |     |      |
|                       |                                            | PMMCOREV = 3                                                     | 2.4 V           | 0                   |     |      |
|                       |                                            |                                                                  | 3 V             | 0                   |     |      |
| t <sub>VALID,MO</sub> | SIMO output data valid time <sup>(2)</sup> | UCLK edge to SIMO valid,<br>C <sub>L</sub> = 20 pF, PMMCOREV = 0 | 1.8 V           | 20                  | ns  |      |
|                       |                                            |                                                                  | 3 V             | 18                  |     |      |
|                       |                                            | UCLK edge to SIMO valid,<br>C <sub>L</sub> = 20 pF, PMMCOREV = 3 | 2.4 V           | 16                  |     |      |
|                       |                                            |                                                                  | 3 V             | 15                  |     |      |
| t <sub>HD,MO</sub>    | SIMO output data hold time <sup>(3)</sup>  | C <sub>L</sub> = 20 pF, PMMCOREV = 0                             | 1.8 V           | –10                 | ns  |      |
|                       |                                            |                                                                  | 3 V             | –8                  |     |      |
|                       |                                            | C <sub>L</sub> = 20 pF, PMMCOREV = 3                             | 2.4 V           | –10                 |     |      |
|                       |                                            |                                                                  | 3 V             | –8                  |     |      |

- (1)  $f_{UCLK} = 1/2t_{LO/HI}$  with  $t_{LO/HI} \geq \max(t_{VALID,MO}(USCI) + t_{SU,SI}(Slave), t_{SU,MI}(USCI) + t_{VALID,SO}(Slave))$ . For the slave parameters  $t_{SU,SI}(Slave)$  and  $t_{VALID,SO}(Slave)$ , see the SPI parameters of the attached slave.
- (2) Specifies the time to drive the next valid data to the SIMO output after the output changing UCLK clock edge. See the timing diagrams in [Figure 5-23](#) and [Figure 5-24](#).
- (3) Specifies how long data on the SIMO output is valid after the output changing UCLK clock edge. Negative values indicate that the data on the SIMO output can become invalid before the output changing clock edge observed on UCLK. See the timing diagrams in [Figure 5-23](#) and [Figure 5-24](#).



**Figure 5-23. SPI Master Mode, CKPH = 0**



**Figure 5-24. SPI Master Mode, CKPH = 1**

### 5.36 USCI (SPI Slave Mode)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup> (see [Figure 5-25](#) and [Figure 5-26](#))

| PARAMETER                                                              | TEST CONDITIONS                                               | V <sub>CC</sub> | MIN | MAX | UNIT |
|------------------------------------------------------------------------|---------------------------------------------------------------|-----------------|-----|-----|------|
| t <sub>STE,LEAD</sub> STE lead time, STE low to clock                  | PMMCOREV = 0                                                  | 1.8 V           | 11  |     | ns   |
|                                                                        |                                                               | 3 V             | 8   |     |      |
|                                                                        | PMMCOREV = 3                                                  | 2.4 V           | 7   |     |      |
|                                                                        |                                                               | 3 V             | 6   |     |      |
| t <sub>STE,LAG</sub> STE lag time, Last clock to STE high              | PMMCOREV = 0                                                  | 1.8 V           | 3   |     | ns   |
|                                                                        |                                                               | 3 V             | 3   |     |      |
|                                                                        | PMMCOREV = 3                                                  | 2.4 V           | 3   |     |      |
|                                                                        |                                                               | 3 V             | 3   |     |      |
| t <sub>STE,ACC</sub> STE access time, STE low to SOMI data out         | PMMCOREV = 0                                                  | 1.8 V           |     | 66  | ns   |
|                                                                        |                                                               | 3 V             |     | 50  |      |
|                                                                        | PMMCOREV = 3                                                  | 2.4 V           |     | 36  |      |
|                                                                        |                                                               | 3 V             |     | 30  |      |
| t <sub>STE,DIS</sub> STE disable time, STE high to SOMI high impedance | PMMCOREV = 0                                                  | 1.8 V           |     | 30  | ns   |
|                                                                        |                                                               | 3 V             |     | 23  |      |
|                                                                        | PMMCOREV = 3                                                  | 2.4 V           |     | 16  |      |
|                                                                        |                                                               | 3 V             |     | 13  |      |
| t <sub>SU,SI</sub> SIMO input data setup time                          | PMMCOREV = 0                                                  | 1.8 V           | 5   |     | ns   |
|                                                                        |                                                               | 3 V             | 5   |     |      |
|                                                                        | PMMCOREV = 3                                                  | 2.4 V           | 2   |     |      |
|                                                                        |                                                               | 3 V             | 2   |     |      |
| t <sub>HD,SI</sub> SIMO input data hold time                           | PMMCOREV = 0                                                  | 1.8 V           | 5   |     | ns   |
|                                                                        |                                                               | 3 V             | 5   |     |      |
|                                                                        | PMMCOREV = 3                                                  | 2.4 V           | 5   |     |      |
|                                                                        |                                                               | 3 V             | 5   |     |      |
| t <sub>VALID,SO</sub> SOMI output data valid time <sup>(2)</sup>       | UCLK edge to SOMI valid, C <sub>L</sub> = 20 pF, PMMCOREV = 0 | 1.8 V           |     | 76  | ns   |
|                                                                        |                                                               | 3 V             |     | 60  |      |
|                                                                        | UCLK edge to SOMI valid, C <sub>L</sub> = 20 pF, PMMCOREV = 3 | 2.4 V           |     | 44  |      |
|                                                                        |                                                               | 3 V             |     | 40  |      |
| t <sub>HD,SO</sub> SOMI output data hold time <sup>(3)</sup>           | C <sub>L</sub> = 20 pF, PMMCOREV = 0                          | 1.8 V           | 18  |     | ns   |
|                                                                        |                                                               | 3 V             | 12  |     |      |
|                                                                        | C <sub>L</sub> = 20 pF, PMMCOREV = 3                          | 2.4 V           | 10  |     |      |
|                                                                        |                                                               | 3 V             | 8   |     |      |

- (1) f<sub>UCXCLK</sub> = 1/2t<sub>LO/HI</sub> with t<sub>LO/HI</sub> ≥ max(t<sub>VALID,MO(Master)</sub> + t<sub>SU,SI(USCI)</sub>, t<sub>SU,MI(Master)</sub> + t<sub>VALID,SO(USCI)</sub>). For the master parameters t<sub>SU,MI(Master)</sub> and t<sub>VALID,MO(Master)</sub>, see the SPI parameters of the attached slave.
- (2) Specifies the time to drive the next valid data to the SOMI output after the output changing UCLK clock edge. See the timing diagrams in [Figure 5-25](#) and [Figure 5-26](#).
- (3) Specifies how long data on the SOMI output is valid after the output changing UCLK clock edge. See the timing diagrams in [Figure 5-25](#) and [Figure 5-26](#).

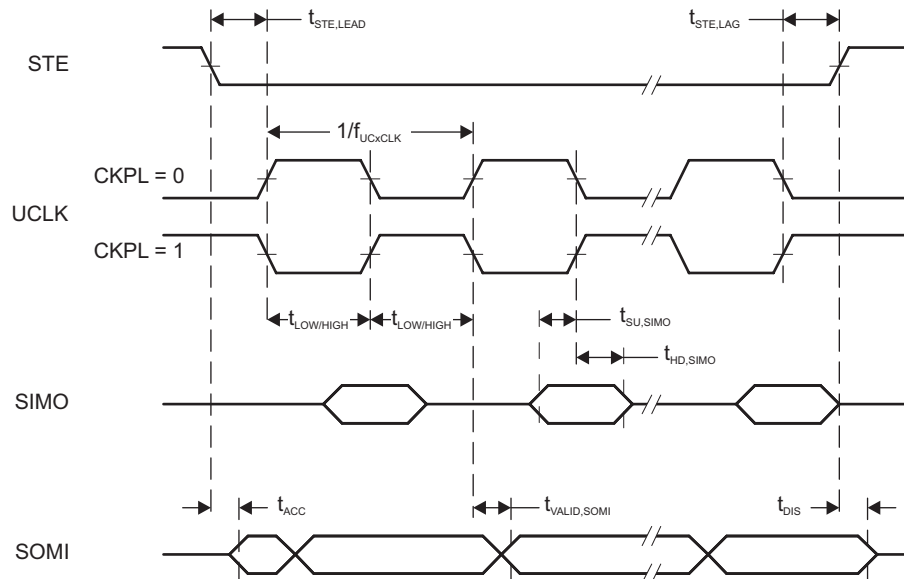


Figure 5-25. SPI Slave Mode, CKPH = 0

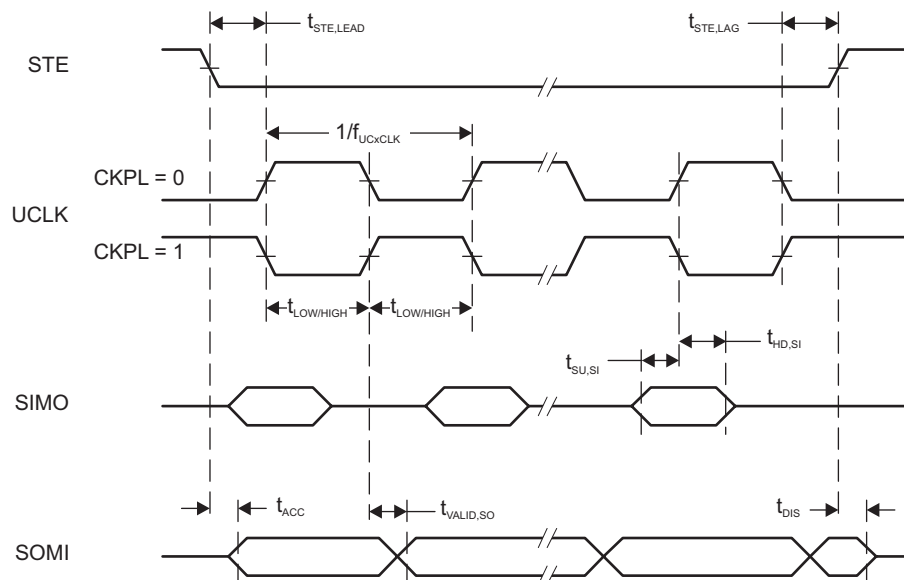
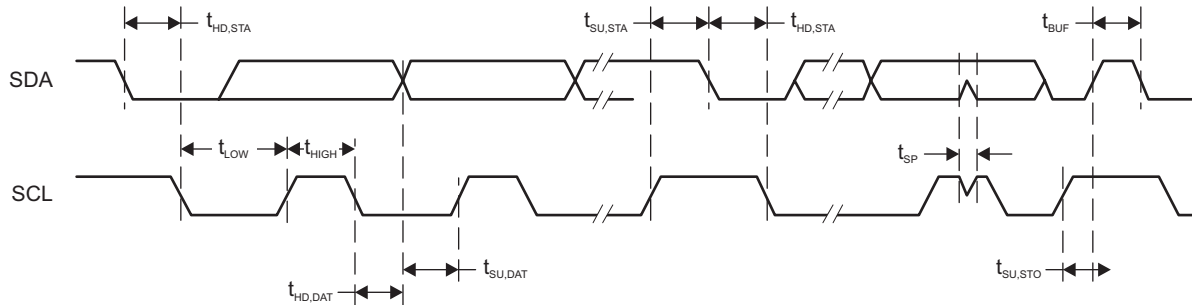


Figure 5-26. SPI Slave Mode, CKPH = 1

### 5.37 USCI (I<sup>2</sup>C Mode)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see [Figure 5-27](#))

| PARAMETER                                                           | TEST CONDITIONS                                                  | V <sub>CC</sub> | MIN                 | MAX | UNIT |
|---------------------------------------------------------------------|------------------------------------------------------------------|-----------------|---------------------|-----|------|
| f <sub>USCI</sub> USCI input clock frequency                        | Internal: SMCLK, ACLK<br>External: UCLK<br>Duty cycle = 50% ±10% |                 | f <sub>SYSTEM</sub> |     | MHz  |
| f <sub>SCL</sub> SCL clock frequency                                |                                                                  | 2.2 V, 3 V      | 0                   | 400 | kHz  |
| t <sub>HD,STA</sub> Hold time (repeated) START                      | f <sub>SCL</sub> ≤ 100 kHz                                       | 2.2 V, 3 V      | 4.0                 |     | μs   |
|                                                                     | f <sub>SCL</sub> > 100 kHz                                       |                 | 0.6                 |     |      |
| t <sub>SU,STA</sub> Setup time for a repeated START                 | f <sub>SCL</sub> ≤ 100 kHz                                       | 2.2 V, 3 V      | 4.7                 |     | μs   |
|                                                                     | f <sub>SCL</sub> > 100 kHz                                       |                 | 0.6                 |     |      |
| t <sub>HD,DAT</sub> Data hold time                                  |                                                                  | 2.2 V, 3 V      | 0                   |     | ns   |
| t <sub>SU,DAT</sub> Data setup time                                 |                                                                  | 2.2 V, 3 V      | 250                 |     | ns   |
| t <sub>SU,STO</sub> Setup time for STOP                             | f <sub>SCL</sub> ≤ 100 kHz                                       | 2.2 V, 3 V      | 4.0                 |     | μs   |
|                                                                     | f <sub>SCL</sub> > 100 kHz                                       |                 | 0.6                 |     |      |
| t <sub>SP</sub> Pulse duration of spikes suppressed by input filter |                                                                  | 2.2 V           | 50                  | 600 | ns   |
|                                                                     |                                                                  | 3 V             | 50                  | 600 |      |



**Figure 5-27. I<sup>2</sup>C Mode Timing**

### 5.38 10-Bit ADC, Power Supply and Input Range Conditions (MSP430F51x2 Devices Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER            |                                                                                   | TEST CONDITIONS                                                                                                                                                             | V <sub>CC</sub> | MIN | TYP | MAX              | UNIT |
|----------------------|-----------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|-----|------------------|------|
| AV <sub>CC</sub>     | Analog supply voltage                                                             | AV <sub>CC</sub> and DV <sub>CC</sub> are connected together, AV <sub>SS</sub> and DV <sub>SS</sub> are connected together, V <sub>(AVSS)</sub> = V <sub>(DVSS)</sub> = 0 V |                 | 1.8 |     | 3.6              | V    |
| V <sub>(Ax)</sub>    | Analog input voltage range <sup>(2)</sup>                                         | All ADC10_A pins: P1.0 to P1.5 and P3.6 and P3.7 terminals                                                                                                                  |                 | 0   |     | AV <sub>CC</sub> | V    |
| I <sub>ADC10_A</sub> | Operating supply current into AVCC terminal, REF module and reference buffer off  | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 1, REFON = 0, SHT0 = 0, SHT1 = 0, ADC10DIV = 0, ADC10SREF = 00                                                                     | 2.2 V           |     | 60  | 90               | μA   |
|                      |                                                                                   |                                                                                                                                                                             | 3 V             |     | 75  | 100              |      |
|                      | Operating supply current into AVCC terminal, REF module on, reference buffer on   | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 1, REFON = 1, SHT0 = 0, SHT1 = 0, ADC10DIV = 0, ADC10SREF = 01                                                                     | 3 V             |     | 113 | 130              |      |
|                      | Operating supply current into AVCC terminal, REF module off, reference buffer on  | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 1, REFON = 0, SHT0 = 0, SHT1 = 0, ADC10DIV = 0, ADC10SREF = 10, VREF = 2.5 V                                                       | 3 V             |     | 105 | 125              |      |
| I <sub>ADC10_A</sub> | Operating supply current into AVCC terminal, REF module off, reference buffer off | f <sub>ADC10CLK</sub> = 5 MHz, ADC10ON = 1, REFON = 0, SHT0 = 0, SHT1 = 0, ADC10DIV = 0, ADC10SREF = 11, VREF = 2.5 V                                                       | 3 V             |     | 70  | 95               | μA   |
|                      |                                                                                   |                                                                                                                                                                             |                 |     |     |                  |      |
| C <sub>I</sub>       | Input capacitance                                                                 | Only one terminal Ax can be selected at one time from the pad to the ADC10_A capacitor array including wiring and pad                                                       | 2.2 V           |     | 3.5 |                  | pF   |
| R <sub>I</sub>       | Input MUX ON resistance                                                           | AV <sub>CC</sub> > 2.0V, 0 V ≤ V <sub>Ax</sub> ≤ AV <sub>CC</sub>                                                                                                           |                 |     |     | 36               | kΩ   |
|                      |                                                                                   | 1.8V < AV <sub>CC</sub> < 2.0V, 0 V ≤ V <sub>Ax</sub> ≤ AV <sub>CC</sub>                                                                                                    |                 |     |     | 96               |      |

(1) The leakage current is defined in the leakage current table with P6.x/Ax parameter.

(2) The analog input voltage range must be within the selected reference voltage range V<sub>R+</sub> to V<sub>R-</sub> for valid conversion results. The external reference voltage requires decoupling capacitors. See 0.

### 5.39 10-Bit ADC, Timing Parameters (MSP430F51x2 Devices Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER             |                                            | TEST CONDITIONS                                                                                           | V <sub>CC</sub> | MIN  | TYP | MAX | UNIT |
|-----------------------|--------------------------------------------|-----------------------------------------------------------------------------------------------------------|-----------------|------|-----|-----|------|
| f <sub>ADC10CLK</sub> |                                            | For specified performance of ADC10_A linearity parameters                                                 | 2.2 V, 3 V      | 0.45 | 5   | 5.5 | MHz  |
| f <sub>ADC10OSC</sub> | Internal ADC10_A oscillator <sup>(1)</sup> | ADC10DIV = 0, f <sub>ADC10CLK</sub> = f <sub>ADC10OSC</sub>                                               | 2.2 V, 3 V      | 4.2  | 4.8 | 5.4 | MHz  |
| t <sub>CONVERT</sub>  | Conversion time                            | REFON = 0, Internal oscillator, 12 ADC10CLK cycles, 10-bit mode<br>f <sub>ADC10OSC</sub> = 4 MHz to 5 MHz | 2.2 V, 3 V      | 2.4  |     | 3.0 | μs   |
|                       |                                            | External f <sub>ADC10CLK</sub> from ACLK, MCLK or SMCLK, ADC10SSEL ≠ 0                                    |                 |      | (2) |     |      |
| t <sub>ADC10ON</sub>  | Turnon settling time of the ADC            | See (3)                                                                                                   |                 |      |     | 100 | ns   |
| t <sub>Sample</sub>   | Sampling time                              | R <sub>S</sub> = 1000 Ω, R <sub>I</sub> = 96 kΩ, C <sub>I</sub> = 3.5 pF <sup>(4)</sup>                   | 1.8 V           | 3    |     |     | μs   |
|                       |                                            | R <sub>S</sub> = 1000 Ω, R <sub>I</sub> = 36 kΩ, C <sub>I</sub> = 3.5 pF <sup>(4)</sup>                   | 3 V             | 1    |     |     |      |

(1) The ADC10OSC is sourced directly from MODOSC inside the UCS.

(2) 12 × ADC10DIV × 1/f<sub>ADC10CLK</sub>

(3) The condition is that the error in a conversion started after t<sub>ADC10ON</sub> is less than ±0.5 LSB. The reference and input signal are already settled.

(4) Approximately eight Tau (τ) are required for an error of less than ±0.5 LSB

## 5.40 10-Bit ADC, Linearity Parameters (MSP430F51x2 Devices Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER      |                                            | TEST CONDITIONS                                                                                               | MIN | TYP | MAX   | UNIT |
|----------------|--------------------------------------------|---------------------------------------------------------------------------------------------------------------|-----|-----|-------|------|
| E <sub>I</sub> | Integral linearity error                   | 1.4 V ≤ (VEREF+ – VREF-) ≤ 1.6 V, C <sub>VEREF+</sub> = 20 pF                                                 |     |     | ±1.0  | LSB  |
|                |                                            | 1.6 V < (VEREF+ – VREF-) ≤ V <sub>AVCC</sub> , C <sub>VEREF+</sub> = 20 pF                                    |     |     | ±1.0  |      |
| E <sub>D</sub> | Differential linearity error               | 1.4 V ≤ (VEREF+ – VREF-),<br>C <sub>VEREF+</sub> = 20 pF                                                      |     |     | ±1.0  | LSB  |
| E <sub>O</sub> | Offset error                               | 1.4 V ≤ (VEREF+ – VREF-), C <sub>VEREF+</sub> = 20 pF,<br>Internal impedance of source R <sub>S</sub> < 100 Ω |     |     | ±1.0  | LSB  |
| E <sub>G</sub> | Gain error, external reference             | 1.4 V ≤ (VEREF+ – VREF-), C <sub>VEREF+</sub> = 20 pF                                                         |     |     | ±1.0  | LSB  |
|                | Gain error, external reference, buffered   |                                                                                                               |     |     | ±5    |      |
|                | Gain error, internal reference             | See <sup>(1)</sup>                                                                                            |     |     | ±1.5% | VREF |
| E <sub>T</sub> | Total unadjusted error, internal reference | See <sup>(1)</sup>                                                                                            |     |     | ±1.5% | VREF |

(1) Dominated by the absolute voltage of the integrated reference voltage.

## 5.41 REF, External Reference (MSP430F51x2 Devices Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                                        |                                               | TEST CONDITIONS                                                                                                          | V <sub>CC</sub> | MIN | TYP  | MAX              | UNIT |
|--------------------------------------------------|-----------------------------------------------|--------------------------------------------------------------------------------------------------------------------------|-----------------|-----|------|------------------|------|
| VEREF+                                           | Positive external reference voltage input     | VEREF+ > VREF- <sup>(2)</sup>                                                                                            |                 | 1.4 |      | AV <sub>CC</sub> | V    |
| VEREF-                                           | Negative external reference voltage input     | VEREF+ > VREF- <sup>(3)</sup>                                                                                            |                 | 0   |      | 1.2              | V    |
| VEREF+ – VREF-                                   | Differential external reference voltage input | VEREF+ > VREF- <sup>(4)</sup>                                                                                            |                 | 1.4 |      | AV <sub>CC</sub> | V    |
| I <sub>(VEREF+)</sub> ,<br>I <sub>(VEREF-)</sub> | Static input current                          | 1.4 V ≤ VREF+ ≤ V(AVCC), VREF- = 0 V,<br>f <sub>ADC10CLK</sub> = 5 MHz, ADC10SHTX = 0x0001,<br>Conversion rate 200 ksp/s | 2.2 V, 3 V      |     | ±8.5 | ±26              | μA   |
|                                                  |                                               | 1.4 V ≤ VREF+ ≤ V(AVCC), VREF- = 0 V,<br>f <sub>ADC10CLK</sub> = 5 MHz, ADC10SHTX = 0x1000,<br>Conversion rate 20 ksp/s  | 2.2 V, 3 V      |     |      | ±1               |      |
| C <sub>(VEREF+/-)</sub>                          | Capacitance at VREF+ and VREF- terminals      | See <sup>(5)</sup>                                                                                                       |                 | 10  |      |                  | μF   |

(1) The external reference is used during ADC conversion to charge and discharge the capacitance array. The input capacitance, C<sub>I</sub>, is also the dynamic load for an external reference during conversion. The dynamic impedance of the reference supply should follow the recommendations on analog-source impedance to allow the charge to settle for 10-bit accuracy.

(2) The accuracy limits the minimum positive external reference voltage. Lower reference voltage levels may be applied with reduced accuracy requirements.

(3) The accuracy limits the maximum negative external reference voltage. Higher reference voltage levels may be applied with reduced accuracy requirements.

(4) The accuracy limits minimum external differential reference voltage. Lower differential reference voltage levels may be applied with reduced accuracy requirements.

(5) Two decoupling capacitors, 10 μF and 100 nF, should be connected to VREF to decouple the dynamic current required for an external reference source if it is used for the ADC10\_A. See also the [MSP430x5xx and MSP430x6xx Family User's Guide](#).

## 5.42 REF, Built-In Reference (MSP430F51x2 Devices Only)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER                                | TEST CONDITIONS                                                                                                                                                            | V <sub>CC</sub>                | MIN  | TYP   | MAX  | UNIT       |
|------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------|------|-------|------|------------|
| V <sub>REF+</sub>                        | REFVSEL = {2} for 2.5 V, REFON = 1                                                                                                                                         | 3 V                            | 2.51 | ±1.5% |      | V          |
|                                          | REFVSEL = {1} for 2.0 V, REFON = 1                                                                                                                                         | 3 V                            | 1.99 | ±1.5% |      |            |
|                                          | REFVSEL = {0} for 1.5 V, REFON = 1                                                                                                                                         | 2.2 V,<br>3 V                  | 1.5  | ±1.5% |      |            |
| AV <sub>CC(min)</sub>                    | REFVSEL = {0} for 1.5 V                                                                                                                                                    |                                | 1.8  |       |      | V          |
|                                          | REFVSEL = {1} for 2.0 V                                                                                                                                                    |                                | 2.3  |       |      |            |
|                                          | REFVSEL = {2} for 2.5 V                                                                                                                                                    |                                | 2.8  |       |      |            |
| I <sub>REF+</sub>                        | f <sub>ADC10CLK</sub> = 5 MHz, REFON = 1,<br>REFBURST = 0, REFVSEL = {0} for 1.5 V                                                                                         | 3 V                            | 15.5 |       | 19   | μA         |
|                                          | f <sub>ADC10CLK</sub> = 5 MHz, REFON = 1,<br>REFBURST = 0, REFVSEL = {1} for 2.0 V                                                                                         | 3 V                            | 18   |       | 24   |            |
|                                          | f <sub>ADC10CLK</sub> = 5 MHz, REFON = 1,<br>REFBURST = 0, REFVSEL = {2} for 2.5 V                                                                                         | 3 V                            | 21   |       | 30   |            |
| TC <sub>REF+</sub>                       | REFVSEL = {0, 1, 2}, REFON = 1                                                                                                                                             |                                | 30   |       | 50   | ppm/<br>°C |
| I <sub>SENSOR</sub>                      | REFON = 1, INCH = 0Ah,<br>ADC10ON = 1, T <sub>A</sub> = 30°C                                                                                                               | 2.2 V                          | 150  |       | 180  | μA         |
|                                          |                                                                                                                                                                            | 3 V                            | 150  |       | 190  |            |
| V <sub>SENSOR</sub>                      | REFON = 1, INCH = 0Ah,<br>ADC10ON = 1, T <sub>A</sub> = 30°C                                                                                                               | 2.2 V                          | 765  |       |      | mV         |
|                                          |                                                                                                                                                                            | 3 V                            | 765  |       |      |            |
| V <sub>MID</sub>                         | ADC10ON = 1, INCH = 0Bh,<br>V <sub>MID</sub> is approximately 0.5 × V <sub>AVCC</sub>                                                                                      | 2.2 V                          | 1.06 | 1.1   | 1.14 | V          |
|                                          |                                                                                                                                                                            | 3 V                            | 1.46 | 1.5   | 1.54 |            |
| t <sub>SENSOR</sub><br>(sample)          | ADC10ON = 1, INCH = 0Ah,<br>Error of conversion result ≤ 1 LSB                                                                                                             |                                | 30   |       |      | μs         |
| t <sub>V<sub>MID</sub></sub><br>(sample) | ADC10ON = 1, INCH = 0Bh,<br>Error of conversion result ≤ 1 LSB                                                                                                             |                                | 1    |       |      | μs         |
| PSRR <sub>DC</sub>                       | AV <sub>CC</sub> = AV <sub>CC(min)</sub> through AV <sub>CC(max)</sub> ,<br>T <sub>A</sub> = 25°C, REFVSEL = {0, 1, 2}, REFON = 1                                          |                                | 120  |       | 300  | μV/V       |
| PSRR <sub>AC</sub>                       | AV <sub>CC</sub> = AV <sub>CC(min)</sub> through AV <sub>CC(max)</sub> ,<br>T <sub>A</sub> = 25°C, f = 1 kHz, ΔV <sub>pp</sub> = 100 mV,<br>REFVSEL = {0, 1, 2}, REFON = 1 |                                | 6.4  |       |      | mV/V       |
| t <sub>SETTLE</sub>                      | AV <sub>CC</sub> = AV <sub>CC(min)</sub> through<br>AV <sub>CC(max)</sub> ,<br>REFVSEL = {0, 1, 2},<br>REFON = 0 → 1                                                       | T <sub>A</sub> = –40°C to 85°C |      | 23    | 125  | μs         |
|                                          |                                                                                                                                                                            | T <sub>A</sub> = 25°C          |      | 23    | 50   |            |
|                                          |                                                                                                                                                                            | T <sub>A</sub> = 85°C          |      | 16    | 25   |            |

- (1) The leakage current is defined in the leakage current table with P6.x/Ax parameter.
- (2) The internal reference current is supplied through terminal AV<sub>CC</sub>. Consumption is independent of the ADC10ON control bit, unless a conversion is active. The REFON bit enables to settle the built-in reference before starting an A/D conversion.
- (3) Calculated using the box method: (MAX(–40°C to 85°C) – MIN(–40°C to 85°C)) / MIN(–40°C to 85°C) / (85°C – (–40°C)).
- (4) The sensor current I<sub>SENSOR</sub> is consumed if (ADC10ON = 1 and REFON = 1) or (ADC10ON = 1 and INCH = 0Ah and sample signal is high). When REFON = 1, I<sub>SENSOR</sub> is already included in I<sub>REF+</sub>.
- (5) The temperature sensor offset can be as much as ±20°C. TI recommends a single-point calibration to minimize the offset error of the built-in temperature sensor.
- (6) The typical equivalent impedance of the sensor is 51 kΩ. The sample time required includes the sensor-on time t<sub>SENSOR(on)</sub>.
- (7) The on-time t<sub>V<sub>MID</sub>(on)</sub> is included in the sampling time t<sub>V<sub>MID</sub>(sample)</sub>; no additional on time is needed.
- (8) The condition is that the error in a conversion started after t<sub>REFON</sub> is less than ±0.5 LSB.

### 5.43 Comparator\_B

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER              |                                                                                   | TEST CONDITIONS                                                                     | V <sub>CC</sub> | MIN                              | TYP                            | MAX                              | UNIT   |
|------------------------|-----------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|-----------------|----------------------------------|--------------------------------|----------------------------------|--------|
| V <sub>CC</sub>        | Supply voltage                                                                    |                                                                                     |                 | 1.8                              |                                | 3.6                              | V      |
| I <sub>AVCC_COMP</sub> | Comparator operating supply current into AVCC, Excludes reference resistor ladder | CBPWRMD = 00, CBON = 1, CBR <sub>Sx</sub> = 00                                      | 1.8 V           |                                  |                                | 38                               | μA     |
|                        |                                                                                   |                                                                                     | 2.2 V           |                                  | 31                             | 38                               |        |
|                        |                                                                                   |                                                                                     | 3 V             |                                  | 32                             | 39                               |        |
|                        |                                                                                   | CBPWRMD = 01, CBON = 1, CBR <sub>Sx</sub> = 00                                      | 2.2 V, 3 V      |                                  | 10                             | 17                               |        |
|                        |                                                                                   | CBPWRMD = 10, CBON = 1, CBR <sub>Sx</sub> = 00                                      | 2.2 V, 3 V      |                                  | 0.2                            | 0.85                             |        |
| V <sub>REF</sub>       | Reference voltage level                                                           | CBREFL <sub>x</sub> = 01, CBREFACC = 0                                              | ≥1.8 V          | 1.42                             | 1.44                           | 1.46                             | V      |
|                        |                                                                                   | CBREFL <sub>x</sub> = 10, CBREFACC = 0                                              | ≥2.2 V          | 1.89                             | 1.92                           | 1.95                             |        |
|                        |                                                                                   | CBREFL <sub>x</sub> = 11, CBREFACC = 0                                              | ≥3.0 V          | 2.35                             | 2.39                           | 2.43                             |        |
| I <sub>AVCC_REF</sub>  | Quiescent current of resistor ladder into AVCC, Including REF module current      | CBREFACC = 1, CBREFL <sub>x</sub> = 01, CBR <sub>Sx</sub> = 10, REFON = 0, CBON = 0 | 2.2 V, 3 V      |                                  | 10                             | 17                               | μA     |
|                        |                                                                                   | CBREFACC = 0, CBREFL <sub>x</sub> = 01, CBR <sub>Sx</sub> = 10, REFON = 0, CBON = 0 | 2.2 V, 3 V      |                                  | 33                             | 40                               |        |
| V <sub>IC</sub>        | Common mode input range                                                           |                                                                                     |                 | 0                                |                                | V <sub>CC</sub> – 1              | V      |
| V <sub>OFFSET</sub>    | Input offset voltage                                                              | CBPWRMD = 00                                                                        |                 |                                  |                                | ±20                              | mV     |
|                        |                                                                                   | CBPWRMD = 01, 10                                                                    |                 |                                  |                                | ±10                              |        |
| C <sub>IN</sub>        | Input capacitance                                                                 |                                                                                     |                 |                                  | 5                              |                                  | pF     |
| R <sub>SIN</sub>       | Series input resistance                                                           | ON (switch closed)                                                                  |                 |                                  | 3                              | 4                                | kΩ     |
|                        |                                                                                   | OFF (switch opened)                                                                 |                 | 50                               |                                |                                  | MΩ     |
| t <sub>PD</sub>        | Propagation delay, response time                                                  | CBPWRMD = 00, CBF = 0                                                               |                 |                                  |                                | 450                              | ns     |
|                        |                                                                                   | CBPWRMD = 01, CBF = 0                                                               |                 |                                  |                                | 600                              |        |
|                        |                                                                                   | CBPWRMD = 10, CBF = 0                                                               |                 |                                  |                                | 50                               | μs     |
| t <sub>PD,filter</sub> | Propagation delay with filter active                                              | CBPWRMD = 00, CBON = 1, CBF = 1, CBF <sub>DLY</sub> = 00                            |                 | 0.35                             | 0.6                            | 1.5                              | μs     |
|                        |                                                                                   | CBPWRMD = 00, CBON = 1, CBF = 1, CBF <sub>DLY</sub> = 01                            |                 | 0.6                              | 1.0                            | 1.8                              |        |
|                        |                                                                                   | CBPWRMD = 00, CBON = 1, CBF = 1, CBF <sub>DLY</sub> = 10                            |                 | 1.0                              | 1.8                            | 3.4                              |        |
|                        |                                                                                   | CBPWRMD = 00, CBON = 1, CBF = 1, CBF <sub>DLY</sub> = 11                            |                 | 1.8                              | 3.4                            | 6.5                              |        |
| t <sub>EN_CMP</sub>    | Comparator enable time                                                            | CBON = 0 to CBON = 1, CBPWRMD = 00 or 01                                            |                 |                                  | 1                              | 2                                | μs     |
|                        |                                                                                   | CBON = 0 to CBON = 1, CBPWRMD = 10                                                  |                 |                                  |                                | 1.5                              |        |
| t <sub>EN_REF</sub>    | Resistor reference enable time                                                    | CBON = 0 to CBON = 1                                                                |                 |                                  | 1.0                            | 1.5                              | μs     |
| TC <sub>CB_REF</sub>   | Temperature coefficient reference of V <sub>CB_REF</sub>                          |                                                                                     |                 |                                  |                                | 50                               | ppm/°C |
| V <sub>CB_REF</sub>    | Reference voltage for a given tap                                                 | V <sub>IN</sub> = reference into resistor ladder, n = 0 to 31                       |                 | V <sub>IN</sub> × (n + 0.5) / 32 | V <sub>IN</sub> × (n + 1) / 32 | V <sub>IN</sub> × (n + 1.5) / 32 | V      |

## 5.44 Timer\_D, Power Supply and Reference Clock Conditions

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

| PARAMETER              |                                                                    | TEST CONDITIONS                                                                 | V <sub>CC</sub>                       | MIN | TYP | MAX  | UNIT |
|------------------------|--------------------------------------------------------------------|---------------------------------------------------------------------------------|---------------------------------------|-----|-----|------|------|
| DV <sub>CC</sub>       | Digital supply voltage                                             | V <sub>(DVSS)</sub> = 0 V                                                       |                                       | 1.8 |     | 3.6  | V    |
| f <sub>REF,DCO</sub>   | Timer_D input reference clock frequency                            | PMMCOREVx = 0                                                                   | 1.8 V<br>≤ V <sub>CC</sub><br>≤ 3.6 V | 8   |     | 12.0 | MHz  |
|                        |                                                                    | PMMCOREVx = 1                                                                   | 2.0 V<br>≤ V <sub>CC</sub><br>≤ 3.6 V | 8   |     | 16.0 |      |
|                        |                                                                    | PMMCOREVx = 2                                                                   | 2.2 V<br>≤ V <sub>CC</sub><br>≤ 3.6 V | 8   |     | 20.0 |      |
|                        |                                                                    | PMMCOREVx = 3                                                                   | 2.4 V<br>≤ V <sub>CC</sub><br>≤ 3.6 V | 8   |     | 25.5 |      |
| I <sub>(64MHz)</sub>   | I <sub>(DVCC)</sub> at 64-MHz Timer_D clock, clock generator only  | f <sub>reference</sub> = 8 MHz, MCx = 0, TDHREGEN = 1, TDHMx = 0, TDHCLKCR = 0  |                                       |     | 253 | 320  | μA   |
| I <sub>(128MHz)</sub>  | I <sub>(DVCC)</sub> at 128-MHz Timer_D clock, clock generator only | f <sub>reference</sub> = 16 MHz, MCx = 0, TDHREGEN = 1, TDHMx = 0, TDHCLKCR = 0 |                                       |     | 285 | 360  | μA   |
| I <sub>(200MHz)</sub>  | I <sub>(DVCC)</sub> at 200-MHz Timer_D clock, clock generator only | f <sub>reference</sub> = 25 MHz, MCx = 0, TDHREGEN = 1, TDHMx = 0, TDHCLKCR = 1 |                                       |     | 280 | 345  | μA   |
| I <sub>(256MHz)</sub>  | I <sub>(DVCC)</sub> at 256-MHz Timer_D clock, clock generator only | f <sub>reference</sub> = 16 MHz, MCx = 0, TDHREGEN = 1, TDHMx = 1, TDHCLKCR = 1 |                                       |     | 265 | 330  | μA   |
| I <sub>(0,16,64)</sub> | I <sub>(DVCC)</sub>                                                | TDHCLKRx = 0, TDHCLKSRx = 16, TDHCLKTRIM = 64                                   | 2.2 V                                 |     | 244 |      | μA   |
|                        |                                                                    |                                                                                 | 3.0 V                                 |     | 295 | 325  |      |
| I <sub>(1,16,64)</sub> | I <sub>(DVCC)</sub>                                                | TDHCLKRx = 1, TDHCLKSRx = 16, TDHCLKTRIM = 64                                   | 2.2 V                                 |     | 282 |      | μA   |
|                        |                                                                    |                                                                                 | 3.0 V                                 |     | 300 | 400  |      |
| I <sub>(2,16,64)</sub> | I <sub>(DVCC)</sub>                                                | TDHCLKRx = 2, TDHCLKSRx = 16, TDHCLKTRIM = 64                                   | 2.2 V                                 |     | 358 |      | μA   |
|                        |                                                                    |                                                                                 | 3.0 V                                 |     | 414 | 470  |      |

(1) The leakage current is defined in the leakage current table with P6.x/Ax parameter.

## 5.45 Timer\_D, Local Clock Generator Frequency

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                               | TEST CONDITIONS                                                                       | MIN | TYP | MAX | UNIT |
|---------------------------------------------------------|---------------------------------------------------------------------------------------|-----|-----|-----|------|
| $f_{\text{HRCG}(0,0,64)}$ HRCG frequency (0, 0, 64)     | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 0, TDHCLKTRIM = 64   | 39  | 56  | 73  | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 0, TDHCLKTRIM = 64   | 78  | 112 | 146 |      |
| $f_{\text{HRCG}(0,7,64)}$ HRCG frequency (0, 7, 64)     | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 7, TDHCLKTRIM = 64   | 46  | 66  | 86  | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 7, TDHCLKTRIM = 64   | 92  | 132 | 172 |      |
| $f_{\text{HRCG}(0,15,64)}$ HRCG frequency (0, 15, 64)   | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 15, TDHCLKTRIM = 64  | 55  | 78  | 101 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 15, TDHCLKTRIM = 64  | 110 | 156 | 202 |      |
| $f_{\text{HRCG}(0,23,64)}$ HRCG frequency (0, 23, 64)   | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 23, TDHCLKTRIM = 64  | 61  | 87  | 113 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 23, TDHCLKTRIM = 64  | 122 | 174 | 226 |      |
| $f_{\text{HRCG}(0,31,0)}$ HRCG frequency (0, 31, 0)     | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 31, TDHCLKTRIM = 0   | 36  | 56  | 73  | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 31, TDHCLKTRIM = 0   | 72  | 112 | 146 |      |
| $f_{\text{HRCG}(0,31,64)}$ HRCG frequency (0, 31, 64)   | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 31, TDHCLKTRIM = 64  | 68  | 98  | 128 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 31, TDHCLKTRIM = 64  | 136 | 196 | 256 |      |
| $f_{\text{HRCG}(0,31,128)}$ HRCG frequency (0, 31, 128) | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 31, TDHCLKTRIM = 128 | 97  | 138 | 180 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1, TDHCLKRx = 0, TDHCLKSRx = 31, TDHCLKTRIM = 128 | 196 | 176 | 360 |      |
| $f_{\text{HRCG}(1,0,64)}$ HRCG frequency (1, 0, 64)     | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 0, TDHCLKTRIM = 64   | 71  | 101 | 131 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 0, TDHCLKTRIM = 64   | 142 | 202 | 262 |      |
| $f_{\text{HRCG}(1,7,64)}$ HRCG frequency (1, 7, 64)     | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 7, TDHCLKTRIM = 64   | 84  | 120 | 156 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 7, TDHCLKTRIM = 64   | 168 | 240 | 312 |      |
| $f_{\text{HRCG}(1,15,64)}$ HRCG frequency (1, 15, 64)   | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 15, TDHCLKTRIM = 64  | 97  | 139 | 182 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 15, TDHCLKTRIM = 64  | 196 | 278 | 364 |      |
| $f_{\text{HRCG}(1,23,64)}$ HRCG frequency (1, 23, 64)   | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 23, TDHCLKTRIM = 64  | 108 | 154 | 200 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 23, TDHCLKTRIM = 64  | 216 | 308 | 400 |      |
| $f_{\text{HRCG}(1,31,0)}$ HRCG frequency (1, 31, 0)     | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 31, TDHCLKTRIM = 0   | 68  | 97  | 126 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 31, TDHCLKTRIM = 0   | 136 | 194 | 252 |      |
| $f_{\text{HRCG}(1,31,64)}$ HRCG frequency (1, 31, 64)   | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 31, TDHCLKTRIM = 64  | 123 | 175 | 227 | MHz  |
|                                                         | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0, TDHCLKRx = 1, TDHCLKSRx = 31, TDHCLKTRIM = 64  | 246 | 350 | 454 |      |

## Timer\_D, Local Clock Generator Frequency (continued)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER            |                                                     | TEST CONDITIONS                                                                             | MIN | TYP | MAX  | UNIT |
|----------------------|-----------------------------------------------------|---------------------------------------------------------------------------------------------|-----|-----|------|------|
| $f_{HRCG(1,31,128)}$ | HRCG frequency (1, 31, 128)                         | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 0,<br>TDHCLKRx = 1, TDHCLKSRx = 31,<br>TDHCLKTRIM = 128 | 169 | 241 | 313  | MHz  |
|                      |                                                     | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 0,<br>TDHCLKRx = 1, TDHCLKSRx = 31,<br>TDHCLKTRIM = 128 | 338 | 482 | 616  |      |
| $f_{HRCG(2,0,64)}$   | HRCG frequency (2, 0, 64)                           | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 0, TDHCLKTRIM = 64      | 126 | 180 | 234  | MHz  |
|                      |                                                     | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 1, TDHCLKSRx = 0, TDHCLKTRIM = 64      | 252 | 360 | 468  |      |
| $f_{HRCG(2,7,64)}$   | HRCG frequency (2, 7, 64)                           | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 7, TDHCLKTRIM = 64      | 138 | 208 | 270  | MHz  |
|                      |                                                     | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 7, TDHCLKTRIM = 6       | 276 | 416 | 540  |      |
| $f_{HRCG(2,15,64)}$  | HRCG frequency (2, 15, 64)                          | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 15, TDHCLKTRIM = 64     | 168 | 240 | 312  | MHz  |
|                      |                                                     | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 15, TDHCLKTRIM = 64     | 336 | 480 | 624  |      |
| $f_{HRCG(2,23,64)}$  | HRCG frequency (2, 23, 64)                          | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 23, TDHCLKTRIM = 64     | 189 | 270 | 351  | MHz  |
|                      |                                                     | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 23, TDHCLKTRIM = 64     | 378 | 540 | 702  |      |
| $f_{HRCG(2,31,0)}$   | HRCG frequency (2, 31, 0)                           | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 31, TDHCLKTRIM = 0      | 119 | 170 | 221  | MHz  |
|                      |                                                     | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 31, TDHCLKTRIM = 0      | 238 | 340 | 442  |      |
| $f_{HRCG(2,31,64)}$  | HRCG frequency (2, 31, 64)                          | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 31, TDHCLKTRIM = 64     | 212 | 303 | 394  | MHz  |
|                      |                                                     | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 31, TDHCLKTRIM = 64     | 424 | 606 | 788  |      |
| $f_{HRCG(2,31,128)}$ | HRCG frequency (2, 31, 128)                         | TDHREGEN = 0, TDHMx = 0, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 31,<br>TDHCLKTRIM = 128 | 290 | 413 | 537  | MHz  |
|                      |                                                     | TDHREGEN = 0, TDHMx = 1, TDHCLKCR = 1,<br>TDHCLKRx = 2, TDHCLKSRx = 31,<br>TDHCLKTRIM = 128 | 580 | 826 | 1074 |      |
| $S_{HRCG,0,SR}$      | TDHCLKSRx step size in range 0                      | $S_{HRCGSR} = f_{HRCGSR(HRCGSR+1)} - f_{HRCG(HRCGSR)}$                                      | 120 | 185 | 225  | kHz  |
| $S_{HRCG,1,SR}$      | TDHCLKSRx step size in range 1                      | $S_{HRCGSR} = f_{HRCGSR(HRCGSR+1)} - f_{HRCG(HRCGSR)}$                                      | 220 | 325 | 395  | kHz  |
| $S_{HRCG,2,SR}$      | TDHCLKSRx step size in range 2                      | $S_{HRCGSR} = f_{HRCGSR(HRCGSR+1)} - f_{HRCG(HRCGSR)}$                                      | 400 | 555 | 700  | kHz  |
| $S_{HRCG,0,TRIM}$    | $0 \geq TDHCLKTRIMx < 16$ ,<br>step size in range 0 | $S_{HRCGSR} = f_{HRCGSR(HRCGTRIM+1)} - f_{HRCG(HRCGTRIM)}$ ,<br>TDHCLKSRx = X, Y, Z         | 55  | 85  | 120  | kHz  |
|                      | $15 < TDHCLKTRIMx < 49$ ,<br>step size in range 1   |                                                                                             | 40  | 85  | 130  |      |
|                      | $48 < TDHCLKTRIMx < 64$ ,<br>step size in range 2   |                                                                                             | 40  | 85  | 120  |      |
| $S_{HRCG,1,TRIM}$    | $0 \geq TDHCLKTRIMx < 16$ ,<br>step size in range 0 | $S_{HRCGSR} = f_{HRCGSR(HRCGTRIM+1)} - f_{HRCG(HRCGTRIM)}$ ,<br>TDHCLKSRx = X, Y, Z         | 90  | 160 | 230  | kHz  |
|                      | $15 < TDHCLKTRIMx < 49$ ,<br>step size in range 1   |                                                                                             | 80  | 160 | 230  |      |
|                      | $48 < TDHCLKTRIMx < 64$ ,<br>step size in range 2   |                                                                                             | 80  | 160 | 230  |      |

## Timer\_D, Local Clock Generator Frequency (continued)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                                  |                                                | TEST CONDITIONS                                                                                               | MIN | TYP | MAX   | UNIT |
|--------------------------------------------|------------------------------------------------|---------------------------------------------------------------------------------------------------------------|-----|-----|-------|------|
| S <sub>HRCG,2,TRIM</sub>                   | 0 >= TDHCLKTRIMx < 16,<br>step size in range 0 | S <sub>HRCGSR</sub> = f <sub>HRCGSR</sub> (HRCGTRIM+1) – f <sub>HRCG</sub> (HRCGTRIM),<br>TDHCLKSRx = X, Y, Z | 150 | 230 | 360   | kHz  |
|                                            | 15 < TDHCLKTRIMx < 49,<br>step size in range 1 |                                                                                                               | 130 | 230 | 350   |      |
|                                            | 48 < TDHCLKTRIMx < 32,<br>step size in range 2 |                                                                                                               | 100 | 230 | 340   |      |
| df <sub>HRCG</sub> /dT                     | HRCG frequency<br>temperature drift            | f <sub>HRCG</sub> = 8 MHz, TDHREGEN = 0                                                                       |     |     | ±0.17 | %/°C |
|                                            |                                                | f <sub>HRCG</sub> = 16 MHz, TDHREGEN = 0                                                                      |     |     | ±0.16 |      |
|                                            |                                                | f <sub>HRCG</sub> = 25 MHz, TDHREGEN = 0                                                                      |     |     | ±0.16 |      |
|                                            |                                                | f <sub>HRCG</sub> = 8, 16, or 25 MHz, TDHREGEN = 1                                                            |     | 0   |       |      |
| df <sub>HRCG</sub> /<br>dV <sub>DVCC</sub> | HRCG frequency voltage drift                   | f <sub>HRCG</sub> = 8, 16, or 25 MHz, TDHREGEN = 0                                                            | 0   |     | 5     | %/V  |
|                                            |                                                | f <sub>HRCG</sub> = 8, 16, or 25 MHz, TDHREGEN = 1                                                            |     | 0   |       |      |
| t <sub>SETTLE</sub>                        | Settling time                                  | TDHEN = 0 -> 1, TDHFW = 0                                                                                     | 3   | 5   | 9     | μs   |
|                                            | Settling time, fast wake-up                    | TDHEN = 0 -> 1, TDHFW = 1                                                                                     |     |     | 1.5   |      |

## 5.46 Timer\_D, Trimmed Clock Frequencies

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                           |                                                                   | TEST CONDITIONS                                   | MIN   | TYP | MAX   | UNIT |
|-------------------------------------|-------------------------------------------------------------------|---------------------------------------------------|-------|-----|-------|------|
| Frequency tolerance during trimming |                                                                   |                                                   | -0.5% |     | +0.5% |      |
| f <sub>TRIM(64MHz)</sub>            | TDHMx = 0, TDHREGEN = 0, TDHCLKCR = 0,<br>TDHxCTL1 = TDHxCTL1_64  | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 1.8 V | 63    | 64  | 65    | MHz  |
| f <sub>TRIM(128MHz)</sub>           | TDHMx = 0, TDHREGEN = 0, TDHCLKCR = 1,<br>TDHxCTL1 = TDHxCTL1_128 | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 2.0 V | 126   | 128 | 130   | MHz  |
| f <sub>TRIM(200MHz)</sub>           | TDHMx = 0, TDHREGEN = 0, TDHCLKCR = 1,<br>TDHxCTL1 = TDHxCTL1_200 | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 2.4 V | 197   | 200 | 203   | MHz  |
| f <sub>TRIM(256MHz)</sub>           | TDHMx = 1, TDHREGEN = 0, TDHCLKCR = 1,<br>TDHxCTL1 = TDHxCTL1_256 | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 2.2 V | 250   | 256 | 262   | MHz  |

## 5.47 Timer\_D, Frequency Multiplication Mode

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                       |                                                                                         | TEST CONDITIONS                                   | MIN | TYP | MAX | UNIT |
|---------------------------------|-----------------------------------------------------------------------------------------|---------------------------------------------------|-----|-----|-----|------|
| External frequency tolerance    |                                                                                         |                                                   |     | 0%  |     |      |
| E <sub>(TDHREGEN = 1,64)</sub>  | f <sub>reference</sub> = 8 MHz, TDHMx = 0, TDHREGEN = 1,<br>TDHCLKCR = 0, TDHCLKRx = 0  | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 1.8 V | -1% |     | +1% |      |
| E <sub>(TDHREGEN = 1,128)</sub> | f <sub>reference</sub> = 16 MHz, TDHMx = 0, TDHREGEN = 1,<br>TDHCLKCR = 1, TDHCLKRx = 0 | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 2.0 V | -1% |     | +1% |      |
| E <sub>(TDHREGEN = 1,200)</sub> | f <sub>reference</sub> = 25 MHz, TDHMx = 0, TDHREGEN = 1,<br>TDHCLKCR = 1, TDHCLKRx = 0 | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 2.4 V | -1% |     | +1% |      |
| E <sub>(TDHREGEN = 1,256)</sub> | f <sub>reference</sub> = 16 MHz, TDHMx = 1, TDHREGEN = 1,<br>TDHCLKCR = 1, TDHCLKRx = 0 | T <sub>A</sub> = 25°C,<br>V <sub>CC</sub> = 2.2 V | -1% |     | +1% |      |

## 5.48 Timer\_D, Input Capture and Output Compare Timing

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                |                                                                                                                                                | TEST CONDITIONS                                          | MIN | TYP | MAX | UNIT |
|--------------------------|------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------|-----|-----|-----|------|
| $t_{TD,cap}$             | Timer_D input capture timing, minimum pulse duration to trigger input capture event                                                            | $f_{MAX} = 262 \text{ MHz}$                              |     | 4   |     | ns   |
| $t_{TD0,cap,matching}$   | Timer0_D input capture timing, matching between input capture channels P1.6 to P1.7 and P2.0                                                   | $f_{MAX} = 262 \text{ MHz}$                              |     | 1   | 2   | LSB  |
|                          | Timer0_D input capture timing, matching between input capture channels. P2.4 to P2.5 and P2.6                                                  | $f_{MAX} = 262 \text{ MHz}$                              |     | 3   | 4   |      |
| $t_{TD1,cap,matching}$   | Timer1_D input capture timing, matching between input capture channels P2.1 to P2.2 and P2.3                                                   | $f_{MAX} = 262 \text{ MHz}$                              |     | 2   | 3   | LSB  |
|                          | Timer1_D input capture timing, matching between input capture channels. P2.7 to P3.0 and P3.1                                                  | $f_{MAX} = 262 \text{ MHz}$                              |     | 2   | 4   |      |
| $t_{TD01,cap,matching}$  | Timer0_D and Timer1_D input capture timing, matching between input capture channels. Timer0_D is the high-resolution clock generator source.   | $f_{MAX} = 262 \text{ MHz}$                              |     | 4   | 8   | LSB  |
| $t_{TD0,comp,matching}$  | Timer0_D output compare timing, matching between output capture compare channels for pins P1.6, P1.7, and P2.0                                 | Rising edges,<br>$f_{MAX} = 262 \text{ MHz}$             |     |     | 4   | ns   |
|                          |                                                                                                                                                | Falling edges,<br>$f_{MAX} = 262 \text{ MHz}$            |     |     | 4   |      |
|                          |                                                                                                                                                | Rising and falling edges,<br>$f_{MAX} = 262 \text{ MHz}$ |     |     | 8   |      |
| $t_{TD1,comp,matching}$  | Timer1_D output compare timing, matching between output capture compare channels for pins P2.1, P2.2, and P2.3                                 | Rising edges,<br>$f_{MAX} = 262 \text{ MHz}$             |     |     | 4   | ns   |
|                          |                                                                                                                                                | Falling edges,<br>$f_{MAX} = 262 \text{ MHz}$            |     |     | 4   |      |
|                          |                                                                                                                                                | Rising and falling edges,<br>$f_{MAX} = 262 \text{ MHz}$ |     |     | 8   |      |
| $t_{TD01,comp,matching}$ | Timer0_D and Timer1_D output compare timing, matching between output compare channels. Timer0_D is the high-resolution clock generator source. | All edges,<br>$f_{MAX} = 262 \text{ MHz}$                |     |     | 8   | LSB  |

## 5.49 Flash Memory

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                               |                                                                                   | TEST CONDITIONS       | MIN             | TYP             | MAX | UNIT   |
|-----------------------------------------|-----------------------------------------------------------------------------------|-----------------------|-----------------|-----------------|-----|--------|
| DV <sub>CC(PGM/ERASE)</sub>             | Program and erase supply voltage                                                  |                       | 1.8             |                 | 3.6 | V      |
| I <sub>PGM</sub>                        | Supply current from DVCC during program                                           |                       |                 | 3               | 5   | mA     |
| I <sub>ERASE</sub>                      | Supply current from DVCC during erase                                             |                       |                 | 2               | 6.5 | mA     |
| I <sub>MERASE</sub> , I <sub>BANK</sub> | Supply current from DVCC during mass erase or bank erase                          |                       |                 | 2               | 6.5 | mA     |
| t <sub>CPT</sub>                        | Cumulative program time                                                           | See <sup>(1)</sup>    |                 |                 | 16  | ms     |
|                                         | Program and erase endurance                                                       |                       | 10 <sup>4</sup> | 10 <sup>5</sup> |     | cycles |
| t <sub>Retention</sub>                  | Data retention duration                                                           | T <sub>J</sub> = 25°C | 100             |                 |     | years  |
| t <sub>Word</sub>                       | Word or byte program time                                                         | See <sup>(2)</sup>    | 64              |                 | 85  | μs     |
| t <sub>Block, 0</sub>                   | Block program time for first byte or word                                         | See <sup>(2)</sup>    | 49              |                 | 65  | μs     |
| t <sub>Block, 1–(N–1)</sub>             | Block program time for each additional byte or word, except for last byte or word | See <sup>(2)</sup>    | 37              |                 | 49  | μs     |
| t <sub>Block, N</sub>                   | Block program time for last byte or word                                          | See <sup>(2)</sup>    | 55              |                 | 73  | μs     |
| t <sub>Mass Erase</sub>                 | Mass erase time                                                                   | See <sup>(2)</sup>    | 23              |                 | 32  | ms     |
| t <sub>Seg Erase</sub>                  | Segment erase time                                                                | See <sup>(2)</sup>    | 23              |                 | 32  | ms     |
| f <sub>MCLK,MGR</sub>                   | MCLK frequency in marginal read mode (FCLK4.MGR0 = 1 or FCTL4.MGR1 = 1)           |                       | 0               |                 | 1   | MHz    |

- (1) The cumulative program time must not be exceeded when writing to a 128-byte flash block. This parameter applies to all programming methods: individual word or byte write and block write modes.
- (2) These values are hardwired into the flash controller state machine.

## 5.50 JTAG and Spy-Bi-Wire Interface

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER             |                                                                                      | V <sub>CC</sub> | MIN   | TYP | MAX | UNIT |
|-----------------------|--------------------------------------------------------------------------------------|-----------------|-------|-----|-----|------|
| f <sub>SBW</sub>      | Spy-Bi-Wire input frequency                                                          | 2.2 V, 3 V      | 0     |     | 20  | MHz  |
| t <sub>SBW,Low</sub>  | Spy-Bi-Wire low clock pulse duration                                                 | 2.2 V, 3 V      | 0.025 |     | 15  | μs   |
| t <sub>SBW,En</sub>   | Spy-Bi-Wire enable time (TEST high to acceptance of first clock edge) <sup>(1)</sup> | 2.2 V, 3 V      |       |     | 1   | μs   |
| t <sub>SBW,Rst</sub>  | Spy-Bi-Wire return to normal operation time                                          |                 | 15    |     | 100 | μs   |
| f <sub>TCK</sub>      | TCK input frequency, 4-wire JTAG <sup>(2)</sup>                                      | 2.2 V           | 0     |     | 5   | MHz  |
|                       |                                                                                      | 3 V             | 0     |     | 10  |      |
| R <sub>internal</sub> | Internal pulldown resistance on TEST                                                 | 2.2 V, 3 V      | 45    | 60  | 80  | kΩ   |

- (1) Tools that access the Spy-Bi-Wire interface must wait for the minimum t<sub>SBW,En</sub> time after pulling the TEST/SBWTCK pin high before applying the first SBWTCK clock edge.
- (2) f<sub>TCK</sub> may be restricted to meet the timing requirements of the module selected.

## 6 Detailed Description

### 6.1 CPU

The MSP430 CPU has a 16-bit RISC architecture that is highly transparent to the application. All operations, other than program-flow instructions, are performed as register operations in conjunction with seven addressing modes for source operand and four addressing modes for destination operand.

The CPU is integrated with 16 registers that provide reduced instruction execution time (see [Figure 6-1](#)). The register-to-register operation execution time is one cycle of the CPU clock.

Four of the registers, R0 to R3, are dedicated as program counter, stack pointer, status register, and constant generator, respectively. The remaining registers are general-purpose registers.

Peripherals are connected to the CPU using data, address, and control buses and can be handled with all instructions.

|                          |           |
|--------------------------|-----------|
| Program Counter          | PC/R0     |
| Stack Pointer            | SP/R1     |
| Status Register          | SR/CG1/R2 |
| Constant Generator       | CG2/R3    |
| General-Purpose Register | R4        |
| General-Purpose Register | R5        |
| General-Purpose Register | R6        |
| General-Purpose Register | R7        |
| General-Purpose Register | R8        |
| General-Purpose Register | R9        |
| General-Purpose Register | R10       |
| General-Purpose Register | R11       |
| General-Purpose Register | R12       |
| General-Purpose Register | R13       |
| General-Purpose Register | R14       |
| General-Purpose Register | R15       |

**Figure 6-1. Integrated CPU Registers**

## 6.2 Instruction Set

The instruction set consists of the original 51 instructions with three formats and seven address modes and additional instructions for the expanded address range. Each instruction can operate on word and byte data. [Table 6-1](#) lists examples of the three types of instruction formats; [Table 6-2](#) lists the address modes.

**Table 6-1. Instruction Word Formats**

| FORMAT                            | EXAMPLE   | OPERATION                                 |
|-----------------------------------|-----------|-------------------------------------------|
| Dual operands, source-destination | ADD R4,R5 | $R4 + R5 \rightarrow R5$                  |
| Single operands, destination only | CALL R8   | $PC \rightarrow (TOS), R8 \rightarrow PC$ |
| Relative jump, un/conditional     | JNE       | Jump-on-equal bit = 0                     |

**Table 6-2. Address Mode Descriptions**

| ADDRESS MODE           | S <sup>(1)</sup> | D <sup>(1)</sup> | SYNTAX             | EXAMPLE          | OPERATION                                             |
|------------------------|------------------|------------------|--------------------|------------------|-------------------------------------------------------|
| Register               | +                | +                | MOV Rs,Rd          | MOV R10,R11      | $R10 \rightarrow R11$                                 |
| Indexed                | +                | +                | MOV X(Rn),Y(Rm)    | MOV 2(R5),6(R6)  | $M(2+R5) \rightarrow M(6+R6)$                         |
| Symbolic (PC relative) | +                | +                | MOV EDE,TONI       |                  | $M(EDE) \rightarrow M(TONI)$                          |
| Absolute               | +                | +                | MOV & MEM, & TCDAT |                  | $M(MEM) \rightarrow M(TCDAT)$                         |
| Indirect               | +                |                  | MOV @Rn,Y(Rm)      | MOV @R10,Tab(R6) | $M(R10) \rightarrow M(Tab+R6)$                        |
| Indirect autoincrement | +                |                  | MOV @Rn+,Rm        | MOV @R10+,R11    | $M(R10) \rightarrow R11$<br>$R10 + 2 \rightarrow R10$ |
| Immediate              | +                |                  | MOV #X,TONI        | MOV #45,TONI     | $\#45 \rightarrow M(TONI)$                            |

(1) S = source, D = destination

## 6.3 Operating Modes

The MSP430 has one active mode and six software-selectable low-power modes of operation. An interrupt event can wake up the device from any of the five low-power modes, service the request, and restore back to the low-power mode on return from the interrupt program.

Software can configure the following operating modes:

- Active mode (AM)
  - All clocks are active
- Low-power mode 0 (LPM0)
  - CPU is disabled
  - ACLK and SMCLK remain active
  - MCLK is disabled
  - FLL loop control remains active
- Low-power mode 1 (LPM1)
  - CPU is disabled
  - FLL loop control is disabled
  - ACLK and SMCLK remain active
  - MCLK is disabled
- Low-power mode 2 (LPM2)
  - CPU is disabled
  - MCLK, FLL loop control, and DCOCLK are disabled
  - DC generator of the DCO remains enabled
  - ACLK remains active
- Low-power mode 3 (LPM3)
  - CPU is disabled
  - MCLK, FLL loop control, and DCOCLK are disabled
  - DC generator of the DCO is disabled
  - ACLK remains active
- Low-power mode 4 (LPM4)
  - CPU is disabled
  - ACLK is disabled
  - MCLK, FLL loop control, and DCOCLK are disabled
  - DC generator of the DCO is disabled
  - Crystal oscillator is stopped
  - Complete data retention
- Low-power mode 5 (LPM4.5)
  - Internal regulator disabled
  - No data retention
  - Wake-up input from  $\overline{\text{RST/NMI}}$ , P1, and P2

## 6.4 Interrupt Vector Addresses

The interrupt vectors and the power-up start address are in the address range 0FFFFh to 0FF80h (see [Table 6-3](#)). The vector contains the 16-bit address of the appropriate interrupt-handler instruction sequence.

**Table 6-3. Interrupt Sources, Flags, and Vectors**

| INTERRUPT SOURCE                                                                                                    | INTERRUPT FLAG                                                                                                            | SYSTEM INTERRUPT | WORD ADDRESS | PRIORITY    |
|---------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------|------------------|--------------|-------------|
| <b>System Reset</b><br>Power-Up<br>External Reset<br>Watchdog Time-out, Key Violation<br>Flash Memory Key Violation | WDTIFG, KEYV (SYSRSTIV) <sup>(1) (2)</sup>                                                                                | Reset            | 0FFFEh       | 63, highest |
| <b>System NMI</b><br>PMM<br>Vacant Memory Access<br>JTAG Mailbox                                                    | SVMLIFG, SVMHIFG, DLYLIFG, DLYHIFG,<br>VLRIFG, VLRHIFG, VMAIFG, JMBNIFG,<br>JMBOUTIFG (SYSSNIV) <sup>(1)</sup>            | (Non)maskable    | 0FFFCh       | 62          |
| <b>User NMI</b><br>NMI<br>Oscillator Fault<br>Flash Memory Access Violation                                         | NMIIFG, OFIFG, ACCVIFG (SYSUNIV) <sup>(1) (2)</sup>                                                                       | (Non)maskable    | 0FFFAh       | 61          |
| <b>Comp_B</b>                                                                                                       | CBIIFG, CBIFG (CBIV) <sup>(1) (3)</sup>                                                                                   | Maskable         | 0FFF8h       | 60          |
| <b>TEC0</b>                                                                                                         | TEC0FLTIFG, TEC0EXCLRIFG,<br>TEC0AXCLRIFG <sup>(1) (3)</sup>                                                              | Maskable         | 0FFF6h       | 59          |
| <b>TD0</b>                                                                                                          | TD0CCR0 CCIFG0 <sup>(3)</sup>                                                                                             | Maskable         | 0FFF4h       | 58          |
| <b>TD0</b>                                                                                                          | TD0CCR1 CCIFG1, ... TD0CCR2 CCIFG2,<br>TD0IFG, TD0HFLIFG, TD0HFHIFG, TD0HLKIFG,<br>TD0HUNLKIFG (TD0IV) <sup>(1) (3)</sup> | Maskable         | 0FFF2h       | 57          |
| <b>Watchdog Timer_A Interval<br/>Timer Mode</b>                                                                     | WDTIFG                                                                                                                    | Maskable         | 0FFF0h       | 56          |
| <b>USCI_A0 Receive or Transmit</b>                                                                                  | UCA0RXIFG, UCA0TXIFG (UCA0IV) <sup>(1) (3)</sup>                                                                          | Maskable         | 0FFEEh       | 55          |
| <b>USCI_B0 Receive or Transmit</b>                                                                                  | UCB0RXIFG, UCB0TXIFG, I <sup>2</sup> C Status Interrupt<br>Flags (UCB0IV) <sup>(1) (3)</sup>                              | Maskable         | 0FFECCh      | 54          |
| <b>ADC10_A (MSP430F51x2 only)</b>                                                                                   | ADC10IFG0, ADC10INIFG, ADC10LOIFG,<br>ADC10HIIFG, ADC10TOVIFG, ADC10OVIFG<br>(ADC10IV) <sup>(1) (3)</sup>                 | Maskable         | 0FFEAh       | 53          |
| <b>TA0</b>                                                                                                          | TA0CCR0 CCIFG0 <sup>(3)</sup>                                                                                             | Maskable         | 0FFE8h       | 52          |
| <b>TA0</b>                                                                                                          | TA0CCR1 CCIFG1 ... TA0CCR2 CCIFG2,<br>TA0IFG (TA0IV) <sup>(1) (3)</sup>                                                   | Maskable         | 0FFE6h       | 51          |
| <b>DMA</b>                                                                                                          | DMA0IFG, DMA1IFG, DMA2IFG (DMAIV) <sup>(1) (3)</sup>                                                                      | Maskable         | 0FFE4h       | 50          |
| <b>TEC1</b>                                                                                                         | TEC1FLTIFG, TEC1EXCLRIFG,<br>TEC1AXCLRIFG <sup>(1) (3)</sup>                                                              | Maskable         | 0FFE2h       | 49          |
| <b>TD1</b>                                                                                                          | TD1CCR0 CCIFG0 <sup>(3)</sup>                                                                                             | Maskable         | 0FFE0h       | 48          |
| <b>TD1</b>                                                                                                          | TD1CCR1 CCIFG1 ... TD1CCR2 CCIFG2,<br>TD1IFG, TD1HFLIFG, TD1HFHIFG, TD1HLKIFG,<br>TD1HUNLKIFG (TD1IV) <sup>(1) (3)</sup>  | Maskable         | 0FFDEh       | 47          |
| <b>I/O Port P1</b>                                                                                                  | P1IFG.0 to P1IFG.7 (P1IV) <sup>(1) (3)</sup>                                                                              | Maskable         | 0FFDCh       | 46          |
| <b>I/O Port P2</b>                                                                                                  | P2IFG.0 to P2IFG.7 (P2IV) <sup>(1) (3)</sup>                                                                              | Maskable         | 0FFDAh       | 45          |
| <b>Reserved</b>                                                                                                     | Reserved <sup>(4)</sup>                                                                                                   |                  | 0FFD8h       | 44          |
|                                                                                                                     |                                                                                                                           |                  | ⋮            | ⋮           |
|                                                                                                                     |                                                                                                                           |                  | 0FF80h       | 0, lowest   |

(1) Multiple source flags

(2) A reset is generated if the CPU tries to fetch instructions from within peripheral space or vacant memory space.

(Non)maskable: the individual interrupt-enable bit can disable an interrupt event, but the general interrupt enable cannot disable it.

(3) Interrupt flags are in the module.

(4) Reserved interrupt vectors at addresses are not used in this device and can be used for regular program code if necessary. To maintain compatibility with other devices, TI recommends reserving these locations.

## 6.5 Memory Organization

Table 6-4 summarizes the memory map of all devices.

**Table 6-4. Memory Organization**

|                                                       |               | MSP430F5132,<br>MSP430F5131        | MSP430F5152,<br>MSP430F5151        | MSP430F5172,<br>MSP430F5171        |
|-------------------------------------------------------|---------------|------------------------------------|------------------------------------|------------------------------------|
| Memory<br>Main: interrupt vector<br>Main: code memory | Size          | 8KB                                | 16KB                               | 32KB                               |
|                                                       | Flash         | 00FFFFh–00FF80h<br>00FFFFh–00E000h | 00FFFFh–00FF80h<br>00FFFFh–00C000h | 00FFFFh–00FF80h<br>00FFFFh–008000h |
| RAM                                                   | Size          | 1KB                                | 2KB                                | 2KB                                |
|                                                       | Sector 0      | 001FFFh–001C00h                    | 0023FFh–001C00h                    | 0023FFh–001C00h                    |
| Information memory<br>(Flash)                         | Size          | 512 Byte                           | 512 Byte                           | 512 Byte                           |
|                                                       | Info A        | 128B<br>0019FFh–001980h            | 128B<br>0019FFh–001980h            | 128B<br>0019FFh–001980h            |
|                                                       | Info B        | 128B<br>00197Fh–001900h            | 128B<br>00197Fh–001900h            | 128B<br>00197Fh–001900h            |
|                                                       | Info C        | 128B<br>0018FFh–001880h            | 128B<br>0018FFh–001880h            | 128B<br>0018FFh–001880h            |
|                                                       | Info D        | 128B<br>00187Fh–001800h            | 128B<br>00187Fh–001800h            | 128B<br>00187Fh–001800h            |
| Bootloader (BSL)<br>memory                            | Size          | 2K                                 | 2KB                                | 2KB                                |
|                                                       | BSL 3         | 512B<br>0017FFh–001600h            | 512B<br>0017FFh–001600h            | 512B<br>0017FFh–001600h            |
|                                                       | BSL 2         | 512B<br>0015FFh–001400h            | 512B<br>0015FFh–001400h            | 512B<br>0015FFh–001400h            |
|                                                       | BSL 1         | 512B<br>0013FFh–001200h            | 512B<br>0013FFh–001200h            | 512B<br>0013FFh–001200h            |
|                                                       | BSL 0         | 512B<br>0011FFh–001000h            | 512B<br>0011FFh–001000h            | 512B<br>0011FFh–001000h            |
| Peripherals                                           | Size<br>Flash | 4KB<br>000FFFh–000000h             | 4KB<br>000FFFh–000000h             | 4KB<br>000FFFh–000000h             |

## 6.6 Bootloader (BSL)

The BSL lets users program the flash memory or RAM using a UART serial interface. Access to the device memory by the BSL is protected by user-defined password. A bootloader security key is provided to disable the BSL completely or to disable the erasure of the flash if an invalid password is supplied. For complete description of the features of the BSL and its implementation, see [MSP430 Programming With the Bootloader \(BSL\)](#). Table 6-5 lists the pins required for BSL access.

**Table 6-5. BSL Functions**

| BSL FUNCTION                                      | DESCRIPTION            |                         |                          |
|---------------------------------------------------|------------------------|-------------------------|--------------------------|
|                                                   | 40-PIN QFN RSB PACKAGE | 38-PIN TSSOP DA PACKAGE | 40-PIN DSBGA YFF PACKAGE |
| $\overline{\text{RST}}/\text{NMI}/\text{SBWTDIO}$ | Entry sequence signal  | Entry sequence signal   | Entry sequence signal    |
| TEST/SBWTK                                        | Entry sequence signal  | Entry sequence signal   | Entry sequence signal    |
| Data transmit                                     | P3.5 - 34<br>P3.7 - 36 | P3.5 - 37               | P3.5 - A3<br>P3.7 - B4   |
| Data receive                                      | P3.6 - 35              | P3.6 - 38               | P3.6 - A4                |
| VCC                                               | Power supply           | Power supply            | Power supply             |
| VSS                                               | Ground supply          | Ground supply           | Ground supply            |

## 6.7 Flash Memory

The flash memory can be programmed through the JTAG port, Spy-Bi-Wire (SBW), the BSL, or in-system by the CPU. The CPU can perform single-byte, single-word, and long-word writes to the flash memory. Features of the flash memory include:

- Flash memory has n segments of main memory and four segments of information memory (A to D) of 128 bytes each. Each segment in main memory is 512 bytes in size.
- Segments 0 to n may be erased in one step, or each segment may be individually erased.
- Segments A to D can be erased individually, or as a group with segments 0 to n. Segments A to D are also called *information memory*.
- Segment A can be locked separately.

## 6.8 RAM

The RAM is made up of n sectors. Each sector can be completely powered down to save leakage; however, all data is lost. Features of the RAM include:

- RAM has n sectors. The size of a sector can be found in [Section 6.5](#).
- Each sector 0 to n can be complete disabled; however, data retention is lost.
- Each sector 0 to n automatically enters low-power retention mode when possible.

## 6.9 Peripherals

Peripherals are connected to the CPU through data, address, and control buses. Peripherals can be managed using all instructions. For complete module descriptions, see the [MSP430x5xx and MSP430x6xx Family User's Guide](#).

### 6.9.1 Digital I/O

Up to three 8-bit I/O ports are implemented. Port PJ contains seven individual I/O pins, common to all devices.

- All individual I/O bits are independently programmable.
- Any combination of input, output, and interrupt conditions is possible.
- Programmable pullup or pulldown on all ports.
- Programmable drive strength on all ports.
- All 8 bits of ports P1 and P2 support edge-selectable interrupt input.
- Read and write access to port-control registers is supported by all instructions.
- Ports can be accessed byte-wise. P1 and P2 can also be accessed word-wise (PA).
- The input and output voltage levels of the pins supplied by DV<sub>IO</sub> (see [Table 4-1](#)) are defined by the voltage supplied by DV<sub>IO</sub> (up to 5 V).

## 6.9.2 Port Mapping Controller

The port mapping controller allows the flexible and reconfigurable mapping of digital functions to Port P1, Port P2, and Port P3 (see [Table 6-6](#)).

**Table 6-6. Port Mapping Mnemonics and Functions**

| VALUE                    | PxMAPy MNEMONIC | INPUT PIN FUNCTION                                                                                                         | OUTPUT PIN FUNCTION          |
|--------------------------|-----------------|----------------------------------------------------------------------------------------------------------------------------|------------------------------|
| 0                        | PM_NONE         | None                                                                                                                       | DVSS                         |
| 1                        | PM_UCA0CLK      | USCI_A0 clock input/output (direction controlled by USCI)                                                                  |                              |
|                          | PM_UCB0STE      | USCI_B0 SPI slave transmit enable (direction controlled by USCI)                                                           |                              |
| 2                        | PM_UCA0TXD      | USCI_A0 UART TXD (Direction controlled by USCI - output)                                                                   |                              |
|                          | PM_UCA0SIMO     | USCI_A0 SPI slave in master out (direction controlled by USCI)                                                             |                              |
| 3                        | PM_UCB0SOMI     | USCI_B0 SPI slave out master in (direction controlled by USCI)                                                             |                              |
|                          | PM_UCB0SCL      | USCI_B0 I <sup>2</sup> C clock (open drain and direction controlled by USCI)                                               |                              |
| 4                        | PM_UCA0RXD      | USCI_A0 UART RXD (Direction controlled by USCI - input)                                                                    |                              |
|                          | PM_UCA0SOMI     | USCI_A0 SPI slave out master in (direction controlled by USCI)                                                             |                              |
| 5                        | PM_UCB0SIMO     | USCI_B0 SPI slave in master out (direction controlled by USCI)                                                             |                              |
|                          | PM_UCB0SDA      | USCI_B0 I <sup>2</sup> C data (open drain and direction controlled by USCI)                                                |                              |
| 6                        | PM_UCB0CLK      | USCI_B0 clock input/output (direction controlled by USCI)                                                                  |                              |
|                          | PM_UCA0STE      | USCI_A0 SPI slave transmit enable (direction controlled by USCI)                                                           |                              |
| 7                        | PM_TD0.0        | TD0 input capture channel 0                                                                                                | TD0 output compare channel 0 |
| 8                        | PM_TD0.1        | TD0 input capture channel 1                                                                                                | TD0 output compare channel 1 |
| 9                        | PM_TD0.2        | TD0 input capture channel 2                                                                                                | TD0 output compare channel 2 |
| 10                       | PM_TD1.0        | TD1 input capture channel 0                                                                                                | TD1 output compare channel 0 |
| 11                       | PM_TD1.1        | TD1 input capture channel 1                                                                                                | TD1 output compare channel 1 |
| 12                       | PM_TD1.2        | TD1 input capture channel 2                                                                                                | TD1 output compare channel 2 |
| 13                       | PM_CLR1TD0.0    | TD0 external clear input                                                                                                   | TD0 output compare channel 0 |
|                          | PM_FLT1_2TD0.0  | TD0 fault input channel 2                                                                                                  |                              |
| 14                       | PM_FLT1_0TD0.1  | TD0 fault input channel 0                                                                                                  | TD0 output compare channel 1 |
| 15                       | PM_FLT1_1TD0.2  | TD0 fault input channel 1                                                                                                  | TD0 output compare channel 2 |
| 16                       | PM_CLR2TD1.0    | TD1 external clear input (controlled by module input enable)                                                               | TD1 output compare channel 0 |
|                          | PM_FLT2_1TD1.0  | TD1 fault input channel 1 (controlled by module input enable)                                                              |                              |
| 17                       | PM_FLT2_2TD1.1  | TD1 fault input channel 2                                                                                                  | TD1 output compare channel 1 |
| 18                       | PM_FLT2_0TD1.2  | TD1 fault input channel 0                                                                                                  | TD1 output compare channel 2 |
| 19                       | PM_TD0.0SMCLK   | TD0 input capture channel 0                                                                                                | SMCLK output                 |
| 20                       | PM_TA0CLKCBOUT  | TA0 input clock                                                                                                            | Comparator_B output          |
| 21                       | PM_TD0CLKMCLK   | TD0 input clock                                                                                                            | MCLK output                  |
| 22                       | PM_TA0_0        | TA0 input capture channel 0                                                                                                | TA0 output compare channel 0 |
| 23                       | PM_TA0_1        | TA0 input capture channel 1                                                                                                | TA0 output compare channel 1 |
| 24                       | PM_TA0_2        | TA0 input capture channel 2                                                                                                | TA0 output compare channel 2 |
| 25                       | PM_DMAE0SMCLK   | DMAE0 input                                                                                                                | SMCLK output                 |
| 26                       | PM_DMAE1MCLK    | DMAE1 input                                                                                                                | MCLK output                  |
| 27                       | PM_DMAE2SVM     | DMAE2 input                                                                                                                | SVM output                   |
| 28                       | PM_TD0OUTH      | TD0 3-state input                                                                                                          | ADC10CLK                     |
| 29                       | PM_TD1OUTH      | TD1 3-state input                                                                                                          | ACLK                         |
| 30                       | Reserved        | None                                                                                                                       | DVSS                         |
| 31 (0FFh) <sup>(1)</sup> | PM_ANALOG       | Disables the output driver and the input Schmitt-trigger to prevent parasitic cross currents when applying analog signals. |                              |

(1) The value of the PM\_ANALOG mnemonic is set to 0FFh. The port mapping registers are only 5 bits wide, and the upper bits are ignored, which results in a read out value of 31.

Table 6-7 lists the default assignments for all pins that support port mapping.

**Table 6-7. Default Mapping**

| PIN                                      | PxMAPy MNEMONIC                | INPUT PIN FUNCTION                                                                                                                  | OUTPUT PIN FUNCTION                                                             |
|------------------------------------------|--------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------|
| P1.0/PM_UCA0CLK/<br>PM_UCB0STE/A0/CB0    | PM_UCA0CLK<br>PM_UCB0STE       | USCI_A0 clock input/output<br>(direction controlled by USCI)                                                                        | USCI_B0 SPI slave transmit enable<br>(direction controlled by USCI)             |
| P1.1/PM_UCA0TXD/<br>PM_UCA0SIMO/A1/CB1   | PM_UCA0TXD<br>PM_UCA0SIMO      | USCI_A0 UART TXD (Direction<br>controlled by USCI – output)                                                                         | USCI_A0 SPI slave in master out<br>(direction controlled by USCI)               |
| P1.2/PM_UCA0RXD/<br>PM_UCA0SOMI/A2/CB2   | PM_UCA0RXD<br>PM_UCA0SOMI      | USCI_A0 UART RXD (Direction<br>controlled by USCI – input)                                                                          | USCI_A0 SPI slave out master in<br>(direction controlled by USCI)               |
| P1.3/PM_UCB0CLK/<br>PM_UCA0STE/A3/CB3    | PM_UCB0CLK<br>PM_UCA0STE       | USCI_B0 clock input/output<br>(direction controlled by USCI)                                                                        | USCI_A0 SPI slave transmit enable<br>(direction controlled by USCI)             |
| P1.4/PM_UCB0SIMO/<br>PM_UCB0SDA/A4/CB4   | PM_UCB0SIMO<br>PM_UCB0SDA      | USCI_B0 SPI slave in master out<br>(direction controlled by USCI)                                                                   | USCI_B0 I <sup>2</sup> C data (open drain and<br>direction controlled by USCI)  |
| P1.5/PM_UCB0SOMI/<br>PM_UCB0SCL/A5/CB5   | PM_UCB0SOMI<br>PM_UCB0SCL      | USCI_B0 SPI slave out master in<br>(direction controlled by USCI)                                                                   | USCI_B0 I <sup>2</sup> C clock (open drain and<br>direction controlled by USCI) |
| P1.6/PM_TD0.0                            | PM_TD0.0                       | TD0 input capture channel 0                                                                                                         | TD0 output compare channel 0                                                    |
| P1.7/PM_TD0.1                            | PM_TD0.1                       | TD0 input capture channel 1                                                                                                         | TD0 output compare channel 1                                                    |
| P2.0/PM_TD0.2                            | PM_TD0.2                       | TD0 input capture channel 2                                                                                                         | TD0 output compare channel 2                                                    |
| P2.1/PM_TD1.0                            | PM_TD1.0                       | TD1 input capture channel 0                                                                                                         | TD1 output compare channel 0                                                    |
| P2.2/PM_TD1.1                            | PM_TD1.1                       | TD1 input capture channel 1                                                                                                         | TD1 output compare channel 1                                                    |
| P2.3/PM_TD1.2                            | PM_TD1.2                       | TD1 input capture channel 2                                                                                                         | TD1 output compare channel 2                                                    |
| P2.4/PM_TEC0CLR/<br>PM_TEC0FLT2/PM_TD0.0 | PM_CLR1TD0.0<br>PM_FLT1_2TD0.0 | TD0 external clear input (controlled<br>by module input enable)<br>TD0 fault input channel 2<br>(controlled by module input enable) | TD0 output compare channel 0                                                    |
| P2.5/PM_TEC0FLT0/PM_TD0.1                | PM_FLT1_0TD0.1                 | TD0 fault input channel 0                                                                                                           | TD0 output compare channel 1                                                    |
| P2.6/PM_TEC0FLT1/PM_TD0.2                | PM_FLT1_1TD0.2                 | TD0 fault input channel 1                                                                                                           | TD0 output compare channel 2                                                    |
| P2.7/PM_TEC1CLR/<br>PM_TEC1FLT1/PM_TD1.0 | PM_CLR2TD1.0<br>PM_FLT2_1TD1.0 | TD1 external clear input (controlled<br>by module input enable)<br>TD1 fault input channel 1<br>(controlled by module input enable) | TD1 output compare channel 0                                                    |
| P3.0/PM_TEC1FLT2/<br>PM_TD1.1            | PM_FLT2_2TD1.1                 | TD1 fault input channel 2                                                                                                           | TD1 output compare channel 1                                                    |
| P3.1/PM_TEC1FLT0/<br>PM_TD1.2            | PM_FLT2_0TD1.2                 | TD1 fault input channel 0                                                                                                           | TD1 output compare channel 2                                                    |
| P3.2/PM_TD0.0/<br>PM_SMCLK/CB14          | PM_TD0.0SMCLK                  | TD0 input capture channel 0                                                                                                         | SMCLK output                                                                    |
| P3.3/PM_TA0CLK/<br>PM_CBOUT/CB13         | PM_TA0CLKCBOUT                 | TA0 input clock                                                                                                                     | Comparator_B output                                                             |
| P3.4/PM_TD0CLK/<br>PM_MCLK               | PM_TD0CLKMCLK                  | TD0 input clock                                                                                                                     | MCLK output                                                                     |
| P3.5/PM_TA0.2/<br>VEREF+/CB12            | PM_TA3_2                       | TA0 input capture channel 0                                                                                                         | TA0 output compare channel 0                                                    |
| P3.6/PM_TA0.1/A7<br>VEREF-/CB11          | PM_TA3_1                       | TA0 input capture channel 1                                                                                                         | TA0 output compare channel 1                                                    |
| P3.7/PM_TA0.0/<br>A6/CB10                | PM_TA3_0                       | TA0 input capture channel 2                                                                                                         | TA0 output compare channel 2                                                    |

### 6.9.3 Oscillator and System Clock

The clock system (Unified Clock System [UCS]) module includes support for a 32-kHz watch crystal oscillator and high-frequency crystal oscillator, an internal very-low-power low-frequency oscillator (VLO), an internal trimmed low-frequency oscillator (REFO), and an integrated internal digitally controlled oscillator (DCO). The UCS module is designed to meet the requirements of both low system cost and low power consumption. The UCS module features digital frequency locked loop (FLL) hardware that, in conjunction with a digital modulator, stabilizes the DCO frequency to a programmable multiple of the watch crystal frequency. The internal DCO provides a fast turnon clock source and stabilizes in less than 5  $\mu$ s. The UCS module provides the following clock signals:

- Auxiliary clock (ACLK), sourced from a 32-kHz watch crystal or high-frequency crystal (XT1), the internal low-frequency oscillator (VLO), the trimmed low-frequency oscillator (REFO), or the internal digitally-controlled oscillator DCO.
- Main clock (MCLK), the system clock used by the CPU. MCLK can be sourced by same sources available to ACLK.
- Sub-Main clock (SMCLK), the subsystem clock used by the peripheral modules. SMCLK can be sourced by same sources available to ACLK.
- ACLK/n, the buffered output of ACLK, ACLK/2, ACLK/4, ACLK/8, ACLK/16, ACLK/32.

### 6.9.4 Power-Management Module (PMM)

The PMM includes an integrated voltage regulator that supplies the core voltage to the device and contains programmable output levels to provide for power optimization. The PMM also includes supply voltage supervisor (SVS) and supply voltage monitoring (SVM) circuitry, as well as brownout protection. The brownout circuit is implemented to provide the proper internal reset signal to the device during power-on and power-off. The SVS/SVM circuitry detects if the supply voltage drops below a user-selectable level and supports both supply voltage supervision (the device is automatically reset) and supply voltage monitoring (SVM, the device is not automatically reset). SVS and SVM circuitry is available on the primary supply and core supply.

### 6.9.5 Hardware Multiplier

The multiplication operation is supported by a dedicated peripheral module. The module performs operations with 32-bit, 24-bit, 16-bit, and 8-bit operands. The module is capable of supporting signed and unsigned multiplication as well as signed and unsigned multiply and accumulate operations

### 6.9.6 Watchdog Timer (WDT\_A)

The primary function of the watchdog timer (WDT\_A) module is to perform a controlled system restart after a software problem occurs. If the selected time interval expires, a system reset is generated. If the watchdog function is not needed in an application, the module can be configured as an interval timer and can generate interrupts at selected time intervals.

### 6.9.7 System Module (SYS)

The SYS module handles many of the system functions within the device. These include power-on reset and power-up clear handling, NMI source selection and management, reset interrupt vector generators (see [Table 6-8](#)), bootloader entry mechanisms, and configuration management (device descriptors). It also includes a data exchange mechanism using JTAG that is called a JTAG mailbox and that can be used in the application.

**Table 6-8. System Module Interrupt Vector Registers**

| INTERRUPT VECTOR REGISTER | INTERRUPT EVENT                | WORD ADDRESS | OFFSET     | PRIORITY |
|---------------------------|--------------------------------|--------------|------------|----------|
| SYSRSTIV, System Reset    | No interrupt pending           | 019Eh        | 00h        | Highest  |
|                           | Brownout (BOR)                 |              | 02h        |          |
|                           | RST/NMI (POR)                  |              | 04h        |          |
|                           | PMMSWBOR (BOR)                 |              | 06h        |          |
|                           | LPM5 wake-up (BOR)             |              | 08h        |          |
|                           | Security violation (BOR)       |              | 0Ah        |          |
|                           | SVSL (POR)                     |              | 0Ch        |          |
|                           | SVSH (POR)                     |              | 0Eh        |          |
|                           | SVML_OVP (POR)                 |              | 10h        |          |
|                           | SVMH_OVP (POR)                 |              | 12h        |          |
|                           | PMMSWPOR (POR)                 |              | 14h        |          |
|                           | WDT time-out (PUC)             |              | 16h        |          |
|                           | WDT key violation (PUC)        |              | 18h        |          |
|                           | KEYV flash key violation (PUC) |              | 1Ah        |          |
|                           | Reserved                       |              | 1Ch        |          |
|                           | Peripheral area fetch (PUC)    |              | 1Eh        |          |
|                           | PMM key violation (PUC)        |              | 20h        |          |
|                           | Reserved                       |              | 22h to 3Eh | Lowest   |
| SYSSNIV, System NMI       | No interrupt pending           | 019Ch        | 00h        | Highest  |
|                           | SVMLIFG                        |              | 02h        |          |
|                           | SVMHIFG                        |              | 04h        |          |
|                           | DLYLIFG                        |              | 06h        |          |
|                           | DLYHIFG                        |              | 08h        |          |
|                           | VMAIFG                         |              | 0Ah        |          |
|                           | JMBINIFG                       |              | 0Ch        |          |
|                           | JMBOUTIFG                      |              | 0Eh        |          |
|                           | VLRIFG                         |              | 10h        |          |
|                           | VLRHIFG                        |              | 12h        |          |
|                           | Reserved                       |              | 14h to 1Eh | Lowest   |
| SYSUNIV, User NMI         | No interrupt pending           | 019Ah        | 00h        | Highest  |
|                           | NMIIFG                         |              | 02h        |          |
|                           | OFIFG                          |              | 04h        |          |
|                           | ACCVIFG                        |              | 06h        |          |
|                           | Reserved                       |              | 08h to 1Eh | Lowest   |

### 6.9.8 DMA Controller

The DMA controller allows movement of data from one memory address to another without CPU intervention. For example, the DMA controller can be used to move data from the ADC10\_A conversion memory to RAM. Using the DMA controller can increase the throughput of peripheral modules. The DMA controller reduces system power consumption by allowing the CPU to remain in sleep mode, without having to wake to move data to or from a peripheral. [Table 6-9](#) lists the triggers that can be assigned to start a DMA transfer.

**Table 6-9. DMA Trigger Assignments<sup>(1)</sup>**

| TRIGGER | CHANNEL       |               |               |
|---------|---------------|---------------|---------------|
|         | 0             | 1             | 2             |
| 0       | DMAREQ        | DMAREQ        | DMAREQ        |
| 1       | TA0CCR0 CCIFG | TA0CCR0 CCIFG | TA0CCR0 CCIFG |
| 2       | TA0CCR2 CCIFG | TA0CCR2 CCIFG | TA0CCR2 CCIFG |
| 3       | TD0CCR0 CCIFG | TD0CCR0 CCIFG | TD0CCR0 CCIFG |
| 4       | TD0CCR2 CCIFG | TD0CCR2 CCIFG | TD0CCR2 CCIFG |
| 5       | TD1CCR0 CCIFG | TD1CCR0 CCIFG | TD1CCR0 CCIFG |
| 6       | TD1CCR2 CCIFG | TD1CCR2 CCIFG | TD1CCR2 CCIFG |
| 7       | Reserved      | Reserved      | Reserved      |
| 8       | Reserved      | Reserved      | Reserved      |
| 9       | Reserved      | Reserved      | Reserved      |
| 10      | Reserved      | Reserved      | Reserved      |
| 11      | Reserved      | Reserved      | Reserved      |
| 12      | Reserved      | Reserved      | Reserved      |
| 13      | Reserved      | Reserved      | Reserved      |
| 14      | Reserved      | Reserved      | Reserved      |
| 15      | Reserved      | Reserved      | Reserved      |
| 16      | UCA0RXIFG     | UCA0RXIFG     | UCA0RXIFG     |
| 17      | UCA0TXIFG     | UCA0TXIFG     | UCA0TXIFG     |
| 18      | UCB0RXIFG     | UCB0RXIFG     | UCB0RXIFG     |
| 19      | UCB0TXIFG     | UCB0TXIFG     | UCB0TXIFG     |
| 20      | Reserved      | Reserved      | Reserved      |
| 21      | Reserved      | Reserved      | Reserved      |
| 22      | Reserved      | Reserved      | Reserved      |
| 23      | Reserved      | Reserved      | Reserved      |
| 24      | ADC10IFG0     | ADC10IFG0     | ADC10IFG0     |
| 25      | Reserved      | Reserved      | Reserved      |
| 26      | Reserved      | Reserved      | Reserved      |
| 27      | Reserved      | Reserved      | Reserved      |
| 28      | Reserved      | Reserved      | Reserved      |
| 29      | MPY ready     | MPY ready     | MPY ready     |
| 30      | DMA2IFG       | DMA0IFG       | DMA1IFG       |
| 31      | DMAE0         | DMAE0         | DMAE0         |

(1) Reserved DMA triggers may be used by other devices in the family. Reserved DMA triggers do not cause any DMA trigger event when selected.

## 6.9.9 Universal Serial Communication Interface (USCI)

The USCI modules are used for serial data communication. The USCI module supports synchronous communication protocols such as SPI (3 or 4 pin) and I<sup>2</sup>C, and asynchronous communication protocols such as UART, enhanced UART with automatic baudrate detection, and IrDA. Each USCI module contains two modules, A and B.

The USCI\_Ax module provides support for SPI (3 or 4 pin), UART, enhanced UART, or IrDA.

The USCI\_Bx module provides support for SPI (3 or 4 pin) or I<sup>2</sup>C.

### 6.9.10 TA0

TA0 is a 16-bit timer/counter with three capture/compare registers (see [Table 6-10](#)). TA0 can support multiple capture/compares, PWM outputs, and interval timing. TA0 also has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers.

**Table 6-10. TA0 Signal Connections**

| INPUT PIN NUMBER |                   |                    | DEVICE INPUT SIGNAL | MODULE INPUT SIGNAL | MODULE BLOCK | MODULE OUTPUT SIGNAL | DEVICE OUTPUT SIGNAL | OUTPUT PIN NUMBER                                         |                                                           |                                                           |
|------------------|-------------------|--------------------|---------------------|---------------------|--------------|----------------------|----------------------|-----------------------------------------------------------|-----------------------------------------------------------|-----------------------------------------------------------|
| RSB (40-PIN QFN) | DA (38-PIN TSSOP) | YFF (40-PIN DSBGA) |                     |                     |              |                      |                      | RSB (40-PIN QFN)                                          | DA (38-PIN TSSOP)                                         | YFF (40-PIN DSBGA)                                        |
| P3.3 - 30        | P3.3 - 34         | P3.3 - G6          | TA0CLK              | TACLK               | Timer        | NA                   | NA                   | –                                                         | –                                                         | –                                                         |
| ACLK (internal)  | ACLK              | ACLK               | ACLK                | ACLK                |              |                      |                      | –                                                         | –                                                         | –                                                         |
| SMCLK (internal) | SMCLK             | SMCLK              | SMCLK               | SMCLK               |              |                      |                      | –                                                         | –                                                         | –                                                         |
| P3.3 - 30        | P3.3 - 34         | P3.3 - G6          | TA0CLK              | TACLK               |              |                      |                      | –                                                         | –                                                         | –                                                         |
| P3.7 - 36        | –                 | P3.7 - G4          | TA0.0               | CCI0A               | CCR0         | TA0                  | TA0.0                | P3.7 - 36                                                 | –                                                         | P3.7 - G4                                                 |
| –                | –                 | –                  | CBOU                | CCI0B               |              |                      |                      | –                                                         | –                                                         | –                                                         |
| –                | –                 | –                  | V <sub>SS</sub>     | GND                 |              |                      |                      | –                                                         | –                                                         | –                                                         |
| –                | –                 | –                  | V <sub>CC</sub>     | V <sub>CC</sub>     |              |                      |                      | –                                                         | –                                                         | –                                                         |
| P3.6 - 35        | –                 | P3.6 - G3          | TA0.1               | CCI1A               | CCR1         | TA1                  | TA0.1                | P3.6 - 35                                                 | P3.6 - 38                                                 | P3.6 - G3                                                 |
| –                | –                 | –                  | ACLK                | CCI1B               |              |                      |                      | ADC10_A <sup>(1)</sup> (internal)<br>ADC10SHS<br>x = 001b | ADC10_A <sup>(1)</sup> (internal)<br>ADC10SHS<br>x = 001b | ADC10_A <sup>(1)</sup> (internal)<br>ADC10SHS<br>x = 001b |
| –                | –                 | –                  | V <sub>SS</sub>     | GND                 |              |                      |                      | –                                                         | –                                                         | –                                                         |
| –                | –                 | –                  | V <sub>CC</sub>     | V <sub>CC</sub>     |              |                      |                      | –                                                         | –                                                         | –                                                         |
| P3.5 - 34        | P3.5 - 37         | P3.5 - F3          | TA0.2               | CCI2A               | CCR2         | TA2                  | TA0.2                | P3.5 - 34                                                 | P3.5 - 37                                                 | P3.5 - F3                                                 |
| –                | –                 | –                  | V <sub>SS</sub>     | CCI2B               |              |                      |                      | –                                                         | –                                                         | –                                                         |
| –                | –                 | –                  | V <sub>SS</sub>     | GND                 |              |                      |                      | –                                                         | –                                                         | –                                                         |
| –                | –                 | –                  | V <sub>CC</sub>     | V <sub>CC</sub>     |              |                      |                      | –                                                         | –                                                         | –                                                         |

(1) The ADC10\_A trigger is available on MSP430F51x2 devices.

## 6.9.11 TD0

TD0 is a 16-bit timer/counter with three capture/compare registers supporting up to 256-MHz (4-ns) resolution (see [Table 6-11](#)). TD0 can support multiple capture/compares, PWM outputs, and interval timing. TD0 also has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers. External fault inputs as well as a external timer counter clear is supported along with interrupt flags from the TEC0 module.

**Table 6-11. TD0 Signal Connections**

| INPUT PIN NUMBER         |                          |                          | DEVICE<br>INPUT<br>SIGNAL | MODULE<br>INPUT<br>SIGNAL | MODULE<br>BLOCK | MODULE<br>OUTPUT<br>SIGNAL | DEVICE<br>OUTPUT<br>SIGNAL | OUTPUT PIN NUMBER                                            |                                                              |                                                              |
|--------------------------|--------------------------|--------------------------|---------------------------|---------------------------|-----------------|----------------------------|----------------------------|--------------------------------------------------------------|--------------------------------------------------------------|--------------------------------------------------------------|
| RSB<br>(40-PIN<br>QFN)   | DA<br>(38-PIN<br>TSSOP)  | YFF<br>(40-PIN<br>DSBGA) |                           |                           |                 |                            |                            | RSB<br>(40-PIN<br>QFN)                                       | DA<br>(38-PIN<br>TSSOP)                                      | YFF<br>(40-PIN<br>DSBGA)                                     |
| P3.4 - 31                | —                        | P3.4 - G5                | TD0CLK                    | TDCLK                     | Timer           | NA                         | NA                         | —                                                            | —                                                            | —                                                            |
| ACLK<br>(internal)       | ACLK<br>(internal)       | ACLK<br>(internal)       | ACLK                      | ACLK                      |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| SMCLK<br>(internal)      | SMCLK<br>(internal)      | SMCLK<br>(internal)      | SMCLK                     | SMCLK                     |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P3.4 - 31                | —                        | P3.4 - G5                | TD0CLK                    | TDCLK                     |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| —                        | —                        | —                        | —                         | CLK0                      |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P2.4 - 19                | P2.4 - 23                | P2.4 - B4                | TEC0CLR                   | TECXCLR                   |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P1.6 - 11 <sup>(1)</sup> | P1.6 - 15 <sup>(1)</sup> | P1.6 - A1 <sup>(1)</sup> | TD0.0                     | CCI0A                     | CCR0            | TD0                        | TD0                        | P1.6 - 11 <sup>(1)</sup>                                     | P1.6 - 15 <sup>(1)</sup>                                     | P1.6 - A1 <sup>(1)</sup>                                     |
| P3.2 - 29                | P3.2 - 33                | P3.2 - F5                | TD0.0                     | CCI0B                     |                 |                            |                            | P2.4 - 19                                                    | P2.4 - 23                                                    | P2.4 - B4                                                    |
| —                        | —                        | —                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | ADC10_A<br>(internal)<br>ADC10SHS<br>x = 010b <sup>(2)</sup> | ADC10_A<br>(internal)<br>ADC10SHS<br>x = 010b <sup>(2)</sup> | ADC10_A<br>(internal)<br>ADC10SHS<br>x = 010b <sup>(2)</sup> |
| —                        | —                        | —                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P2.5 - 20                | P2.5 - 24                | P2.5 - A6                | TEC0FLT0                  | TECXFLT0                  |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P1.7 - 12 <sup>(1)</sup> | P1.7 - 16 <sup>(1)</sup> | P1.7 - B2 <sup>(1)</sup> | TD0.1                     | CCI1A                     | CCR1            | TD1                        | TD1                        | P1.7 - 12 <sup>(1)</sup>                                     | P1.7 - 16 <sup>(1)</sup>                                     | P1.7 - B2 <sup>(1)</sup>                                     |
| CBOU<br>(internal)       | CBOU<br>(internal)       | CBOU<br>(internal)       | TD0.1                     | CCI1B                     |                 |                            |                            | PJ.6 - 28                                                    | PJ.6 - 32                                                    | PJ.6 - E5                                                    |
| —                        | —                        | —                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | P2.5 - 20                                                    | P2.5 - 24                                                    | P2.5 - A6                                                    |
| —                        | —                        | —                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | ADC10_A<br>(internal)<br>ADC10SHS<br>x = 011b <sup>(2)</sup> | ADC10_A<br>(internal)<br>ADC10SHS<br>x = 011b <sup>(2)</sup> | ADC10_A<br>(internal)<br>ADC10SHS<br>x = 011b <sup>(2)</sup> |
| P2.6 - 21                | P2.6 - 20                | P2.6 - B5                | TEC0FLT1                  | TECXFLT1                  |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P2.0 - 13 <sup>(1)</sup> | P2.0 - 17 <sup>(1)</sup> | P2.0 - B3 <sup>(1)</sup> | TD0.2                     | CCI2A                     | CCR2            | TD2                        | TD2                        | P2.0 - 13 <sup>(1)</sup>                                     | P2.0 - 17 <sup>(1)</sup>                                     | P2.0 - B3 <sup>(1)</sup>                                     |
| ACLK<br>(internal)       | ACLK<br>(internal)       | ACLK<br>(internal)       | TD0.2                     | CCI2B                     |                 |                            |                            | P2.6 - 21                                                    | P2.6 - 25                                                    | P2.6 - B5                                                    |
| —                        | —                        | —                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| —                        | —                        | —                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | —                                                            | —                                                            | —                                                            |
| P2.4 - 19                | P2.4 - 23                | P2.4 - B4                | TEC0FLT2                  | TECXFLT2                  |                 |                            |                            | —                                                            | —                                                            | —                                                            |

(1) Pins P1.6 for TD0.0, P1.7 for TD0.1, and P2.0 for TD0.2 are optimized for matching.

(2) The ADC10\_A trigger is available on MSP430F51x2 devices.

### 6.9.12 TD1

TD1 is a 16-bit timer/counter with three capture/compare registers supporting up to 256-MHz (4-ns) resolution (see [Table 6-12](#)). TD1 can support multiple capture/compares, PWM outputs, and interval timing. TD1 also has extensive interrupt capabilities. Interrupts may be generated from the counter on overflow conditions and from each of the capture/compare registers. External fault inputs as well as a external timer counter clear is supported along with interrupt flags from the TEC0 module.

**Table 6-12. TD1 Signal Connections**

| INPUT PIN NUMBER         |                          |                          | DEVICE<br>INPUT<br>SIGNAL | MODULE<br>INPUT<br>SIGNAL | MODULE<br>BLOCK | MODULE<br>OUTPUT<br>SIGNAL | DEVICE<br>OUTPUT<br>SIGNAL | OUTPUT PIN NUMBER        |                          |                          |
|--------------------------|--------------------------|--------------------------|---------------------------|---------------------------|-----------------|----------------------------|----------------------------|--------------------------|--------------------------|--------------------------|
| RSB<br>(40-PIN<br>QFN)   | DA<br>(38-PIN<br>TSSOP)  | YFF<br>(40-PIN<br>DSBGA) |                           |                           |                 |                            |                            | RSB<br>(40-PIN<br>QFN)   | DA<br>(38-PIN<br>TSSOP)  | YFF<br>(40-PIN<br>DSBGA) |
| PJ.6 - 28                | PJ.6 - 32                | PJ.6 - E5                | TD1CLK                    | TDCLK                     | Timer           | NA                         | NA                         | –                        | –                        | –                        |
| ACLK<br>(internal)       | ACLK<br>(internal)       | ACLK<br>(internal)       | ACLK                      | ACLK                      |                 |                            |                            | –                        | –                        | –                        |
| SMCLK(inte<br>rnal)      | SMCLK                    | SMCLK                    | SMCLK                     | SMCLK                     |                 |                            |                            | –                        | –                        | –                        |
| PJ.6 - 28                | PJ.6 - 32                | PJ.6 - E5                | TD1CLK                    | TDCLK                     |                 |                            |                            | –                        | –                        | –                        |
| –                        | –                        | –                        | from TD0<br>(internal)    | CLK0                      |                 |                            |                            | –                        | –                        | –                        |
| P2.7 - 22                | P2.7 - 26                | P2.7 - C5                | TEC1CLR                   | TECxCLR                   |                 |                            |                            | –                        | –                        | –                        |
| P2.1 - 14 <sup>(1)</sup> | P2.1 - 18 <sup>(1)</sup> | P2.1 - A2                | TD1.0                     | CCI0A                     | CCR0            | TD0                        | TD0                        | P2.1 - 14 <sup>(1)</sup> | P2.1 - 18 <sup>(1)</sup> | P2.1 - A2 <sup>(1)</sup> |
| –                        | –                        | –                        | TD1.0                     | CCI0B                     |                 |                            |                            | P2.7 - 22                | P2.7 - 26                | P2.7 - C5                |
| –                        | –                        | –                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | –                        | –                        | –                        |
| –                        | –                        | –                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | –                        | –                        | –                        |
| P3.1 - 24                | P3.1 - 28                | P3.1 - C6                | TEC1FLT0                  | TECXFLT0                  |                 |                            |                            | –                        | –                        | –                        |
| P2.2 - 15 <sup>(1)</sup> | P2.2 - 19 <sup>(1)</sup> | P2.2 - A3                | TD1.1                     | CCI1A                     | CCR1            | TD1                        | TD1                        | P2.2 - 15 <sup>(1)</sup> | P2.2 - 19 <sup>(1)</sup> | P2.2 - A3 <sup>(1)</sup> |
| CBOU<br>T(interna<br>l)  | CBOU<br>T(interna<br>l)  | CBOU<br>T(interna<br>l)  | TD1.1                     | CCI1B                     |                 |                            |                            | P3.0 - 23                | P3.0 - 27                | P3.0 - B6                |
| –                        | –                        | –                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | –                        | –                        | –                        |
| –                        | –                        | –                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | –                        | –                        | –                        |
| P2.7 - 22                | P2.7 - 26                | P2.7 - C5                | TEC1FLT1                  | TECXFLT1                  |                 |                            |                            | –                        | –                        | –                        |
| P2.3 - 16 <sup>(1)</sup> | P2.3 - 20 <sup>(1)</sup> | P2.3 - C4                | TD1.2                     | CCI2A                     | CCR2            | TD2                        | TD2                        | P2.3 - 16 <sup>(1)</sup> | P2.3 - 20 <sup>(1)</sup> | P2.3 - C4 <sup>(1)</sup> |
| ACLK<br>(internal)       | ACLK<br>(internal)       | ACLK<br>(internal)       | TD1.2                     | CCI2B                     |                 |                            |                            | P3.1 - 24                | P3.1 - 28                | P3.1 - C6                |
| –                        | –                        | –                        | V <sub>SS</sub>           | GND                       |                 |                            |                            | –                        | –                        | –                        |
| –                        | –                        | –                        | V <sub>CC</sub>           | V <sub>CC</sub>           |                 |                            |                            | –                        | –                        | –                        |
| P3.0 - 23                | P3.0 - 27                | P3.0 - B6                | TEC1FLT2                  | TECXFLT2                  |                 |                            |                            | –                        | –                        | –                        |

(1) Pins P2.1 for TD1.0, P2.2 for TD1.1, and P2.3 for TD1.2 are optimized for matching.

### 6.9.13 *Comparator\_B*

The primary function of the Comparator\_B module is to support precision slope analog-to-digital conversions, battery voltage supervision, and monitoring of external analog signals.

### 6.9.14 *ADC10\_A (MSP430F51x2 Only)*

The ADC10\_A module supports fast 10-bit analog-to-digital conversions. The module implements a 10-bit SAR core, sample select control, reference generator and a conversion result buffer. A window comparator with lower and upper limits allows CPU-independent result monitoring with three window comparator interrupt flags.

### 6.9.15 *CRC16*

The CRC16 module produces a signature based on a sequence of entered data values and can be used for data checking purposes. The CRC16 module signature is based on the CRC-CCITT standard.

### 6.9.16 *Reference (REF) Module Voltage Reference*

The REF is responsible for generation of all critical reference voltages that can be used by the various analog peripherals in the device.

### 6.9.17 *Embedded Emulation Module (EEM) (S Version)*

The EEM supports real-time in-system debugging. The S version of the EEM has the following features:

- Three hardware triggers or breakpoints on memory access
- One hardware trigger or breakpoint on CPU register write access
- Up to four hardware triggers can be combined to form complex triggers or breakpoints
- One cycle counter
- Clock control on module level

## 6.9.18 Peripheral File Map

Table 6-13 lists the base address and offset range for the registers of all peripherals.

**Table 6-13. Peripherals**

| MODULE NAME                                    | BASE ADDRESS | OFFSET ADDRESS RANGE |
|------------------------------------------------|--------------|----------------------|
| Special Functions (see Table 6-14)             | 0100h        | 000h–01Fh            |
| PMM (see Table 6-15)                           | 0120h        | 000h–010h            |
| Flash Control (see Table 6-16)                 | 0140h        | 000h–00Fh            |
| CRC16 (see Table 6-17)                         | 0150h        | 000h–007h            |
| RAM Control (see Table 6-18)                   | 0158h        | 000h–001h            |
| Watchdog (see Table 6-19)                      | 015Ch        | 000h–001h            |
| UCS (see Table 6-20)                           | 0160h        | 000h–01Fh            |
| SYS (see Table 6-21)                           | 0180h        | 000h–01Fh            |
| Shared Reference (see Table 6-22)              | 01B0h        | 000h–001h            |
| Port Mapping Control (see Table 6-23)          | 01C0h        | 000h–007h            |
| Port Mapping Port P1 (see Table 6-24)          | 01C8h        | 000h–007h            |
| Port Mapping Port P2 (see Table 6-25)          | 01D0h        | 000h–007h            |
| Port Mapping Port P3 (see Table 6-26)          | 01D8h        | 000h–007h            |
| Port P1, P2 (see Table 6-27)                   | 0200h        | 000h–01Fh            |
| Port P3 (see Table 6-28)                       | 0220h        | 000h–01Fh            |
| Port PJ (see Table 6-29)                       | 0320h        | 000h–01Fh            |
| TA0 (see Table 6-30)                           | 03C0h        | 000h–03Fh            |
| 32-Bit Hardware Multiplier (see Table 6-31)    | 04C0h        | 000h–02Fh            |
| DMA General Control (see Table 6-32)           | 0500h        | 000h–00Fh            |
| DMA Channel 0 (see Table 6-33)                 | 0500h        | 010h–00Ah            |
| DMA Channel 1 (see Table 6-34)                 | 0500h        | 020h–00Ah            |
| DMA Channel 2 (see Table 6-35)                 | 0500h        | 030h–00Ah            |
| USCI_A0 (see Table 6-36)                       | 05C0h        | 000h–01Fh            |
| USCI_B0 (see Table 6-36)                       | 05E0h        | 000h–01Fh            |
| ADC10_A (see Table 6-38)<br>(MSP430F51x2 only) | 0740h        | 000h–01Fh            |
| Comparator_B (see Table 6-39)                  | 08C0h        | 000h–00Fh            |
| TD0 (see Table 6-40)                           | 0B00h        | 000h–03Fh            |
| TEC0 (see Table 6-42)                          | 0C00h        | 000h–007h            |
| TD1 (see Table 6-41)                           | 0B40h        | 000h–03Fh            |
| TEC1 (see Table 6-43)                          | 0C20h        | 000h–007h            |

**Table 6-14. Special Function Registers (Base Address: 0100h)**

| REGISTER DESCRIPTION  | REGISTER | OFFSET |
|-----------------------|----------|--------|
| SFR interrupt enable  | SFRIE1   | 00h    |
| SFR interrupt flag    | SFRIFG1  | 02h    |
| SFR reset pin control | SFRRPCR  | 04h    |

**Table 6-15. PMM Registers (Base Address: 0120h)**

| REGISTER DESCRIPTION     | REGISTER | OFFSET |
|--------------------------|----------|--------|
| PMM control 0            | PMMCTL0  | 00h    |
| PMM control 1            | PMMCTL1  | 02h    |
| SVS high-side control    | SVSMHCTL | 04h    |
| SVS low-side control     | SVSMLCTL | 06h    |
| PMM interrupt flags      | PMMIFG   | 0Ch    |
| PMM interrupt enable     | PMMIE    | 0Eh    |
| PMM power mode 5 control | PM5CTL0  | 10h    |

**Table 6-16. Flash Control Registers (Base Address: 0140h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| Flash control 1      | FCTL1    | 00h    |
| Flash control 3      | FCTL3    | 04h    |
| Flash control 4      | FCTL4    | 06h    |

**Table 6-17. CRC16 Registers (Base Address: 0150h)**

| REGISTER DESCRIPTION | REGISTER   | OFFSET |
|----------------------|------------|--------|
| CRC data input       | CRC16DI    | 00h    |
| CRC result           | CRC16INRES | 04h    |

**Table 6-18. RAM Control Registers (Base Address: 0158h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| RAM control 0        | RCCTL0   | 00h    |

**Table 6-19. Watchdog Registers (Base Address: 015Ch)**

| REGISTER DESCRIPTION   | REGISTER | OFFSET |
|------------------------|----------|--------|
| Watchdog timer control | WDTCTL   | 00h    |

**Table 6-20. UCS Registers (Base Address: 0160h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| UCS control 0        | UCSCTL0  | 00h    |
| UCS control 1        | UCSCTL1  | 02h    |
| UCS control 2        | UCSCTL2  | 04h    |
| UCS control 3        | UCSCTL3  | 06h    |
| UCS control 4        | UCSCTL4  | 08h    |
| UCS control 5        | UCSCTL5  | 0Ah    |
| UCS control 6        | UCSCTL6  | 0Ch    |
| UCS control 7        | UCSCTL7  | 0Eh    |
| UCS control 8        | UCSCTL8  | 10h    |

**Table 6-21. SYS Registers (Base Address: 0180h)**

| REGISTER DESCRIPTION          | REGISTER  | OFFSET |
|-------------------------------|-----------|--------|
| System control                | SYSCTL    | 00h    |
| Bootloader configuration area | SYSBSLC   | 02h    |
| JTAG mailbox control          | SYSJMBC   | 06h    |
| JTAG mailbox input 0          | SYSJMBI0  | 08h    |
| JTAG mailbox input 1          | SYSJMBI1  | 0Ah    |
| JTAG mailbox output 0         | SYSJMBO0  | 0Ch    |
| JTAG mailbox output 1         | SYSJMBO1  | 0Eh    |
| Bus Error vector generator    | SYSBERRIV | 18h    |
| User NMI vector generator     | SYSUNIV   | 1Ah    |
| System NMI vector generator   | SYSSNIV   | 1Ch    |
| Reset vector generator        | SYSRSTIV  | 1Eh    |

**Table 6-22. Shared Reference Registers (Base Address: 01B0h)**

| REGISTER DESCRIPTION     | REGISTER | OFFSET |
|--------------------------|----------|--------|
| Shared reference control | REFCTL   | 00h    |

**Table 6-23. Port Mapping Control (Base Address: 01C0h)**

| REGISTER DESCRIPTION  | REGISTER | OFFSET |
|-----------------------|----------|--------|
| Port mapping password | PMAPPWD  | 00h    |
| Port mapping control  | PMAPCTL  | 02h    |

**Table 6-24. Port Mapping for Port P1 (Base Address: 01C8h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| Port P1.0 mapping    | P1MAP0   | 00h    |
| Port P1.1 mapping    | P1MAP1   | 01h    |
| Port P1.2 mapping    | P1MAP2   | 02h    |
| Port P1.3 mapping    | P1MAP3   | 03h    |
| Port P1.4 mapping    | P1MAP4   | 04h    |
| Port P1.5 mapping    | P1MAP5   | 05h    |
| Port P1.6 mapping    | P1MAP6   | 06h    |
| Port P1.7 mapping    | P1MAP7   | 07h    |

**Table 6-25. Port Mapping for Port P2 (Base Address: 01D0h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| Port P2.0 mapping    | P2MAP0   | 00h    |
| Port P2.1 mapping    | P2MAP2   | 01h    |
| Port P2.2 mapping    | P2MAP2   | 02h    |
| Port P2.3 mapping    | P2MAP3   | 03h    |
| Port P2.4 mapping    | P2MAP4   | 04h    |
| Port P2.5 mapping    | P2MAP5   | 05h    |
| Port P2.6 mapping    | P2MAP6   | 06h    |
| Port P2.7 mapping    | P2MAP7   | 07h    |

**Table 6-26. Port Mapping for Port P3 (Base Address: 01D8h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| Port P3.0 mapping    | P3MAP0   | 00h    |
| Port P3.1 mapping    | P3MAP1   | 01h    |
| Port P3.2 mapping    | P3MAP2   | 02h    |
| Port P3.3 mapping    | P3MAP3   | 03h    |
| Port P3.4 mapping    | P3MAP4   | 04h    |
| Port P3.5 mapping    | P3MAP5   | 05h    |
| Port P3.6 mapping    | P3MAP6   | 06h    |
| Port P3.7 mapping    | P3MAP7   | 07h    |

**Table 6-27. Port Registers Port P1, P2 (Base Addresses: 0200h)**

| REGISTER DESCRIPTION           | REGISTER | OFFSET |
|--------------------------------|----------|--------|
| Port P1 input                  | P1IN     | 00h    |
| Port P1 output                 | P1OUT    | 02h    |
| Port P1 direction              | P1DIR    | 04h    |
| Port P1 pullup/pulldown enable | P1REN    | 06h    |
| Port P1 drive strength         | P1DS     | 08h    |
| Port P1 selection              | P1SEL    | 0Ah    |
| Port P1 interrupt vector word  | P1IV     | 0Eh    |
| Port P1 interrupt edge select  | P1IES    | 18h    |
| Port P1 interrupt enable       | P1IE     | 1Ah    |
| Port P1 interrupt flag         | P1IFG    | 1Ch    |
| Port P2 input                  | P2IN     | 01h    |
| Port P2 output                 | P2OUT    | 03h    |
| Port P2 direction              | P2DIR    | 05h    |
| Port P2 pullup/pulldown enable | P2REN    | 07h    |
| Port P2 drive strength         | P2DS     | 09h    |
| Port P2 selection              | P2SEL    | 0Bh    |
| Port P2 interrupt vector word  | P2IV     | 1Eh    |
| Port P2 interrupt edge select  | P2IES    | 19h    |
| Port P2 interrupt enable       | P2IE     | 1Bh    |
| Port P2 interrupt flag         | P2IFG    | 1Dh    |

**Table 6-28. Port Registers P3 (Base Addresses: 0220h)**

| REGISTER DESCRIPTION           | REGISTER | OFFSET |
|--------------------------------|----------|--------|
| Port P3 input                  | P3IN     | 00h    |
| Port P3 output                 | P3OUT    | 02h    |
| Port P3 direction              | P3DIR    | 04h    |
| Port P3 pullup/pulldown enable | P3REN    | 06h    |
| Port P3 drive strength         | P3DS     | 08h    |
| Port P3 selection              | P3SEL    | 0Ah    |

**Table 6-29. Port Registers PJ (Base Addresses: 0320h)**

| REGISTER DESCRIPTION           | REGISTER | OFFSET |
|--------------------------------|----------|--------|
| Port PJ input                  | PJIN     | 00h    |
| Port PJ output                 | PJOUT    | 02h    |
| Port PJ direction              | PJDIR    | 04h    |
| Port PJ pullup/pulldown enable | PJREN    | 06h    |
| Port PJ drive strength         | PJDS     | 08h    |
| Port PJ selection              | PJSEL    | 0Ah    |

**Table 6-30. TA0 Registers (Base Address: 03C0h)**

| REGISTER DESCRIPTION      | REGISTER | OFFSET |
|---------------------------|----------|--------|
| TA0 control               | TA0CTL   | 00h    |
| Capture/compare control 0 | TA0CCTL0 | 02h    |
| Capture/compare control 1 | TA0CCTL1 | 04h    |
| Capture/compare control 2 | TA0CCTL2 | 06h    |
| TA0 counter               | TA0R     | 10h    |
| Capture/compare 0         | TA0CCR0  | 12h    |
| Capture/compare 1         | TA0CCR1  | 14h    |
| Capture/compare 2         | TA0CCR2  | 16h    |
| TA0 expansion 0           | TA0EX0   | 20h    |
| TA0 interrupt vector      | TA0IV    | 2Eh    |

**Table 6-31. 32-Bit Hardware Multiplier Registers (Base Address: 04C0h)**

| REGISTER DESCRIPTION                                    | REGISTER  | OFFSET |
|---------------------------------------------------------|-----------|--------|
| 16-bit operand 1 – multiply                             | MPY       | 00h    |
| 16-bit operand 1 – signed multiply                      | MPYS      | 02h    |
| 16-bit operand 1 – multiply accumulate                  | MAC       | 04h    |
| 16-bit operand 1 – signed multiply accumulate           | MACS      | 06h    |
| 16-bit operand 2                                        | OP2       | 08h    |
| 16 × 16 result low word                                 | RESLO     | 0Ah    |
| 16 × 16 result high word                                | RESHI     | 0Ch    |
| 16 × 16 sum extension register                          | SUMEXT    | 0Eh    |
| 32-bit operand 1 – multiply low word                    | MPY32L    | 10h    |
| 32-bit operand 1 – multiply high word                   | MPY32H    | 12h    |
| 32-bit operand 1 – signed multiply low word             | MPYS32L   | 14h    |
| 32-bit operand 1 – signed multiply high word            | MPYS32H   | 16h    |
| 32-bit operand 1 – multiply accumulate low word         | MAC32L    | 18h    |
| 32-bit operand 1 – multiply accumulate high word        | MAC32H    | 1Ah    |
| 32-bit operand 1 – signed multiply accumulate low word  | MACS32L   | 1Ch    |
| 32-bit operand 1 – signed multiply accumulate high word | MACS32H   | 1Eh    |
| 32-bit operand 2 – low word                             | OP2L      | 20h    |
| 32-bit operand 2 – high word                            | OP2H      | 22h    |
| 32 × 32 result 0 – least significant word               | RES0      | 24h    |
| 32 × 32 result 1                                        | RES1      | 26h    |
| 32 × 32 result 2                                        | RES2      | 28h    |
| 32 × 32 result 3 – most significant word                | RES3      | 2Ah    |
| MPY32 control 0                                         | MPY32CTL0 | 2Ch    |

**Table 6-32. DMA General Control (Base Address: 0500h)**

| REGISTER DESCRIPTION | REGISTER | OFFSET |
|----------------------|----------|--------|
| DMA module control 0 | DMACTL0  | 00h    |
| DMA module control 1 | DMACTL1  | 02h    |
| DMA module control 2 | DMACTL2  | 04h    |
| DMA module control 3 | DMACTL3  | 06h    |
| DMA module control 4 | DMACTL4  | 08h    |
| DMA interrupt vector | DMAIV    | 0Eh    |

**Table 6-33. DMA Channel 0 (Base Address: 0510h)**

| REGISTER DESCRIPTION                   | REGISTER | OFFSET |
|----------------------------------------|----------|--------|
| DMA channel 0 control                  | DMA0CTL  | 00h    |
| DMA channel 0 source address low       | DMA0SAL  | 02h    |
| DMA channel 0 source address high      | DMA0SAH  | 04h    |
| DMA channel 0 destination address low  | DMA0DAL  | 06h    |
| DMA channel 0 destination address high | DMA0DAH  | 08h    |
| DMA channel 0 transfer size            | DMA0SZ   | 0Ah    |

**Table 6-34. DMA Channel 1 (Base Address: 0520h)**

| REGISTER DESCRIPTION                   | REGISTER | OFFSET |
|----------------------------------------|----------|--------|
| DMA channel 1 control                  | DMA1CTL  | 00h    |
| DMA channel 1 source address low       | DMA1SAL  | 02h    |
| DMA channel 1 source address high      | DMA1SAH  | 04h    |
| DMA channel 1 destination address low  | DMA1DAL  | 06h    |
| DMA channel 1 destination address high | DMA1DAH  | 08h    |
| DMA channel 1 transfer size            | DMA1SZ   | 0Ah    |

**Table 6-35. DMA Channel 2 (Base Address: 0530h)**

| REGISTER DESCRIPTION                   | REGISTER | OFFSET |
|----------------------------------------|----------|--------|
| DMA channel 2 control                  | DMA2CTL  | 00h    |
| DMA channel 2 source address low       | DMA2SAL  | 02h    |
| DMA channel 2 source address high      | DMA2SAH  | 04h    |
| DMA channel 2 destination address low  | DMA2DAL  | 06h    |
| DMA channel 2 destination address high | DMA2DAH  | 08h    |
| DMA channel 2 transfer size            | DMA2SZ   | 0Ah    |

**Table 6-36. USCI0\_A Registers (Base Address: 05C0h)**

| REGISTER DESCRIPTION       | REGISTER   | OFFSET |
|----------------------------|------------|--------|
| USCI control 0             | UCA0CTL0   | 01h    |
| USCI control 1             | UCA0CTL1   | 00h    |
| USCI baud rate 0           | UCA0BR0    | 06h    |
| USCI baud rate 1           | UCA0BR1    | 07h    |
| USCI modulation control    | UCA0MCTL   | 08h    |
| USCI status                | UCA0STAT   | 0Ah    |
| USCI receive buffer        | UCA0RXBUF  | 0Ch    |
| USCI transmit buffer       | UCA0TXBUF  | 0Eh    |
| USCI LIN control           | UCA0ABCTL  | 10h    |
| USCI IrDA transmit control | UCA0IRTCTL | 12h    |
| USCI IrDA receive control  | UCA0IRRCTL | 13h    |
| USCI interrupt enable      | UCA0IE     | 1Ch    |
| USCI interrupt flags       | UCA0IFG    | 1Dh    |
| USCI interrupt vector word | UCA0IV     | 1Eh    |

**Table 6-37. USCI0\_B Registers (Base Address: 05E0h)**

| REGISTER DESCRIPTION             | REGISTER  | OFFSET |
|----------------------------------|-----------|--------|
| USCI synchronous control 0       | UCB0CTL0  | 00h    |
| USCI synchronous control 1       | UCB0CTL1  | 01h    |
| USCI synchronous bit rate 0      | UCB0BR0   | 06h    |
| USCI synchronous bit rate 1      | UCB0BR1   | 07h    |
| USCI synchronous status          | UCB0STAT  | 0Ah    |
| USCI synchronous receive buffer  | UCB0RXBUF | 0Ch    |
| USCI synchronous transmit buffer | UCB0TXBUF | 0Eh    |
| USCI I2C own address             | UCB0I2COA | 10h    |
| USCI I2C slave address           | UCB0I2CSA | 12h    |
| USCI interrupt enable            | UCB0IE    | 1Ch    |
| USCI interrupt flags             | UCB0IFG   | 1Dh    |
| USCI interrupt vector word       | UCB0IV    | 1Eh    |

**Table 6-38. ADC10\_A Registers (MSP430F51x2 Devices Only) (Base Address: 0740h)**

| REGISTER DESCRIPTION                     | REGISTER   | OFFSET |
|------------------------------------------|------------|--------|
| ADC10_A control 0                        | ADC10CTL0  | 00h    |
| ADC10_A control 1                        | ADC10CTL1  | 02h    |
| ADC10_A control 2                        | ADC10CTL2  | 04h    |
| ADC10_A window comparator low threshold  | ADC10LO    | 06h    |
| ADC10_A window comparator high threshold | ADC10HI    | 08h    |
| ADC10_A memory control register 0        | ADC10MCTL0 | 0Ah    |
| ADC10_A conversion memory register       | ADC10MEM0  | 12h    |
| ADC10_A interrupt enable                 | ADC10IE    | 1Ah    |
| ADC10_A interrupt flags                  | ADC10IGH   | 1Ch    |
| ADC10_A interrupt vector word            | ADC10IV    | 1Eh    |

**Table 6-39. Comparator\_B Registers (Base Address: 08C0h)**

| REGISTER DESCRIPTION               | REGISTER | OFFSET |
|------------------------------------|----------|--------|
| Comparator_B control 0             | CBCTL0   | 00h    |
| Comparator_B control 1             | CBCTL1   | 02h    |
| Comparator_B control 2             | CBCTL2   | 04h    |
| Comparator_B control 3             | CBCTL3   | 06h    |
| Comparator_B interrupt             | CBINT    | 0Ch    |
| Comparator_B interrupt vector word | CBIV     | 0Eh    |

**Table 6-40. TD0 Registers (Base Address: 0B00h)**

| REGISTER DESCRIPTION          | REGISTER | OFFSET |
|-------------------------------|----------|--------|
| TD0 control 0                 | TD0CTL0  | 00h    |
| TD0 control 1                 | TD0CTL1  | 02h    |
| TD0 control 2                 | TD0CTL2  | 04h    |
| TD0 counter                   | TD0R     | 06h    |
| Capture/compare control 0     | TD0CCTL0 | 08h    |
| Capture/compare 0             | TD0CCR0  | 0Ah    |
| Capture/compare latch 0       | TD0CL0   | 0Ch    |
| Capture/compare control 1     | TD0CCTL1 | 0Eh    |
| Capture/compare 1             | TD0CCR1  | 10h    |
| Capture/compare latch 1       | TD0CL1   | 12h    |
| Capture/compare control 2     | TD0CCTL2 | 14h    |
| Capture/compare 2             | TD0CCR2  | 16h    |
| Capture/compare latch 2       | TD0CL2   | 18h    |
| TD0 high-resolution control 0 | TD0HCTL0 | 38h    |
| TD0 high-resolution control 1 | TD0HCTL1 | 3Ah    |
| TD0 high-resolution interrupt | TD0HINT  | 3Ch    |
| TD0 interrupt vector          | TD0IV    | 3Eh    |

**Table 6-41. TD1 Registers (Base Address: 0B40h)**

| REGISTER DESCRIPTION          | REGISTER | OFFSET |
|-------------------------------|----------|--------|
| TD1 control 0                 | TD1CTL0  | 00h    |
| TD1 control 1                 | TD1CTL1  | 02h    |
| TD1 control 2                 | TD1CTL2  | 04h    |
| TD1 counter                   | TD1R     | 06h    |
| Capture/compare control 0     | TD1CCTL0 | 08h    |
| Capture/compare 0             | TD1CCR0  | 0Ah    |
| Capture/compare latch 0       | TD1CL0   | 0Ch    |
| Capture/compare control 1     | TD1CCTL1 | 0Eh    |
| Capture/compare 1             | TD1CCR1  | 10h    |
| Capture/compare latch 1       | TD1CL1   | 12h    |
| Capture/compare control 2     | TD1CCTL2 | 14h    |
| Capture/compare 2             | TD1CCR2  | 16h    |
| Capture/compare latch 2       | TD1CL2   | 18h    |
| TD1 high-resolution control 0 | TD1HCTL0 | 38h    |
| TD1 high-resolution control 1 | TD1HCTL1 | 3Ah    |
| TD1 high-resolution interrupt | TD1HINT  | 3Ch    |
| TD1 interrupt vector          | TD1IV    | 3Eh    |

**Table 6-42. TEC0 Registers (Base Address: 0C00h)**

| REGISTER DESCRIPTION                            | REGISTER | OFFSET |
|-------------------------------------------------|----------|--------|
| Timer event control 0 external control 0        | TEC0CTL0 | 00h    |
| Timer event control 0 external control          | TEC0CTL1 | 02h    |
| Timer event control 0 external control          | TEC0CTL2 | 04h    |
| Timer event control 0 status                    | TEC0STA  | 06h    |
| Timer event control 0 external interrupt        | TEC0XINT | 08h    |
| Timer event control 0 external interrupt vector | TEC0IV   | 0Ah    |

**Table 6-43. TEC1 Registers (Base Address: 0C20h)**

| REGISTER DESCRIPTION                            | REGISTER | OFFSET |
|-------------------------------------------------|----------|--------|
| Timer event control 1 external control 0        | TEC1CTL0 | 00h    |
| Timer event control 1 external control          | TEC1CTL1 | 02h    |
| Timer event control 1 external control          | TEC1CTL2 | 04h    |
| Timer event control 1 status                    | TEC1STA  | 06h    |
| Timer event control 1 external interrupt        | TEC1XINT | 08h    |
| Timer event control 1 external interrupt vector | TEC1IV   | 0Ah    |

## 6.10 Input/Output Diagrams

### 6.10.1 Port P1 (P1.0 to P1.5) Input/Output With Schmitt Trigger

Figure 6-2 shows the port diagram. Table 6-44 summarizes the selection of the pin function.

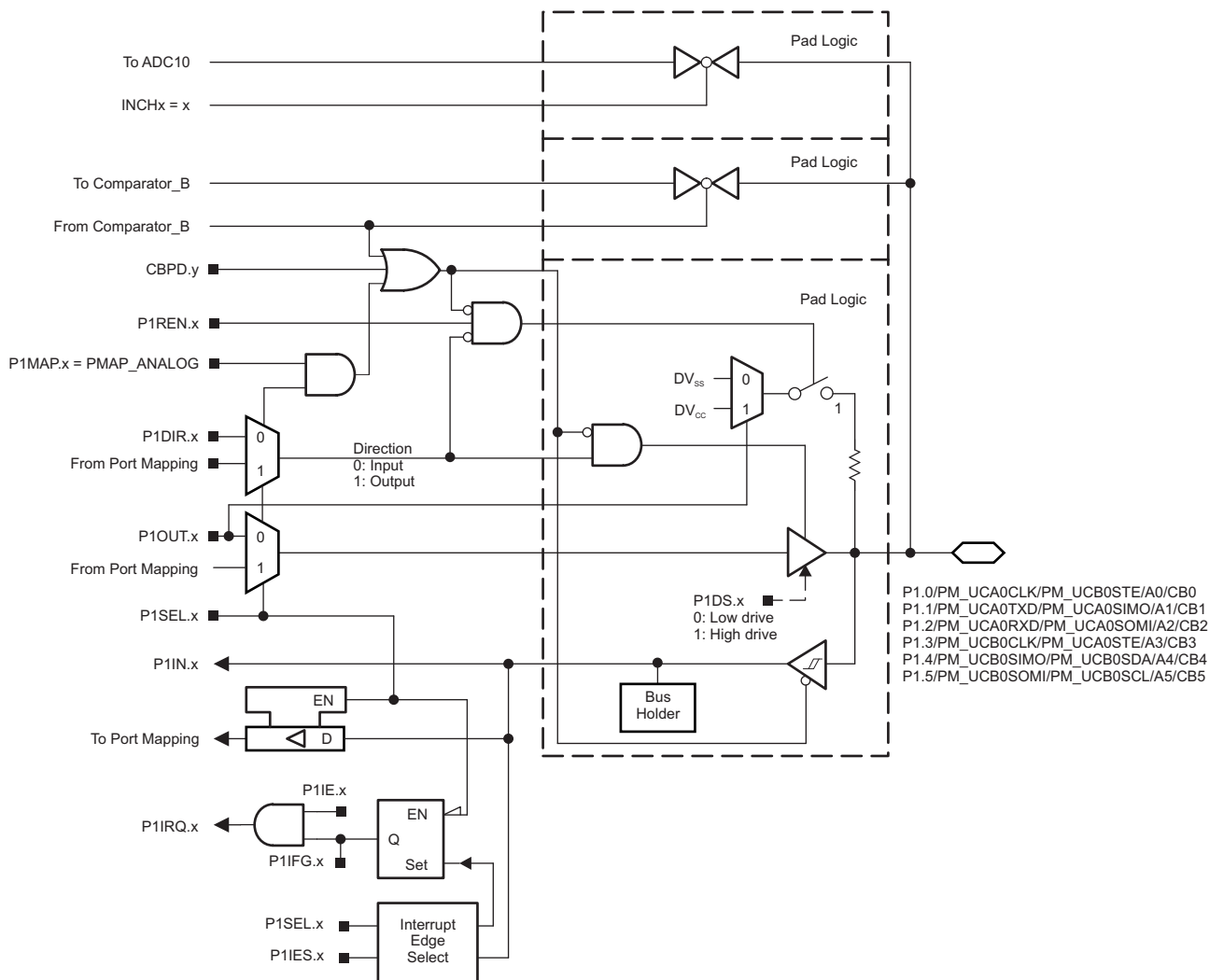


Figure 6-2. Port P1 (P1.0 to P1.5) Diagram

**Table 6-44. Port P1 (P1.0 to P1.5) Pin Functions**

| PIN NAME (P1.x)                      | x | FUNCTION                                  | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |                 |           |
|--------------------------------------|---|-------------------------------------------|----------------------------------------|---------|-----------------|-----------|
|                                      |   |                                           | P1DIR.x                                | P1SEL.x | P1MAP.x         | CBPD.y    |
| P1.0/<br>PM_UCA0CLK/<br>PM_UCB0STE/  | 0 | P1.x (I/O)                                | I: 0; O: 1                             | 0       | X               | 0         |
|                                      |   | UCA0CLK/UCB0STE <sup>(2) (3)</sup>        | 0                                      | 1       | default         | 0         |
| A0/                                  |   | A0 <sup>(4)</sup>                         | X                                      | 1       | 31<br>INCHx = 0 | X         |
| CB0                                  |   | CB0                                       | X                                      | X       | X               | 1 (y = 0) |
| P1.1/<br>PM_UCA0TXD/<br>PM_UCA0SIMO/ | 1 | P1.x (I/O)                                | I: 0; O: 1                             | 0       | X               | 0         |
|                                      |   | PM_UCA0TXD/PM_UCA0SIMO <sup>(2)</sup>     | 0                                      | 1       | default         | 0         |
| A1/                                  |   | A1 <sup>(4)</sup>                         | X                                      | 1       | 31<br>INCHx = 1 | X         |
| CB1                                  |   | CB1                                       | X                                      | X       | X               | 1 (y = 1) |
| P1.2/<br>PM_UCA0RXD/<br>PM_UCA0SOMI/ | 2 | P1.x (I/O)                                | I: 0; O: 1                             | 0       | X               | 0         |
|                                      |   | PM_UCA0RXD/PM_UCA0SOMI <sup>(2)</sup>     | 0                                      | 1       | default         | 0         |
| A2/                                  |   | A2 <sup>(4)</sup>                         | X                                      | 1       | 31<br>INCHx = 2 | X         |
| CB2                                  |   | CB2                                       | X                                      | X       | X               | 1 (y = 2) |
| P1.3/<br>PM_UCB0CLK/<br>PM_UCA0STE/  | 3 | P1.x (I/O)                                | I: 0; O: 1                             | 0       | X               | 0         |
|                                      |   | UCB0CLK/UCA0STE <sup>(2)</sup>            | 0                                      | 1       | default         | 0         |
| A3/                                  |   | A3 <sup>(4)</sup>                         | X                                      | 1       | 31<br>INCHx = 3 | X         |
| CB3                                  |   | CB3                                       | X                                      | X       | X               | 1 (y = 3) |
| P1.4/<br>PM_UCB0SIMO/<br>PM_UCB0SDA/ | 4 | P1.x (I/O)                                | I: 0; O: 1                             | 0       | X               | 0         |
|                                      |   | PM_UCB0SIMO/PM_UCB0SDA <sup>(2) (5)</sup> | 0                                      | 1       | default         | 0         |
| A4/                                  |   | A4 <sup>(4)</sup>                         | X                                      | 1       | 31<br>INCHx = 4 | X         |
| CB4                                  |   | CB4                                       | X                                      | X       | X               | 1 (y = 4) |
| P1.5/<br>PM_UCB0SOMI/<br>PM_UCB0SCL/ | 5 | P1.x (I/O)                                | I: 0; O: 1                             | 0       | X               | 0         |
|                                      |   | PM_UCB0SOMI/PM_UCB0SCL <sup>(2) (5)</sup> | 0                                      | 1       | default         | 0         |
| A5/                                  |   | A5 <sup>(4)</sup>                         | X                                      | 1       | 31<br>INCHx = 5 | X         |
| CB5                                  |   | CB5                                       | X                                      | X       | X               | 1 (y = 5) |

(1) X = Don't care

(2) The pin direction is controlled by the USCI module.

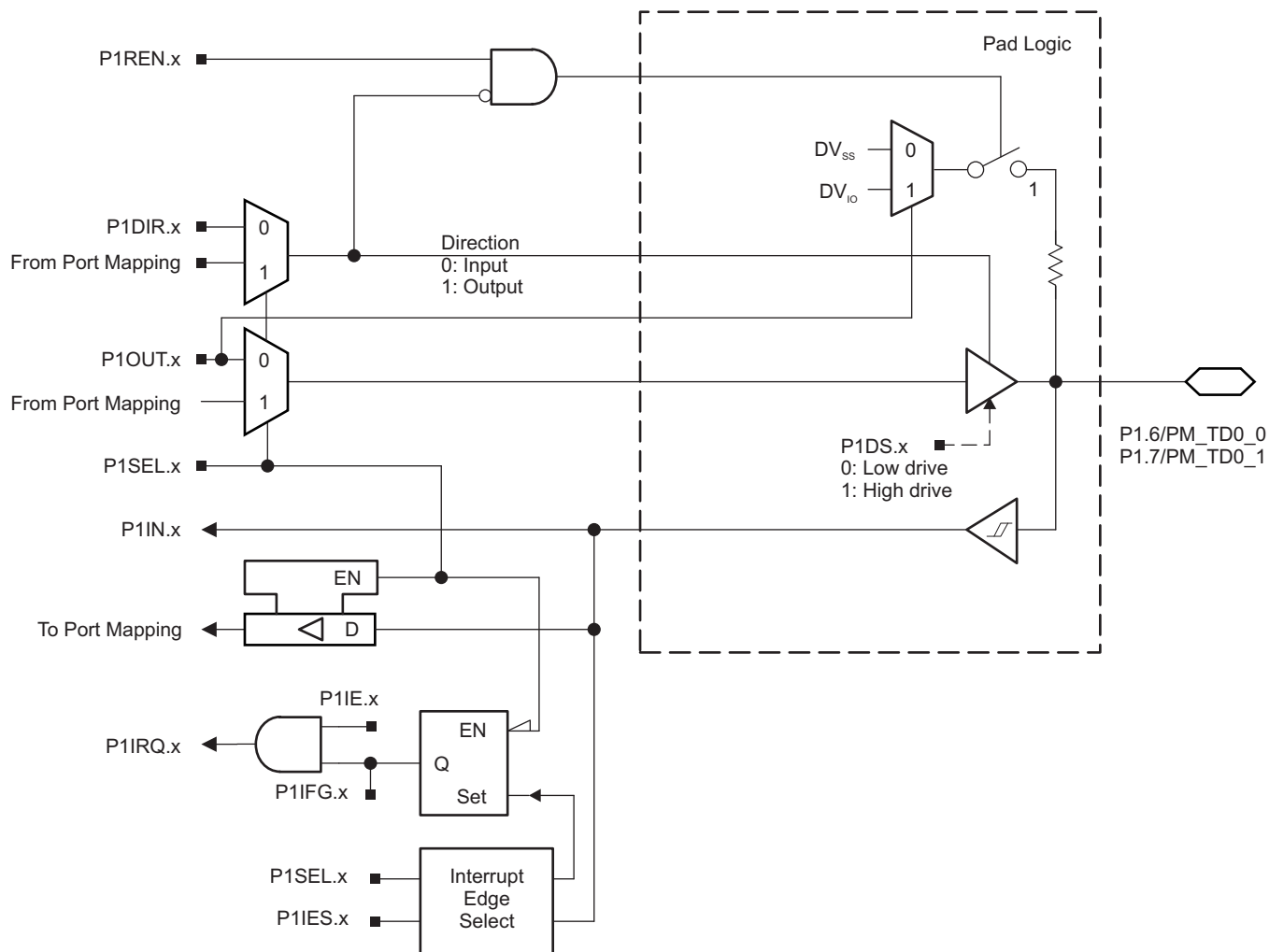
(3) UCA0CLK function takes precedence over UCB0STE function. If the pin is required as UCA0CLK input or output, USCI\_B0 is forced to 3-wire SPI mode if 4-wire SPI mode is selected.

(4) MSP430F51x2 device only

(5) If the I<sup>2</sup>C functionality is selected, the output drives only the logical 0 to V<sub>SS</sub> level.

### 6.10.2 Port P1 (P1.6 to P1.7) Input/Output With Schmitt Trigger

Figure 6-3 shows the port diagram. Table 6-45 summarizes the selection of the pin function.



### Figure 6-3. Port P1 (P1.6 and P1.7) Diagram

### Table 6-45. Port P1 (P1.6 and P1.7) Pin Functions

| PIN NAME (P1.x)   | x | FUNCTION   | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |         |
|-------------------|---|------------|----------------------------------------|---------|---------|
|                   |   |            | P1DIR.x                                | P1SEL.x | P1MAP.x |
| P1.6/<br>PM_TD0.0 | 6 | P1.x (I/O) | I: 0; O: 1                             | 0       | X       |
|                   |   | TD0.CCI0A  | 0                                      | 1       | default |
|                   |   | TD0.TA0    | 1                                      | 1       | default |
| P1.7/<br>PM_TD0.1 | 7 | P1.x (I/O) | I: 0; O: 1                             | 0       | X       |
|                   |   | TD0.CCI1A  | 0                                      | 1       | default |
|                   |   | TD0.TA1    | 1                                      | 1       | default |

(1)  $X = \text{Don't care}$

### 6.10.3 Port P2 (P2.0 to P2.7) Input/Output With Schmitt Trigger

Figure 6-4 shows the port diagram. Table 6-46 summarizes the selection of the pin function.

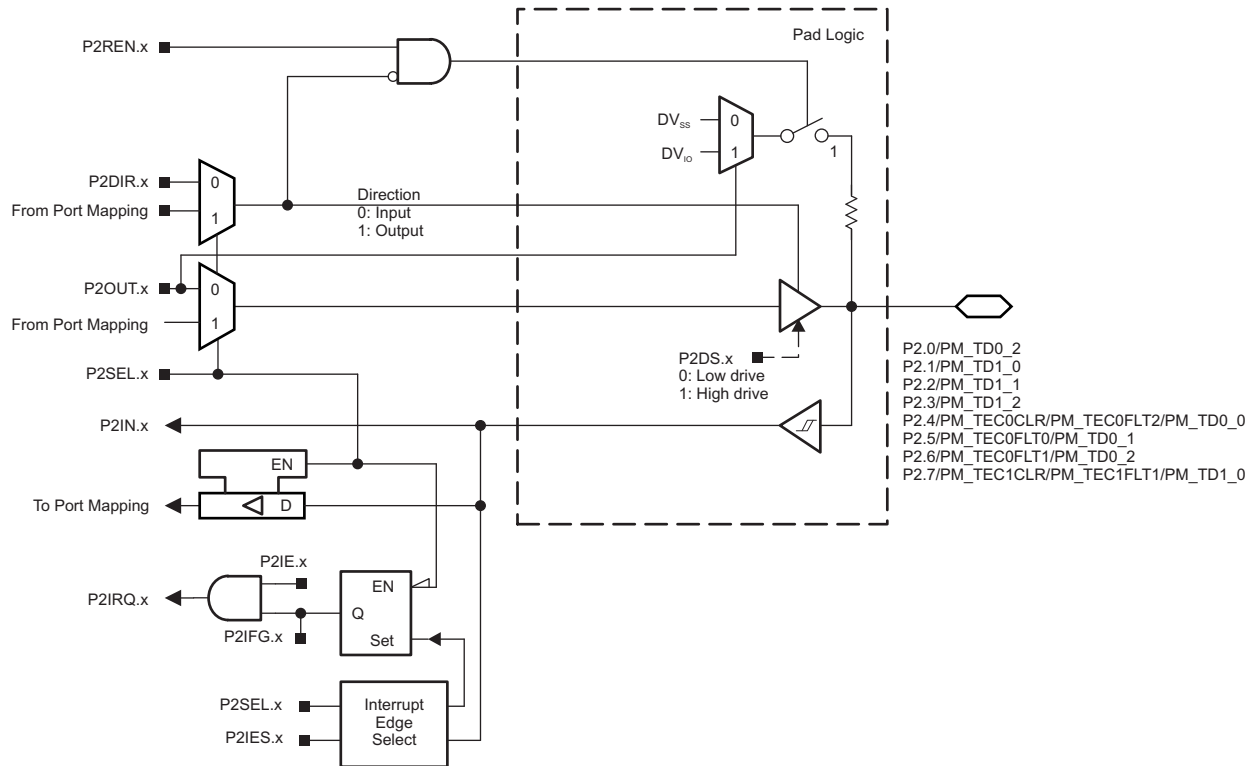


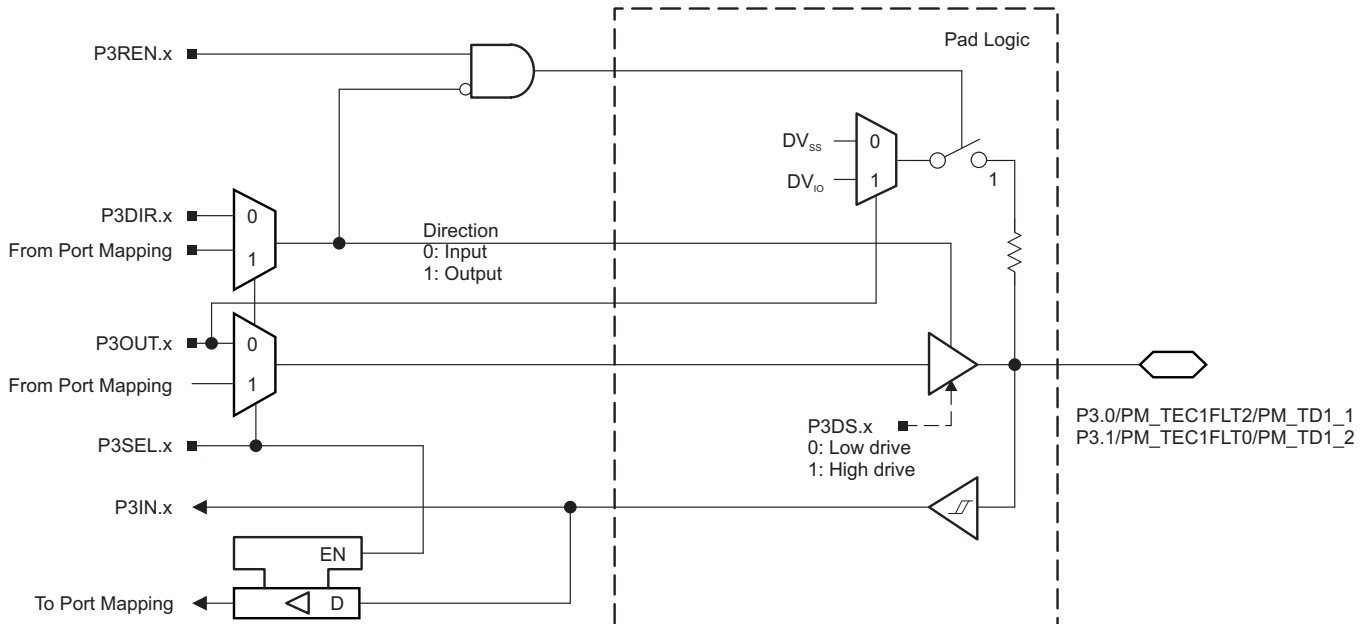
Figure 6-4. Port P2 (P2.0 to P2.7) Diagram

**Table 6-46. Port P2 (P2.0 to P2.7) Pin Functions**

| PIN NAME (P2.x)                                  | x | FUNCTION                                                       | CONTROL BITS OR SIGNALS |         |         |
|--------------------------------------------------|---|----------------------------------------------------------------|-------------------------|---------|---------|
|                                                  |   |                                                                | P2DIR.x                 | P2SEL.x | P2MAP.x |
| P2.0/<br>PM_TD0.2                                | 0 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | X       |
|                                                  |   | TD0.CCI2A                                                      | 0                       | 1       | default |
|                                                  |   | TD0.TA2                                                        | 1                       | 1       | default |
| P2.1/<br>PM_TD1.0                                | 1 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | X       |
|                                                  |   | TD1.CCI0A                                                      | 0                       | 1       | default |
|                                                  |   | TD1.TA0                                                        | 1                       | 1       | default |
| P2.2/<br>PM_TD1.1                                | 2 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | X       |
|                                                  |   | TD1.CCI1A                                                      | 0                       | 1       | default |
|                                                  |   | TD1.TA1                                                        | 1                       | 1       | default |
| P2.3/<br>PM_TD1.2                                | 3 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | 0       |
|                                                  |   | TD1.CCI2A                                                      | 0                       | 1       | default |
|                                                  |   | TD1.TA2                                                        | 1                       | 1       | default |
| P2.4/<br>PM_TEC0CLR/<br>PM_TEC0FLT2/<br>PM_TD0.0 | 4 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | X       |
|                                                  |   | TD0.TECEXTCLR, controlled by enable signals in the TEC0 module | 0                       | 1       | default |
|                                                  |   | TD0.TECXFLT2, controlled by enable signals in the TEC0 module  | 0                       | 1       | default |
|                                                  |   | TD0.TA0                                                        | 1                       | 1       | default |
| P2.5/<br>PM_TEC0FLT0/<br>PM_TD0.1                | 5 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | x       |
|                                                  |   | TD0.TECXFLT0, controlled by enable signals in the TEC0 module  | 0                       | 1       | default |
|                                                  |   | TD0.TA1                                                        | 1                       | 1       | default |
| P2.6/<br>PM_TEC0FLT1/<br>PM_TD0.2                | 6 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | X       |
|                                                  |   | TD0.TECXFLT1, controlled by enable signals in the TEC0 module  | 0                       | 1       | default |
|                                                  |   | TD0.TA2                                                        | 1                       | 1       | default |
| P2.7/<br>PM_TEC1CLR/<br>PM_TEC1FLT1/<br>PM_TD1.0 | 7 | P2.x (I/O)                                                     | I: 0; O: 1              | 0       | X       |
|                                                  |   | TD1.TECEXTCLR, controlled by enable signals in the TEC1 module | 0                       | 1       | default |
|                                                  |   | TD1.TECXFLT1, controlled by enable signals in the TEC1 module  | 0                       | 1       | default |
|                                                  |   | TD1.TA0                                                        | 1                       | 1       | default |

#### 6.10.4 Port P3 (P3.0 and P3.1) Input/Output With Schmitt Trigger

Figure 6-5 shows the port diagram. Table 6-47 summarizes the selection of the pin function.



**Figure 6-5. Port P3 (P3.0 and P3.1) Diagram**

**Table 6-47. Port P3 (P3.0 and P3.1) Pin Functions**

| PIN NAME (P3.x) | x | FUNCTION                                                      | CONTROL BITS OR SIGNALS |         |         |
|-----------------|---|---------------------------------------------------------------|-------------------------|---------|---------|
|                 |   |                                                               | P3DIR.x                 | P3SEL.x | P3MAP.x |
| P3.0/           | 0 | P3.x (I/O)                                                    | I: 0; O: 1              | 0       | X       |
| PM_TEC1FLT2/    |   | TD1.TECXFLT2, controlled by enable signals in the TEC1 module | 0                       | 1       | default |
| PM_TD1.1        |   | TD1.TA1                                                       | 1                       | 1       | default |
| P3.1/           | 1 | P3.x (I/O)                                                    | I: 0; O: 1              | 0       | X       |
| PM_TEC1FLT0/    |   | TD1.TECXFLT0, controlled by enable signals in the TEC1 module | 0                       | 1       | default |
| PM_TD1.2        |   | TD1.TA2                                                       | 1                       | 1       | default |

### 6.10.5 Port P3 (P3.2 and P3.3) Input/Output With Schmitt Trigger

Figure 6-6 shows the port diagram. Table 6-48 summarizes the selection of the pin function.

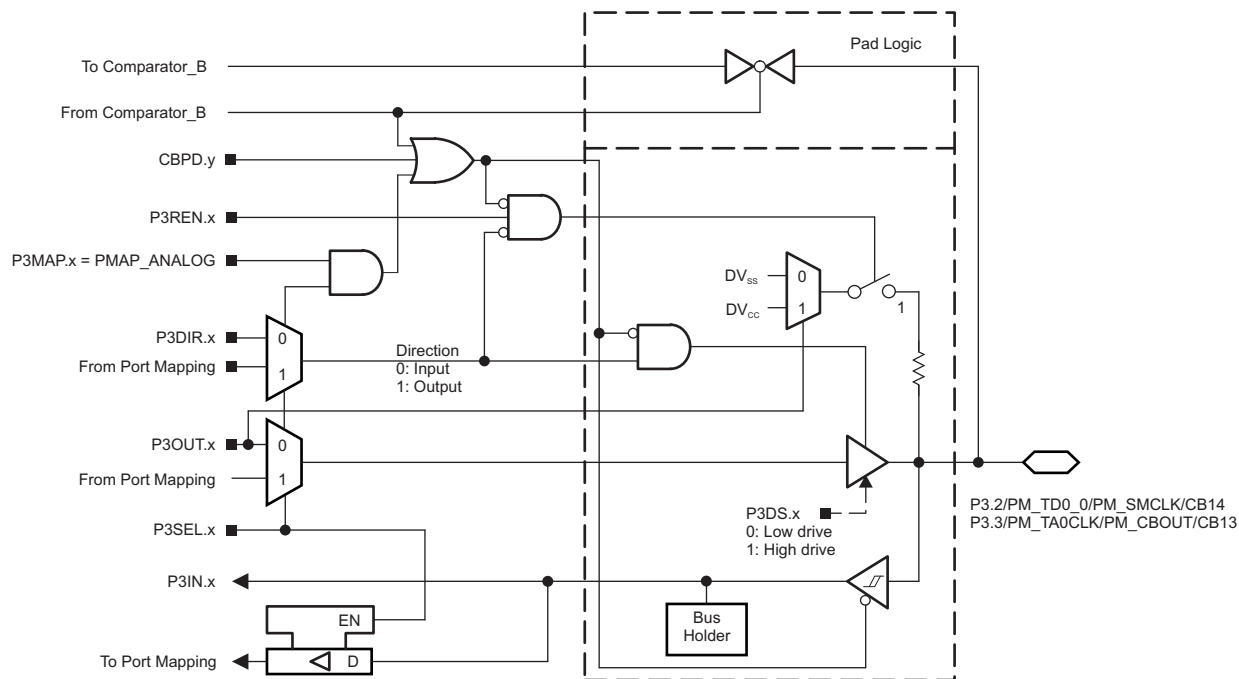


Figure 6-6. Port P3 (P3.2 and P3.3) Diagram

Table 6-48. Port P3 (P3.2 and P3.3) Pin Functions

| PIN NAME (P3.x)                          | x | FUNCTION     | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |         |            |
|------------------------------------------|---|--------------|----------------------------------------|---------|---------|------------|
|                                          |   |              | P3DIR.x                                | P3SEL.x | P3MAP.x | CBPD.y     |
| P3.2/<br>PM_TD0.0/<br>PM_SMCLK/<br>CB14  | 2 | P3.x (I/O)   | I: 0; O: 1                             | 0       | X       | 0          |
|                                          |   | TD0.CCI0A    | 0                                      | 1       | default | 0          |
|                                          |   | SMCLK output | 1                                      | 1       | default | 0          |
|                                          |   | CB14         | X                                      | X       | X       | 1 (y = 14) |
| P3.3/<br>PM_TA0CLK/<br>PM_CBOUT/<br>CB13 | 3 | P3.x (I/O)   | I: 0; O: 1                             | 0       | X       | 0          |
|                                          |   | TA0.TA0CLK   | 0                                      | 1       | default | 0          |
|                                          |   | CBOUT        | 1                                      | 1       | default | 0          |
|                                          |   | CB13         | X                                      | X       | X       | 1 (y = 13) |

(1) X = Don't care

### 6.10.6 Port P3 (P3.4) Input/Output With Schmitt Trigger

Figure 6-7 shows the port diagram. Table 6-49 summarizes the selection of the pin function.

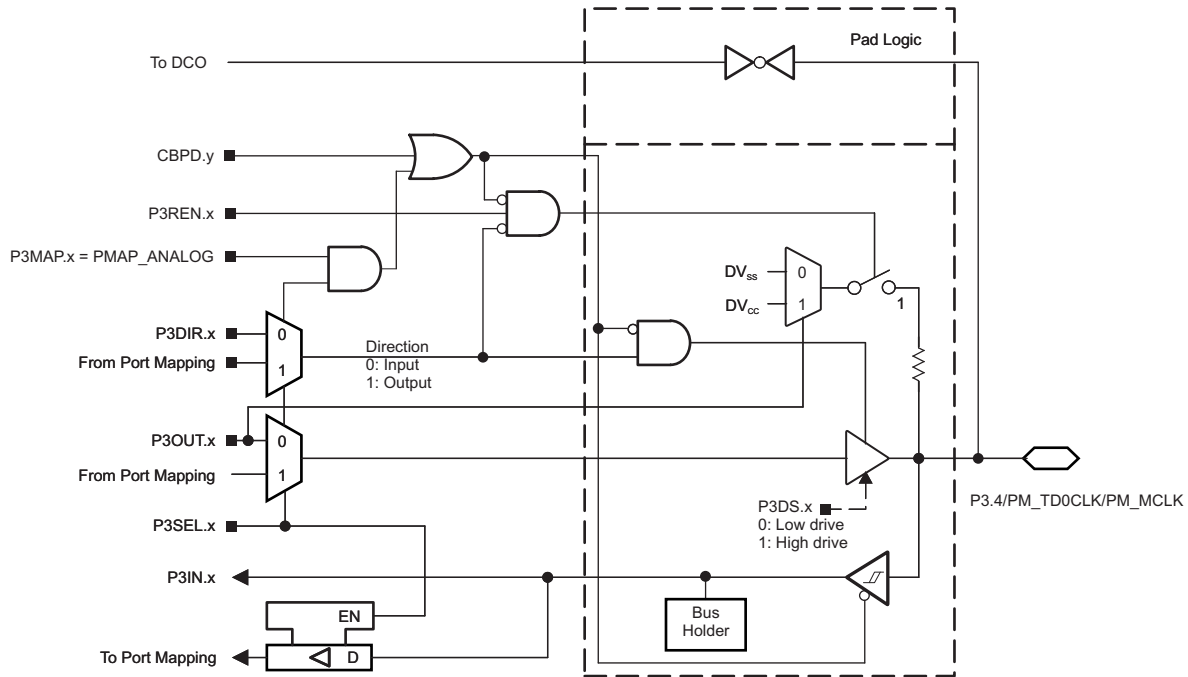


Figure 6-7. Port P3 (P3.4) Diagram

Table 6-49. Port P3 (P3.4) Pin Functions

| PIN NAME (P3.x) | x | FUNCTION        | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |         |   |
|-----------------|---|-----------------|----------------------------------------|---------|---------|---|
|                 |   |                 | P3DIR.x                                | P3SEL.x | P3MAP.x |   |
| P3.4/           | 4 | P3.x (I/O)      | I: 0; O: 1                             | 0       | X       | 0 |
| PM_TD0CLK/      |   | TD0 clock input | 0                                      | 1       | default | 0 |
| PM_MCLK         |   | MCLK output     | 1                                      | 1       | default | 0 |

(1) X = Don't care

### 6.10.7 Port P3 (P3.5) Input/Output With Schmitt Trigger

Figure 6-8 shows the port diagram. Table 6-50 summarizes the selection of the pin function.

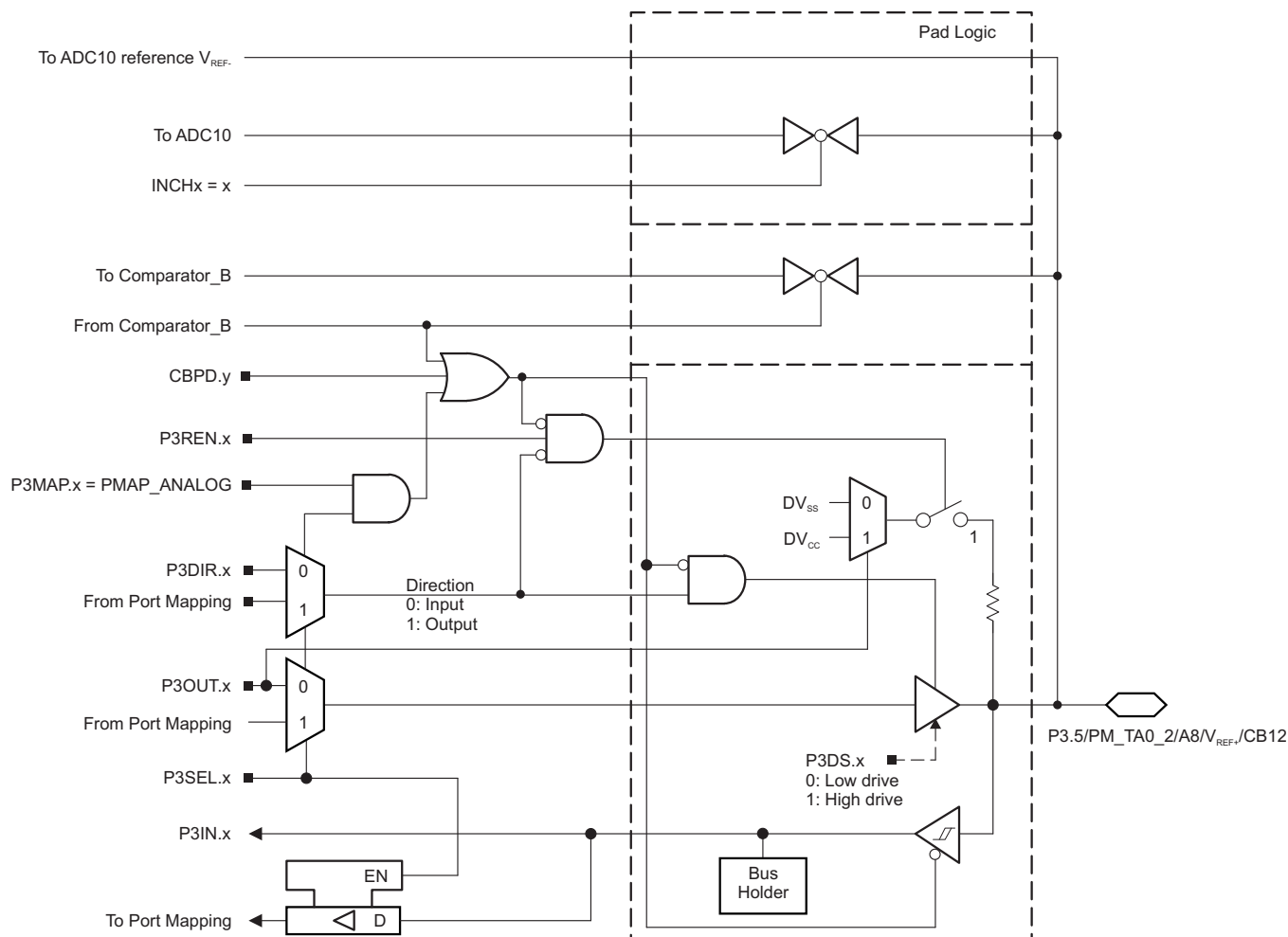


Figure 6-8. Port P3 (P3.5) Diagram

Table 6-50. Port P3 (P3.5) Pin Functions

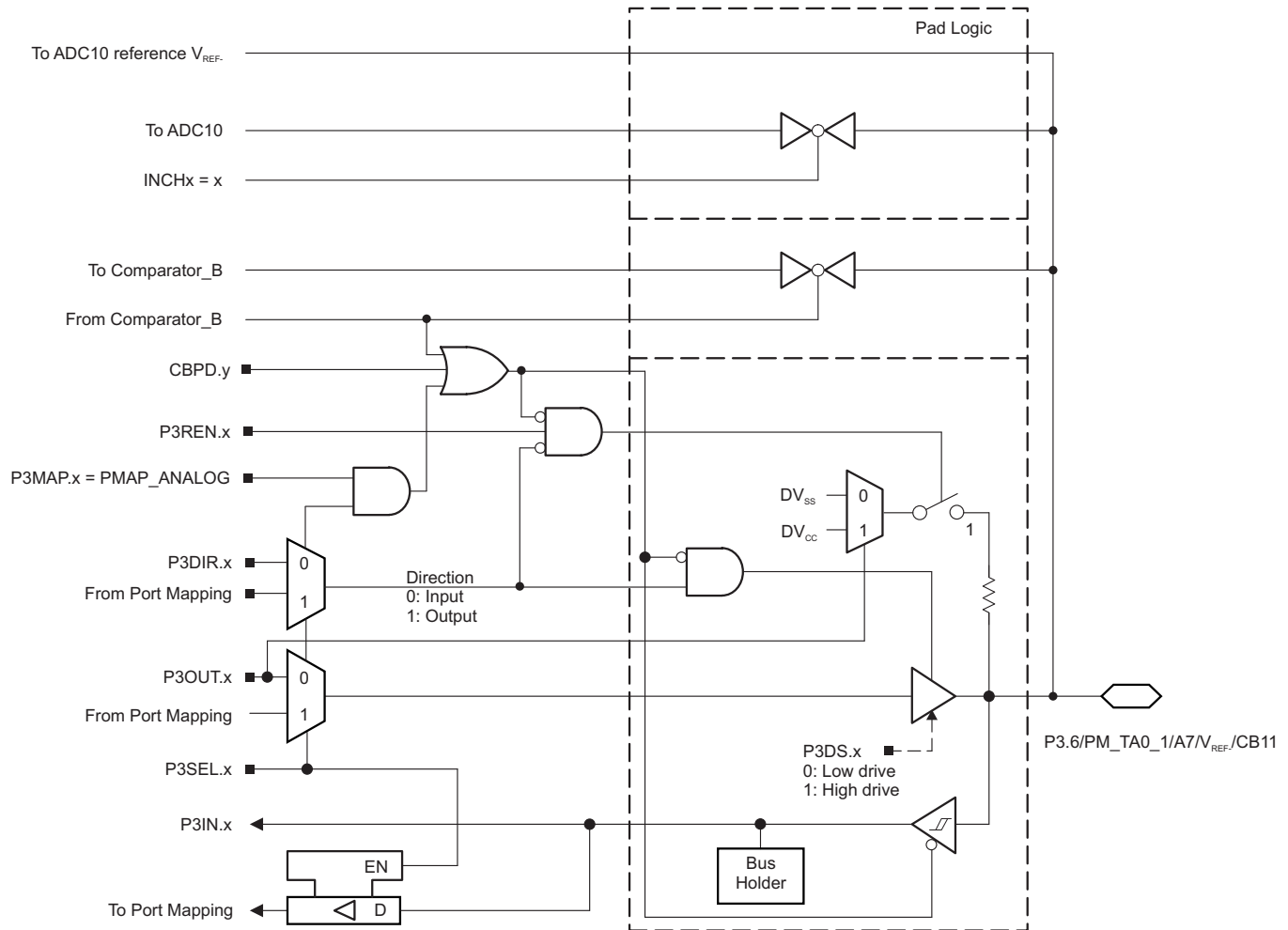
| PIN NAME (P3.x) | x | FUNCTION              | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |         |            |
|-----------------|---|-----------------------|----------------------------------------|---------|---------|------------|
|                 |   |                       | P3DIR.x                                | P3SEL.x | P3MAP.x | CBPD.y     |
| P3.5/           | 5 | P3.x (I/O)            | I: 0; O: 1                             | 0       | X       | 0          |
| PM_TA0.2/       |   | TA0.CCI2A             | 0                                      | 1       | default | 0          |
|                 |   | TA0.TA2               | 1                                      | 1       | default | 0          |
| VEREF+/-        |   | VEREF+ <sup>(2)</sup> | X                                      | 1       | 31      | X          |
| A8/             |   | A8 <sup>(2)</sup>     | X                                      | 1       | INCHx=8 | X          |
| CB12            |   | CB12                  | X                                      | X       | X       | 1 (y = 12) |

(1) X = Don't care

(2) MSP430F51x2 devices only.

### 6.10.8 Port P3 (P3.6) Input/Output With Schmitt Trigger

Figure 6-9 shows the port diagram. Table 6-51 summarizes the selection of the pin function.



**Figure 6-9. Port P3 (P3.6) Diagram**

**Table 6-51. Port P3 (P3.6) Pin Functions**

| PIN NAME (P3.x) | x | FUNCTION                  | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |                 |            |
|-----------------|---|---------------------------|----------------------------------------|---------|-----------------|------------|
|                 |   |                           | P3DIR.x                                | P3SEL.x | P3MAP.x         | CBPD.y     |
| P3.6/           | 6 | P3.x (I/O) <sup>(2)</sup> | I: 0; O: 1                             | 0       | X               | 0          |
| PM_TA0.1/       |   | TA0.CCR0                  | 0                                      | 1       | default         | 0          |
|                 |   | TA0.TA1                   | 1                                      | 1       | default         | 0          |
| VEREF-/         |   | VEREF- <sup>(3)</sup>     | X                                      | 1       | 31              | X          |
| A7/             |   | A7 <sup>(3)</sup>         | X                                      | 1       | 31<br>INCHx = 7 | X          |
| CB11            |   | CB11                      | X                                      | X       | 0               | 1 (y = 11) |

- (1) X = Don't care  
(2) Default condition.  
(3) MSP430F51x2 devices only.

### 6.10.9 Port P3 (P3.7) Input/Output With Schmitt Trigger

Figure 6-10 shows the port diagram. Table 6-52 summarizes the selection of the pin function.

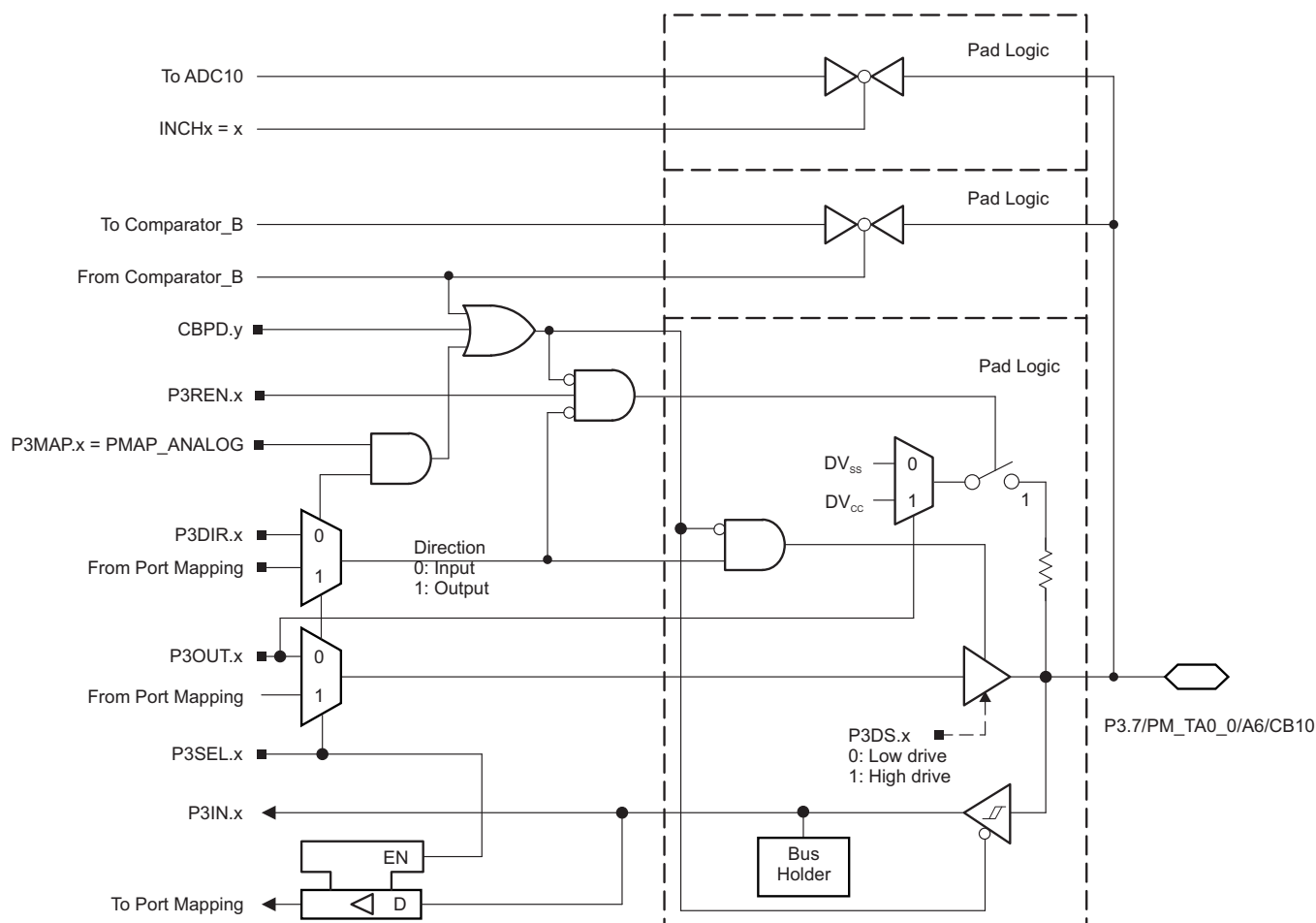


Figure 6-10. Port P3 (P3.7) Diagram

Table 6-52. Port P3 (P3.7) Pin Functions

| PIN NAME (P3.x) | x | FUNCTION                  | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |                            |            |
|-----------------|---|---------------------------|----------------------------------------|---------|----------------------------|------------|
|                 |   |                           | P3DIR.x                                | P3SEL.2 | P3MAP.x                    | CBPD.y     |
| P3.7/           | 7 | P3.x (I/O) <sup>(1)</sup> | I: 0; O: 1                             | 0       | X                          | 0          |
| PM_TA0.0/       |   | TA0.CCR0                  | 0                                      | 1       | default                    | 0          |
|                 |   | TA0.TA0                   | 1                                      | 1       | default                    | 0          |
| A6/             |   | A6 <sup>(2)</sup>         | X                                      | 1       | <sup>31</sup><br>INCHx = 6 | X          |
| CB10            |   | CB10                      | X                                      | X       | 0                          | 1 (y = 10) |

(1) X = Don't care

(2) MSP430F51x2 devices only.

### 6.10.10 Port J (PJ.0) JTAG Pin TDO, Input/Output With Schmitt Trigger or Output

Figure 6-11 shows the port diagram. Table 6-53 summarizes the selection of the pin function.

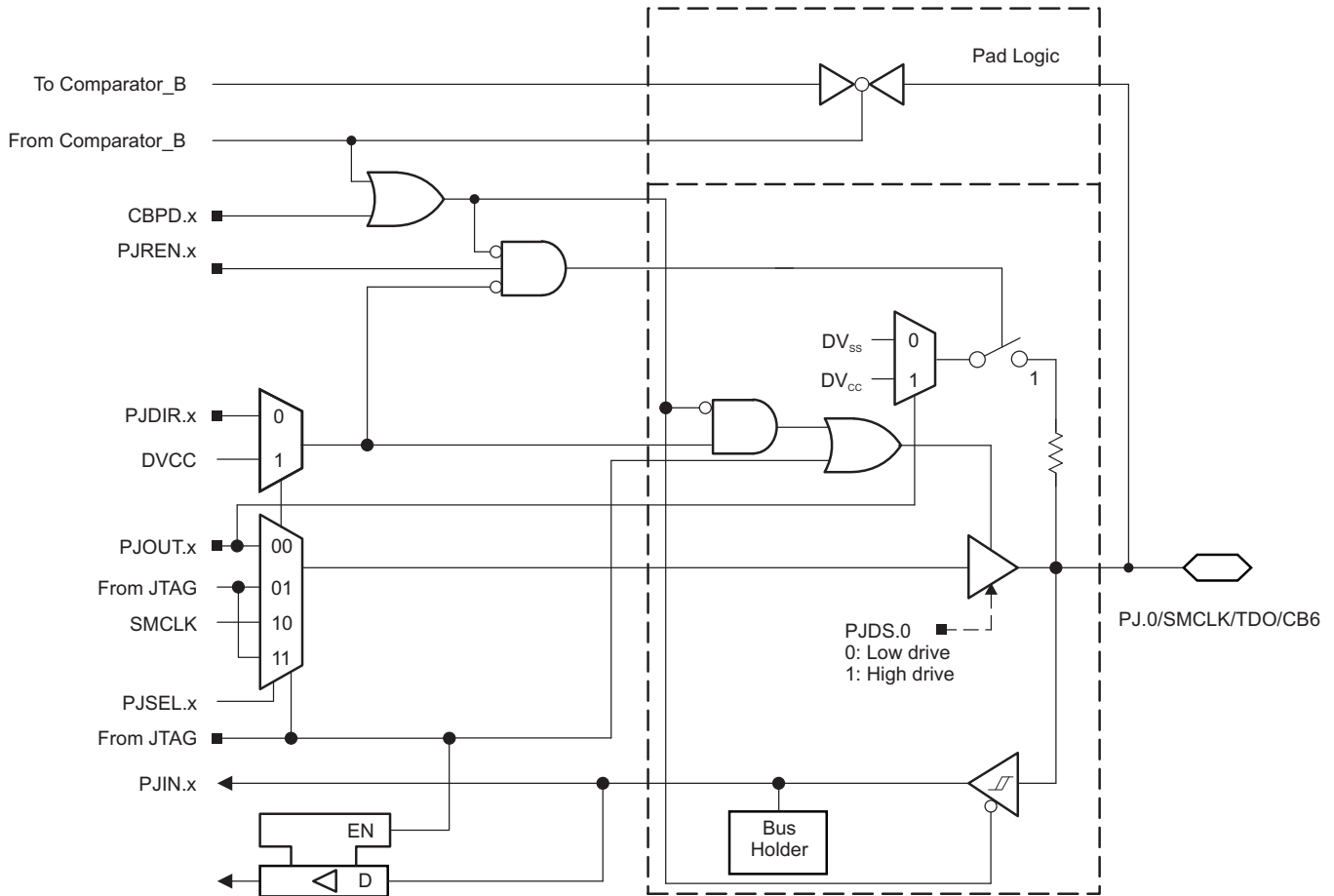
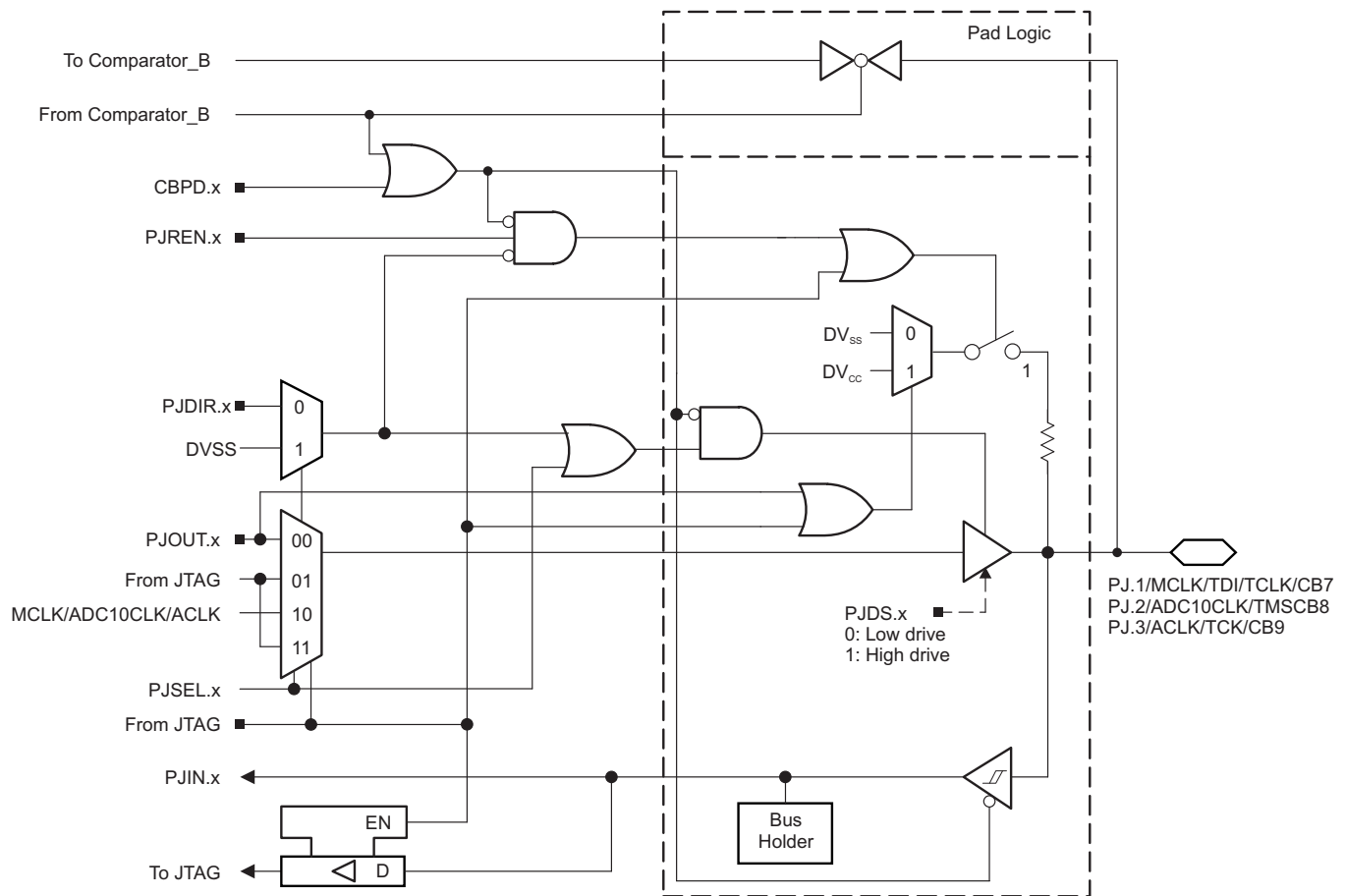


Figure 6-11. Port PJ (PJ.0) Diagram

### 6.10.11 Port J (PJ.1 to PJ.3) JTAG Pins TMS, TCK, TDI/TCLK, Input/Output With Schmitt Trigger or Output

Figure 6-12 shows the port diagram. Table 6-53 summarizes the selection of the pin function.



**Figure 6-12. Port PJ (PJ.1 to PJ.3) Diagram**

**Table 6-53. Port PJ (PJ.0 to PJ.3) Pin Functions**

| PIN NAME (PJ.x)                    | x | FUNCTION                       | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |           |           |
|------------------------------------|---|--------------------------------|----------------------------------------|---------|-----------|-----------|
|                                    |   |                                | PJDIR.x                                | PJSEL.x | JTAG MODE | CBPD.y    |
| PJ.0/<br>SMCLK/<br>TDO/<br>CB6     | 0 | PJ.x (I/O) <sup>(2)</sup>      | I: 0; O: 1                             | 0       | 0         | 0         |
|                                    |   | SMCLK                          | 1                                      | 1       | 0         | 0         |
|                                    |   | TDO <sup>(3)</sup>             | X                                      | X       | 1         | X         |
|                                    |   | CB6                            | X                                      | X       | 0         | 1 (y = 6) |
| PJ.1/<br>MCLK/<br>TDI/TCLK/<br>CB7 | 1 | PJ.x (I/O) <sup>(2)</sup>      | I: 0; O: 1                             | 0       | 0         | 0         |
|                                    |   | MCLK                           | 1                                      | 1       | 0         | 0         |
|                                    |   | TDI/TCLK <sup>(3) (4)</sup>    | X                                      | X       | 1         | X         |
|                                    |   | CB7                            | 0                                      | X       | 0         | 1 (y = 7) |
| PJ.2/<br>ADC10CLK/<br>TMS/<br>CB8  | 2 | PJ.x (I/O) <sup>(2)</sup>      | I: 0; O: 1                             | 0       | 0         | 0         |
|                                    |   | ADC10CLK (See <sup>(5)</sup> ) | 1                                      | 1       | 0         | 0         |
|                                    |   | TMS <sup>(3) (4)</sup>         | X                                      | X       | 1         | X         |
|                                    |   | CB8                            | X                                      | X       | 0         | 1 (y = 8) |
| PJ.3/<br>ACLK/<br>TCK/<br>CB9      | 3 | PJ.x (I/O) <sup>(2)</sup>      | I: 0; O: 1                             | 0       | 0         | 0         |
|                                    |   | ACLK                           | 1                                      | 1       | 0         | 0         |
|                                    |   | TCK <sup>(3) (4)</sup>         | X                                      | X       | 1         | X         |
|                                    |   | CB9                            | X                                      | X       | 0         | 1 (y = 9) |

(1) X = Don't care

(2) Default condition

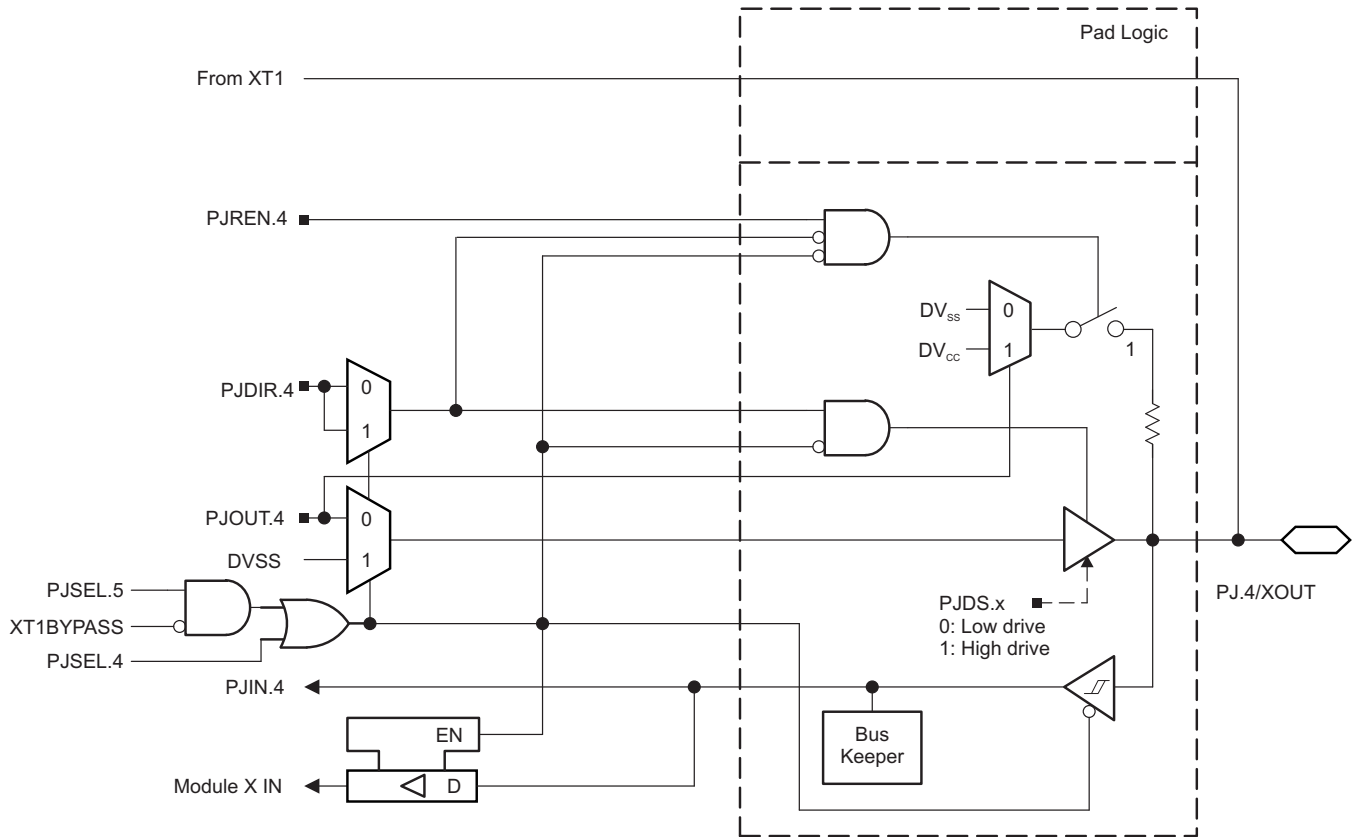
(3) The pin direction is controlled by the JTAG module.

(4) In JTAG mode, pullups are activated automatically on TMS, TCK, and TDI/TCLK. PJREN.x are don't care.

(5) MSP430F51x2 device only.

### 6.10.12 Port J (PJ.4) Input/Output With Schmitt Trigger

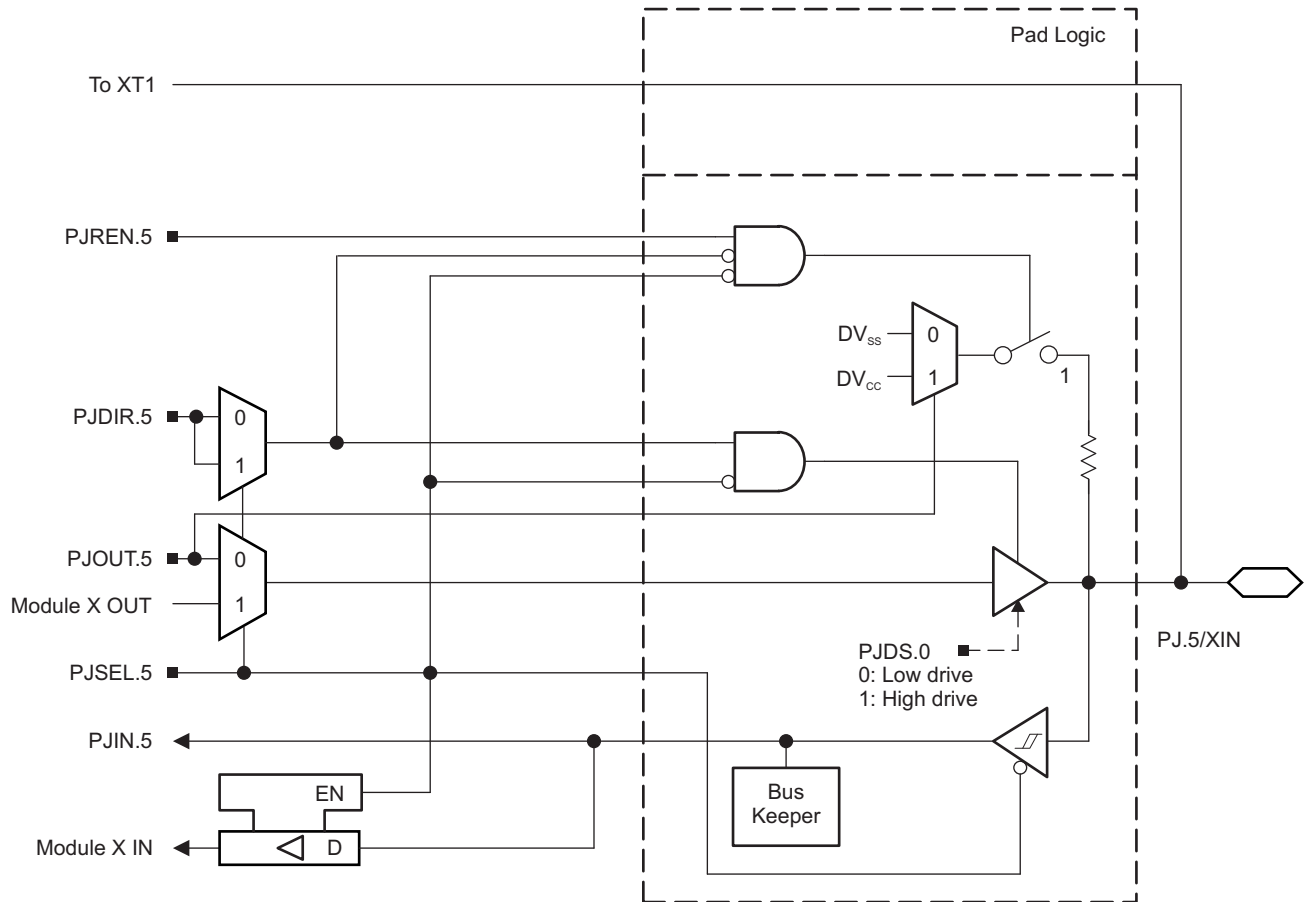
Figure 6-13 shows the port diagram. Table 6-54 summarizes the selection of the pin function.



**Figure 6-13. Port PJ (PJ.4) Diagram**

### 6.10.13 Port J (PJ.5) Input/Output With Schmitt Trigger

Figure 6-14 shows the port diagram. Table 6-54 summarizes the selection of the pin function.



**Figure 6-14. Port PJ (PJ.5) Diagram**

**Table 6-54. Port PJ (PJ.4 and PJ.5) Pin Functions**

| PIN NAME (PJ.x) | x | FUNCTION                         | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |         |           |
|-----------------|---|----------------------------------|----------------------------------------|---------|---------|-----------|
|                 |   |                                  | PJDIR.x                                | PJSEL.4 | PJSEL.5 | XT1BYPASS |
| PJ.4/<br>XOUT   | 4 | PJ.4 (I/O)                       | I: 0; O: 1                             | 0       | 0       | X         |
|                 |   | XOUT crystal mode <sup>(2)</sup> | X                                      | X       | 1       | 1         |
| PJ.5/<br>XIN    | 5 | PJ.5 (I/O) <sup>(2)</sup>        | I: 0; O: 1                             | X       | 0       | x         |
|                 |   | XIN crystal mode <sup>(3)</sup>  | X                                      | X       | 1       | 0         |
|                 |   | XIN bypass mode <sup>(3)</sup>   | X                                      | X       | 1       | 1         |

(1) X = Don't care

(2) Setting PJSEL.5 causes the general-purpose I/O to be disabled in crystal mode. When using bypass mode, PJ.4 can be used as general-purpose I/O.

(3) Setting PJSEL.5 causes the general-purpose I/O to be disabled. Pending the setting of XT1BYPASS, PJ.5 is configured for crystal mode or bypass mode.

#### 6.10.14 Port J (PJ.6) Input/Output With Schmitt Trigger

Figure 6-15 shows the port diagram. Table 6-55 summarizes the selection of the pin function.

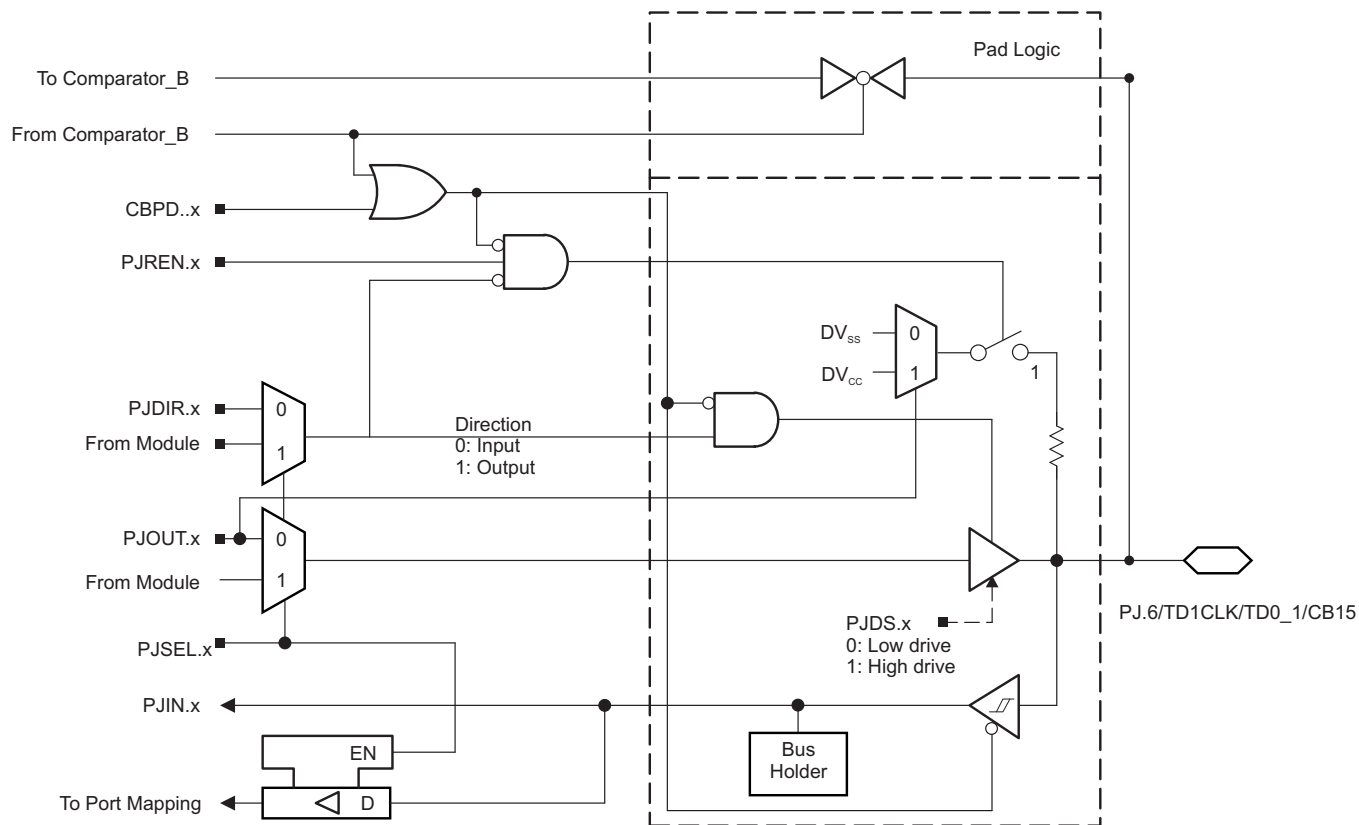


Figure 6-15. Port PJ (PJ.6) Diagram

Table 6-55. Port PJ (PJ.6) Pin Functions

| PIN NAME (PJ.x) | x | FUNCTION        | CONTROL BITS OR SIGNALS <sup>(1)</sup> |         |            |
|-----------------|---|-----------------|----------------------------------------|---------|------------|
|                 |   |                 | PJDIR.x                                | PJSEL.x | CBPD.y     |
| PJ.6/           | 6 | PJ.x (I/O)      | I: 0; O: 1                             | 0       | 0          |
| TD1CLK/         |   | TD1 clock input | 0                                      | 1       | 0          |
| TD0.1/          |   | TD0.TA1         | 1                                      | 1       | 0          |
| CB15            |   | CB15            | X                                      | X       | 1 (y = 15) |

(1) X = Don't care

## 6.11 Device Descriptors

Table 6-56 and Table 6-57 list the complete contents of the device descriptor tag-length-value (TLV) structure for the MSP430F51x2 and MSP430F51x1 devices, respectively.

**Table 6-56. MSP430F51x2 Device Descriptor Table<sup>(1)</sup>**

| DESCRIPTION          |                                                | ADDRESS | SIZE<br>(bytes) | VALUE    |          |          |          |          |          |
|----------------------|------------------------------------------------|---------|-----------------|----------|----------|----------|----------|----------|----------|
|                      |                                                |         |                 | F5172    |          | F5152    |          | F5132    |          |
|                      |                                                |         |                 | RSB, YFF | DA       | RSB      | DA       | RSB      | DA       |
| Info Block           | Info length                                    | 0x1A00  | 1               | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     |
|                      | CRC length                                     | 0x1A01  | 1               | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     |
|                      | CRC value                                      | 0x1A02  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Device ID                                      | 0x1A04  | 1               | 0x30     | 0x30     | 0x2C     | 0x2C     | 0x28     | 0x28     |
|                      | Device ID                                      | 0x1A05  | 1               | 0x80     | 0x80     | 0x80     | 0x80     | 0x80     | 0x80     |
|                      | Hardware revision                              | 0x1A06  | 1               | 0x30     | 030      | 0x30     | 0x30     | 0x30     | 0x30     |
|                      | Firmware revision                              | 0x1A07  | 1               | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     |
| Die Record           | Die record tag                                 | 0x1A08  | 1               | 0x08     | 08       | 0x08     | 08       | 0x08     | 08       |
|                      | Die record length                              | 0x1A09  | 1               | 0x0A     | 0A       | 0x0A     | 0A       | 0x0A     | 0A       |
|                      | Lot/wafer ID                                   | 0x1A0A  | 4               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Die X position                                 | 0x1A0Eh | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Die Y position                                 | 0x1A10  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Test results                                   | 0x1A12  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
| ADC10 Calibration    | ADC10 calibration tag                          | 0x1A14  | 1               | 0x13     | 0x13     | 0x13     | 0x13     | 0x13     | 0x13     |
|                      | ADC10 calibration length                       | 0x1A15  | 1               | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     |
|                      | ADC gain factor                                | 0x1A16  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC offset                                     | 0x1A18  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC 1.5-V reference<br>Temperature sensor 30°C | 0x1A1A  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC 1.5-V reference<br>Temperature sensor 85°C | 0x1A1C  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC 2.0-V reference<br>Temperature sensor 30°C | 0x1A1Eh | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC 2.0-V reference<br>Temperature sensor 85°C | 0x1A20  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC 2.5-V reference<br>Temperature sensor 30°C | 0x1A22  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC 2.5-V reference<br>Temperature sensor 85°C | 0x1A24  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
| REF User Calibration | REF tag                                        | 0x1A26  | 1               | 0x12     | 0x12     | 0x12     | 0x12     | 0x12     | 0x12     |
|                      | REF length                                     | 0x1A27  | 1               | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     |
|                      | REF 1.5-V reference                            | 0x1A28  | 2               | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     |
|                      | REF 2.0-V reference                            | 0x1A2A  | 2               | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     |
|                      | REF 2.5-V reference                            | 0x1A2C  | 2               | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     |
| Timer_D0 Calibration | Timer_D tag                                    | 0x1A2E  | 1               | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     |
|                      | Timer_D length                                 | 0x1A2F  | 1               | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     |
|                      | Timer_D 64-MHz frequency                       | 0x1A30  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Timer_D 128-MHz frequency                      | 0x1A32  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Timer_D 200-MHz frequency                      | 0x1A34  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Timer_D 256-MHz frequency                      | 0x1A36  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
| Timer_D1 Calibration | Timer_D tag                                    | 0x1A38  | 1               | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     |
|                      | Timer_D length                                 | 0x1A39  | 1               | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     |
|                      | Timer_D 64-MHz frequency                       | 0x1A3A  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Timer_D 128-MHz frequency                      | 0x1A3C  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Timer_D 200-MHz frequency                      | 0x1A3E  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Timer_D 256-MHz frequency                      | 0x1A40  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |

(1) NA = Not applicable

**Table 6-56. MSP430F51x2 Device Descriptor Table<sup>(1)</sup> (continued)**

| DESCRIPTION              |                              | ADDRESS | SIZE<br>(bytes) | VALUE    |        |         |        |         |        |
|--------------------------|------------------------------|---------|-----------------|----------|--------|---------|--------|---------|--------|
|                          |                              |         |                 | F5172    |        | F5152   |        | F5132   |        |
|                          |                              |         |                 | RSB, YFF | DA     | RSB     | DA     | RSB     | DA     |
| Peripheral<br>Descriptor | Peripheral descriptor tag    | 0x1A42  | 1               | 0x02     | 0x02   | 0x02    | 0x02   | 0x02    | 0x02   |
|                          | Peripheral descriptor length | 0x1A43  | 1               | 0x53     | 0x53   | 0x53    | 0x53   | 0x53    | 0x53   |
|                          | BSL memory                   | 0x1A44  | 2               | 0x8A08   | 0x8A08 | 0x8A08  | 0x8A08 | 0x8A08  | 0x8A08 |
|                          | Information memory           | 0x1A46  | 2               | 0x860C   | 0x860C | 0x860C  | 0x860C | 0x860C  | 0x860C |
|                          | RAM                          | 0x1A48  | 2               | 0x2A0E   | 0x2A0E | 0x2A0E  | 0x2A0E | 0x280E  | 0x280E |
|                          | Main memory                  | 0x1A4A  | 2               | 0x9240   | 0x9240 | 0x9060  | 0x9060 | 0x8E70  | 0x8E70 |
|                          | Delimiter                    | 0x1A4C  | 1               | 0x00     | 0x00   | 0x00    | 0x00   | 0x00    | 0x00   |
|                          | Peripheral count             | 0x1A4D  | 1               | 0x1C     | 0x1C   | 0x1B    | 0x1B   | 0x1B    | 0x1B   |
|                          | MSP430CPUXV2                 | 0x1A4E  | 2               | 0x2300   | 0x2300 | 0x2300  | 0x2300 | 0x2300  | 0x2300 |
|                          | SBW                          | 0x1A50  | 2               | 0x0F00   | 0x0F00 | 0x0F00  | 0x0F00 | 0x0F00  | 0x0F00 |
|                          | EEM-S                        | 0x1A52  | 2               | 0x0300   | 0x0300 | 0x0300  | 0x0300 | 0x0300  | 0x0300 |
|                          | TI BSL                       | 0x1A54  | 2               | 0xFC00   | 0xFC00 | 0xFC00  | 0xFC00 | 0xFC00  | 0xFC00 |
|                          | SFR                          | 0x1A56  | 2               | 0x4110   | 0x4110 | 0x4110  | 0x4110 | 0x4110  | 0x4110 |
|                          | PMM                          | 0x1A58  | 2               | 0x3002   | 0x3002 | 0x3002  | 0x3002 | 0x3002  | 0x3002 |
|                          | FCTL                         | 0x1A5A  | 2               | 0x3802   | 0x3802 | 0x3802  | 0x3802 | 0x3802  | 0x3802 |
|                          | CRC16                        | 0x1A5C  | 2               | 0x3C01   | 0x3C01 | 0x3C01  | 0x3C01 | 0x3C01  | 0x3C01 |
|                          | CRC16_RB                     | 0x1A5E  | 2               | 0x3D00   | 0x3D00 | 0x3D00  | 0x3D00 | 0x3D00  | 0x3D00 |
|                          | RAMCTL                       | 0x1A60  | 2               | 0x4400   | 0x4400 | 0x4400  | 0x4400 | 0x4400  | 0x4400 |
|                          | WDT_A                        | 0x1A62  | 2               | 0x4000   | 0x4000 | 0x4000  | 0x4000 | 0x4000  | 0x4000 |
|                          | UCS                          | 0x1A64  | 2               | 0x4801   | 0x4801 | 0x4801  | 0x4801 | 0x4801  | 0x4801 |
|                          | SYS                          | 0x1A66  | 2               | 0x4202   | 0x4202 | 0x4202  | 0x4202 | 0x4202  | 0x4202 |
|                          | Shared REF                   | 0x1A68  | 2               | 0xA003   | 0xA003 | 0xA003  | 0xA003 | 0xA003  | 0xA003 |
|                          | Port Mapping                 | 0x1A6A  | 2               | 0x1001   | 0x1001 | 0x1001  | 0x1001 | 0x1001  | 0x1001 |
|                          | Port 1/2                     | 0x1A6C  | 2               | 0x5104   | 0x5104 | 0x5104  | 0x5104 | 0x5104  | 0x5104 |
|                          | Port 3/4                     | 0x1A6E  | 2               | 0x5202   | 0x5202 | 0x5202  | 0x5202 | 0x5202  | 0x5202 |
|                          | Port J                       | 0x1A70  | 2               | 0x5F10   | 0x5F10 | 0x5F10  | 0x5F10 | 0x5F10  | 0x5F10 |
|                          | TA0                          | 0x1A72  | 2               | 0x610A   | 0x610A | 0x610A  | 0x610A | 0x610A  | 0x610A |
|                          | MPY32                        | 0x1A74  | 2               | 0x8510   | 0x8510 | 0x8510  | 0x8510 | 0x8510  | 0x8510 |
|                          | DMA with 3 channels          | 0x1A76  | 2               | 0x4704   | 0x4704 | 0x4704  | 0x4704 | 0x4704  | 0x4704 |
|                          | USCI_A0/B0                   | 0x1A78  | 2               | 0x900C   | 0x900C | 0x900C  | 0x900C | 0x900C  | 0x900C |
|                          | ADC10_A                      | 0x1A7A  | 2               | 0xD318   | 0xD318 | 0xD318  | 0xD318 | 0xD318  | 0xD318 |
|                          | COMP_B                       | 0x1A7C  | 2               | 0xA818   | 0xA818 | 0x1A919 | 0xA818 | 0x1A919 | 0xA818 |
|                          | TIMER_D0                     | 0x1A7E  | 2               | 0xD624   | 0xD624 | 0xD624  | 0xD624 | 0xD624  | 0xD624 |
|                          | TIMER_D1                     | 0x1A80  | 2               | 0x6D04   | 0x6D04 | 0x6D04  | 0x6D04 | 0x6D04  | 0x6D04 |
|                          | TEC_0                        | 0x1A82  | 2               | 0x700C   | 0x700C | 0x700C  | 0x700C | 0x700C  | 0x700C |
|                          | TEC_1                        | 0x1A84  | 2               | 0x7002   | 0x7002 | 0x7002  | 0x7002 | 0x7002  | 0x7002 |

**Table 6-56. MSP430F51x2 Device Descriptor Table<sup>(1)</sup> (continued)**

| DESCRIPTION |               | ADDRESS            | SIZE<br>(bytes) | VALUE    |      |       |      |       |      |
|-------------|---------------|--------------------|-----------------|----------|------|-------|------|-------|------|
|             |               |                    |                 | F5172    |      | F5152 |      | F5132 |      |
|             |               |                    |                 | RSB, YFF | DA   | RSB   | DA   | RSB   | DA   |
| Interrupts  | COMP_B        | 0x1A86             | 1               | 0xA8     | 0xA8 | 0xA8  | 0xA8 | 0xA8  | 0xA8 |
|             | TEC_0         | 0x1A87             | 1               | 0x6D     | 0x6D | 0x6D  | 0x6D | 0x6D  | 0x6D |
|             | TIMER_D0      | 0x1A88             | 1               | 0x62     | 0x62 | 0x62  | 0x62 | 0x62  | 0x62 |
|             | TIMER_D0      | 0x1A89             | 1               | 0x63     | 0x63 | 0x63  | 0x63 | 0x63  | 0x63 |
|             | WDTIFG        | 0x1A8A             | 1               | 0x40     | 0x40 | 0x40  | 0x40 | 0x40  | 0x40 |
|             | USCI_A0       | 0x1A8B             | 1               | 0x90     | 0x90 | 0x90  | 0x90 | 0x90  | 0x90 |
|             | USCI_B0       | 0x1A8C             | 1               | 0x91     | 0x91 | 0x91  | 0x91 | 0x91  | 0x91 |
|             | ADC10_A       | 0x1A8D             | 1               | 0xD0     | 0xD0 | 0xD0  | 0xD0 | 0xD0  | 0xD0 |
|             | TA0.CCIFG0    | 0x1A8E             | 1               | 0x60     | 0x60 | 0x60  | 0x60 | 0x60  | 0x60 |
|             | TA0.CCIFG1..4 | 0x1A8F             | 1               | 0x61     | 0x61 | 0x61  | 0x61 | 0x61  | 0x61 |
|             | DMA           | 0x1A90             | 1               | 0x46     | 0x46 | 0x46  | 0x46 | 0x46  | 0x46 |
|             | TEC_1         | 0x1A91             | 1               | 0x6E     | 0x6E | 0x6E  | 0x6E | 0x6E  | 0x6E |
|             | TIMER_D1      | 0x1A92             | 1               | 0x64     | 0x64 | 0x64  | 0x64 | 0x64  | 0x64 |
|             | TIMER_D1      | 0x1A93             | 1               | 0x65     | 0x65 | 0x65  | 0x65 | 0x65  | 0x65 |
|             | Port P1       | 0x1A94             | 1               | 0x50     | 0x50 | 0x50  | 0x50 | 0x50  | 0x50 |
|             | Port P2       | 0x1A95             | 1               | 0x51     | 0x51 | 0x51  | 0x51 | 0x51  | 0x51 |
|             | Delimiter     | 0x1A96             | 1               | 0x00     | 0x00 | 0x00  | 0x00 | 0x00  | 0x00 |
| Empty       | Unused memory | 0x1A97 -<br>0x1AB9 |                 | 0xFF     | 0xFF | 0xFF  | 0xFF | 0xFF  | 0xFF |

**Table 6-57. MSP430F51x1 Device Descriptor Table<sup>(1)</sup>**

| DESCRIPTION |                   | ADDRESS | SIZE<br>(bytes) | VALUE    |          |          |          |          |          |
|-------------|-------------------|---------|-----------------|----------|----------|----------|----------|----------|----------|
|             |                   |         |                 | F5171    |          | F5151    |          | F5131    |          |
|             |                   |         |                 | RSB      | DA       | RSB      | DA       | RSB      | DA       |
| Info Block  | Info length       | 0x1A00  | 1               | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     |
|             | CRC length        | 0x1A01  | 1               | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     |
|             | CRC value         | 0x1A02  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|             | Device ID         | 0x1A04  | 1               | 0x2E     | 0x2E     | 0x2A     | 0x2A     | 0x26     | 0x26     |
|             | Device ID         | 0x1A05  | 1               | 0x80     | 0x80     | 0x80     | 0x80     | 0x80     | 0x80     |
|             | Hardware revision | 0x1A06  | 1               | 0x30     | 0x30     | 0x30     | 0x30     | 0x30     | 0x30     |
|             | Firmware revision | 0x1A07  | 1               | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     |
| Die Record  | Die record tag    | 0x1A08  | 1               | 0x08     | 08       | 0x08     | 08       | 0x08     | 08       |
|             | Die record length | 0x1A09  | 1               | 0x0A     | 0A       | 0x0A     | 0A       | 0x0A     | 0A       |
|             | Lot/wafer ID      | 0x1A0A  | 4               | per unit | per unit | per unit | per unit | per unit | per unit |
|             | Die X position    | 0x1A0Eh | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|             | Die Y position    | 0x1A10  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|             | Test results      | 0x1A12  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |

(1) NA = Not applicable

**Table 6-57. MSP430F51x1 Device Descriptor Table<sup>(1)</sup> (continued)**

| DESCRIPTION          |                                                | ADDRESS | SIZE<br>(bytes) | VALUE    |          |          |          |          |          |
|----------------------|------------------------------------------------|---------|-----------------|----------|----------|----------|----------|----------|----------|
|                      |                                                |         |                 | F5171    |          | F5151    |          | F5131    |          |
|                      |                                                |         |                 | RSB      | DA       | RSB      | DA       | RSB      | DA       |
| ADC10 Calibration    | ADC10 calibration tag                          | 0x1A14  | 1               | 0x05     | 0x05     | 0x05     | 0x05     | 0x05     | 0x05     |
|                      | ADC10 calibration length                       | 0x1A15  | 1               | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     | 0x10     |
|                      | ADC gain factor                                | 0x1A16  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC offset                                     | 0x1A18  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC 1.5-V reference<br>Temperature sensor 30°C | 0x1A1A  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC 1.5-V reference<br>Temperature sensor 85°C | 0x1A1C  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC 2.0-V reference<br>Temperature sensor 30°C | 0x1A1Eh | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC 2.0-V reference<br>Temperature sensor 85°C | 0x1A20  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC 2.5-V reference<br>Temperature sensor 30°C | 0x1A22  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | ADC 2.5-V reference<br>Temperature sensor 85°C | 0x1A24  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
| REF User Calibration | REF tag                                        | 0x1A26  | 1               | 0x12     | 0x12     | 0x12     | 0x12     | 0x12     | 0x12     |
|                      | REF length                                     | 0x1A27  | 1               | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     | 0x06     |
|                      | REF 1.5-V reference                            | 0x1A28  | 2               | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     |
|                      | REF 2.0-V reference                            | 0x1A2A  | 2               | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     |
|                      | REF 2.5-V reference                            | 0x1A2C  | 2               | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     | 0xFF     |
| Timer_D0 Calibration | Timer_D tag                                    | 0x1A2E  | 1               | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     |
|                      | Timer_D length                                 | 0x1A2F  | 1               | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     |
|                      | Timer_D 64-MHz frequency                       | 0x1A30  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Timer_D 128-MHz frequency                      | 0x1A32  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Timer_D 200-MHz frequency                      | 0x1A34  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Timer_D 256-MHz frequency                      | 0x1A36  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
| Timer_D1 Calibration | Timer_D tag                                    | 0x1A38  | 1               | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     | 0x15     |
|                      | Timer_D length                                 | 0x1A39  | 1               | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     | 0x08     |
|                      | Timer_D 64-MHz frequency                       | 0x1A3A  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Timer_D 128-MHz frequency                      | 0x1A3C  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Timer_D 200-MHz frequency                      | 0x1A3E  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |
|                      | Timer_D 256-MHz frequency                      | 0x1A40  | 2               | per unit | per unit | per unit | per unit | per unit | per unit |

**Table 6-57. MSP430F51x1 Device Descriptor Table<sup>(1)</sup> (continued)**

| DESCRIPTION              |                              | ADDRESS | SIZE<br>(bytes) | VALUE  |        |        |        |        |        |
|--------------------------|------------------------------|---------|-----------------|--------|--------|--------|--------|--------|--------|
|                          |                              |         |                 | F5171  |        | F5151  |        | F5131  |        |
|                          |                              |         |                 | RSB    | DA     | RSB    | DA     | RSB    | DA     |
| Peripheral<br>Descriptor | Peripheral descriptor tag    | 0x1A42  | 1               | 0x02   | 0x02   | 0x02   | 0x02   | 0x02   | 0x02   |
|                          | Peripheral descriptor length | 0x1A43  | 1               | 0x51   | 0x51   | 0x51   | 0x51   | 0x51   | 0x51   |
|                          | BSL memory                   | 0x1A44  | 2               | 0x8A08 | 0x8A08 | 0x8A08 | 0x8A08 | 0x8A08 | 0x8A08 |
|                          | Information memory           | 0x1A46  | 2               | 0x860C | 0x860C | 0x860C | 0x860C | 0x860C | 0x860C |
|                          | RAM                          | 0x1A48  | 2               | 0x2A0E | 0x2A0E | 0x2A0E | 0x2A0E | 0x280E | 0x280E |
|                          | Main memory                  | 0x1A4A  | 2               | 0x9240 | 0x9240 | 0x9060 | 0x9060 | 0x8E70 | 0x8E70 |
|                          | Delimiter                    | 0x1A4C  | 1               | 0x00   | 0x00   | 0x00   | 0x00   | 0x00   | 0x00   |
|                          | Peripheral count             | 0x1A4D  | 1               | 0x1B   | 0x1B   | 0x1B   | 0x1B   | 0x1B   | 0x1B   |
|                          | MSP430CPUXV2                 | 0x1A4E  | 2               | 0x2300 | 0x2300 | 0x2300 | 0x2300 | 0x2300 | 0x2300 |
|                          | SBW                          | 0x1A50  | 2               | 0x0F00 | 0x0F00 | 0x0F00 | 0x0F00 | 0x0F00 | 0x0F00 |
|                          | EEM-S                        | 0x1A52  | 2               | 0x0300 | 0x0300 | 0x0300 | 0x0300 | 0x0300 | 0x0300 |
|                          | TI BSL                       | 0x1A54  | 2               | 0xFC00 | 0xFC00 | 0xFC00 | 0xFC00 | 0xFC00 | 0xFC00 |
|                          | SFR                          | 0x1A56  | 2               | 0x4110 | 0x4110 | 0x4110 | 0x4110 | 0x4110 | 0x4110 |
|                          | PMM                          | 0x1A58  | 2               | 0x3002 | 0x3002 | 0x3002 | 0x3002 | 0x3002 | 0x3002 |
|                          | FCTL                         | 0x1A5A  | 2               | 0x3802 | 0x3802 | 0x3802 | 0x3802 | 0x3802 | 0x3802 |
|                          | CRC16                        | 0x1A5C  | 2               | 0x3C01 | 0x3C01 | 0x3C01 | 0x3C01 | 0x3C01 | 0x3C01 |
|                          | CRC16_RB                     | 0x1A5E  | 2               | 0x3D00 | 0x3D00 | 0x3D00 | 0x3D00 | 0x3D00 | 0x3D00 |
|                          | RAMCTL                       | 0x1A60  | 2               | 0x4400 | 0x4400 | 0x4400 | 0x4400 | 0x4400 | 0x4400 |
|                          | WDT_A                        | 0x1A62  | 2               | 0x4000 | 0x4000 | 0x4000 | 0x4000 | 0x4000 | 0x4000 |
|                          | UCS                          | 0x1A64  | 2               | 0x4801 | 0x4801 | 0x4801 | 0x4801 | 0x4801 | 0x4801 |
|                          | SYS                          | 0x1A66  | 2               | 0x4202 | 0x4202 | 0x4202 | 0x4202 | 0x4202 | 0x4202 |
|                          | Shared REF                   | 0x1A68  | 2               | 0xA003 | 0xA003 | 0xA003 | 0xA003 | 0xA003 | 0xA003 |
|                          | Port Mapping                 | 0x1A6A  | 2               | 0x1001 | 0x1001 | 0x1001 | 0x1001 | 0x1001 | 0x1001 |
|                          | Port 1/2                     | 0x1A6C  | 2               | 0x5104 | 0x5104 | 0x5104 | 0x5104 | 0x5104 | 0x5104 |
|                          | Port 3/4                     | 0x1A6E  | 2               | 0x5202 | 0x5202 | 0x5202 | 0x5202 | 0x5202 | 0x5202 |
|                          | Port J                       | 0x1A70  | 2               | 0x5F10 | 0x5F10 | 0x5F10 | 0x5F10 | 0x5F10 | 0x5F10 |
|                          | TA0                          | 0x1A72  | 2               | 0x610A | 0x610A | 0x610A | 0x610A | 0x610A | 0x610A |
|                          | MPY32                        | 0x1A74  | 2               | 0x8510 | 0x8510 | 0x8510 | 0x8510 | 0x8510 | 0x8510 |
|                          | DMA with 3 channels          | 0x1A76  | 2               | 0x4704 | 0x4704 | 0x4704 | 0x4704 | 0x4704 | 0x4704 |
|                          | USCI_A0/B0                   | 0x1A78  | 2               | 0x900C | 0x900C | 0x900C | 0x900C | 0x900C | 0x900C |
|                          | COMP_B                       | 0x1A7A  | 2               | 0xA830 | 0xA830 | 0xA830 | 0xA830 | 0xA830 | 0xA830 |
|                          | TIMER_D0                     | 0x1A7C  | 2               | 0xD624 | 0xD624 | 0xD624 | 0xD624 | 0xD624 | 0xD624 |
|                          | TIMER_D1                     | 0x1A7E  | 2               | 0x6D04 | 0x6D04 | 0x6D04 | 0x6D04 | 0x6D04 | 0x6D04 |
|                          | TEC_0                        | 0x1A80  | 2               | 0x700C | 0x700C | 0x700C | 0x700C | 0x700C | 0x700C |
|                          | TEC_1                        | 0x1A82  | 2               | 0x7002 | 0x7002 | 0x7002 | 0x7002 | 0x7002 | 0x7002 |

**Table 6-57. MSP430F51x1 Device Descriptor Table<sup>(1)</sup> (continued)**

| DESCRIPTION |               | ADDRESS           | SIZE<br>(bytes) | VALUE |      |       |      |       |      |
|-------------|---------------|-------------------|-----------------|-------|------|-------|------|-------|------|
|             |               |                   |                 | F5171 |      | F5151 |      | F5131 |      |
|             |               |                   |                 | RSB   | DA   | RSB   | DA   | RSB   | DA   |
| Interrupts  | COMP_B        | 0x1A83            | 1               | 0xA8  | 0xA8 | 0xA8  | 0xA8 | 0xA8  | 0xA8 |
|             | TEC_0         | 0x1A84            | 1               | 0x6D  | 0x6D | 0x6D  | 0x6D | 0x6D  | 0x6D |
|             | TIMER_D0      | 0x1A85            | 1               | 0x62  | 0x62 | 0x62  | 0x62 | 0x62  | 0x62 |
|             | TIMER_D0      | 0x1A86            | 1               | 0x63  | 0x63 | 0x63  | 0x63 | 0x63  | 0x63 |
|             | WDTIFG        | 0x1A87            | 1               | 0x40  | 0x40 | 0x40  | 0x40 | 0x40  | 0x40 |
|             | USCI_A0       | 0x1A88            | 1               | 0x90  | 0x90 | 0x90  | 0x90 | 0x90  | 0x90 |
|             | USCI_B0       | 0x1A89            | 1               | 0x91  | 0x91 | 0x91  | 0x91 | 0x91  | 0x91 |
|             | ADC10_A       | 0x1A8A            | 1               | 0xD0  | 0xD0 | 0xD0  | 0xD0 | 0xD0  | 0xD0 |
|             | TA0.CCIFG0    | 0x1A8B            | 1               | 0x60  | 0x60 | 0x60  | 0x60 | 0x60  | 0x60 |
|             | TA0.CCIFG1..4 | 0x1A8C            | 1               | 0x61  | 0x61 | 0x61  | 0x61 | 0x61  | 0x61 |
|             | DMA           | 0x1A8D            | 1               | 0x46  | 0x46 | 0x46  | 0x46 | 0x46  | 0x46 |
|             | TEC_1         | 0x1A8E            | 1               | 0x6E  | 0x6E | 0x6E  | 0x6E | 0x6E  | 0x6E |
|             | TIMER_D1      | 0x1A8F            | 1               | 0x64  | 0x64 | 0x64  | 0x64 | 0x64  | 0x64 |
|             | TIMER_D1      | 0x1A90            | 1               | 0x65  | 0x65 | 0x65  | 0x65 | 0x65  | 0x65 |
|             | Port P1       | 0x1A91            | 1               | 0x50  | 0x50 | 0x50  | 0x50 | 0x50  | 0x50 |
|             | Port P2       | 0x1A92            | 1               | 0x51  | 0x51 | 0x51  | 0x51 | 0x51  | 0x51 |
|             | Delimiter     | 0x1A93            | 1               | 0x00  | 0x00 | 0x00  | 0x00 | 0x00  | 0x00 |
| Empty       | Unused Memory | 0x1A94–<br>0x1AB9 |                 | 0xFF  | 0xFF | 0xFF  | 0xFF | 0xFF  | 0xFF |

## 7 器件和文档支持

### 7.1 入门和下一步

有关 MSP430 系列器件以及开发协助工具和库的更多信息，请访问[入门](#)页面。

### 7.2 Device Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all MSP430 MCU devices and support tools. Each MSP430 MCU commercial family member has one of three prefixes: MSP, PMS, or XMS (for example, MSP430F5438A). TI recommends two of three possible prefix designators for its support tools: MSP and MSPX. These prefixes represent evolutionary stages of product development from engineering prototypes (with XMS for devices and MSPX for tools) through fully qualified production devices and tools (with MSP for devices and MSP for tools).

Device development evolutionary flow:

**XMS** – Experimental device that is not necessarily representative of the electrical specifications for the final device

**PMS** – Final silicon die that conforms to the electrical specifications for the device but has not completed quality and reliability verification

**MSP** – Fully qualified production device

Support tool development evolutionary flow:

**MSPX** – Development-support product that has not yet completed TI's internal qualification testing.

**MSP** – Fully-qualified development-support product

XMS and PMS devices and MSPX development-support tools are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

MSP devices and MSP development-support tools have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

Predictions show that prototype devices (XMS and PMS) have a greater failure rate than the standard production devices. TI recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the package type (for example, PZP) and temperature range (for example, T). [图 7-1](#) provides a legend for reading the complete device name for any family member.

|                                      |                                                                                                                                |                                                                                                                                                                                                                                         |
|--------------------------------------|--------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MSP 430 F 5 438 A I ZQW T -EP        |                                                                                                                                |                                                                                                                                                                                                                                         |
| Processor Family                     | MCU Platform                                                                                                                   | Optional: Additional Features                                                                                                                                                                                                           |
|                                      | Device Type                                                                                                                    | Optional: Tape and Reel                                                                                                                                                                                                                 |
|                                      | Series                                                                                                                         | Packaging                                                                                                                                                                                                                               |
|                                      | Feature Set                                                                                                                    | Optional: Temperature Range                                                                                                                                                                                                             |
|                                      |                                                                                                                                | Optional: A = Revision                                                                                                                                                                                                                  |
| <b>Processor Family</b>              | CC = Embedded RF Radio<br>MSP = Mixed-Signal Processor<br>XMS = Experimental Silicon<br>PMS = Prototype Device                 |                                                                                                                                                                                                                                         |
| <b>MCU Platform</b>                  | 430 = MSP430 low-power microcontroller platform                                                                                |                                                                                                                                                                                                                                         |
| <b>Device Type</b>                   | <b>Memory Type</b><br>C = ROM<br>F = Flash<br>FR = FRAM<br>G = Flash or FRAM (Value Line)<br>L = No Nonvolatile Memory         | <b>Specialized Application</b><br>AFE = Analog Front End<br>BT = Preprogrammed with <i>Bluetooth</i><br>BQ = Contactless Power<br>CG = ROM Medical<br>FE = Flash Energy Meter<br>FG = Flash Medical<br>FW = Flash Electronic Flow Meter |
| <b>Series</b>                        | 1 Series = Up to 8 MHz<br>2 Series = Up to 16 MHz<br>3 Series = Legacy<br>4 Series = Up to 16 MHz with LCD                     | 5 Series = Up to 25 MHz<br>6 Series = Up to 25 MHz with LCD<br>0 = Low-Voltage Series                                                                                                                                                   |
| <b>Feature Set</b>                   | Various Levels of Integration Within a Series                                                                                  |                                                                                                                                                                                                                                         |
| <b>Optional: A = Revision</b>        | N/A                                                                                                                            |                                                                                                                                                                                                                                         |
| <b>Optional: Temperature Range</b>   | S = 0°C to 50°C<br>C = 0°C to 70°C<br>I = –40°C to 85°C<br>T = –40°C to 105°C                                                  |                                                                                                                                                                                                                                         |
| <b>Packaging</b>                     | <a href="http://www.ti.com/packaging">http://www.ti.com/packaging</a>                                                          |                                                                                                                                                                                                                                         |
| <b>Optional: Tape and Reel</b>       | T = Small Reel<br>R = Large Reel<br>No Markings = Tube or Tray                                                                 |                                                                                                                                                                                                                                         |
| <b>Optional: Additional Features</b> | -EP = Enhanced Product (–40°C to 105°C)<br>-HT = Extreme Temperature Parts (–55°C to 150°C)<br>-Q1 = Automotive Q100 Qualified |                                                                                                                                                                                                                                         |

图 7-1. Device Nomenclature

### 7.3 工具和软件

所有 MSP 微控制器均受多种软件和硬件开发工具的支持。相关工具由 TI 以及多家第三方供应商提供。可从 [低功耗 MCU 开发套件和软件](#) 获取全部信息。

表 7-1 列出了这些微控制器所支持的调试功能。关于可用特性的详细信息，请参见《[适用于 MSP430 的 Code Composer Studio 用户指南](#)》。

表 7-1. 硬件调试功能

| MSP430 架构 | 4 线制 JTAG | 2 线制 JTAG | 断点 (N) | 范围断点 | 时钟控制 | 状态序列发生器 | 跟踪缓冲器 | LPMx.5 调试支持 |
|-----------|-----------|-----------|--------|------|------|---------|-------|-------------|
| MSP430Xv2 | 是         | 是         | 3      | 是    | 是    | 无       | 无     | 无           |

#### 设计套件与评估模块

**适用于 MSP430F5x MCU 的 MSP430 40 引脚目标开发板** MSP-TS430RSB40 是一款独立的 40 引脚 ZIF 插接目标板，适用于通过 JTAG 接口或 Spy Bi-Wire（双线制 JTAG）协议对 MSP430 MCU 系统内置器件进行编程和调试。

**MSP430 40 引脚封装板和 USB 编程器** MSP-FET430U40 是一款独立的 40 引脚 ZIF 插接目标板，用于通过 JTAG 接口或 Spy Bi-Wire（双线制 JTAG）协议和 MSP-FET 闪存仿真工具对 MSP430 MCU 系统内置器件进行编程和调试。

#### 软件

**MSP430F51x2、MSP430F51x1 代码示例** 根据不同应用需求配置各集成外设的每个 MSP 器件均具备相应 C 代码示例。

**MSPWare™ 软件** MSPWare 软件集合了所有 MSP 器件的代码示例、数据表和其他设计资源一起提供给用户。除了提供现有 MSP 设计资源的完备集合外，MSPWare 软件还包含名为 MSP0 驱动程序库的高级 API。该库可简化针对 MSP 硬件的编程。MSPWare 软件以 CCS 组件或独立软件包两种形式提供。

**MSP 驱动程序库** 驱动程序库的抽象化 API 提供易于使用的函数调用，用户可以不再受到 MSP430 硬件位和字节数的局限。完整的文档通过帮助性 API 指南交付，其中包括有关每个函数调用和识别参数的详细信息。开发人员可以使用驱动程序库功能，以最低开销编写完整项目。

**MSP EnergyTrace™ 技术** MSP430 微控制器的 EnergyTrace 技术是基于能量的代码分析工具，用于测量和显示应用的能量配置，同时协助优化应用以实现超低功耗。

**ULP（超低功耗）Advisor** ULP Advisor™ 软件是一款辅助工具，旨在指导开发人员编写更为高效的代码，从而充分利用 MSP 和 MSP432 微控制器独特的超低功耗功能。ULP Advisor 的目标人群是微控制器的资深开发者和开发新手，可以根据详尽的 ULP 检验表检查代码，以便最大限度地利用应用程序。在编译时，ULP Advisor 会提供通知和备注以突出显示代码中可以进一步优化的区域，进而实现更低功耗。

**IEC60730 软件包** IEC60730 MSP430 软件包经过专门开发，用于协助客户达到 IEC 60730-1:2010（家用及类似用途的自动化电气控制 - 第 1 部分：一般要求）B 类产品的要求。其中涵盖家用电器、电弧检测器、电源转换器、电动工具、电动自行车及其他诸多产品。IEC60730 MSP430 软件包可以嵌入在 MSP430 中运行的客户应用程序，从而帮助客户简化其消费类器件在功能安全方面遵循 IEC 60730-1:2010 B 类规范的认证工作。

**适用于 MSP 的定点数学运算库** MSP IQmath 和 Qmath 库是一套经过高度优化的高精度数学运算函数集合，适用于 C 语言开发者，能够将浮点算法无缝嵌入 MSP430 和 MSP432 器件的定点代码中。这些例程通常用于计算密集的实时应用，而优化的执行速度、高精度以及超低能耗通常是影响这些实时应用的关键因素。与使用浮点数学算法编写的同等代码相比，使用 IQmath 和 Qmath 库可以大幅提高执行速度并显著降低能耗。

**适用于 MSP430 的浮点数学运算库** TI 在低功耗和低成本微控制器领域锐意创新，为您提供 MSPMATHLIB。这是标量函数的浮点数学运算库，能够充分利用器件的智能外设，使性能提升高达 26 倍。Mathlib 能够轻松集成到您的设计中。该运算库免费使用并集成在 Code Composer Studio 和 IAR IDE 中。如需深入了解该数学运算库及相关基准，请阅读用户指南。

## 开发工具

**适用于 MSP 微控制器的 Code Composer Studio™ 集成开发环境** Code Composer Studio 是一种集成开发环境 (IDE)，支持所有 MSP 微控制器器件。Code Composer Studio 由一套嵌入式软件实用程序组成，用于开发和调试嵌入式应用。它包含一个经过优化的 C/C++ 编译器、源代码编辑器、项目构建环境、调试器、分析器以及其他众多功能。直观的 IDE 提供单个用户界面，有助于实施应用开发流程的每个步骤。相似的实用程序和接口便于用户提升入门速度。Code Composer Studio 将 Eclipse 软件框架的优势和 TI 先进的嵌入式调试功能相结合，为嵌入式开发人员提供了一个功能丰富、具有说服力的开发环境。将 MSP MCU 与 CCS 搭配使用时，提供了独特且功能强大的插件集以及嵌入式软件实用程序，以充分利用 MSP 微控制器。

**命令行编程器** MSP Flasher 是一套基于 shell 的 MSP 微控制器开源编程接口，可利用 JTAG 或 SPY-Bi-Wire (SBW) 通信方式通过 FET 编程器或 eZ430 对 MSP 微控制器进行编程。MSP Flasher 可将二进制文件 (.txt 或 .hex 文件) 直接下载到 MSP 微控制器中，而无需使用 IDE。

**MSP MCU 编程器和调试器** MSP-FET 是一款强大的仿真开发工具（通常称为调试探针），可帮助用户在 MSP 低功耗微控制器 (MCU) 中快速开发应用。创建 MCU 软件通常需要将生成的二进制程序下载到 MSP 器件中，从而进行验证和调试。MSP-FET 在主机和目标 MSP 之间提供调试通信通道。此外，MSP-FET 在计算机的 USB 接口和 MSP UART 之间还提供 UART 反向通道连接。这就为 MSP 编程器提供了一种在 MSP 和运行在计算机上的终端之间进行串行通信的便利方法。它还支持使用 BSL（引导加载程序）通过 UART 和 I<sup>2</sup>C 通信协议将程序（通常称为固件）直接下载到 MSP 目标中。

**MSP-GANG 生产编程器** MSP Gang 编程器是一个适用于 MSP430 或 MSP432 器件的编程器，能够同时对多达八个相同的 MSP430 或 MSP432 闪存或 FRAM 器件进行编程。MSP Gang 编程器可使用标准的 RS-232 或 USB 连接与主机 PC 相连，同时提供灵活的编程选项，允许用户完全自定义流程。MSP Gang 编程器配有扩展板，即“Gang 分离器”，可在 MSP Gang 编程器和多个目标器件间实施互连。提供了八条电缆，用于将扩展板与八个目标器件相连（通过 JTAG 或 SPY-Bi-Wire 连接器）。编程工作可在 PC 或独立设备上完成。PC 端具备基于 DLL 的图形化用户界面。

## 7.4 文档支持

以下文档介绍 MSP430F51x2 和 MSP430F51x1 器件。[www.ti.com.cn](http://www.ti.com.cn) 网站上提供了这些文档的副本。

### 接收文档更新通知

如需接收文档更新通知（包括芯片勘误表），请访问 [ti.com](http://ti.com) 网站上的器件产品文件夹（例如 [MSP430F5172](#)）。单击右上角的“提醒我”(Alert me) 按钮。点击后，您将每周定期收到已更改的产品信息（如果有的话）。有关更改的详细信息，请查阅已修订文档的修订历史记录。

### 勘误

《[MSP430F5172 器件勘误表](#)》 描述了对此器件的所有芯片修订版本功能技术规格的已知例外情况。

《[MSP430F5152 器件勘误表](#)》 描述了对此器件的所有芯片修订版本功能技术规格的已知例外情况。

《[MSP430F5132 器件勘误表](#)》 描述了对此器件的所有芯片修订版本功能技术规格的已知例外情况。

《[MSP430F5171 器件勘误表](#)》 描述了对此器件的所有芯片修订版本功能技术规格的已知例外情况。

《[MSP430F5151 器件勘误表](#)》 描述了对此器件的所有芯片修订版本功能技术规格的已知例外情况。

《[MSP430F5131 器件勘误表](#)》 描述了对此器件的所有芯片修订版本功能技术规格的已知例外情况。

### 用户指南

《[MSP430x5xx 和 MSP430x6xx 系列用户指南](#)》 详细介绍了该器件系列提供的模块和外设。

《[适用于 MSP430 的 Code Composer Studio v6.1 用户指南](#)》 本手册描述了 TI Code Composer Studio IDE v6.1 (CCS v6.1) 以及 MSP430 超低功耗微控制器的使用方法。本文档仅适用于 Code Composer Studio IDE 的 Windows 版本。由于 Linux 版本与之类似，因此未单独进行说明。

《[适用于 MSP430 的 IAR 嵌入式工作平台版本 3+ 用户指南](#)》 本手册介绍了 IAR 嵌入式工作平台 (EW430) 和 MSP430 超低功耗微控制器的使用。

《利用引导加载程序 (BSL) 对 MSP430 进行编程》 MSP430 引导加载程序 (BSL, 之前称为引导装载程序) 方便用户在原型建模阶段、最终生产和维修期间与 MSP430 微控制器中的嵌入式存储器进行通信。可编程存储器 (闪存) 和数据存储器 (RAM) 能够按照要求进行变更。不要将此处的引导加载程序与某些数字信号处理器 (DSP) 中将外部存储器中的程序代码 (和数据) 自动加载到 DSP 内部存储器的引导装载程序混为一谈。

《通过 JTAG 接口对 MSP430 进行编程》 本文档介绍了使用 JTAG 通信端口对基于 MSP430 闪存和 FRAM 的微控制器系列进行擦除、编程和验证的存储器模块所需的功能。此外, 该文档还介绍了如何通过编程设定所有 MSP430 器件提供的 JTAG 访问安全熔丝。本文档介绍了使用标准四线制 JTAG 接口和双线制 JTAG 接口 (也称为 Spy-Bi-Wire (SBW)) 进行器件访问。

《MSP430 硬件工具用户指南》 本手册介绍了 TI MSP-FET430 闪存仿真工具 (FET) 的硬件。FET 是针对 MSP430 超低功耗微控制器的程序开发工具。对提供的接口类型, 即并行端口接口和 USB 接口进行了说明。

## 应用报告

**MSP430 32kHz 晶体振荡器** 选择适当的晶体、正确的负载电路和适合的板面布局对于实现稳定的晶体振荡器而言至关重要。此应用报告总结了晶体振荡器的功能, 介绍了为实现 MSP430 超低功耗运行而选择正确晶体的参数。此外, 还给出了正确电路板布局布线的提示和示例。本文档还包含与可能振荡器测试相关的详细信息以确保大批量生产中的稳定振荡器运行。

《MSP430 系统级 ESD 注意事项》 系统级 ESD 对于低电压下的硅晶技术以及经济高效型和超低功耗组件的需求日益增加。此应用报告重点讨论了三个不同的 ESD 主题, 以帮助板卡设计师和原始设备制造商 (OEM) 理解和设计稳健的系统级设计产品: (1) 组件级 ESD 测试和系统级 ESD 测试, 二者的差异以及为何组件级 ESD 无法确保达到系统级的稳健性。(2) 系统级 ESD 保护在不同电平下的通用设计指南 (包括外壳、电缆、PCB 布局和板载 ESD 防护器件)。(3) 介绍了系统高效 ESD 设计 (SEED)。这是一种板上和片上 ESD 保护协同设计的方法论, 用于实现系统级 ESD 的稳健性, 配备仿真示例和测试结果。另外, 还讨论了一些真实的系统级 ESD 保护设计示例及其成果。

## 7.5 相关链接

表 7-2 列出了快速访问链接。范围包括技术文档、支持与社区资源、工具和软件, 并且可以快速访问样片或购买链接。

表 7-2. 相关链接

| 器件          | 产品文件夹                 | 样片与购买                 | 技术文档                  | 工具与软件                 | 支持与社区                 |
|-------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|
| MSP430F5172 | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |
| MSP430F5152 | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |
| MSP430F5132 | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |
| MSP430F5171 | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |
| MSP430F5151 | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |
| MSP430F5131 | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |

## 7.6 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### [TI E2E™ Community](#)

*TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas, and help solve problems with fellow engineers.

### [TI Embedded Processors Wiki](#)

*Texas Instruments Embedded Processors Wiki.* Established to help developers get started with embedded processors from Texas Instruments and to foster innovation and growth of general knowledge about the hardware and software surrounding these devices.

## 7.7 商标

MSP430, MSPWare, EnergyTrace, ULP Advisor, 适用于 MSP 微控制器的 Code Composer Studio, E2E are trademarks of Texas Instruments.

All other trademarks are the property of their respective owners.

## 7.8 静电放电警告



ESD 可能会损坏该集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理措施和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

## 7.9 出口管制提示

接收方同意：如果美国或其他适用法律限制或禁止将通过非披露义务的披露方获得的任何产品或技术数据（其中包括软件）（见美国、欧盟和其他出口管理条例之定义）、或者其他适用国家条例限制的任何受管制产品或此项技术的任何直接产品出口或再出口至任何目的地，那么在没有事先获得美国商务部和其他相关政府机构授权的情况下，接收方不得在知情的情况下，以直接或间接的方式将其出口。

## 7.10 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 8 机械、封装和可订购信息

以下页中包括机械、封装和可订购信息。这些信息是针对指定器件可提供的最新数据。这些数据会在无通知且不对本文档进行修订的情况下发生改变。欲获得该数据表的浏览器版本，请查阅左侧的导航栏。

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| MSP430F5131IDA   | ACTIVE        | TSSOP        | DA                 | 38   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430F5131               | <a href="#">Samples</a> |
| MSP430F5131IDAR  | ACTIVE        | TSSOP        | DA                 | 38   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430F5131               | <a href="#">Samples</a> |
| MSP430F5131RSBR  | ACTIVE        | WQFN         | RSB                | 40   | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430<br>F5131           | <a href="#">Samples</a> |
| MSP430F5131RSBT  | ACTIVE        | WQFN         | RSB                | 40   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430<br>F5131           | <a href="#">Samples</a> |
| MSP430F5131YFFR  | ACTIVE        | DSBGA        | YFF                | 40   | 3000           | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | M430F5131               | <a href="#">Samples</a> |
| MSP430F5131YFFT  | ACTIVE        | DSBGA        | YFF                | 40   | 250            | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | M430F5131               | <a href="#">Samples</a> |
| MSP430F5132IDA   | ACTIVE        | TSSOP        | DA                 | 38   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430F5132               | <a href="#">Samples</a> |
| MSP430F5132IDAR  | ACTIVE        | TSSOP        | DA                 | 38   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430F5132               | <a href="#">Samples</a> |
| MSP430F5132RSBR  | ACTIVE        | WQFN         | RSB                | 40   | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430<br>F5132           | <a href="#">Samples</a> |
| MSP430F5132RSBT  | ACTIVE        | WQFN         | RSB                | 40   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430<br>F5132           | <a href="#">Samples</a> |
| MSP430F5132YFFR  | ACTIVE        | DSBGA        | YFF                | 40   | 3000           | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | M430F5132               | <a href="#">Samples</a> |
| MSP430F5132YFFT  | ACTIVE        | DSBGA        | YFF                | 40   | 250            | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | M430F5132               | <a href="#">Samples</a> |
| MSP430F5151IDA   | ACTIVE        | TSSOP        | DA                 | 38   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430F5151               | <a href="#">Samples</a> |
| MSP430F5151IDAR  | ACTIVE        | TSSOP        | DA                 | 38   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430F5151               | <a href="#">Samples</a> |
| MSP430F5151RSBR  | ACTIVE        | WQFN         | RSB                | 40   | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430<br>F5151           | <a href="#">Samples</a> |
| MSP430F5151RSBT  | ACTIVE        | WQFN         | RSB                | 40   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430<br>F5151           | <a href="#">Samples</a> |
| MSP430F5151YFFR  | ACTIVE        | DSBGA        | YFF                | 40   | 3000           | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | M430F5151               | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| MSP430F5151IYFFT | ACTIVE        | DSBGA        | YFF                | 40   | 250            | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | M430F5151               | <a href="#">Samples</a> |
| MSP430F5152IDA   | ACTIVE        | TSSOP        | DA                 | 38   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430F5152               | <a href="#">Samples</a> |
| MSP430F5152IDAR  | ACTIVE        | TSSOP        | DA                 | 38   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430F5152               | <a href="#">Samples</a> |
| MSP430F5152IRSB  | ACTIVE        | WQFN         | RSB                | 40   | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430<br>F5152           | <a href="#">Samples</a> |
| MSP430F5152IRSBT | ACTIVE        | WQFN         | RSB                | 40   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430<br>F5152           | <a href="#">Samples</a> |
| MSP430F5152IYFFR | ACTIVE        | DSBGA        | YFF                | 40   | 3000           | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | M430F5152               | <a href="#">Samples</a> |
| MSP430F5152IYFFT | ACTIVE        | DSBGA        | YFF                | 40   | 250            | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | M430F5152               | <a href="#">Samples</a> |
| MSP430F5171IDA   | ACTIVE        | TSSOP        | DA                 | 38   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430F5171               | <a href="#">Samples</a> |
| MSP430F5171IDAR  | ACTIVE        | TSSOP        | DA                 | 38   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430F5171               | <a href="#">Samples</a> |
| MSP430F5171IRSB  | ACTIVE        | WQFN         | RSB                | 40   | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430<br>F5171           | <a href="#">Samples</a> |
| MSP430F5171IRSBT | ACTIVE        | WQFN         | RSB                | 40   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430<br>F5171           | <a href="#">Samples</a> |
| MSP430F5171IYFFR | ACTIVE        | DSBGA        | YFF                | 40   | 3000           | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | M430F5171               | <a href="#">Samples</a> |
| MSP430F5171IYFFT | ACTIVE        | DSBGA        | YFF                | 40   | 250            | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | M430F5171               | <a href="#">Samples</a> |
| MSP430F5172IDA   | ACTIVE        | TSSOP        | DA                 | 38   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430F5172               | <a href="#">Samples</a> |
| MSP430F5172IDAR  | ACTIVE        | TSSOP        | DA                 | 38   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430F5172               | <a href="#">Samples</a> |
| MSP430F5172IRSB  | ACTIVE        | WQFN         | RSB                | 40   | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430<br>F5172           | <a href="#">Samples</a> |
| MSP430F5172IRSBT | ACTIVE        | WQFN         | RSB                | 40   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-2-260C-1 YEAR  | -40 to 85    | M430<br>F5172           | <a href="#">Samples</a> |
| MSP430F5172IYFFR | ACTIVE        | DSBGA        | YFF                | 40   | 3000           | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | M430F5172               | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| MSP430F5172IYFFT | ACTIVE        | DSBGA        | YFF                | 40   | 250            | Green (RoHS<br>& no Sb/Br) | SNAGCU                  | Level-1-260C-UNLIM   | -40 to 85    | M430F5172               | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

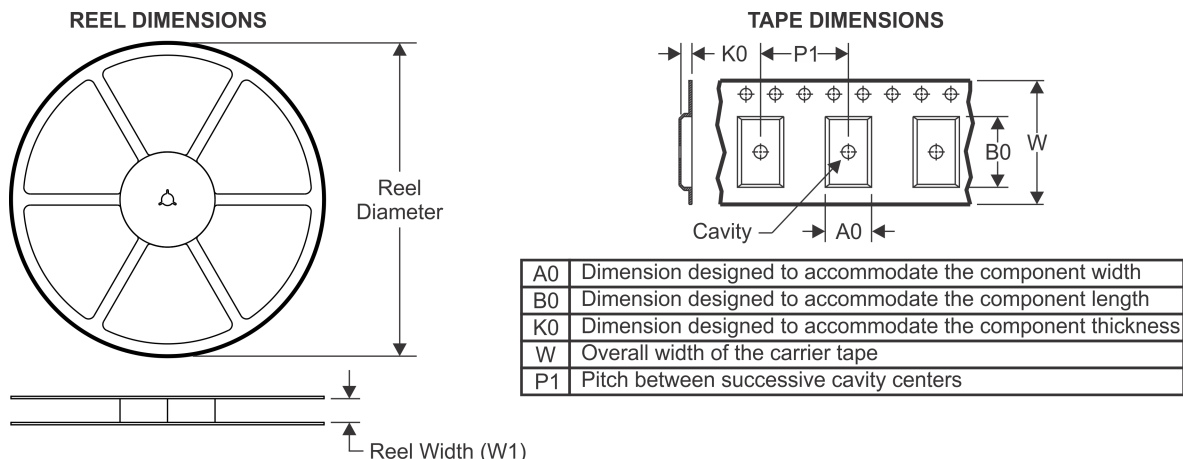
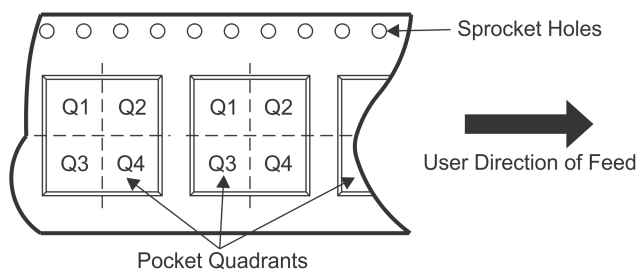
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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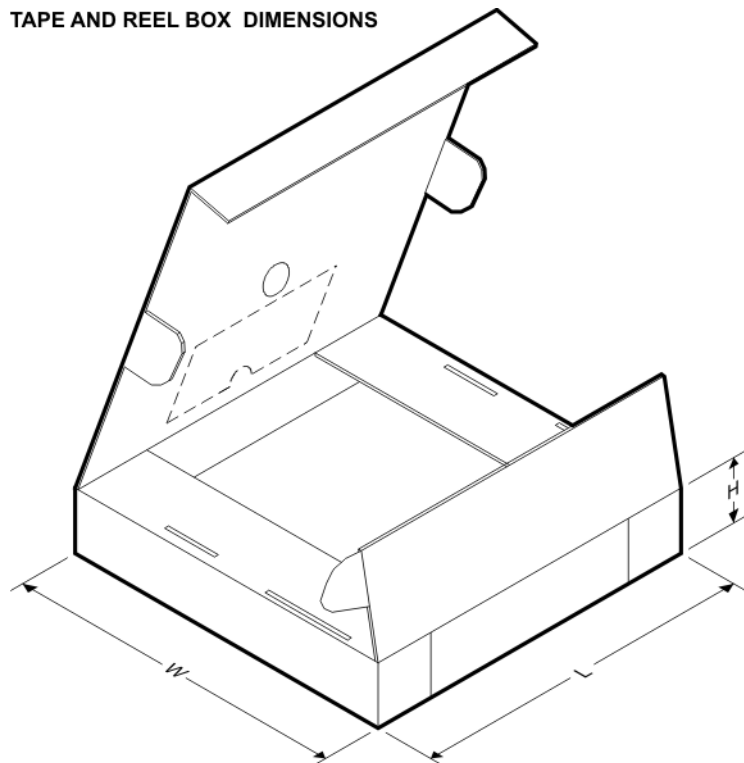
**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| MSP430F5131IDAR  | TSSOP        | DA              | 38   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |
| MSP430F5131IRSB  | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5131IRSBT | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5131IYFFR | DSBGA        | YFF             | 40   | 3000 | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5131IYFFT | DSBGA        | YFF             | 40   | 250  | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5132IDAR  | TSSOP        | DA              | 38   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |
| MSP430F5132IRSB  | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5132IRSBT | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5132IYFFR | DSBGA        | YFF             | 40   | 3000 | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5132IYFFT | DSBGA        | YFF             | 40   | 250  | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5151IDAR  | TSSOP        | DA              | 38   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |
| MSP430F5151IRSB  | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5151IRSBT | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5151IYFFR | DSBGA        | YFF             | 40   | 3000 | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5151IYFFT | DSBGA        | YFF             | 40   | 250  | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5152IDAR  | TSSOP        | DA              | 38   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |
| MSP430F5152IRSB  | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5152IRSBT | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| MSP430F5152IYFFR | DSBGA        | YFF             | 40   | 3000 | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5152IYFFT | DSBGA        | YFF             | 40   | 250  | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5171IDAR  | TSSOP        | DA              | 38   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |
| MSP430F5171IRSB  | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5171IRSBT | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5171IYFFR | DSBGA        | YFF             | 40   | 3000 | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5171IYFFT | DSBGA        | YFF             | 40   | 250  | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5172IDAR  | TSSOP        | DA              | 38   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |
| MSP430F5172IRSB  | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5172IRSBT | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.5     | 8.0     | 12.0   | Q2            |
| MSP430F5172IYFFR | DSBGA        | YFF             | 40   | 3000 | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |
| MSP430F5172IYFFT | DSBGA        | YFF             | 40   | 250  | 180.0              | 8.4                | 2.86    | 3.16    | 0.69    | 4.0     | 8.0    | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

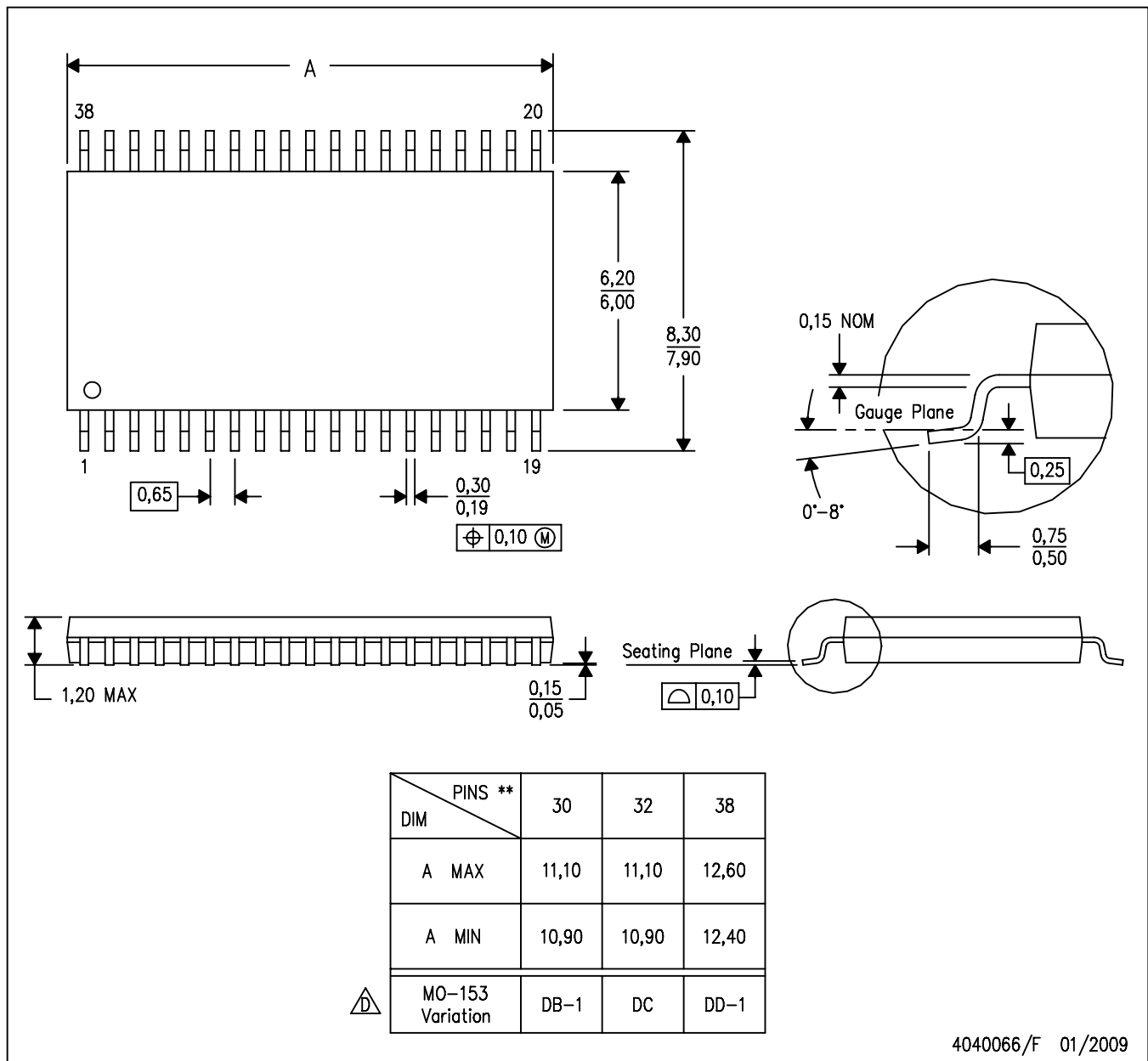
| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| MSP430F5131IDAR  | TSSOP        | DA              | 38   | 2000 | 367.0       | 367.0      | 45.0        |
| MSP430F5131IRSB  | WQFN         | RSB             | 40   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430F5131IRSBT | WQFN         | RSB             | 40   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430F5131IYFFR | DSBGA        | YFF             | 40   | 3000 | 182.0       | 182.0      | 20.0        |
| MSP430F5131IYFFT | DSBGA        | YFF             | 40   | 250  | 182.0       | 182.0      | 20.0        |

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| MSP430F5132IDAR  | TSSOP        | DA              | 38   | 2000 | 367.0       | 367.0      | 45.0        |
| MSP430F5132IRSB  | WQFN         | RSB             | 40   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430F5132IRSBT | WQFN         | RSB             | 40   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430F5132IYFFR | DSBGA        | YFF             | 40   | 3000 | 182.0       | 182.0      | 20.0        |
| MSP430F5132IYFFT | DSBGA        | YFF             | 40   | 250  | 182.0       | 182.0      | 20.0        |
| MSP430F5151IDAR  | TSSOP        | DA              | 38   | 2000 | 367.0       | 367.0      | 45.0        |
| MSP430F5151IRSB  | WQFN         | RSB             | 40   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430F5151IRSBT | WQFN         | RSB             | 40   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430F5151IYFFR | DSBGA        | YFF             | 40   | 3000 | 182.0       | 182.0      | 20.0        |
| MSP430F5151IYFFT | DSBGA        | YFF             | 40   | 250  | 182.0       | 182.0      | 20.0        |
| MSP430F5152IDAR  | TSSOP        | DA              | 38   | 2000 | 367.0       | 367.0      | 45.0        |
| MSP430F5152IRSB  | WQFN         | RSB             | 40   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430F5152IRSBT | WQFN         | RSB             | 40   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430F5152IYFFR | DSBGA        | YFF             | 40   | 3000 | 182.0       | 182.0      | 20.0        |
| MSP430F5152IYFFT | DSBGA        | YFF             | 40   | 250  | 182.0       | 182.0      | 20.0        |
| MSP430F5171IDAR  | TSSOP        | DA              | 38   | 2000 | 367.0       | 367.0      | 45.0        |
| MSP430F5171IRSB  | WQFN         | RSB             | 40   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430F5171IRSBT | WQFN         | RSB             | 40   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430F5171IYFFR | DSBGA        | YFF             | 40   | 3000 | 182.0       | 182.0      | 20.0        |
| MSP430F5171IYFFT | DSBGA        | YFF             | 40   | 250  | 182.0       | 182.0      | 20.0        |
| MSP430F5172IDAR  | TSSOP        | DA              | 38   | 2000 | 367.0       | 367.0      | 45.0        |
| MSP430F5172IRSB  | WQFN         | RSB             | 40   | 3000 | 367.0       | 367.0      | 35.0        |
| MSP430F5172IRSBT | WQFN         | RSB             | 40   | 250  | 210.0       | 185.0      | 35.0        |
| MSP430F5172IYFFR | DSBGA        | YFF             | 40   | 3000 | 182.0       | 182.0      | 20.0        |
| MSP430F5172IYFFT | DSBGA        | YFF             | 40   | 250  | 182.0       | 182.0      | 20.0        |

DA (R-PDSO-G\*\*)

38 PIN SHOWN

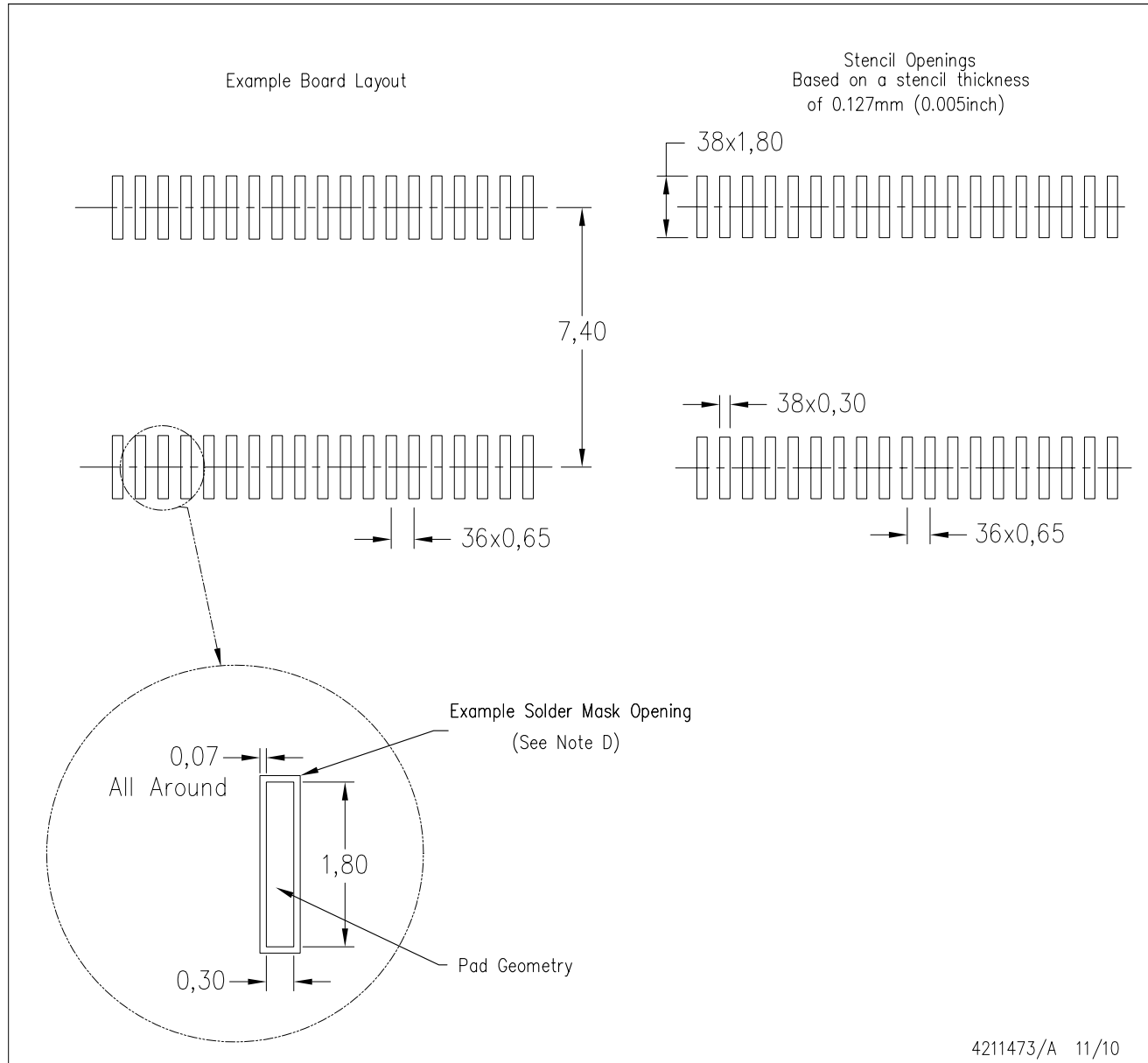
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - Falls within JEDEC MO-153, except 30 pin body length.

DA (R-PDSO-G38)

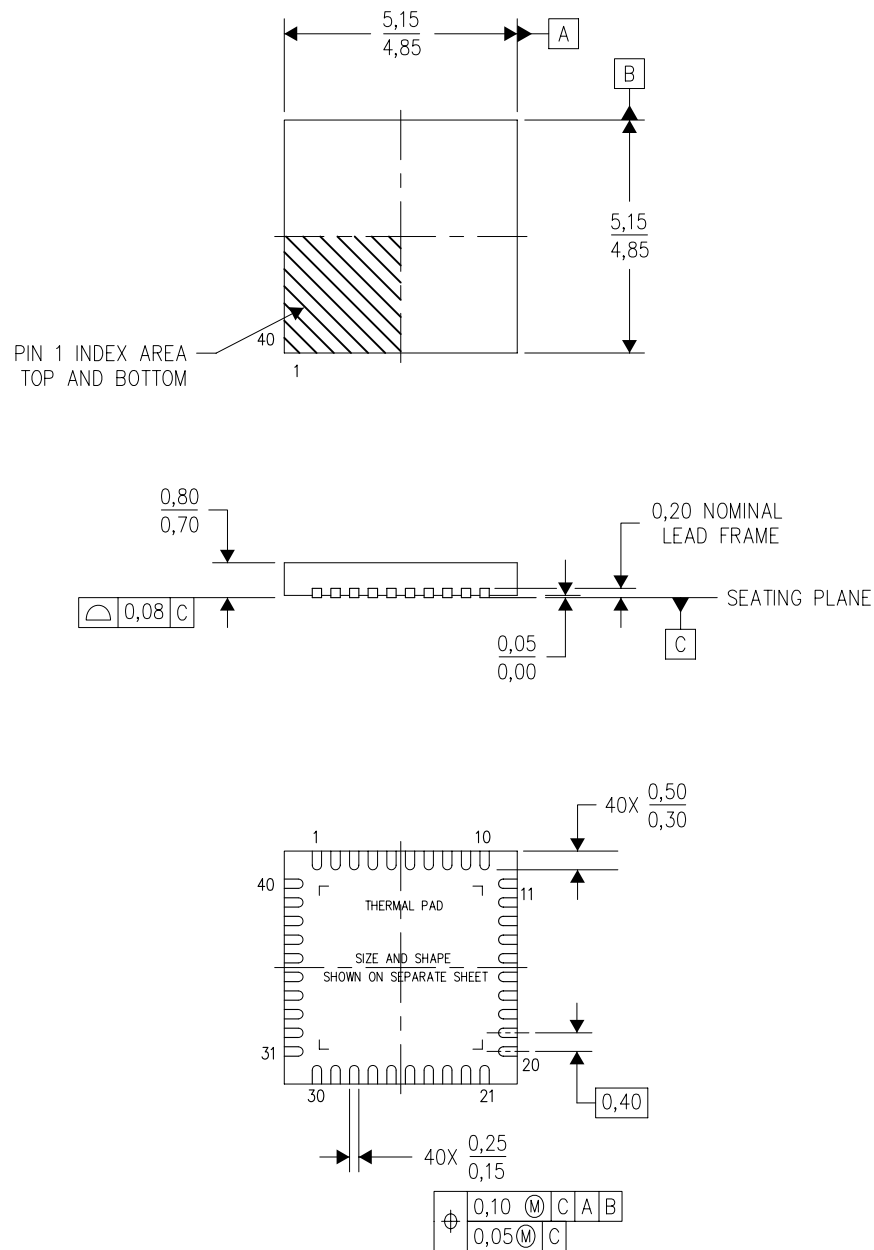
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.
  - D. Contact the board fabrication site for recommended soldermask tolerances.

RSB (S-PWQFN-N40)

PLASTIC QUAD FLATPACK NO-LEAD



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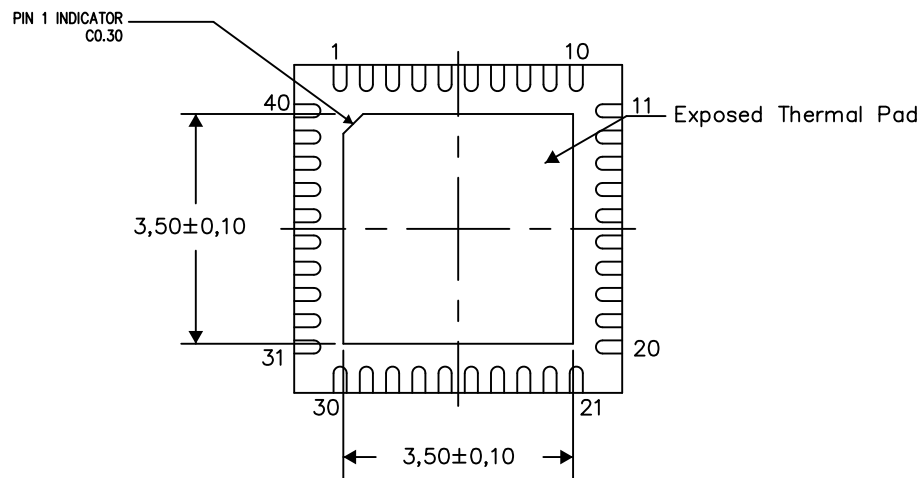
- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - This drawing is subject to change without notice.
  - QFN (Quad Flatpack No-Lead) Package configuration.
  - The package thermal pad must be soldered to the board for thermal and mechanical performance.
  - See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.

### THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at [www.ti.com](http://www.ti.com).

The exposed thermal pad dimensions for this package are shown in the following illustration.



Bottom View

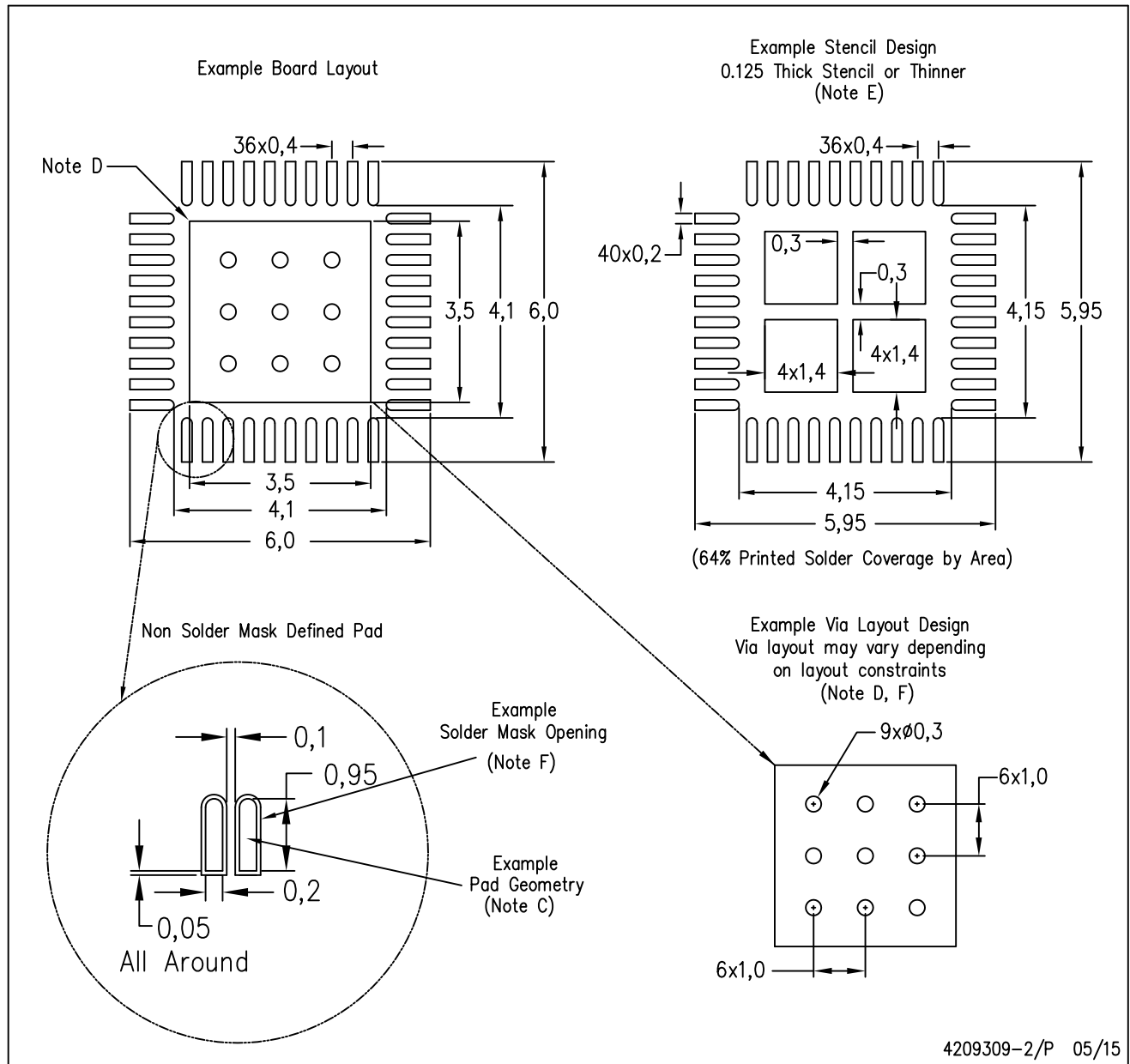
Exposed Thermal Pad Dimensions

4207183-2/R 05/15

NOTE: All linear dimensions are in millimeters

RSB (S-PWQFN-N40)

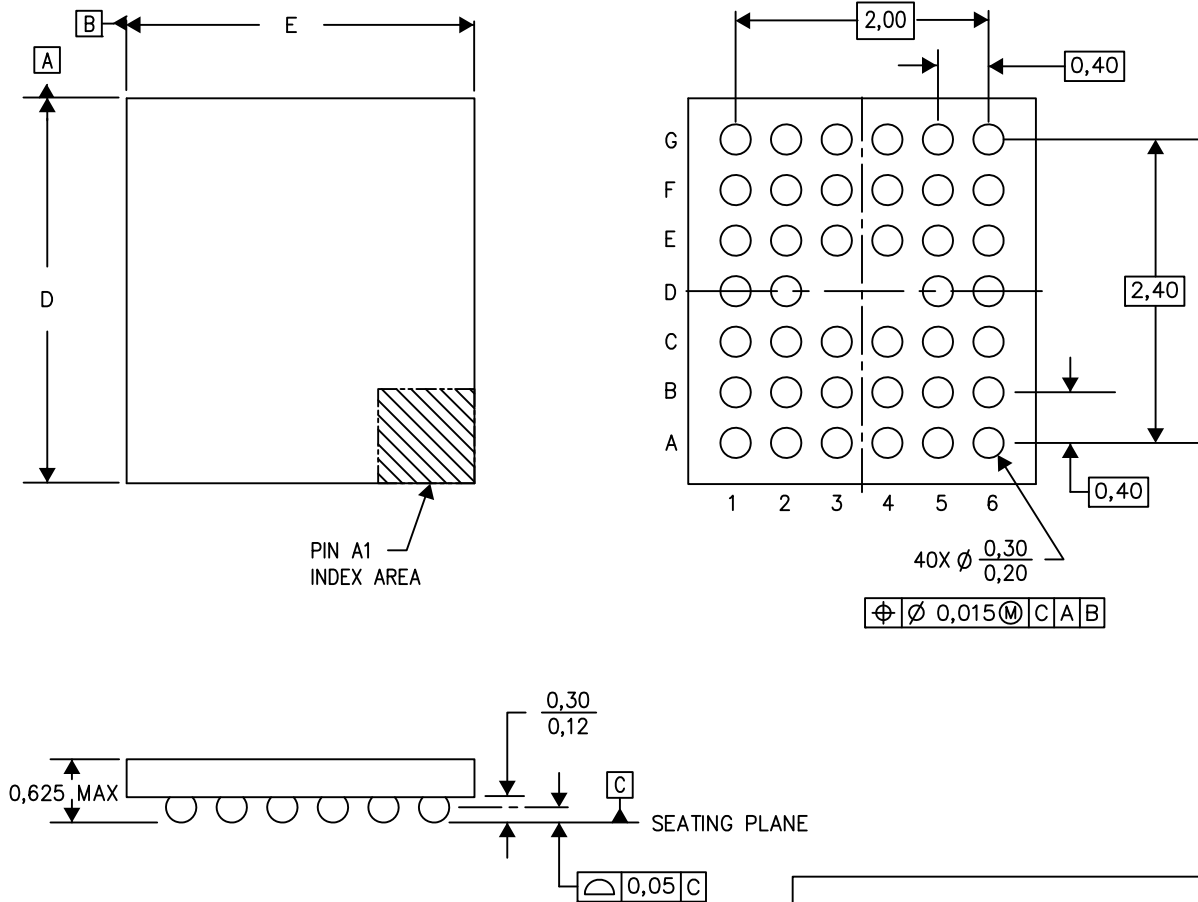
PLASTIC QUAD FLATPACK NO-LEAD



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack Packages, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at [www.ti.com](http://www.ti.com) <<http://www.ti.com>>.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
  - Customers should contact their board fabrication site for recommended solder mask tolerances and via tenting recommendations for vias placed in the thermal pad.

YFF (R-XBGA-N40)

DIE-SIZE BALL GRID ARRAY



4207625-35/A0 12/13

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. NanoFree™ package configuration.

NanoFree is a trademark of Texas Instruments.

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